

SPECIAL ISSUE—Part 1 Product Showcase No 26

R

Highlighting key trends in power sources, software, integrated circuits, and hardware and interconnects Expanded literature section

ELECTRONIC TECHNOLOGY FOR ENGINEERS AND ENGINEERING MANAGERS

PRODUCT SHOWCASE

They're field programmable (even re-programmable). And they give you up to 1800 usable gates in an extremely flexible architecture.

Naturally, we have all the programming tools you'll need to get your PLDs up and running in a hurry. The latest version of our PALASM[®] CAD software for your PAL designs. And XACT[™] software for LCAs.

Best of all, we'll support you with a team of FAEs that's worked around

programmable logic for years.

So call or write us for a CMOS sample kit and data sheets. Monolithic Memories, 2175 Mission College Blvd., M/S 09-14, Santa Clara, CA 95054-1592. (800) 222-9323.

And start getting the most out of CMOS.



PAL and PALASM are registered trademarks and ZPAL is a trademark of Monolithic Memories, Inc. Logic Cell and XACT are trademarks of XILINX, Inc. © 1987, Monolithic Memories



CMOST.

There was nothing to it really. Instead of making one CMOS PLD (like some competitors we could name), Monolithic Memories makes many.

So many, in fact, that our CMOS PLDs offer you more speed, power and architecture options than you can get from any of our competitors.

Take our ZPAL[™] family, for example. It's a zero standby power (less than 100µA) version of our popular PAL[®] C20R8 Series. And it comes in both 35ns and 45ns versions.

Or for universal applications, our PAL C22V10 combines a wide-open architecture with 25ns or 35ns speed. Yet it consumes a mere 90mA.

Better yet, our new quarter-power CMOS PAL C16R8 Series devices consume but 45mA. While their 25ns speed approaches the best of bipolar.

And should you need gate array density, but prefer PLD convenience, try our CMOS Logic Cell[™] Arrays (LCA).



CMOS.

How we improved CMOS PLDs.

Access Dale's MIL Arsenal.

Be prepared to save time and add efficiency when buying or specifying MIL components. Check the list at right then call Dale[®]. We have carefully assembled the industry's broadest stock of MIL resistors including networks...chips...wirewound and metal film. And, we can also supply RF chokes and connectors to popular MIL requirements. This complete arsenal is stockpiled at strategic factory and distributor. locations — giving you a reliable source of supply that will assure operation with low inventories. For complete information contact your Dale representative, your distributor, or call the factory.

RESISTOR NETWORKS Phone 915-592-3253 MIL-R-83401 • RZ010, RZ020, RZ030 • RZ040, RZ050, RZ060

In

• R2040, R2050, R2060 • R2070, R2080, R2090 THICK FILM CHIPS Phone 402-371-0080

MIL-R-55342/2,/3,/4,/5,/6 • RM0505, RM1005, RM1505 • RM2208, RM0705

METAL FILM RESISTORS Phone 402-371-0080 MIL-R-122 MIL-R-10509 • RN50, RN55, RN60 • RN50, RN55, RN60

MIL-R-22684

• RL07, RL20 MIL-R-39017

- RLR05, RLR07, RLR20 MIL-R-55182
- RNR55, RNR60, RNR65
- RNC50, RNC55, RNC60 • RNC65, RNC70

WIREWOUND RESISTORS Phone 402-564-3131 MIL-R-26

RW67, RW68, RW69
RW70, RW74, RW78, RW79
RW80, RW81
MIL-R-18546

• RE60, RE65, RE70 • RE75, RE77, RE80

MIL-R-39007

- RWR71, RWR74, RWR78
- RWR80, RWR81, RWR82 • RWR84, RWR89
- MIL-R-39009
- RER40, RER45, RER50
- RER55, RER60, RER65
- RER70, RER75

INDUCTORS Phone 605-665-9301 MIL-C-15305 • MS75087, MS75088, MS75089

MS75083, MS75084, MS75085
MS14046, MS18130, MS90538

CONNECTORS Phone 605-665-9301 MIL-C-28748/7,/8



Dale makes your basics better:

Standards Update

Uncle Sam Cracks Down on Computer Interference

ast Fall's COMDEX show in Las Vegas had a new kind of visitor. Federal marshals were there to seize equipment the FCC had tagged as non-compliant and to serve notice that arrests may follow. The computers were found to be in violation of Part 15 of the FCC rules, which bans sales of most electronic hardware unless tested for compliance.

The event did not surprise most computer executives, some of whom paid their share of more than \$800,000 in fines issued by the FCC last year. Said one disgruntled manager, "These guys walk around here like Matt Dillon."

The need to comply has spawned a whole new kind of test business, companies specially skilled in designing and testing for compliance. One of these, the Boxborough, MA-based laboratory of Dash, Straus & Goodhue, combines testing, design and even legal services under one roof, permitting manufacturers to go to COMDEX with their minds on sales, not sanctions. The company even offers a "Guaranteed



Rate/Guaranteed Date" plan under which equipment is tested, modified for compliance, and retested per FCC standards for a fixed price guaranteed in advance. The laboratory has been accredited by the National Bureau of Standards for telecommunications and emissions testing, and can be reached at 617-263-2662.

Canada Lays Out the Welcome Mat for Telecom Firms

The Canadian government has swung its doors wide open for US telecom manufacturers. The open door policy is a welcome change for US manufacturers who have found most foreign markets closed to their goods. Canada's free trade telecom policy has allowed savvy manufacturers to increase their sales by up to 20%. But to sell north of the border, firms still need to follow a few simple steps. Most importantly, the equipment has to be registered under Canadian Standard CS-03, roughly equivalent to the FCC's interconnect regulations in Part 68. The government of Canada has already approved a number of firms in the United States to do the required telecom testing and submissions. One such firm, Dash, Straus & Goodhue of Boxborough, MA (617-263-2662), has seen a sharp rise in requests for Canadian approvals, especially among the industry's most successful firms. "There seems to be a correlation between economic success and willingness to enter foreign markets," says firm founder Glen Dash.

Fed's Own Instruments Help Manufacturers Comply

What kind of tools can best convince an agency that equipment complies? Why, their own, of course. Now the FCC's own designs are available through a company called Compliance Design. Key to emissions compliance is the use of the **Roberts Antenna**, developed for the FCC in the 1950's. Willmar Roberts, its inventor, is a former Assistant Chief Engineer of the FCC Laboratory in Laurel, MD.

The antennas are renowned for their near-lossless characteristics. Compliance Design, the exclusive vendor of the Roberts brand, also offers a complete laboratory assembly package. The firm will supply antennas, masts, turntables, site design; and will even perform the crucial "site attenuation" tests the FCC requires. The Boxborough, MA-firm can be reached at 617-264-4668.

Safety Violation Sends a CEO to Jail

• n February 13, Kenneth Oden, prosecutor for Travis County, TX, won a landmark case that sent shivers down corporate backbones nationwide. For the first time, company executives were sentenced to jail terms for negligence that cost a worker his life. The case highlighted a nationwide trend in which prosecutors are holding executives criminally liable for the death of a customer or employee.

For makers of EDP, medical and telecom equipment, safety on the job generally means getting their products UL[®] listed. Listing is a recognition that the product meets UL's standards for fire, shock, energy and mechanical hazards; listing is a legal requirement of certain municipalities. In those places, a death caused by a non-compliant product could give rise to the same charge of gross negligence which caused Travis County executives to be sentenced to jail. Elsewhere in the world, telecom markets are opening. Dash, Straus & Goodhue is currently performing submissions for telecom equipment in both the United Kingdom and Japan. New efforts within the Common Market (EC Directive 86/361/EEC) may make one unified approval scheme throughout Western Europe a reality within two to three years.





For telecom manufacturers, Compliance Design also supplies a **Part 68 Workstation**[™] containing everything that's needed to comply with FCC, CS-03 (Canada) and EIA standards. The Workstation makes setting up Part 68 laboratories practical for just about everyone.

Overseas, marks such as Canada's CSA and West Germany's GS are required, and foreign courts have been even less tolerant of corporate negligence than have our own. With the profusion of worldwide standards, obtaining those marks has proven to be quite a chore. Fortunately, certain key test labs have set up liaison services which permit worldwide product approvals at one location. Dash, Straus & Goodhue is one such lab and is regularly visited by agents of UL, CSA and West German TüV. Required marks for fourteen countries can be initiated from DS&G's location. Since the Travis County case, according to execs, its business has been brisk. Dash, Straus & Goodhue, Inc. can be reached at 617-263-2662.



Dash, Straus & Goodhue, Inc., 593 Massachusetts Avenue, Boxborough, MA 01719 617-263-2662

rugged plug-in **Complifiers**

0.5 to 1000/MHz from \$1395 (5 to 24 qty)

Tough enough to meet full MIL-specs, capable of operating over a wide -55° to +100°C temperature range, in a rugged package... that's Mini-Circuits' new MAN-amplifier series. The MAN-amplifier's tiny package (only 0.4 by 0.8 by 0.25 in.) requires about the same pc board area as a TO-8 and can take tougher punishment with leads that won't break off. Models are unconditionally stable and available covering frequency ranges 0.5 to 500MHz and 0.5 to 1000MHz, and NF as low as 2.8dB.

Prices start at only \$13.95, *including* screening, thermal shock -55°C to +100°C, fine and gross leak, and burn-in for 96 hours at 100°C under normal operating voltage and current.

Internally the MAN amplifiers consist of two stages, including coupling capacitors. A designer's delight, with all components self-contained. Just connect to a dc supply voltage and get up to 28dB gain with +9dBm output.

The new MAN-amplifier series...

another Mini-Circuits' price/performance breakthrough.

	FREQ. RANGE (MHz)	GA	AIN	MAX. OUT/PWR†	NF dB	DC PWR 12V,	PRICE \$ ea.
MODEL	f _L to f _u	min	flatness++	dBm	(typ)	mA	(5-24)
MAN-1 MAN-2 MAN-1LN	0.5-500 0.5-1000 0.5-500	28 19 28	1.0 1.5 1.0	8 7 8	4.5 6.0 2.8	60 85 60	13.95 15.95 15.95
♦MAN-1HLN	10-500	10	0.8	15	3.7	70	15.95

 $\label{eq:linear} \begin{array}{l} ++ \mbox{Midband 10f}_L \mbox{ to } \mbox{I}_{4/2}, \pm \mbox{0.5dB} \\ + \mbox{IdB Gain Compression} \\ \mbox{Max input power (no damage) +15dBm; VSWR in/out 1.8:1 max.} \end{array}$

♦Case Height 0.3 In.

finding new ways ... setting higher standards



A Division of Scientific Components Corporation P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 Domestic and International Telexes: 6852844 or 620156

CIRCLE NO 189

tiny SPDT switch dc to 4.6 GHz... \$3295 (1-24)

Tough enough to pass stringent MIL-STD-202 tests, useable from dc to 6GHz operation, and smaller than most RF switches, Mini-Circuits' hermetically-sealed KSW-2-46 offers a new, unexplored horizon of applications. Unlike pin diode switches that become ineffective below 1MHz, this GaAs switch can operate down to dc with control voltage as low as -5V, at a blinding 2ns switching speed.

Despite its extremely tiny size, only 0.185 by 0.185 by 0.06 in., the KSW-2-46 provides 50dB isolation (considerably higher than many larger units) and insertion loss of only 1dB. The surface-mount unit can be soldered to pc boards using conventional assembly techniques. The KSW-2-46, priced at only \$32.95, is yet another example of components from Mini-Circuits with unbeatable price/performance.

Switch fast... to Mini-Circuits' KSW-2-46

SPECIFICATIONS

dc-4.6	GHz
typ 0.9 1.0 1.3	ma 1.1 1.3 1.7
typ 60 45 30	mi 50 40 23
1.3:1	
2(typ)	
+17 +27	
-5V on	, OV off
-50 to	+100°C
\$32.95	(1-24)
	dc-4.6 typ 0.9 1.0 45 30 1.3:1 2(typ) +17 +27 -5V on -50 to \$32.95

C 117 REV. A

finding new ways ... setting higher standards Minipic Components Corporation P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 Domestic and International Telexes: 6852844 or 620156 Volume 32, Number 25



December 10, 1987

ELECTRONIC TECHNOLOGY FOR ENGINEERS AND ENGINEERING MANAGERS



On the cover: Part 1 of EDN's Product Showcase No 26 contains a multifarious selection of products: devices such as EG&G Wakefield Engineering's heat sinks for pin-grid-array packages, and a slew of semiconductor products such as the ones Analog Devices manufactures. This issue's staff-written coverage includes an article on fans and blowers, which complements the section on hardware and interconnect devices (pg 96). The Showcase also deals with software in general, and debuggers in particular (pg 152); power sources such as dc/dc converters (pg 194); and integrated circuits for cache-memory systems (pg 244). (Conceptual photography by Dana Sigall; art direction by Kathleen Ruhl)

DESIGN FEATURES Hardware and Interconnect Devices

Cooling devices take the heat from SMDs

96

152

194

244

Shrinking board size has changed the rules for thermal design: A surface-mount assembly that occupies only 40% of the space of its through-hole counterpart can nevertheless dissipate as much power. Achieving adequate reliability requires that you understand and apply the new rules.—*Dan Strassberg, Associate Editor*

Software

Debuggers help you perfect high-level and real-time code

Because of the increasing use of high-level languages and real-time operating systems, assembly-language debuggers no longer suffice. They're giving way to debuggers that can correlate target-system activity with high-level source code and ones that can manipulate real-time operating systems.—*Charles H Small, Associate Editor*

Power Sources

DC/DC converters simplify system power distribution

Although practically every electronic circuit requires a dc power source, not all can operate from the same dc level. For systems that require multiple dc voltages, you may have to design complex powerdistribution schemes. Point-source power devices—dc/dc converters—can ease your power-distribution design task.—*Tom Ormond, Senior Editor*

Integrated Circuits

Cache-memory systems benefit from on-chip solutions

As μ P clock frequencies increase, the access time of the memories servicing the μ Ps must decrease. When you use a cache memory, you can use low-cost, relatively slow main memory and still keep up with the microprocessor.—*David Shear, Regional Editor*

Continued on page 7



Φ

EDN* (ISSN 0012-7515) is published 38 times a year (biweekly with 1 additional issue a month) by Cahners Publishing Co, a Division of Reed Publishing USA, 275 Washington Street, Newton, MA 02158, William M Platt, President; Terrence M McDermott, Executive Vice President, Jerry D Neth, Vice President Production & Manufacturing; Frank Sibley, Group Vice President/Magazing; Thomas J Dellamaria, Vice President Production & Manufacturing; Frank Sibley, Group Vice President. Copyright 1987 by Reed Publishing USA, a division of Reed Holdings Inc; Saul Goldweitz, Chairman; Ronald G Segel, President and Chief Executive Officer, Robert L Krakoff, Executive Vice President. Circulation records are maintained at Cahners Publishing Co, 44 Cook Street, Denver, CO 80206. Phone (303) 388-4511. Second class postage paid at Denver, CO and additional mailing offices. POSTMASTER: Send address corrections to EDN* at the Denver address.

YOUR BEST PROTECTION:

From simple electrical lockout to high security mechanical lockout with electrical control, C&K Components offers the most complete line of Switchlocks.

Whether you want to control computer access, point-of-sale terminals, test instruments, medical equipment, process control systems, security and/or alarm systems, C&K Components can provide the right combination of value added features at the right cost to meet your specifications.

 Standard and instrument grade switching up to four poles
Power ratings from low-level up to 12 amps
From three to seven tumbler mechanisms including MEDECO high security locks
UL/CSA Listed
Shorting or nonshorting contacts
Special harnesses, finishes, latches and cosmetic designs
Front
To back panel mounting
Anti-static options

30-, 45-, or 90-degree indexing
Modular assembly

For the best protection, specify C&K Switchlocks. Send us your specs and we'll send you a free engineering sample. Call or write for our FREE literature.

1-800-334-7729





® C&K Components, Inc. 2035 Highway 70 East Clayton, NC 27520-0687

The Primary Source Worldwide....

Continued from page 5



TIDI

December 10, 1987



In the first part of December's showcase, you can read about hardware and interconnect devices, beginning on pg 115; software, beginning on pg 169; power sources, beginning on pg 205; and integrated circuits (shown above), beginning on pg 263.

PRODUCT UPDATE	
CMOS FIFO memory	59
High-density ASIC family	61
Internal 19,200-bps modem	64
ASIC verification tester	66

PRODUCT REVIEWS

Hardware and Interconnect Dev	vices
Software	
Power Sources	
Integrated Circuits	

DESIGN IDEAS

Circuit protects solenoids in dot printer325Compressed amplifier improves dynamic range326Amp provides 100V common-mode range328Multiplexers enhance timer's capabilities331Power op amp forms position controller332

LITERATURE

Computers and Peripherals	335
Components	339
Instruments	347
Computer-Aided Engineering	351

Continued on page 9

Advertising and editorial offices: 275 Washington St, Newton, MA 02158. Phone (617) 964-3030. Subscription offices: 44 Cook Street, Denver, CO 80206. Phone (303) 388-4511. EDN® is circulated without charge to those qualified. Subscription to others: US, \$95/year, \$6/copy; Canada and Mexico, \$110/year, \$8/copy; Europe Air Mail, \$135/year, \$10/copy; all other nations Air Mail, \$135/year, \$10/copy; all other nations Air Mail, \$200/year. Special issue prices may vary. Send requests for qualification forms and/or change of address to subscription office.



THE FIRST PROGRAMMER WITH A **SINGLE SITE FOR EVERY DEVICE.**

NEW UNISITE 40 HANDLES LEADING-EDGE DEVICES WITH SPEED AND EASE.

Now you can program and test the latest programmable devices and packages, fast and accurately - all in a single site. The first true universal pin drivers support any device of a given package type in the same site. The UniSite[™] 40's single DIP socket handles any device up to 40 pins, including PLDs, PROMs, IFLs, FPLAs, EPROMs, EEPROMs, and microcontrollers. The same site accommodates the most popular PLCCs and SO packages. A 16-bit processor, coupled with custom ICs and high-speed RAM, set new speed records for programming and testing.

TIMELY ACCESS TO TOMORROW'S

DEVICES. With universal pin driver electronics hardware, device-specific instructions can be loaded from one



31/2" micro-diskette. When new devices are introduced, you simply load a new master diskette, and the UniSite 40 is quickly updated.

MENUS MAKE PROGRAMMING EASY.

Use your cursor to select any function. Menus prompt you step-by-step and HELP messages assist you

throughout operation. A built-in listing of devices speeds part selection. The UniSite 40 can even save your most frequently used parameters for instant recall.

SHORTCUTS SPEED SETUP. More frequent users can bypass menus and zoom directly to specific operations by selecting key commands. Special software commands, like the ones in our QuickCopy™ mode, are also available to streamline your programmer operation.

DESIGN FREEDOM FOR TOMORROW.

Call today and get the design freedom only the UniSite 40 can provide.





Continued from page 7

EDN

December 10, 1987

EDITORIAL

A service-based economy may not be a prescription for growth.

PROFESSIONAL ISSUES

363

373

53

An experimental graduate-engineering program opens new study opportunities.-Deborah Asbrand, Associate Editor

LOOKING AHEAD

Erasable optical drives to surge into marketplace. . . Unexpected growth seen for enclosure sales.

DEPARTMENTS

News Breaks
News Breaks International
ignals & Noise
Calendar
Readers' Choice
eadtime Index
Business/Corporate Staff
Career Opportunities
Advertisers Index

A product-oriented design aid

To save you time in your efforts to keep current, EDN's editors have surveyed the new-product offerings from thousands of companies, screening and selecting only the most significant of those offerings introduced in the last six months. We present our findings—the best of the best—in a format devised to make your product selection as easy as possible. You can keep this Product Showcase as a reference until the next one that covers these four key product areas appears in July.

Cahners Publishing Company A Division of Reed Publishing USA Specialized Business and Consumer Magazines for Building & Construction Interior Design Electronics & Computers Foodservice & Lodging Manufacturing Book Publishing & Libraries Medical & Health Care Child Care/Development

VP/Publisher F Warren Dickson VP/Associate Publisher/Editorial Director **Roy Forsberg** Editor Jonathan Titus Assistant Managing Editor Joan Morrow **Special Projects** Gary Legg Home Office Editorial Staff 275 Washington St, Newton, MA 02158 (617) 964-3030 Tom Ormond, Senior Editor Deborah Asbrand, Associate Editor Joanne Clay, Associate Editor Joanne Clay, Associate Editor Tarlton Fleming, Associate Editor John A Gallant, Associate Editor Clare Mansfield, Associate Editor Dave Pryce, Associate Editor Cynthia B Rettig, Associate Editor Charles Small, Associate Editor Dan Strassberg, Associate Editor Chris Terry, Associate Editor Jim Wiegand, Associate Editor Ron Gilbert, Staff Editor Valerie Lauzon, Staff Editor Helen McElwee, Staff Editor Steven Paul, Senior Production Editor **Editorial Field Offices** Margery S Conner, Regional Editor Los Osos, CA: (805) 528-0833 Doug Conner, Regional Editor Los Osos, CA: (805) 528-0865 Bob Cushman, Special Features Editor Port Washington, NY: (516) 944-6524 Steven H Leibson, Regional Editor Boulder, CO: (303) 494-2233 J D Mosley, Regional Editor Arlington, TX: (817) 465-4961 David Shear, *Regional Editor* San Jose, CA: (408) 296-0868 Maury Wright, Regional Editor San Diego, CA: (619) 748-6785 Peter Harold, European Editor 0603-630782 (St Francis House, Queens Rd, Norwich, Norfolk NR1 3PN, UK) **Contributing Editors** Robert Pease, Bob Peterson, Don Powers, Bill Travis **Editorial Services** Kathy Leonard, Office Manager Loretta Curcio, Nancy Weiland, Sharon Gildea Art Staff Kathleen Ruhl, Art Director Ken Racicot, Assistant Art Director Chin-Soo Chung, Graphic Designer Production/Manufacturing Staff William Tomaselli, Production Supervisor Donna Pono, Production Manager Janice Dow, Production Assistant Andrew A Jantz, Production Assistant Diane Malone, Composition **Graphics Director** Norman Graf **VP/Production/Manufacturing** Wayne Hulitzky **Director of Production/Manufacturing** John R Sanders

Director of Research Deborah Virtue

Marketing Communications Janice Molinari, Manager Jennifer Ware, Communications Manager Corie Rand, Promotion Coordinator Anne Foley, Promotion Assistant



int

~

INMOS. IMS T800 TRANSPUTER. 4.6 MEGAWHETSTONES. A

Motorola and (A) are registered trademarks of Motorola, Inc. Intel is a regi

INTEL. 386/387 16 MHz 1.8 MEGAWHETSTONES. .

MOTOROLA. 68020/68881 20 MHz 1.5 MEGAWHETSTONES.

DEC. VAX 11/780/FPA 1.1 MEGAWHETSTONES. VAX



Riddell

ONE T800 TRANSPUTER GIVES 2.5 DOUBLE PRECISION MEGAWHETSTONES... SO WHEN IT COMES TO PROCESSING POWER SEVEN INMOS T800 CHIPS COULD GIVE THE MIGHTY CRAY 15, RATED AT 16.1 MEGAWHETSTONES A REAL RUN FOR ITS MONEYI 0

DOUBLE PRECISION WHETSTONE LEAGUE

ademork of Cray Research



When you're out in the trenches fighting it out with ordinary microprocessors, running out of muscle is all too easy. That's why you should look to the new T800 Transputer from INMOS.

The T800 is the fastest 32-bit, single chip, floating-point microprocessor available today. A quick glance at its statistics will show why nothing else is in its league ...

32-bit enhanced RISC processor...64-bit on-chip IEEE floating-point processor...4K Bytes on-chip 50ns static RAM...Four 20 MBits/sec interprocessor communication links...Eight independent DMA engines. All on a single chip capable of sustained 1.5 MFLOPS...and 4.6M Whetstones!

And, if that's not enough raw power, the T800's links allow multiprocessor systems to be constructed quickly and easily giving you 6 MFLOPS with four T800's ... 30 MFLOPS with 20 ... 150 MFLOPS with 100...In fact, there's no limit to the number of Transputers you can use!

Programming Transputers couldn't be easier, with compilers for C, Fortran and Pascal, and the world's first concurrent programming language OCCAM.

Want to turbocharge your current system? No problem. Our exclusive Link Adaptor IC's allow Transputers to be connected to other microprocessors or peripherals.

Other team members include the pin compatible T414 Transputer, offering lower cost, 10 MIP performance and 0.75M Whetstones Lined-up to provide all the I/O processing you need, the T212 16-bit Transputer is the ideal high performance controller and the M212 Disk Processor combines disk controller hardware and a Transputer on a single chip, supporting both Winchester and floppy disks. And the C004 Link Switch makes the design of software reconfigurable multiprocessor

systems as easy as kicking an extra point. Whatever field you're in - from real-time distributed systems to high-performance graphics, from fault-tolerant systems to robotics, Transputer technology can give you scalable performance at a cost

you can afford. Transputers are manufactured using an advanced 1.5 micron

CMOS process which keeps the power consumption under one watt. So your system stays cool while under fire. Transputers to MIL-STD 883C will be available in the first half

of 1988

If this all sounds like your kind of game, put the ball in play by contacting your local INMOS sales office today. And get ready to score.

DI	ESCRIPTION		PERF	ORMANCE	AVAILABI	PACKAGE	
Part No.	Word Length	Clock MHz	Integer Drystones	Floating Point Whetstones	Commercial	Military	
IMS T800-20 IMS T414-20 IMS T212-17 IMS T212-20 IMS M212-17	300-20 32-Bit 20 9500 414-20 32-Bit 20 9500 212-17 16-Bit 17 8000 212-20 16-Bit 20 9500 212-17 16-Bit 17 8000 212-17 16-Bit 20 9500		4.6 Million 0.75 Million –	Now Now Now Now Now	Q2 88 Q2 88 Q2 88 Q2 88 Q2 88	84 PGA 84 PGA 68 PGA 68 PGA 68 PGA	
	NETV	ORK SUPPO	ORT PRODUCTS	5	AVAILABI	LITY	PACKAGE
Part No. Description		Commu	nication Speed	Commercial	Military		
IMS C004 IMS C011 IMS C012	Software co 32 way link Link to syste Link to syste	onfigurable switch em bus em bus	10 + 2 10 + 2 10 + 2	0 MBits/sec 0 MBits/sec 0 MBits/Sec	Now Now Now	Q2 88	84 PGA 24 Pin DIP 24 Pin DIP

T	HE TRANSP	UTER TEAN	1
	e in r	nos	
	INMOS, Colorado Springs, Co	olorado 80935. Tel. (303) 630-400	00.
County — 714-957-6018 Clara — 408-727-7771	Denver – 303-252-4100 Minneapolis – 612-932-7121	Dallas – 214-490-9522 Boston – 617-366-4020	Baltimore – 301-995-6952 Atlanta – 404-242-7444
Send me inforr of third-party ma Please have a Name	mation on the Transputer Team. nufacturers' transputer-based pro Field Applications Engineer call. 	Send me the Transputer Whi oducts and services. Please have a salesman co	ite Pages, a listing
Company	Address		4112687
	Zip	Tel	Gannaanaad

INMOS Transputer) and IMS are trademarks of the INMOS Group of Companies

Orange Santa (

CIRCLE NO 186





Conventional wisdom is fine. For conventional designs.

Imagine a parallel-to-serial converter that lets you move data at 100 Megabits per second. Imagine it working like a register, shooting data into a latch that's stretched from point to point, letting that data race, transparently, ten times faster than conventional wisdom says it can go.

You just imagined TAXI the Am7968 Transmitter and



the Am7969 Receiver—two of the most unconventional, incalculably useful products we've ever offered.

Our new 125MHz analog Phase-Lock-Loop receiver runs ten times faster than the popular 26LS family of RS422 devices. That makes TAXI the highest speed serial data device available. And, where you used to use ribbon cable or bundles, you can design with a single coaxial or fiber optic cable.

Its simplicity and speed don't confine you to a narrow data path, though. Twelve parallel interface pins allow you to operate with data that is 8,9 or 10 bits wide. TAXI is cascadable, too, in multiples of 8, 9 or 10 bits. They all move through a single cable to get the message across fast.

To get your hands on TAXI, just call 1 (800) 634-TAXI. And when someone says "You can't move data that way!", you can just smile and say, "Watch."

Advanced Micro Devices 20 901 Thompson Place, P.O. Box 3453, Sunnyvale, CA 94088 © Advanced Micro Devices, Inc. 1987 CIRCLE NO 191

THE POINT **OF NO RETURN.**

When you put a Fujitsu ASIC to work, you can rest assured it will work the way it should. And keep on doing its job for a very long time to come. In fact, when you look at our performance record over the years, you'll be hard pressed to find any field failures at all. This is no empty promise. Product reliability has been a way of life for us for more than 15

years.



That's why we always take a conservative approach to the design process. Giving you realistic worst case specs that no production device will exceed.

Guaranteeing a minimum 90% utilization of all gates. And giving you a simulation-to-production correlation of 99%.

It's also why we control every step of the production process. From design to wafer fab to assembly and final test, including 100% AC testing at frequency. So nothing is left to chance.

To us, reliability in the field is everything. And when you remember we've taken over 8,000 ASIC devices from design through mass production, you can see that we'll give you a level of confidence no one else can offer.

So count on parts that have longer life expectancies.

Call our Hot Line today at (800) 556-1234, Ext. 82; in California (800) 441-2345. Look into ASICs you can send out the door. Never to return again.

FUJITSU MICROELECTRONICS. INC. Technology That Works. CIRCLE NO 192



More power for less than the cost of a TO-126 bipolar

When it comes to motor drive control or high-side switching of grounded loads. our new N- and P-Channel 50V HEXDIP power MOSFETs deliver more at less cost than do equivalent bipolar devices. Here are some reasons why.

HEXDIPS

Unlike traditional die-mounting, HEXDIP chips are mounted on a dual-drain copper tab, resulting in power dissipation of up to 1 Watt-more than any FET in its class.

Designed for automatic insertion, our 4-pin HEXDIP packages are end-stackable on 100 mil centers. This cuts assembly time. And there's no wasted board space in high density packing applications.

Four new HEXDIP 50V Series are available in N- and P-Channel types for today's state-of-the-art designs in automotive electronics, power supplies, and motor drive control circuits.

Rds(on) ranges from a low of 0.10 Ohms. with current ratings up to 2.4 amps depending on die size. For complete data, call (213) 607-8842. Today.



Most HEXFETs now in stock for immediate delivery!

HEXFET TECHNOLOGY .. HEXDIPs are produced through our exclusive HEXFET process, resulting in guaranteed quality and reliability.

ACTUAL SIZE

International Number 1 in power MOSFETs IOR Rect

WORLD HEADQUARTERS: 233 KANSAS ST., EL SEGUNDO, CA 90245. U.S.A. (213) 772-2000. TWX 910-348-6291, TELEX 472-0403 EUROPEAN HEADQUARTERS: HURST GREEN, OXTED, SURREY RH8 9BB. ENGLAND TELEPHONE (088 33) 3215/4231. TELEX 95219

Power MOSFETs · CMOS Power ICs · Commercial/Custom Power Packages · Schottkys Rectifiers · Thyristors (SCRs) · Diode Bridges · Molded Circuits · Assemblies

CIRCLE NO 185

Only one company has the technology, the resources, and the vision to top the 68020.



Introducing the 68030.

The next generation.

In 1984, we introduced the 68020. Now, three years later, it has the largest installed and broadest application base of any 32-bit MPU on the market. Having set that standard in the first place, we feel qualified to raise it. Which is why the only microprocessor that really surpasses the 68020 is our second generation 68030.

Meet the *Chethicty!* The '030 is twice the microprocessor its predecessor is. It's the first to sport an instruction cache, data cache and MMU on-chip. Combined with a Harvardstyle parallel bus architecture that allows simultaneous, multiple fetches of instructions and data, processor throughput is pushed to unmatched levels.

What can you do with all that performance? Anything you like—from low-cost personal workstations to super-computers—and the 68030 will help you to do it less expensively.

With its burst fill mode for the dual caches, you'll be able to squeeze SRAM performance from low-cost DRAMs. It gives you graphics capability without the need for a graphics co-processor. And there's true objectcode compatibility between the '030 and the '020. All this adds up to economies you can count on.

An architecture you can build on. And count on.

Application software that runs on any 68000 family MPU runs on the 68030. There's also a full array of development tools, and a new 68882 floating point co-processor, with up to 4x the performance of its predecessor. All of which gives your product plans an enormous amount of continuity. And that's not going to change. Since the 68030 supports both MS-DOSTM and UNIX[®] V.3, you can have your pick of over \$12 billion worth of applications— and the broadest possible market.

With Motorola, you can see forever.

Our plans for the rest of the 68000 family extend well into the future, offering continuing compatibility and leadingedge performance. So you can go with Motorola, not just for what our microprocessors can do now, but what you'll be able to do with them later on.

For more information about the new 68030, call us toll-free at 800-521-6274 or

write, Motorola Semiconductor Products, Inc., P.O. Box 20912, Phoenix, AZ 85036. We're on your design-in team.



To: P.C	Motorola Semiconductor Products, Inc. Box 20912, Phoenix, AZ 85036	345EDN121087
Pl	ease send more information on the OK	thirty!
	Title	
MC CORRECTION	Company	i
Transa at	Address	
THE PARTY OF THE P	City State	Zip
	Call me (22.2

MS-DOS is a trademark of Microsoft Corporation. UNIX is a registered trademark of AT&T. ©1987 Motorola, Inc.

Now scan and record temperatures from freezing to scorching.



The new Fluke 52 goes to great extremes to outperform any other handheld thermometer.

With extra features, like our exclusive SCAN mode. Touch the button, and your Fluke 52 sequentially scans the readouts of two temperature inputs, and their difference.

Hit the RECORD button, walk away, and record the minimum and maximum from any one of these three channels for up to 1,200 hours. For troubleshooting intermittent problems, overnight monitoring, inlet/outlet servicing, and comparing trend information, it can't be beat.

If you don't need the scanning and recording features, you may prefer the single-point Fluke 51. Like the 52, it's easy to use, offers unsurpassed accuracy with resolution to 1/10th of a degree, and can use any K or J type thermocouple probe to fit your application.

Even the warranty goes to great extremes: three years on parts and service — the longest in the industry. And prices start as low as \$119.

But you don't have to go to extremes to get one.

Just contact your local supplier now for immediate delivery.

Or for more information, call toll-free **1-800-227-3800, Ext. 229.**

FROM THE WORLD LEADER IN HANDHELD TEST INSTRUMENTS.





Fluke 51 Single Input Fluke 52 Dual Input

J-type: -200°C to +760°C (-328°F to +2498°) J-type: -200°C to +760°C (-328°F to +1400°F))
Accuracy: K-type is $\pm (0.1\% \text{ of reading } +0.7^{\circ}\text{C or } 1.3^{\circ}\text{F})$ J-type is $\pm (0.1\% \text{ of reading } +0.8^{\circ}\text{C or } 1.4^{\circ}\text{F})$	
C or °F Selectable	
fold Mode	
Scan, Differential, and Min/Max Recording Modes (52 only)	
Standard mini-connector input	
200 hour 9V battery life	
-year warranty	
Caparal purpose K type head prohe included (type with 52)	_

FLUKE

IN THE U.S. AND NON-EUROPEAN COUNTRIES: John Fluke Mig. Co., Inc., P.O. Box C9090, M/S 250C, Everett, WA 98206, Sales: (206) 356-5400, Other: (206) 347-6100. EUROPEAN HEADQUARTERS: Fluke (Holland) P.V., P.D. Box 2269, 5600 CG Eindhoven, The Netherlands, (204) 458045, TLX: 51846. (C Opyright 1985 John Fluke Mig. Co., Inc. All rights reserved. Ad No. 4701-50

NEWS BREAKS

EDITED BY JOANNE CLAY

THE LONG-AWAITED MC68030 FINALLY ARRIVES

The MC68030 32-bit μ P from Motorola (Phoenix, AZ, (512) 440-2839) is now available. The 68030, which is fully compatible with the 68000 family, has on-chip data and instruction caches, a parallel (Harvard-style) architecture, and an on-chip memorymanagement unit. The vendor claims the 68030 achieves twice the performance of the 32-bit MC68020. The 68030 is currently available in 16- and 20-MHz versions priced at \$400 and \$550, respectively. The MC68882 math coprocessor (its 16- and 20-MHz versions cost \$245 and \$375, respectively) offers two to four times the performance of the MC68881, with which it is pin and software compatible.—David Shear

INSTRUMENT MONITORS FREQUENCY AND TIME-INTERVAL VARIATIONS

For more than a generation, engineers have been able to buy digital counters that sit on a benchtop and monitor time intervals, frequency, and phase. Some of these instruments provide outputs that can drive recording devices to indicate how the measured quantities vary over minutes, hours, or days. Now, Hewlett-Packard (Santa Clara, CA) is introducing the HP 5371A frequency and time analyzer, which, though it measures frequency and time, is quite unlike conventional counters. For example, it measures frequencies as high as 500 MHz, using sampling intervals as short as 100 nsec, with no dead time between measurements.

The analyzer performs a variety of firmware-based calculations on data it acquires, and it incorporates a CRT, which can display such information as histograms and plots of measured values vs time. HP expects the \$21,500 analyzer to find application in development and testing of frequency-agile and digital communications systems, radar, electronic warfare systems, data-storage peripherals, and electromechanical devices.—Dan Strassberg

VME BUS INTERFACE CARD LINKS TO 96 RS-232C DEVICES

Using 1M-bps serial links to communicate with as many as six SYS336M16 Deltalink servers, the \$1800 MVME336K Deltalink hub card from Motorola Inc's Microcomputer Div (Tempe, AZ, (800) 441-2345 ext 230) connects 96 full-duplex, RS-232C devices to a VME Bus-based system. Each \$1800 server provides 16 RS-232C ports, and links to the hub card by means of as much as 800 ft of unshielded, twisted-pair cable (including telephone cord.) The Deltalink protocol encapsulates RS-232C transmissions in HDLC packets that provide both transport and error checking. Motorola currently incorporates drivers for this product in release 3 of its System V/68 operating system; the company will provide source code for driver routines to customers who wish to use the hardware with other operating systems.—Steven H Leibson

MODEM GIVES STD-BUS SYSTEMS PROGRAMMABLE COMMUNICATION

Supporting the full Hayes AT command set for modem control, the MCM-Modem from WinSystems (Arlington, TX) is the first STD-bus card that can provide systems with programmable, full-duplex 1200/300-bps Bell 212A/102 and CCITT V.22 and V.21 communications. The onboard Data Access Arrangement connects an STD-bus system directly to dial-up telephone lines. The modem card also offers self-test, autoanswer, autodial, and call-monitoring functions. An auxiliary RJ-11 jack lets you plug in a separate telephone handset. You can program this \$395 modem to communicate at speeds ranging from 50 to 1200 bps.—J D Mosley

NEWS BREAKS

REAL-TIME OPERATING SYSTEM FOR RISC μ P

Ready Systems (Palo Alto, CA, (415) 326-2950) has signed a contract with Advanced Micro Devices (Sunnyvale, CA) to port Ready's VRTX32 to AMD's forthcoming Am29000. VRTX32 is a multitasking executive designed for real-time embedded computer applications. It will work on the Am29000 without modification, so you should be able to move your high-level-language code from other processors to the Am29000 without revising the code. The Am29000 is a 32-bit μ P based on a reduced-instruction-set computer (RISC) architecture and targeted at embedded applications. VRTX32 for the Am29000 will be available in May 1988 and will cost \$9000.—David Shear

WORKSTATION TRANSFORMS 300,000 VECTORS / SEC

The HP 9000 Series 330CHX and 350CHX workstations transform as many as 250,000 and 300,000 vectors/sec, respectively. The workstations, from Hewlett-Packard (Fort Collins, CO), can achieve this level of performance because they each include an HP 98556A graphics accelerator. The accelerator is also available separately for \$6000; you can use it with the vendor's 330CH and 350CH workstations. The 330CHX costs \$22,250; the 350CHX sells for \$38,550.—Jim Wiegand

SYSTEM AUTOMATES PLACEMENT, ROUTING, AND POSTPROCESSING

Combining hardware and software tools that automate the entire pc-board-design task, the PCB design system from Intergraph (Huntsville, AL, (205) 772-2000) helps you develop your concept from package placement through photoplotting. It costs \$120,000. The design system includes a Micro II data-processing unit with tape drive, two InterPro 32C workstations, and software for pc-board design, automatic packaging and placement, automatic routing, and photoplotting.—J D Mosley

PLOTTERS SPEC 32-IPS PEN SPEED; OFFER SCANNING OPTION

For \$4695, you can buy a DMP-61 single-pen plotter with an axial pen speed that reaches 32 ips and a maximum axial acceleration of 4g for A- through D-size drawings. For E-size drawings, the \$6495 DMP-62 provides a maximum pen speed of 24 ips with a 2g acceleration. Both of these $68000-\mu$ P-based plotters from Houston Instruments (Austin, TX, (512) 835-0900) accept options such as the \$750 MP-60 pen changer, the \$2995 Scan-Cad optical scanner, a \$995 1M-byte-buffer board with a replot feature for drawing multiple originals, and a \$495 Kanji character-set board.—J D Mosley_

CAD/CAE/CAM VENDOR CLIMBS ABOARD STANDARD PLATFORM

Cadnetix Corp (Boulder, CO, (303) 444-8075) has ported its CAD and CAE software packages to Sun Microsystems' (Mountain View, CA) workstations and become an OEM for those systems. The vendor calls these new workstation/software packages the Concept 3 family. The company offers the CDX-9600, a \$15,900 CAE workstation based on the Sun 3/60, and the CDX-56000, a \$89,900 CAD system that's also based on a Sun 3 workstation. The CAD system incorporates a graphics processor developed by the vendor that performs 400,000 vector clips and transformations per second. The Concept 3 family also includes a CAM workstation, the CDX-61000, for \$88,900. Because the vendor's proprietary offerings incorporate Sun's LAN communications protocols, all of the vendor's existing products (which the company continues to offer), including its route engines, are compatible with the Concept 3 family.—Steven H Leibson

Imagine what you could do with a little quick cache.



A quick cache like DisCache,[™] the unique drive-resident caching feature available on Quantum Q200 Series[™] of half-high 5¼″ intelligent disk drives.

A Quantum 53 or 80megabyte (formatted) drive with its integrated SCSI controller and DisCache can help your system perform faster and smarter. Depending upon the application, DisCache can actually cut disk transaction times in half by reducing seek and rotational latency delays. DisCache acts as a highspeed memory between the disk and the host system. DisCache anticipates sequential host requests by looking beyond the current data request and storing adjacent data in cache memory. When the host requests this data, it is accessed in microseconds from the 60 KB of high-speed memory instead of in milliseconds from the disk.

Since typically 50% or more of all disk requests are sequential, DisCache can make your systems substantially faster. And that can help your systems sell faster.

DisCache is as flexible as it is fast, with programmable options to tailor caching parameters to suit your system.

DisCache is an option on both our Q250 and Q280 drives. Each drive features Quantum's innovative design and exceptional reliability.

Call or write for more information about DisCache and the Q200 Series of half-high 5¹/₄" intelligent disk drives.

We'll show you what a little quick cache can do for your business.

Quantum Corporation, 1804 McCarthy Blvd., Milpitas, CA 95035 (408) 432-1100. TWX 910-338-2203. Eastern Regional Sales: Salem, NH (603) 893-2672. Western Regional Sales: Santa Clara, CA (408) 980-8555. European Sales: Frankfurt, West Germany 069-666-6167. Quantum products are distributed in the United States and Canada by Arrow Electronics and Marshall Industries.

Quantum First In Intelligent Disk Drives

© 1987 Quantum Corporation. DisCache and Q200 Series are trademarks of Quantum Corporation

NEWS BREAKS: INTERNATIONAL

CHANNELLESS GATE ARRAYS SUIT A VARIETY OF ASIC REQUIREMENTS

Combining the resources and technologies of its merged parent companies (SGS and Thomson Semiconductors), Innovative Silicon Technology (Agrate Brianza, Italy, TLX 330131) has introduced 1.5- and $1.2-\mu m$, single-level-poly, double-level-metal gate-array families based on the sea-of-gates principle. The ISB8000 family comprises four $1.5-\mu m$ arrays having gate counts of between 3500 and 21,000. They suit random logic designs, and have output drivers with 24-mA capability.

Suitable for use in high-pin-count designs, the $1.5 - \mu m$ ISB9000 family comprises 10 gate arrays with gate counts of between 288 and 21,000. The $1.2 - \mu m$ ISB12000 family comprises 10 gate arrays with gate counts of between 8000 and 128,000. The ISB12000 arrays have a typical layout efficiency of 40% for random logic, but they easily accommodate large blocks of RAM and ROM. The 2-input NAND-gate propagation delays for the ISB8000, ISB9000, and ISB12000 arrays are 0.7 nsec, <0.7 nsec, and 0.6 nsec, respectively. The vendor expects to offer the larger ISB8000 gate arrays for between \$0.18 to \$0.19 (10,000) per gate for devices packaged in plastic leaded chip carriers. —Peter Harold

IC-DESIGN SOFTWARE ENVIRONMENT ADAPTS TO CHANGING TOOL SETS

The Spirit IC-design software environment from Integrated Circuit Design (Enschede, The Netherlands, TLX 72280) provides you with a stable user interface through which you can access a variety of proprietary or commercial IC-design software tools. If you add to or change the set of design tools, the user interface remains the same, eliminating the need to learn a new user interface for each tool. In addition to the user interface, the tool set is surrounded by a design manager, a design database, and a foundry interface that allows you to meet the requirements of different silicon foundries. System-management software allows the system administrator to create and change information about users, projects, foundries, libraries, and process parameters. Priced at approximately gld 175,000 (including a tool set), Spirit is intended for use by teams that create full-custom IC designs. It is available for use on the Apollo Domain 3000 workstation, HP 9000 Series 300 and Series 500 computers, and the PCS Cadmus computer.—Peter Harold

16-BIT PARITY GENERATOR / CHECKER OPERATES AT 30 MHz

You can generate parity for 16-bit data with a single device by using the CMOScompatible PC74HC7080 or TTL-compatible PC74HCT7080 parity generator/checker from Philips' Components Div (Eindhoven, The Netherlands, TLX 51573; in the US, Signetics Corp, Sunnyvale, CA, (408) 991-2000). For 16-bit data, the device operates at speeds as high as 30 MHz. Two cascaded devices generate parity for 32-bit systems at speeds as high as 20 MHz. You can select even or odd parity generation on an activehigh or active-low output. At 20 MHz, both versions dissipate 17 mW typ. They operate over -40 to +125°C and come in 20-pin DIPs or small-outline surface-mount packages. Approximately gld 5.25 (100).—Peter Harold

ADAPTER CONVERTS 68-PIN PGA TO PLCC

If you're developing a design that will incorporate a device in a 68-lead plastic leaded chip carrier (PLCC), but you can only obtain the device in pin-grid arrays (PGAs), the 308-1846-XX Series adapter from Methode Electronics Inc (Chicago, IL, (312) 867-9600) can solve your problem. The top of the adapter accepts a 68-pin PGA; PLCC leads protrude from the bottom. The adapter is available in 10×10 and 11×11 grid patterns and costs \$265 in production quantities.—Steven H Leibson

Alphanumeric Display Systems



Get our detailed message: Send for specs.



CHERRY ELECTRICAL PRODUCTS

3600 Sunset Avenue, Waukegan, IL 60087 • (312) 360-3500 Switches • Automotive Devices • Electronic Components • Displays • Printed Circuit Boards • ICs • Keyboards



the world's smallest surface mount mixers \$695

SPECIFICATIONS	RMS	-1	RMS	RMS-2		
FREQUENCY RANGE, MHz						
LO, RF	0.5 -	- 500	5 –	- 1000		
IF	DC -	- 500	DC-	- 500		
CONVERSION LOSS, dB, Typ.						
Mid-band $(10f_1 - f_{\mu/2})$	5.5		6.5			
Total range $(f_1 - f_u)$	6.2		7.0			
ISOLATION, dB, Typ.	L-R	L-I	L-R	L-I		
Low-band $(f_1 - 10f_1)$	55	50	55	50		
Mid-band $(10f_1 - f_{\mu/2})$	33	30	35	30		
Upper-band $(f_{u/2} - f_u)$	27	24	25	20		
PRICE (10-49)	\$6.95	5	\$7.95	;		

 $f_1 =$ lowest frequency in range

f_u = highest frequency in range

Tight packing density, lowered assembly costs, and improved reliability make surface-mount technology (SMT) highly attractive to systems and product manufacturers. If your design is ready for SMT, specify Mini Circuits' new RMS series, the world's smallest (0.25 by 0.30 by 0.2 in.) double-balanced SMT mixers, spanning 0.5 to 1000MHz, from only \$6.95 (10-49 qty).

The tiny, non-hermetic package houses RF transformers, a ceramicalumina substrate, and a four-diode assembly. A unique edge-plated design eases the job of making reliable solder connections to a printed-circuit board. A protective-barrier layer on top of the package's conductive layer retards the harmful effect of electromigration which may occur during soldering. The RMS can be attached to a pc-board by conventional manual soldering or with automatic equipment; mixers can be supplied in a tape-and-reel format for automated pick-and-place machines.

When you think SMT, think small, low-cost ... think Mini-Circuits RMS series.



F110 REV. ORIG. EDN December 10, 1987

CIRCLE NO 180

Filtgers \$995

dc to 3GHz

- less than 1dB insertion loss over entire passband
- greater than 40dB stopband rejection
- 5 section, 30dB per octave roll-off
- VSWR less than 1.7 (typ)
- over 100 models, immediate delivery
- meets MIL-STD-202
- rugged hermetically sealed package (0.4 x 0.8 x 0.4 in.)
- BNC, Type N, SMA available

LOW PASS	Model	*LP-	10.7	21.4	30	50	70	100	150	200	300	450	550	600	750	850	1000
Min. Pass Band	(MHz) DC to		10.7	22	32	48	60	98	140	190	270	400	520	580	700	780	900
Max, 20dB Sto	MHz)	19	32	47	70	90	147	210	290	410	580	750	840	1000	1100	1340	
Prices (ea.): P	Prices (ea.): P \$9.95 (6-49), B \$24.95 (1-49), N \$27.95 (1-49), S \$26.95 (1-49)																

HIGH PASS	Model	*HP-	50	100	150	200	250	300	400	500	600	700	800	900	1000
Dage Rand (MUT)		start, max.	41	90	133	185	225	290	395	500	600	700	780	910	1000
Fass Dariu (IVITZ))	end, min.	200	400	600	800	1200	1200	1600	1600	1600	1800	2000	2100	2200
Min. 20dB Stop Frequency (MHz)			26	55	95	116	150	190	290	365	460	520	570	660	720

Prices (ea.): P \$12.95 (6-49), B \$27.95 (1-49), N \$30.95 (1-49), S \$29.95 (1-49) PrefixP for pins, B for BNC, N for Type N, S for SMA example: PLP-10.7

CIRCLE NO 179

finding new ways ... setting higher standards

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 Domestic and International Telexes: 6852844 or 620156

Circuits

VME/PLUS gives view of your

Hold on to your seat. You're about to discover an entirely new level of VME performance. And life in the fast lane will never be the same.

Meet VME/PLUS. Our new family of VMEbus products with a host of sophisticated features



that will give your project the kind of performance you've only dreamed about.

VME/PLUS starts with a 68020 running at 25MHz without wait states. Complemented by 1MB of local memory. There's also a new VSB interface on P2. Which lets you add lots of local memory and I/O without increasing bus overhead. You also get two serial ports and up to 4MB of EPROM. The result is system throughput that's way ahead of anything else in the VME world. Think about the possibilities for real-time applications. For the first time, you can squeeze every ounce of performance from every processor.

With no wasted overhead. And no stalls.

But that's only the beginning. Take a look at the newest member of the VME/PLUS family, CPU 29. It comes with a powerful new realtime, multitasking monitor called VMEPROM.[™]

you a different competition.

It's resident in EPROM. so there's no license required. And

no extra charge. CPU-29 also incorporates a remarkable new gate array that packs

the functionality of many complex ICs into a single, 135-pin device.

What this new technology means for you is unprecedented

levels of speed and system throughput, exceptional reliability and - here's the best part-lower total system cost.

And if that's not enough, we also offer a full set of offthe-shelf peripheral boards and software. All VMEbus

CPU-29 CHARACTERISTICS					
68020/12.5 TO 25 MHz					
68882/12.5 TO 25 MHz					
1MB					
REAL-TIME,					
MULTITASKING MONITOR					
UP TO 4MB					
@ 1 WAIT STATE					
2 RS-232 CHANNELS					
VSB					

compatible. And guaranteed to cut the wait states out of your design cycle. So if you're looking for the best way to stay ahead

of your competition and your deadline, take a close look at VME/PLUS. You'll get the best performance for simulation systems, real-time graphics, factory automation and many other tough applications.

Give us a call today for our new 500-page, 1988

data book. You'll get such a great view of VME performance, vou'll never look back. 1(800)BEST VME. In California. 1(800)237-8862.



FORCE COMPUTERS, INC. 727 University Ave., Los Gatos, CA 95030 Telephone (408) 354-3410 Telex 172465 Telefax (408) 395-7718

FORCE COMPUTERS, GmbH Daimlerstrasse 9 D-8012 Ottobrunn Telefon (089) 60091-0 Telex 524190 forc-d Telefax (089) 6 097793

© 1987 Force Computers, Inc. VME/PLUS and VMEPROM are trademarks of FORCE COMPUTERS, Inc.

CIRCLE NO 178



Calling all modems NEC introduces an enhanced 16-bit DSP

Whatever your modem design calls for, NEC's DSP family has the answer. We've been covering your 16-bit needs since 1980 with our pioneering µPD7720. For 32-bit applications, we offer the μ PD77230. And now we're bridging the gap with our enhanced 16-bit CMOS µPD77C25.

The enhanced 77C25 gives you twice the performance of the 77C20A. 77P25 is coming soon. Twice the speed-122ns. More than twice the memory capacity $-2K \times 24$ instruction ROM, $1K \times 16$ data ROM. and 256×16 data RAM. Yet the same

power consumption-0.2W max.

You can replace two 77C20As with one 77C25-with little modification in peripheral circuits. Available in 28-pin DIP or 44-pin PLCC. The 77C25 is both pin- and software-compatible at the source level with the 77C20A. Development tools are available off the shelf and the EPROM-version

For a complete answer to your modem needs, call NEC. We've got you covered from 1,200 to 19,200bps and everywhere in between.

ITC A	Tol-1 900 632 3531
- USA	In California: 1-800-632-3532.
	TWX: 910-379-6985.
Europe	W. Germany
	Tel:0211-650302. Telex:8589960 NE D.
	The Netherlands
	Tel:040-445-845. Telex:51923 NEC B NL.
	Sweden
	Tel:08-732-8200. Telex:13839 NECSCAN S.
	France
	Tel:1-3946-9617. Telex:699499 NEC EF.
	Italy
	Tel:02-6709108. Telex:315355 NECEIT I.
	UK
	Tel:0908-691133. Telex:826791 NECUK G.
Asia	Hong Kong
	Tel:3-755-9008. Telex:54561 HKNEC HX.
	Taiwan
	Tel:02-522-4192. Telex:22372 HKNEC TP.
	Singapore
	Tel:4819881. Telex:39726 NECES RS.
Oceania	Australia
	Tel:03-267-6355. Telex: AA38343 NECBCD





SIGNALS & NOISE

Motor's inductance is unlikely to decrease

In his article, "Proper design tradeoffs translate to a precise positioncontrol system" (EDN, August 6, pg 167), Yoram Hirsch writes (on pg 173) that the winding inductance of the motor used in his tests "actually decreases with increasing frequency." He continues: "As unlikely as this might seem, measurement results indicate that, even though the winding inductance is about 3 mH at 1 kHz, it is only 0.8 mH at 100 kHz." Yet, the thing that he describes is, in my opinion, easily explained.

The simple equivalent circuit of a motor's winding, whose impedance appears simply as an inductor and a resistor in series, is not usable at high chopping frequencies. Here the distributed winding capacitance, eddy-current losses, and other factors come into play, and you account for them by adding a few more components to the old model.

The accompanying figure shows one attempt at such a model (a). It consists of two inductors, two resistors, and one capacitor. Its complex impedance, calculated at 20 kHz and 100 kHz, is seen to be inductive. Yet the imaginary parts are at a ratio of 2.3:1 instead of 5:1. If you measured the equivalent series inductance on a bridge, you would read 3.3 mH at 1 kHz, 1.2 mH at 20 kHz, and 0.6



ELECTRIFYING SOLUTIONS!





3601 VETERANS HIGHWAY RONKONKOMA, NEW YORK 11779 TEL. 516/981–7231 TWX 510 220 1528



Call or write for our free Catalog – 130 to 4000 watts.

SURFACE MOUNT ADHESIVES

Anatomy of a dot.

EXCELLENT THIXOTROPIC QUALITIES

higher dot aspect ratio with no sacrifice in flow or reproducibility.

WIDE PROCESS FLEXIBILITY variable cure cycles to meet your production speed.

HIGH STRENGTH

superior chip shear strength after cure ensures reliability and reduces rework.

OPTIONAL CURES heat and/or ultraviolet

cure systems to meet your manufacturing demands.

VOID FREE

smooth, uniform, void free dots that won't trap process chemicals.

EXCELLENT GREEN STRENGTH assures component retention with no skewing prior to cure.

CONVENIENT PACKAGING syringes, cartridges and jars for pneumatic dispensing, pin transfer or screen printing.

We pack a lot of features and versatility into a little dot. Plus a lot of know-how. We were the first to pioneer and develop surface mount adhesives (SMA[™]). As the world's leading manufacturer supplying the largest companies, we have the products, application knowledge and technology to meet your dot demands. No matter what in-

No matter what industry you're in, our highcontrast, fluorescent SMA's are ready for your pneumatic dispensing, pin transfer or screen printing operations. And we're ready to provide the dot you want.

Find out more. Call or write us on your letterhead for a free sample. Just give us your basic application specs and we'll send you a special **Dot Decision Kit**. It's packed with information and a free sample of material. Call or write: Emerson & Cuming, Inc. Dot Decision Kit 77 Dragon Court Woburn, MA 01888 617-935-7574

> Send for information and a free sample.


SIGNALS & NOISE

mH at 100 kHz. Furthermore, the current waveforms shown in the accompanying figure (Spice simulation at $\pm 40V$ square wave) (b) are strikingly similar to the oscilloscope photos in Fig 8 of the article (pg 172).

As a consequence, it is unlikely that the motor's inductance decreases with increasing frequency. But if in fact it happens, then let us have some explanation of the mechanism causing such a strange effect. *Claudio de Sa e Silva*

Unitrode Integrated Circuits Corp Merrimack, NH

Misplaced resistor

Please note a correction to the Design Idea "Low-power circuit splits supply voltage" (EDN, October 1, pg 198). The 5-k Ω resistor belongs after the 0.01- μ F capacitor, as shown below, and not in series with the op amp's inverting input as in the original figure.



Correction

The News Breaks section of the September 17 issue (EDN, pg 21) listed an incorrect phone number for James Electronics, a Chicago, IL, maker of 4W adapters. The correct number is (800) 438-1400; in IL, (312) 463-6500. Please also note that the company offers a line of sixteen 4W adapters (not 16 and 4W adapters as the article states.)

Solenoid control design tips



Microprocessor turns snap action solenoid into a smooth positioner. It's quiet, too. See below.

Solenoids are used to control the performance of devices such as valves, gates, and dampers. New research and development provides better design capability over solenoid parameters and characteristics to make them a system designer's dream come true. Designers are specifying solenoids in applications that once used other actuators.

Some hot solenoid applications Variable, repeatable positioner = Flyby-wire = High speed liquid metering = Safe-arm locks = Fuel injection

Design benefits The simpler control required by solenoids means faster product development cycles, higher reliability from fewer interfaces, high force and speed capabilities. A solenoid is practically made for digital control because it's a pulsed device. And its few components can be optimized.



Example: Want higher speed actuation than a given solenoid allows? Consider using two or more smaller, faster solenoids and take advantage of their multiplied force.



Example: A designer wanted a solenoid to operate within a millisecond, in a window only 70 microseconds wide. With a specified life of 500 million cycles! Ledex solenoids are repeatable, predictable, reliable.

Workhorse

Ledex Soft Shift" variable positioning solenoid starting force is 3 to 5 times conventional, using the same power. It can actuate in milliseconds, or its plunger velocity can be controlled smoothly and noiselessly if you ramp the input current. Used as a hydraulic valve actuator, you can eliminate hydraulic shock.



Soft Shift™ solenoid 17/8" dia.

Solenoid package size Need low profile? Minimum volume? Smallest frontal area? Ledex solenoids can pack more work per cubic inch than motors.

Ledex configurations

Rotary	-High torque, compact.
Magton	-Longest life rotary, no axial movement.
Linear	-Short, medium, long stroke types.
	Push or pull.
Open Fran	me-High performance at least cost.

5 Controllable characteristics Look at the variety of parameters and characteristics the designer can optimize. ■ Force ■ Speed ■ Life ■ Acceleration ■ Quality ■ Noise ■ Repeatability ■ Reliability. Design flexibility also comes by using controls, such as: ■ Current limiting ■ Pulse (A to D) ■ Position sensing ■ Packaged switches. Call on Ledex to discuss your application. Often just a phone call will start a shelf-stocked solenoid on its way.

Want to know more?

Request catalogs.

Ledex Inc. A Subsidiary of Lucas Industries P.O. Box 427 Vandalia, Ohio 45377-0427 U.S.A. Phone: 513-898-3621



helpful solenoid technology

OUR NEW GRAPHICS WORKSTATIONS RUN CIRCLES, CYLINDERS AND SOLIDS AROUND THE COMPETITION.

TEK UNIX-BASED WORKSTATIONS

^

Led by dual 32-bit engines dividing computing and graphics processing tasks, Tek's new 4300 Series Workstations set the pace in graphics-intensive productivity. Now you can count on Tek's 68020-based graphics processor, parallel pipelined architecture, and five custom gate arrays to put your graphics throughput on the fastest track.

Match these workstations against the rest of the field: with

speeds like 450,000 2D vectors, 340,000 3D vectors, and 20,000 Gouraud shaded polygons per second—plus Tek's high resolution displays, superior user interface and unsurpassed quality—the 4300 Series outdistances them all.

The 4300 Series protects your software investment, too, because it's compatible with more than 300,000 PLOT 10[®] packages already written for Tek terminals. Finally, 14 different standalone workstation and highperformance terminal products let you shape and reshape each configuration to fit your evolving needs. For more information on the graphics workstations that run circles, cylinders and solids around the competition, contact your local Tektronix representative.

Or call 1-800-225-5434. In Oregon, 1-235-7202.



Motorola announces one of the smallest advances in the history of VME.



Motorola puts awesome multiprocessing performance on two new single-board computers.

As computer applications get more complex, OEMs are turning more to multiprocessing designs. To handle things like CAD/CAM, robotics, signal processing, simulation and large-scale data acquisition, a single processor simply can't keep up.

Adding several CPUs to a system off-loads the main processor, but what happens to the system bus? It frequently reaches saturation, slowing down the entire system.

Motorola introduces a single chip solution to this problem. The VME Subsystem Bus, a fast, 32-bit secondary bus, has been implemented on a gate array at Motorola.

The end of the multiprocessor traffic jams.

The VSB sub-bus removes traffic from the VMEbus, increasing total system throughput. And by saving space on the VSB-and other components-Motorola has been able to pack an impressive array of multiprocessor functions onto two standard VME boards: the MVME135 and MVME136. These highly integrated microcomputers include all the functions usually required for high-performance multiprocessing. In addition to the VSB, they feature the MC68020 with floating-point coprocessor, both running at either 16.67 or 20.0MHz.

For virtual memory environments, a demand-paged memory management unit can also be added. Plus 1 Megabyte of shared local dynamic RAM is included—with optional parity—designed to operate with zero wait states.

Included in the 135/136 modules

are many special hardware features that facilitate multiprocessing. Things like MP control and status registers. An expanded interrupthandling mechanism. And master/ slave control bit settings.

Hardware alone is hardly enough.

Complete multiprocessing hardware on a single board saves you design time and system space. But to get your application up and running on a tight schedule, it takes software and support tools too. Like those available from Motorola.

If you're building a multi-user/ multi-tasking system, you can use our version of AT&T's UNIX® System V Release 3, with Remote File Sharing. For real-time tasks, there's our full-featured VERSAdos[™] operating system, as well as debugging firmware with on-board diagnostics. Then too, you have access to thirdparty software such as OS-9,[™] MTOS,[™] PDOS,[™] pSOS,[™] RTUX,[™] and VRTX.[®]

Add to that Motorola's in-depth technical support. We have more experience in building reliable, high-performance VME system com-

ponents than any other vendor. Plus a specialized systems and support staff available at over 100 field offices worldwide.

> To see how good multiprocessors can come in small packages, call us toll-free today: **1-800-556-1234**

Ext. 230 (in California,

1-800-441-2345 Ext. 230). Or write; Motorola Microcomputer Division, 2900 South Diablo Way, Tempe, AZ 85282.

MVME135/136 Highlights

Model	Description			
MVME135	VMEbus 32-bit SBC; 16.67-MHz MC68020 CPU; MC68881 FPU; 1Mb on-board DRAM; up to 512 Kb EPROM; two RS-232-C serial ports; two 16-bit timers; master/ slave interface; MP control and			
MVME135-1	Same as MVME135, but with 20-MHz MC68020 CPU			
MVME136	Same as MVME135, but with			

OS-9 is a trademark of Microware Systems Corporation. MTOS is a trademark of Industrial Programming Inc. PDOS is a trademark of Eyring Research Institute, Inc. pSOS is a trademark of Software Components Group, RTUX is a trademark of Emerge Systems. VRTX is a registered trademark of READY SYSTEMS. VERSAdos is a registered trademark of Motorola, Inc. UNIX is a registered trademark of AT&T.



Approaching our technology from your point of view.

39



Here are the keys to faster design of military ASICs...

"All my military and space ASICs...same tools!" "Same supplier, too. Harris." I ANALOG

GaAs





DIGITAL







One workstation, one company, for all your military/space designs.

Remember when semicustom IC designing was impractical because your technology options were too limited, your CAD tools too new and turnaround too slow?

Times have changed! Now Harris makes designing military/space ASICs — in the broadest range of technologies — easier than ever. Because you use the same workstation and design tools for all.

Libraries of solutions: Our GaAs DIGI-II library offers nearly 50 fully characterized cells that are ECL, TTL, CMOS or GaAs compatible. Or...in silicon our advanced HSC 2.0-micron rad-hard CMOS library provides cells and macros you can intermix. Resident libraries also exist for CMOS and bipolar, analog, and digital plus analog/digital mixed technologies.

Hardware and software: Our open-system software CAE/CAD toolset fully integrates with Harris/Masscomp workstations, and meshes easily with other UNIX-based platforms. Daisy and Mentor support is also available.

On to manufacturing: You handle the front-end; leave the back-end to Harris. We carry your ASIC design through to mask, then manufacturing — with the screenings you want and most popular packages: metal flat-pack, side-brazed DIP, chip carriers, and more.

Guaranteed survivors: Now you can create ASICs that tap the high speed of GaAs, or the low power of CMOS, and are guaranteed to survive military and space environments. And you can do it faster.

For more on military/space silicon and GaAs ASICs, call for our Rad-Hard/Hi-Rel Data Book. In U.S. phone 1-800-4-HARRIS, or in Canada: 1-800-344-2444; for GaAs ask for Ext. 1525, for CMOS ask for Ext. 1925.



© 1987, Harris Corporation

CIRCLE NO 70

Quietly In Control





Thermal management control is complete utilizing Comair Rotron's new patented ThermaPro-V technology. This acoustically quiet, flexible, cooling technology allows for continuous motor speed adjustments while extending performance ranges.

THERMAL SPEED CONTROL, with its closed loop system capability, can reduce heat dissipating units and regulate fan speed as a function of temperature...automatically. The PROGRAMMABILITY feature allows for a single fan for multi-purpose use—drastically reducing inventories.

VOLTAGE REGULATION eliminates problems caused by sudden drops in voltage. Internally programmed voltage provides constant cooling under the most hostile environments.

ThermaPro-V. Precise applications for sensitive equipment. Thermal management. Comair Rotron, The first Name in Forced

Convection Cooling Technology.

For literature only call 800-367-2662. In NYS and for product or technical assistance call our application Engineering Dept. at (914) 246-3615.

12 North Street Sawyer Industrial Park, Saugerties, N.Y. 12477-1096 Telephone: (914) 246-3615 TWX 910-333-7572 Telex: 551496

CIRCLE NO 4

NEW LOW PROFILE, SEALED CONTACT SWITCH FOR COST EFFECTIVE KEYBOARD ARRAYS

Examine our new T-15 keyboard switch. Sealed contacts for easy wave soldering and aqueous cleaning. Wide spring-like terminals hold/align switches securely before and after soldering without a metal subpanel. Center to center mounting close as 12.7mm. U.S. automated production/ testing result in a quality and low price unmatched by hand assembled switches.

MEI Stock/Custom Keytops

We offer a wide variety of keytop sizes, shapes and colors with custom or stock legends. Plus our extensive mold system produces custom shapes at a fraction of normal costs. Space bars, leveling mechanisms and LED windows also available.

MEI's years of keyboard construction experience can help resolve your design problems too – from PCB layout to selection of the best legend system. Call today for samples & specs. Toll Free: 1-800-782-7177; In VA: 703-435-9496.

MECHANICAL ENTERPRISES, INC. 461 Carlisle Dr. Herndon, VA 22070 Telex 710-832-0942



G4 BACK SPACE TUT TUT

CALENDAR

Microcomputer Graphics Conference, New York, NY. Expoconsul International, 3 Independence Way, Princeton, NJ 08540. (609) 987-9400. December 16 to 18.

Third Annual Technical Symposium on Optoelectronics and Laser Applications in Science and Engineering, Los Angeles, CA. SPIE, Box 10, Bellingham, WA 98227. (206) 676-3290. January 10.

ATE and Instrumentation Conference West, Anaheim, CA. MG Expositions Group, 1050 Commonwealth Ave, Boston, MA 02215. (800) 223-7126. January 12 to 14.

Third Annual Battery Conference on Applications and Advances, Long Beach, CA. Cecile Duong, Department of Electrical Engineering, California State University at Long Beach, 1250 Bellflower Blvd, Long Beach, CA 90840. (213) 498-4605. January 12 to 14.

Annual IEEE Design Automation Workshop, Apache Junction, AZ. Walling Cyre, Control Data, HQM 173, Box 1249, Minneapolis, MN 55440. (612) 853-2692. January 13 to 15.

Conference on Optical Fiber Communication (OFC '88), New Orleans, LA. Optical Society of America, 1816 Jefferson Pl NW, Washington, DC 20036. (202) 223-0926. January 25 to 27.

Annual Reliability and Maintainability Symposium, Los Angeles, CA. V R Monshaw, RCA, Astro Electronics, Box 800, MS 55, Princeton, NJ 08540. (609) 426-2182. January 26 to 28.

Modern Electronic Packaging (seminar), Orlando, FL. Technology Seminars, Box 487, Lutherville, MD 21093. (301) 269-4102. February 9 to 11.



MICRO-CAP II." The CAE tool with fully interactive analog simulation for your PC.

Spectrum Software's MICRO-CAP II[®] is fast, powerful, and feature rich. This fully interactive, advanced electronic circuit analysis program helps engineers speed through analog problems right at their own PCs.

MICRO-CAP II, which is based on our original MICRO-CAP software, is a field-proven, second-generation program. But it's dramatically improved.



Schematic Editor

MICRO-CAP II has faster analysis routines. Better resolution and color. Larger libraries. All add up to a powerful, cost-effective CAE tool for your PC.

The program has a sophisticated integrated schematic editor with a pan capability. Just sketch and analyze. You can step



Transient Analysis

component values, and run worst-case scenarios—all interactively. And a 500-type* library of standard parts is at your fingertips for added flexiblity.

MICRO-CAP II is available for IBM[®] PCs and Macintosh.[™] The IBM version is CGA, EGA, and Hercules[®] compatible and costs only \$895 complete. An evaluation version is available for \$100. Call or write today for our free brochure and demo disk. We'd like to tell you more about analog solutions in the fast lane.

- Integrated schematic editor
- Fast analysis routines
- High-resolution graphic output
- Standard parts library of 500* types
 *IBM versions only.

- Transient, AC, DC, and FFT routines
- Op-amp and switch models
- Spec-sheet-to model converter*
- Printer and plotter* hard copy



AC Analysis



1021 S. Wolfe Road, Dept. E Sunnyvale, CA 94087 (408) 738-4387

MICRO-CAP II is a registered trademark of Spectrum Software. Macintosh is a trademark of McIntosh Laboratory, Inc. and is being used with express permission of its owner. Hercules is a registered trademark of Hercules Computer Technology IBM is a registered trademark of International Business Machines. Inc.

WATCH WHAT YOU'RE DOING.



Introducing UniLab 8620 analyzer-emulator with InSight.

■ There's nothing like InSight.[™] A feature of the new 8620 that lets you actually **watch** your program go through its paces. So you can debug faster. And speed up microprocessor development. For demanding applications like the automotive controller shown.

An exciting industry first, InSight blends analyzer/emulator techniques to give you continuous, real time monitoring of key processor functions. See changing register contents, I/O lines, ports, user-defined memory windows. With your own labels. And all at once. Interactively.

Without stopping your program.





InSight is made possible by the 8620's advanced bus state analyzer, its 2730-bus-cycle trace buffer, and a new high-speed parallel interface that eliminates RS-232 bottlenecks.

The fast interface also speeds data throughput. From your hard drive, you can load a 64K program into emulation memory in five seconds.

• On top of that, you get a new, crystalcontrolled 1 µsec clock for super precise event timing. • Computer integrated instruments from Orion prove debugging needn't be costly or tedious. For more than 150 processors. Like all our analyzer-emulators, the 8620 debugs by symptom. Via advanced truth table triggering. Always included is enough breakpointing and single stepping (now faster than ever) to assure optimum efficiency. We even provide a stimulus generator and built-in EPROM programmer to help finish the job.

Get serious about price/performance. Save big on design, test, and support costs. UniLab 8620 analyzer-emulator.

Look into it.

Toll free: 800/245-8500. In CA: 415/361-8883.



Computer Integrated Instrumentation 702 Marshall Street, Redwood City, CA 94063 Telex: 530942

*InSight is a trademark of Orion Instruments, Inc.

CALENDAR

Unix Technical Conference, Dallas, TX. Usenix Conference Office, Box 385, Sunset Beach, CA 90742. (213) 592-1381. February 9 to 12.

Compcon Spring (33rd IEEE Computer Society International Conference), San Francisco, CA. Hasan AlKhatib, Dept of EECS, Santa Clara University, Santa Clara, CA 95053. (408) 927-1818. February 29 to March 4.

Modern Electronic Packaging (seminar), Torrance, CA. Technology Seminars, Box 487, Lutherville, MD 21093. (301) 269-4102. March 16 to 18.

American Power Conference, Chicago, IL. Robert Porter, Chicago Institute of Technology, Chicago, IL 60618. (312) 567-3202. April 18 to 20.

IEEE Instrumentation/Measurement Technology Conference (IMtc/88), San Diego, CA. Bob Myers, IMtc, 1700 Westwood Blvd, Los Angeles, CA 90024. (213) 475-4571. April 19 to 22.

Modern Electronic Packaging (seminar), Washington, DC. Technology Seminars, Box 487, Lutherville, MD 21093. (301) 269-4102. April 21 to 23.

Pittsburgh Conference on Modeling and Simulation, Pittsburgh, PA. William Vogt or Marlin Mickle, 348 Benedum Engineering Hall, University of Pittsburgh, Pittsburgh, PA 15261. May 5 to 6.

EMC Expo, Washington, DC. Karen Smith, EMC Expo, Box D, Gainesville, VA 22065. (703) 347-0030. May 10 to 12.

IEEE Custom Integrated Circuits Conference, Rochester, NY. Roberta Kaspar, 20 Ledgewood Dr, Rochester, NY 14615. (716) 865-7164. May 16 to 19. CUT COATING COSTS, WITH PARYLENE!



1-800-554-1697

Parylene coating equipment and application engineering assistance also available.

Copyright @1986 Nova Tran Corporation



Count all of your circuit board coating expenses

you may find that off-site custom parylene coating can help cut costs. Consider the advantages:

- eliminates contamination, pollution, disposal problems and expenses
- reduces labor and need for space/equipment
- provides unmatched coating performance
- preserves board repairability, improves reliability

Contact Nova Tran for a closer look at parylene conformal coating. Qualified to Mil I-46058C

Coating Centers:

New Hampshire Wisconsin Indiana California



CARBIDE Subsidiary of Union Carbide Corporation

CIRCLE NO 6



ISOLATED INPUT TO OUTPUT AND OUTPUT TO OUTPUT

Lowers Your Cost Per Channel
 Lowers Your Assembly Costs
 Saves Board Space
 Eliminates Beat Frequency
 Over 80 Dual and Quad Models Available

Model Number	No. of Channels	Isolation Between Input/Output Channels
PWR5038	2	500VDC
PWR3XX Series	2	1000VDC (1, 2)
PWR8XX Series	2	1000VDC (1, 2)
PWR74	2	1500VDC 12
PWR5XX Series	4	750VDC (2)
PWR71	4	1000VDC (2)
PWR1017	4	1000VDC (2)
 Availabl voltage Tested a 	e with multipl combinations it 2 times ratir	e input/output ng +1000VDC.

representative for complete details. Or call 602-746-1111. Burr-Brown Corp., P.O. Box 11400, Tucson, Arizona 85734.

Your Partner In Quality

WHO CAN PUT POWER MOSFETS

0

BIPOLAR STEPPER MOTOR

SGS-THOMSON Microelectronics--The Brighter wer-- of course. The L6100 and L6102 are

Power--of course. The L6100 and L6102 are implemented in our unique Multipower-BCD™ technology, which allows complete isolation of the output MOSFETs. With prices starting at less than \$2 in 10K quantities, the 100V, 5A/8A devices open up a whole spectrum of design possibilities.

The L6100/2 is a more economical, more reliable and more compact alternative to using four discrete MOSFETs.

Compared to darlingtons, the L6100/2 offers much lower dissipation, no secondary breakdown and an intrinsic free wheeling diode in each transistor.

The L6100, now in full production, is available in an 18 lead DIP package with a special leadframe that conducts heat to the PCB copper. The L6102—soon to be in full production—comes in SGS-THOMSON's own industry standard 15 pin Multiwatt[®] package. Regardless of whether you're driving unipolar DC motors, stepper motors, needle solenoids or many other types of loads—the fast switching, easily paralleled L6100/2 delivers the economy and reliability to turn design possibilities into realities.

UNIPOLAR

STEPPER MOTOR

NEEDLE

DRIVER

the second s	
V _{DS} Max	100V min
I _D (Powerdip)	1.5A cont., 5A peak
(Multiwatt)	2.0A cont., 8A peak
R _{DS(ON)}	1.2 Ohms max
Packages	Powerdip (18 pin) L6100
	Multiwatt (15 pin) L6102

SGS-THOMSON Microelectronics 1000 E. Bell Road, Phoenix, Arizona 85022

SGS and Thomson anticipate a merger of their U.S. subsidiaries in the near future. The name of the new company will be SGS-THOMSON Microelectronics, Inc.

© 1987 All rights reserved.

FOUR ISOLATED IN A SINGLE CHIP?

SGS-THOMSON's exclusive Multipower-BCD[™] technology—that's integrated Bipolar, CMOS, DMOS—has a lot more to offer. What other smart power IC technology isolates the DMOS output power transistors to let you connect as many as you need on a chip anyway you like? None.

That's just one example of how smart our power really is. And the L6100 is just one of many SGS-THOMSON smart power products.

Why not get the full story on SGS-THOMSON Multipower-BCD[™] technology plus full data on the L6100. Call 602/867-6259 now. After all, the brighter your smart power source, the brighter your design's future.



TOSHIBA.THE POWER



AREA SALES OFFICES: CENTRAL AREA, Toshiba America, Inc., (312) 945-1500; EASTERN AREA, Toshiba America, Inc., (617) 272-4352; NORTHWESTERN AREA, Toshiba America, Inc., (408) 244-4070; SOUTHWESTERN AREA, Toshiba America, Inc., (714) 259-0368; SOUTH CENTRAL REGION, Toshiba America, Inc., (214) 480-0470; SOUTHEASTERN REGION, Toshiba America, Inc., (404) 368-0203; MAJOR ACCOUNT OFFICE, POUGH-KEEPSIE, NEW YORK, Toshiba America, Inc., (914) 452-5710; MAJOR ACCOUNT OFFICE, BOLGRARTON, FLORIDA, Toshiba America, Inc., (305) 394-3004, REPRESENTATIVE OFFICES: ALBAMA, Montgomery MArketing, Inc., (205) 830-0498; RAIZONA, Summir Sales, (602) 984-860; ARKANSAS, MIL-REP Associates, (512) 346-6331; CALIFORNIA (NA-MITHER) EIFOC, Inc., (415) 962-0600; CALIFORNIA (NA-& Orange County) Bager Electronices, Inc., (818) 712-0011, (714) 957-3367, (San Diego County) Eagle Technical Sales, (619) 743-650; COLORADO, Straube Associates Mountain States, Inc., (303) 426-0809; CONNECTICUT, Datcom, Inc., (203) 288-7005; FLORIDA, Sales Engineering Concepts, (305) 426-4601, (305) 682-4800; GEORGIA, Montgomery Marketing, Inc., (404) 447-6124; IDAHO, Components West, (509) 922-2412; ILLINDIS, Carlson Electronic Sales, (312) 956-8240, R.W. Kunz, (314) 965-4977; MDIANA, Leslie M. DeVoe Company, (317) 842-3245; IOWA, C.H. Horn, (319) 338-8703; KANSAS, D.L.E. Fleertonics, Sales, (509) 942-2412; ILLINDIS, Carlson Electronic Sales, (312) 956-8240, R.W. KMAS, D.L.E. Fleertonics, Sales, (513) 349-3940; (317) 842-3245; IOWA, C.H. Horn, (319) 338-8703; KANSAS, D.L.E. Fleertonics, Sales, (313) 349-3940; (317) 842-3245; IOWA, C.H. Horn, (319) 338-8703; KANSAS, D.L.E. Fleertonics, Sales, (313) 349-3940; (317) 842-3245; IOWA, C.H. Horn, (319) 338-8703; KANSAS, D.L.E. Fleertonics, Sales, (313) 349-3940; (317) 842-3245; IOWA, C.H. Horn, (319) 338-8703; KANSAS, D.L.E. Fleertonics, Sales, (313) 349-3940; (317) 842-3245; IOWA, C.H. Horn, (319) 338-8703; KANSAS, D.L.E. Fleertonics, Sales, (313) 349-3940; (317) 842-3245; IOWA, C.H. Horn, (319) 338-8703; KANSAS, J.L.E. F

IN MEMORIES.

We are the leader in 1Mb DRAMs. In 256K static RAMs, CMOS EPROMs and 1Mb ROMs. Yet, people still think of us only as the world leader in CMOS and NMOS static RAMs.

We are the world leader in CMOS and NMOS static RAMs, in 16K, 64K and 256K byte wide memory products. We make the fastest 2K x 8 at 35 ns and also a 4K x 4 static RAM at 35 ns. We pioneered the 8K x 8 CMOS static RAM and are now offering a 64K x 1 (55 ns) and 32K x 8 CMOS static RAM.

But we make more than static RAMs. As you can see from the chart, we have a complete line of DRAMs, CMOS, and NMOS ROMs, EPROMs, and one time programmables. And they are all in volume production today.

Tradition of being first.

We were also the first to introduce the 1 Mb DRAM and we're now the market leader. We were one of the first suppliers of the 256K CMOS static RAM. We were a leader with the 256K ROM and within a year of introduction, we shipped more than all other suppliers combined. And we are matching that with our 1 Mb CMOS mask ROM.

So you can see that we have the capability to supply the memory products you want—when you want them.

That's memory power; that's Toshiba.

PART NO. ORG. PROCESS SAMPLES PROD. SPEED SORTS AVAILAB DYNAMIC RAMS TMM1256APAT/AZ 256KX1 NMOS YES YES 100 120 150 TMM14164APAT/AZ 256KX1 NMOS YES YES 100 120 150 TG51000PJ/Z IMAXI CMOS YES YES 85 100 120 TC51002PJ/Z J66KAI CMOS YES YES 85 100 120 TC51002PJ/Z J66KAI CMOS YES YES 100 120 TC514238PJ/Z 256KAI CMOS YES YES 100 120 TMM2016AP 2KX8 NMOS YES YES 90 100 120 TMM2016AP 2KX8 NMOS YES YES 70 100 120 TMM2054AP 8KX8 NMOS YES YES 70 100 120 TMM2054AP 8KX8 NMOS YES YES <t< th=""><th>LA LAL J</th><th></th></t<>	LA LAL J	
DYNAMIC RAMS NMOS YES YES 100 120 150 TMM412564PATAZ 266KX NNOS YES YES 100 120 150 TCS1100PJ/Z IMbX1 CMOS YES YES 85 100 120 TCS1100PJ/Z IMbX1 CMOS YES YES 85 100 120 TCS1100PJ/Z Z6KK CMOS YES YES 85 100 120 TCS1426PJ/Z Z66KK CMOS YES YES 100 120 TTG14264PJ/Z Z66KK CMOS YES YES 100 120 TTMM2016AP ZKX8 NMOS YES YES 90 100 120 TMM2016AP ZKX8 NMOS YES YES 70 100 120 TMM2016AP ZKX8 NMOS YES YES 70 100 120 TMM206AP ZKX8 NMOS YES YES 70 <th>BLE (ns)</th> <th>PACKAG</th>	BLE (ns)	PACKAG
JAMALSAATA JAZ, SARAI NMOS TES 100 120 150 TMML165AP/ATAZ, SARAI NMOS YES YES 100 120 150 TMML166AP/ATAZ, SARAI NMOS YES YES 100 120 150 TC511000PJ/Z IMbX1 CMOS YES YES 85 100 120 TC51100PJ/Z IMbX1 CMOS YES YES 100 120 TC514256PJ/Z 256KAI CMOS YES YES 100 120 TTMM2016BP 12KAS NMOS YES YES 100 120 TMM2016AP 2KAS NMOS YES YES 90 100 120 TMM2016AP 2KAS NMOS YES YES 90 100 120 TMM2016AP 2KAS NMOS YES YES 70 100 120 TMM204AP 8KAS NMOS YES YES 70 100 120 <		
JAMALGSJAFCA17AZ ZANKAI NMOS TES 100 120 150 TCS11000PJ/Z IMbX1 CMOS YES YES 100 120 150 TCS11000PJ/Z IMbX1 CMOS YES YES 85 100 120 TCS11002PJ/Z IMbX1 CMOS YES YES 100 120 TCS11002PJ/Z 256KX4 CMOS YES YES 100 120 TCS11002PJ/Z 256KX4 CMOS YES YES 100 120 TIMISODOS IMbX8 CMOS YES YES 90 100 120 TMM2016AP 2KX8 NMOS YES YES 70 100 120 TMM2046AP 8KX8 NMOS YES YES 70 100 120 TMM2046AP 8KX8 NMOS YES YES 70 100 120 TMM2046AP 8KX8 NMOS YES YES 70 <	_	P,1,2
JAMMUGAT/A1/AL ORKAT NMOS TES TES 100 120 TSJ TC511000PJ/Z IMbX1 CMOS YES YES 85 100 120 TC511002PJ/Z IMbX1 CMOS YES YES 85 100 120 TC514258PJ/Z 256KX4 CMOS YES YES 100 120 TC514258PJ/Z 256KX4 CMOS YES YES 100 120 TMM2016AP 2KX8 NMOS YES YES 90 100 120 TMM2016AP 2KX8 NMOS YES YES 90 100 120 TMM2016AP 2KX8 NMOS <yes< td=""> YES 90 100 120 TMM2016AP 2KX8 NMOS<yes< td=""> YES 70 100 120 TMM204AP 8KX8 NMOS<yes< td=""> YES 70 100 120 TMM205AP 8KX8 NMOS<yes< td=""> YES 70 100 120 <</yes<></yes<></yes<></yes<>		P,1,2
ILG.10.007/J.2 INDAT CMIOS TES NO 120 TCG11002P/J.7 IMDAT CMIOS YES YES #5 100 120 TCG11002P/J.7 256KA4 CMOS YES YES 100 120 TCG14256P/J.7 256KA4 CMOS YES YES 100 120 TCG14256P/J.7 256KA4 CMOS YES YES 100 120 TCM2016AP 2KA8 NMOS YES YES 90 100 120 TMM2016BP 2KA8 NMOS YES YES 90 100 120 TMM2046AP 2KA8 NMOS <yes< td=""> YES 70 100 120 TMM2046AP 8KX8 NMOS<yes< td=""> YES 70 100 120 TMM204AP 8KX8 NMOS YES YES 100 120 TMM204AP 8KX8 NMOS YES YES 100 120 TC5566AP 2KX8</yes<></yes<>		P.1.2
ILSIIOURD/2. INDAIL CMOS TES No. 120 TCS100267/2. IMSXI CMOS YES YES No. 120 TCS10267/2. 256KXI CMOS YES YES 100 120 TIMB0005 1MbX8 CMOS YES YES 100 120 TIMM2016AP 2KX8 NMOS YES YES 90 100 120 TMM2016AP 2KX8 NMOS YES YES 90 100 120 TMM2016AP 2KX8 NMOS YES YES 70 100 120 TMM204AP 8KX8 NMOS <yes< td=""> YES 70 100 120 TMM206AP 8KX8 NMOS<yes< td=""> YES 70 100 120 TMM206AP 8KX8 NMOS<yes< td=""> YES 70 100 120 TMM206AP 8KX8 NMOS<yes< td=""> YES 70 100 120 TC5566AP 8KX8</yes<></yes<></yes<></yes<>		P, J, Z
11.31.00.27/J.2 100.01 CM035 TES 35 100 120 TC514236P/J.2 250KX4 CM0S YES YES 100 120 TC514236P/J.2 250KX4 CM0S YES YES 100 120 STATIC RAMS TMM2016AP 2KX8 NMOS YES YES 90 100 120 TMM2016AP 2KX8 NMOS YES YES 90 100 120 TMM2015AP 2KX8 NMOS <yes< td=""> YES 90 100 120 TMM204P 8KX8 NMOS<yes< td=""> YES 70 100 120 TMM204AP 8KX8 NMOS<yes< td=""> YES 70 100 120 TMM204AP 8KX8 NMOS<yes< td=""> YES 70 100 120 TMM204AP 8KX8 NMOS<yes< td=""> YES 70 100 120 TC5564P 8KX8 CMOS YES YES 120 150 TC5564P</yes<></yes<></yes<></yes<></yes<>		P. J. Z
12.0142.017.2 2.050.34 CM03 TE3 TE3 TE3 TE3 TE3 TIMM2000S TMMXX CM0S YES YES TE3 TE3 TIMM2016AP 2KX8 NMOS NO YES 90 100 120 TIMM2016AP 2KX8 NMOS NO YES 90 100 120 TIMM2016AP 2KX8 NMOS YES YES 90 100 120 TIMM2015AP 2KX8 NMOS YES YES 70 100 120 TMM2046P 8KX8 NMOS <yes< td=""> YES 70 100 120 TIMM204AP 8KX8 NMOS<yes< td=""> YES 70 100 120 TIMM204AP 8KX8 NMOS<yes< td=""> YES 100 120 TC55647 TIMM204AP 8KX8 NMOS<yes< td=""> YES 100 120 TC55647 TC55647 2KX8 CMOS YES YES 100 TC5</yes<></yes<></yes<></yes<>		P. J. Z
12.03.2.037.2 2.03.04.3 CMO3 TES TES 100 120 STATIC RAMS TMM2016AP 2KX8 NMOS YES YES 100 120 TMM2016AP 2KX8 NMOS YES YES 90 100 120 TMM2016AP 2KX8 NMOS YES YES 90 100 120 TMM2016AP 2KX8 NMOS YES YES 90 100 120 TMM2046P 8KX8 NMOS YES YES 70 100 120 TMM2046P 8KX8 NMOS YES YES 70 100 120 TMM206AP 8KX8 NMOS YES YES 100 120 TC55664P 8KX8 CMOS YES YES 100 120 TC5564AP 8KX8 *CMOS YES YES 100 120 TC5564AP 8KX8 *CMOS YES YES 160 120 </td <td></td> <td>F, J, C</td>		F, J, C
STATUC RAMS YMS NO YES 90 100 120 TMM2016AP 2KX8 NMOS YES 90 100 120 TMM2015AP 2KX8 NMOS YES YES 90 100 120 TMM2015AP 2KX8 NMOS YES YES 90 100 120 TMM204P 8KX8 NMOS YES YES 70 100 120 TMM2043P 8KX8 NMOS <yes< td=""> YES 70 100 120 TMM2043P 8KX8 NMOS<yes< td=""> YES 70 100 120 TMM2043P 8KX8 YMOS<yes< td=""> YES 70 100 120 TC5564P 8KX8 YMOS<yes< td=""> YES 150 200 TC5564P TC5564P 8KX8 YMOS YES YES 160 120 TC5564P 8KX8 YMOS YES YES 160 120 TC5564P 8KX8 <td< td=""><td></td><td>F, J, Z S</td></td<></yes<></yes<></yes<></yes<>		F, J, Z S
Instantionar 2AAS NMOS NO TES 30 100 120 IMM2016BP 2KX8 NMOS NO YES 90 100 120 IMM2015AP 2KX8 NMOS YES YES 90 100 120 IMM2015AP 2KX8 NMOS YES YES 90 100 120 IMM204AP 8KX8 NMOS <yes< td=""> YES 70 100 120 IMM206AP 8KX8 NMOS<yes< td=""> YES 70 100 120 IMM206AP 8KX8 NMOS<yes< td=""> YES 70 100 120 ITC5566P 8KX8 CMOS YES YES 120 150 TC5566AP 8KX8 *CMOS YES YES 100 120 TC5565AP 8KX8 *CMOS YES YES 150 120 TC5565AP 3KX8 *CMOS YES YES 85 100 120 TC5</yes<></yes<></yes<>	150	P
Instantion 24X8 NMOS TES 30 100 120 TMM2015AP 2KX8 NMOS YES 90 100 120 TMM2015BP 2KX8 NMOS YES YES 90 100 120 TMM204FP 8KX8 NMOS YES YES 70 100 120 TMM2064AP 8KX8 NMOS YES YES 70 100 120 TMM2064AP 8KX8 NMOS YES YES 70 100 120 TMM2064AP 8KX8 NMOS YES YES 70 100 120 TC5566AP 2KX8 CMOS YES YES 120 150 TC5563AP 8KX8 *CMOS YES YES 120 150 TC5563AP 8KX8 *CMOS YES YES 120 150 TC5563AP 3KX8 *CMOS YES YES 150 120 TC5563AP <td>150</td> <td>P</td>	150	P
1 MB2015M 2KAS NM03 YES YES 90 100 120 TMM2015P 2KAS NM05 YES YES 90 100 120 TMM204P 8KX8 NM05 YES YES 70 100 120 TMM2040P 8KX8 NM05 YES YES 70 100 120 TMM2043P 8KX8 NM05 YES YES 100 120 TMM2043P 8KX8 NM05 YES YES 200 250 TC5564P 2KX8 CM05 YES YES 100 120 TC5564P 8KX8 *CM05 YES YES 100 120 TC5564P 8KX8 CM05 YES YES 100 120 TC5564P 8KX8 CM05 YES YES 100 120 TC5564P 3KX8 *CM05 YES YES 85 100 120 TC5564P <t< td=""><td>150</td><td>P 200 MII</td></t<>	150	P 200 MII
Instantion Lakas NMOS YES YES YES 70 100 120 TIMM2064P 8KX8 NMOS YES YES 70 100 120 TIMM2064P 8KX8 NMOS YES YES 70 100 120 TIMM2064P 8KX8 NMOS YES YES 70 100 120 TKM2064P 8KX8 NMOS YES YES 70 100 120 TC5567P 2KX8 CMOS YES YES 100 120 150 TC556AP 8KX8 *CMOS YES YES 100 120 150 TC556AP 8KX8 *CMOS YES YES 120 150 120 120 150 TC556AP 8KX8 CMOS YES YES 120 120 120 120 120 120 120 120 120 120 120 120 120 120 120	150	P 300 MIL
Instationary BAXD NMOS TES TO TO TO TO IMAD004P BKXB NMOS YES YES 70 TO TO 120 TMM2064P BKXB NMOS YES YES 70 100 120 TMM2063P BKXB NMOS YES YES 70 100 120 TKM2063AP BKXB NMOS YES YES 200 250 TC556AP 2KXB CMOS YES YES 120 150 TC556AP 8KXB *CMOS YES YES 120 120 TC556AP 8KXB *CMOS YES YES 120 120 TC556AP 8KXB *CMOS YES YES 85 100 120 TC556AP 8KXB *CMOS YES YES 85 100 120 TC556AP 3KXB *CMOS YES YES 35 45 5	150	P 300 MIL
Instance SKAS NMOS TES 10 120 Instance SKAS NMOS YES YES 100 120 INM20x3P SKXS NMOS YES YES 70 100 120 TCS50FAP 2KX8 CMOS YES YES 120 TCS50FAP 2KX8 CMOS YES YES 120 TCS565AP 3KX8 *CMOS YES YES 100 120 TC5565AP 3KX8 *CMOS YES YES 100 120 TC5565AP 3KX8 *CMOS YES YES 100 120 TC5562F7 32KX8 *CMOS YES YES 85 100 120 TC55257P 32KX8 *CMOS YES YES 85 100 120 TC55527P 32KX8 *CMOS YES YES 35 45 55 55 TMM208AD 4KX4 NMOS YES 35 45 55 TMM208AD 4KX4 NMOS YES	100	P
TABLESS FILSS TES TES <thte< td=""><td>150</td><td>P 200 MIL</td></thte<>	150	P 200 MIL
Instantion SKAS KMOS TES 10	150	P 300 MIL
LALADOM 2.KAØ C.MUS 16.5 2.00 2.00 CIGS171RCF 2KX8 CMOS YES YES 120 150 TC55663P 8KX8<*CMOS		r JOU MIL
LABBLE CAND CAND FE3 FE		DEV
Lassor ORAB CMODS TES TES L20 L50 TC5565AP 8KX8 *CMOS YES YES 100 120 150 TC556AP 8KX8 *CMOS YES YES 100 120 150 TC556AP 8KX8 CMOS YES YES 120 150 TC556F7 32KX8<*CMOS		PFY
Name PARAD CANDY TES TE		PFY
Lassaar BKAD "LMOS YES YES 100 120 TG5564P BKX8 CMOS YES YES 150 200 TG5564P BKX8 CMOS YES YES 150 200 TG55257P 32KX8 *CMOS YES YES 85 100 120 TG55257P 32KX8 *CMOS YES YES 85 100 120 TG55257P 32KX8 *CMOS YES YES 35 45 55 TIMM2018AD 2KX8 NMOS YES YES 25 35 45 TIMM2078D 4KX4 NMOS YES YES 35 45 TIMM2078D 4KX4 NMOS YES YES 35 45 TG5541P 4KX4 NMOS YES YES 35 45 TG5562P 64KX1 *CMOS YES YES 150 200 TIM274AD- 8KX8		PFY
ICS664P 8KA8 CMOS YES YES 150 200 TC5526AP 8KX8 *CMOS YES YES 150 120 TC55267P 32KX8 *CMOS YES YES 85 100 120 TC55257P 32KX8 *CMOS YES YES 85 100 120 TC55257P 32KX8 *CMOS YES YES 85 100 120 TC55047P 32KX8 NMOS YES YES 35 45 55 TMM2018D 2KX8 NMOS YES YES 35 45 55 TMM2098D 4KX4 NMOS YES YES 35 35 45 TMM2098D 4KX4 NMOS YES YES 35 45 55 TMM2098D 4KX4 NMOS YES YES 35 45 55 TMM2098P 8KX9 NMOS YES YES 35 45 </td <td>_</td> <td>P 300 MIL</td>	_	P 300 MIL
TC3564AP SKX8 CMOS YES YES 120 150 TC55257P 32KX8<*CMOS	-	PFY
TCS5257P 32KX8<*CMOS YES YES 85 100 120 HIGH SPEED STATIC RAMS *CMOS YES YES 85 100 120 HIM2018ID 2KX8 NMOS YES YES 85 100 120 HIM2018ID 2KX8 NMOS YES YES 25 35 45 55 TMM2018AD 2KX4 NMOS YES YES 25 35 45 55 TMM208AD 4KX4 NMOS YES YES 25 35 45 55 TMM2078D 4KX4 NMOS YES YES 35 45 55 TMM2078D 4KX4 NMOS YES YES 35 45 55 TMM2078D 4KX4 NMOS YES YES 35 45 55 56 70 70 70 70 70 70 70 70 70 70 70 70 70	_	PFY
TCS3527AP 328Xx8 *CM0S YES YES YES 85 100 120 TIMM2018D 2Kx8 NM0S YES YES 35 45 55 TIMM2018D 2Kx8 NM0S YES YES 25 35 45 TIMM2018D 4Kx4 NM0S YES YES 25 35 45 TIMM2018D 4Kx4 NM0S YES YES 25 35 45 TIMM2018D 4Kx4 NM0S YES YES 25 35 45 TIMM208AD 4Kx4 NM0S YES YES 35 45 TIMM208BP 8Kx8 NM0S YES YES 35 45 TIMM208BP 8Kx8 NM0S YES YES 35 45 TIC5541P 16Kx4 *CM0S YES YES 70 - TC5562P 64Kx1 *CM0S YES YES 150 200 -<	150	Р
HIGH SPEED STATIC RAMS TIMM20180 2KX8 NNOS YES YES 35 45 55 TIMM20180 2KX8 NNOS YES YES 25 35 45 55 TIMM20180 4KX4 NNOS YES YES 25 35 45 55 TIMM200800 4KX4 NNOS YES YES 35 45 55 TIMM200800 4KX4 NNOS YES YES 35 45 55 TIMM20780 4KX4 NNOS YES YES 35 35 45 TIMM20780 4KX4 NNOS YES YES 35 35 45 TIMM20780 4KX4 NNOS YES YES 35 45 55 TIMM2080P 8KX9 NNOS YES YES 35 45 55 TIM2080P 6KX1 *CMOS YES YES 100 200 100 200 100 100	150	PF
IMM0018D 2.8.88 NM0S Y.E.S Y.E.S 3.5 4.5 5.5 IMM0018D 2.8.88 NM0S Y.E.S Y.E.S 3.5 4.5 5.5 IMM2018D 2.8.88 NM0S Y.E.S Y.E.S 3.5 4.5 5.5 IMM208AD 4.8.X4 NM0S Y.E.S Y.E.S 2.5 3.5 4.5 IMM2078AD 4.8.X4 NM0S Y.E.S Y.E.S 2.5 3.5 4.5 IMM2078AD 4.8.X4 NM0S Y.E.S Y.E.S 3.5 4.5 IMM2078AP 8.8.X8 NM0S Y.E.S Y.E.S 3.5 4.5 IC55614P 16.8.X4 *CM0S Y.E.S Y.E.S 3.5 4.5 IC5661P 64.8.X1 *CM0S Y.E.S Y.E.S 1.50 2.00 IC5642P 3.2.8.2.8 NM0S Y.E.S Y.E.S 1.50 2.00 IMM2704AD- 8.8.2.8 NM0S Y.E.S Y.E.S		
IMM2018AD 2KX8 NMOS YES YES 25 35 45 IMM2018AD 4KX4 NMOS YES YES 25 35 45 IMM2018AD 4KX4 NMOS YES YES 25 35 45 IMM2078AD 4KX4 NMOS YES YES 25 35 45 IMM2078AD 4KX4 NMOS YES YES 25 35 45 IMM2078AD 4KX4 NMOS YES YES 35 45 IMM2089P 8KX8 NMOS YES YES 35 45 IC55417P 16KX4 *CMOS YES YES 35 45 IC5582P 64KX1 *CMOS YES YES 120 150 EPPCMMS TMM2704AD- 8KX8 NMOS YES YES 150 200 IMM27128AD- 6KX8 NMOS YES YES 150 200 <		D
IMM2008D 4kX4 NMOS YES YES 33 45 55 IMM2008D 4KX4 NMOS YES YES 25 35 45 IMM2008D 4KX4 NMOS YES YES 25 35 45 IMM2008D 4KX4 NMOS YES YES 25 35 45 IMM2008P 8KX8 NMOS YES YES 25 35 45 IMM2008P 8KX8 NMOS YES YES 35 45 IMM2008P 8KX8 NMOS YES YES 35 45 IC55416P 16KX4 *CMOS YES YES 70 7 IC5562P 64KX1 *CMOS YES YES 120 150 7 IC5562P 64KX1 *CMOS YES YES 150 200 7 IMM2704AD- 6KX8 NMOS YES YES 150 200 7 <		D
IMM.0908AD 4KX4 NMOS YES YES 25 35 45 IMM.0078AD 4KX4 NMOS YES YES 25 35 45 IMM.0078AD 4KX4 NMOS YES YES 25 35 45 IMM.0078AD 4KX4 NMOS YES YES 25 35 45 IMM.0089V 8KX9 NMOS YES YES 35 45 IC53416P 16KX4 *CMOS YES YES 35 45 IC5561P 64KX1 *CMOS YES YES 70 - TC5562P 64KX1 *CMOS YES YES 150 200 EPROMS - 150 200 - - 170/44D- MM27128AD- 8KX8 NMOS YES YES 150 200 IMM2728AD- 16KX8 NMOS YES YES 150 200 IMM2728AD- 32KX8		D
IMM2078D 4KX4 NMOS YES YES 35 45 55 IMM2078D 4KX4 NMOS YES YES 35 45 55 IMM2078D 4KX4 NMOS YES YES 25 35 45 IMM2088P 8KX8 NMOS YES YES 35 45 IMM2089V 8KX8 NMOS YES YES 35 45 IC55416P 16KX4<*CMOS	_	D
TMM2078AD 4KX4 NMOS YES YES 25 35 45 TMM2088P 8KX8 NMOS YES YES 35 35 45 TMM2088P 8KX8 NMOS YES YES 35 45 TC55416P 16KX4 *CMOS YES YES 35 45 TC5561P 64KX1 *CMOS YES YES 35 45 TC5561P 64KX1 *CMOS YES YES 70 - TC5562P 32KX8 PSEUDO YES YES 150 200 EM2704AD- 8KX8 NMOS YES YES 150 200 TMM2704AD- 8KX8 NMOS YES YES 150 200 TMM2728AD- 16KX8 NMOS YES YES 150 200 TMM2728AD- 16KX8 NMOS YES YES 150 200 TMM2728AD- 16KX8 NMOS YES<		D
TMM2088P 8KX8 NMOS YES YES 35 45 TC55416P 16KX4 *CMOS YES YES 35 45 TC55417P 16KX4 *CMOS YES YES 35 45 TC55417P 16KX4 *CMOS YES YES 35 45 TC55417P 16KX4 *CMOS YES YES 35 45 TC55612P 64KX1 *CMOS YES YES 45 55 TC5582P 64KX1 *CMOS YES YES 120 150 EPROMS TMM2704AD- 8KX8 NMOS YES YES 150 200 TIMM2704AD- 8KX8 NMOS YES YES 150 200 TIMM2704AD- 8KX8 NMOS YES YES 150 200 TIMM2728AD- 16KX8 NMOS YES YES 150 200 TIMM2726AD- 32KX8 NMOS YES		D
IMM@ev9 8kx9 NMOS YES YES 35 45 TC55416P 16kX4 *CMOS YES YES 35 45 TC55417P 16kX4 *CMOS YES YES 35 45 TC55417P 16kX4 *CMOS YES YES 70 TC562P 64kX1 *CMOS YES YES 45 55 TC5682P 64kX1 *CMOS YES YES 120 150 EPROMS E FES 150 200 TMM2704AD- 8kX8 NMOS <yes< td=""> YES 150 200 TMM2704AD- 8kX8 NMOS<yes< td=""> YES 150 200 TMM2726AD- 6kX8 NMOS<yes< td=""> YES 150 200 TMM2726AD- 6kX8 NMOS<yes< td=""> YES 150 200 TMM2726AD- 6kX8 NMOS<yes< td=""> YES 150 200 TG726AD 6kX8 NMOS<yes< td=""> YES 150 200 TG726AD 6kX8 NMOS<!--</td--><td></td><td>Р</td></yes<></yes<></yes<></yes<></yes<></yes<>		Р
TICS410P 16KX4 *CMOS YES YES 35 45 TCS5017P 16KX4 *CMOS YES YES 35 45 TCS501P 64KX1 *CMOS YES YES 70 TC5562P TC5562P 64KX1 *CMOS YES YES 45 55 TC51832P 32KX8 PSEUDO YES YES 120 150 EPPCMMS TMM2764AD- 8KX8 NMOS YES YES 150 200 TMM2728AD- 16KX8 NMOS YES YES 150 200 TMM2728AD- 16KX8 NMOS YES YES 150 200 TMM2728AD- 16KX8 NMOS YES YES 150 200 TMM2728AD- 32KX8 NMOS YES YES 150 200 TC5756AD 32KX8 CMOS YES YES 150 200 250 TMM27512D 64KX8 NMO	_	C 300 MIL
TICS541P 16KX4 *CMOS YES YES 35 45 TCS561P 64KX1 *CMOS YES YES 70 TCS562P 64KX1 *CMOS YES YES 45 55 TCS562P 64KX1 *CMOS YES YES 150 200 TCS562P 32KX8 PSEUDO YES YES 150 200 TMM2764AD 8KX8 NMOS YES YES 150 200 TMM27128AD 16KX8 NMOS YES YES 150 200 TMM27266AD 32KX8 NMOS YES YES 150 200 TC5726AD 32KX8 NMOS YES YES 150 200 TC5726AD 32KX8 NMOS YES YES 150 200 TC5726AD 32KX8 NMOS YES YES 200 250 TC5726AD 32KX8 NMOS YES YES 20		D
ICL550[P 64KXI *CMOS YES YES 70 TCS582P 96KXI *CMOS YES YES 45 55 TCS182P 32KX8 PSEUDO YES YES 120 150 EPROMS IMM2704AD- 8KX8 NMOS YES YES 150 200 TMM2704AD- 8KX8 NMOS YES YES 150 200 TMM2704AD- 16KX8 NMOS YES YES 150 200 TMM2728AD- 16KX8 NMOS YES YES 150 200 TMM2726AD- 32KX8 NMOS YES YES 150 200 TMM2726AD- 32KX8 NMOS YES YES 200 250 TC5726AD 32KX8 CMOS YES YES 200 250 TC57102D 64KX8 NMOS YES YES 200 250 TC571001D 128KX8 CMOS YES YES		D
TCS582P 64KX1 *CM0S YES YES 45 55 TCS1822P 32KX8 PSEUDO YES YES 150 EPROMS 8KX8 NMOS YES YES 150 200 TMM2764AD- 8KX8 NMOS YES YES 150 200 TMM2764AD- 8KX8 NMOS YES YES 150 200 TMM27128AD- 16KX8 NMOS YES YES 150 200 TMM27266AD- 32KX8 NMOS YES YES 150 200 TMM27266AD- 32KX8 NMOS YES YES 150 200 TC57266D 32KX8 CMOS YES YES 200 250 TC5726AD 32KX8 CMOS YES YES 200 250 TMM27512D 64KX8 NMOS YES YES 200 250 TC571001D 128KX8 CMOS YES 200 250 <td></td> <td>Р</td>		Р
TCS182P 328X88 PSEUDD YES YES 120 150 TMM2704AD- 8KX8 NMOS YES YES 150 200 TMM2704AD- 8KX8 NMOS YES YES 150 200 TMM2704AD- 8KX8 NMOS YES YES 150 200 TMM2704AD- 16KX8 NMOS YES YES 150 200 TMM2728AD- 16KX8 NMOS YES YES 150 200 TMM2726AD- 32KX8 NMOS YES YES 150 200 TC5726AD- 32KX8 NMOS YES YES 200 250 TC5726AD 32KX8 NMOS YES YES 200 250 TC57100D 128KX8 CMOS YES YES 200 250 TC57102D 64KX16 CMOS YES YES 200 250 TC57102D 64KX16 CMOS YES YE		PY
EPROMS NM05 YES YES 150 200 TMM2704AD1- 8KX8 NM05 YES YES 150 200 TMM2704AD1- 8KX8 NM05 YES YES 150 200 TMM2704AD1- 16KX8 NM05 YES YES 150 200 TMM27128AD1- 16KX8 NM05 YES YES 150 200 TMM27266AD- 32KX8 NM05 YES YES 150 200 TG57256D 32KX8 CM05 YES YES 150 200 TC57256D 32KX8 CM05 YES YES 150 200 TMM27512D 64KX8 NM05 YES YES 200 250 TC57102D 128KX8 CM05 YES YES 200 250 TC57102D 128KX8 CM05 YES YES 200 250 TC57102D 128KX8 CM05 YES YES 200		Р
Internation Internation <thinternation< th=""> <thinternation< th=""></thinternation<></thinternation<>		D
TMM27128AD- 16KX8 NMOS YES YES 150 200 TMM27128AD- 16KX8 NMOS YES YES 150 200 TMM27128AD- 16KX8 NMOS YES YES 150 200 TMM27128AD- 32KX8 NMOS YES YES 150 200 TMM27256AD- 32KX8 NMOS YES YES 150 200 TC57256AD 32KX8 CMOS YES YES 200 250 TC57256AD 32KX8 CMOS YES YES 200 250 TC5712D 64KX8 NMOS YES YES 200 250 TC57100D 128KX8 CMOS YES YES 200 250 TC57102D 64KX16 CMOS YES YES 200 250 TC57102D 64KX16 CMOS YES YES 200 250 TC5426AP 32KX8 NMOS YES <t< td=""><td></td><td>D</td></t<>		D
International and the second		p
India India <th< td=""><td></td><td>D</td></th<>		D
IMP2756.0L1 IMP IMP <th< td=""><td>-</td><td>D</td></th<>	-	D
International Internat International International		D
Intel Intol Intol <th< td=""><td></td><td>D</td></th<>		D
Subsect Subsect <t< td=""><td></td><td>D</td></t<>		D
Induction Induction <t< td=""><td>-</td><td>D</td></t<>	-	D
Industry JHAB		D
Northward Lebrard	-	D
Internation Jakes B Jobs Joss		D
ONE TIME PROGRAMMABLES Int Dot Dot IMM2614AP 8KX8 NMOS YES YES 200 IMM2612AP 16KX8 NMOS YES YES 200 IMM2612BAP 16KX8 NMOS YES YES 200 IMM2612BAP 32KX8 NMOS YES YES 200 IMM2612P 64KX8 NMOS YES YES 200 IMM2612P 64KX8 NMOS YES YES 200 IMM2612P 64KX8 NMOS YES YES 200 IMM2512P 64KX8 NMOS YES YES 200 ICS256P 32KX8 NMOS YES YES 150 ICS257P 32KX8 CMOS YES YES 200		D
IMM2404AP 8KX8 NMOS YES YES 200 IMM2402AP 16KX8 NMOS YES YES 200 IMM24256AP 32KX8 NMOS YES YES 200 IMM24026AP 32KX8 CMOS YES YES 200 IMM24512P 64KX8 NMOS YES YES 200 MM24512P 64KX8 NMOS YES YES 250 MASK ROMS IMOS YES YES 150 TC58256P 32KX8 NMOS YES YES 200	11	
IMMERIZADAY IBKAB NMUS YE.S 240 IMMERIZADAY IBKAB NMOS YE.S 240 IMMERIZADAY IBKAB NMOS YE.S 240 TC54256AP 32KX8 CMOS YE.S YE.S 200 TMM24512P 64KX8 NMOS YE.S YE.S 200 MASK RCMS YE.S YE.S 250 TMM24512P 64KX8 NMOS YE.S YE.S MASK RCMS YE.S YE.S 150 TC54256P 32KX8 NMOS YE.S YE.S 200	-	PF
Instructionar JERANS NMUS YE.5 200 ICSUE56AP JERANS CMOS YE.5 YE.5 200 ITMIZ4512P 64KX8 NMOS YE.5 YE.5 250 MASK ROMS ITMIZ2566P 32KX8 NMOS YE.5 YE.5 150 ICSUE57P 32KX8 CMOS YE.5 YE.5 200		PF
LONGROAT JEARAB LMUS TE.S 200 MM25112P GKX8 NMOS YES YES 250 MASK ROMS MM05 YES YES 150 TC05257P 32KX8 NMOS YES YES 150		PF
IMMA2012F OHKAN NMUS YES YES Z90 MASK ROMS Imma20260 32KX8 NMOS YES YES 150 TCS2577P 32KX8 CMOS YES YES 200		PF
MASK ROMS Second S		PF
I MM23230F 32KX8 NMOS YES YES 150 FC53257P 32KX8 CMOS YES YES 200		Dee
1C53257P 32KX8 CMOS YES YES 200		F28
		FP28
TC53512P 64KX8 CMOS YES YES 200		P28
TC531000P 128KX8 CMOS YES YES 200	_	P28

TOSHIBA. THE POWER IN MEMORIES.

TOSHIBA AMERICA, INC.

MINNESOTA, Electric Component Sales, (612) 933-2594; MISSISSIPPI, Montgomery Marketing, Inc., (205) 830-0498; MISSOURI, D.L.E. Electronics, (316) 744-1229; MONTANA, Components West, (206) 885-5880; NEVADA, Eirepco, Inc., (415) 962-0660; NEBRASKA, D.L.E. Electronics, (316) 744-1229; NEW ENGLAND, Datcom, Inc., (617) 891-4600; NEW HAMPSHIRE, Datcom, Inc., (617) 891-4600; NEW JERSEY, Nexus-Technology, (201) 947-0151; NEW MEXICO, Summit Sales, (602) 998-4850; NEW YORK, Nexus Technology, (201) 947-0151; Pitronics, (315) 455-7346; MORTH CAROLINA/SOUTH CAROLINA, SOUTH CAROLINA, Nexus Technology, (201) 947-0151; Pitronics, (315) 884-2313; (315) 203-3159; (314) 545-7360; MORTH CAROLINA/SOUTH CAROLINA, Nexus Technology, (201) 947-0151; Pitronics, (315) 485-7346; MORTH CAROLINA/SOUTH CAROLINA, Nexus Technology, (201) 947-0151; Pitronics, (315) 485-7346; MORTH CAROLINA/SOUTH CAROLINA, Nexus Technology, (201) 947-0151; Pitronics, (315) 485-7346; MORTH CAROLINA/SOUTH CAROLINA, Nexus Technology, (201) 947-0151; Pitronics, (315) 848-231; (315) 249-3416; Concentes, Jeta, (216) 484-2331; WORTH JAK00; TENNESSEE, Montgomery Marketing, Inc., (205) 830-0498; TEXAS, MIL-REP Associates, (512) 446-6331, (713) 444-257, (214) 644-6731; UTAH, Straube Associates, (410) 487, EX31; WASHINGTON, Components West, (206) 885-5880, (509) 922-2412; WISCONSIN, Carison Electronics, (414) 476-2790, Electric Component SWest, (206) 885-5880, (509) 922-2412; WISCONSIN, Carison Electronics, (414) 476-2790, Electric Component SWest, (206) 885-5880; ONTARIO, Electro Source, Inc., (416) 675-4490, (613) 726-1452.

World's largest selec

The world's largest, fastest family of FIFOs provides flexible system architecture.

IDT has the FIFO you need for any highspeed application:

Big FIFOs. Use our 256, 512, 1K, 2K or 4Kx9 FIFOs to build larger memory buffers for data storage or networking applications. Using these large FIFOs, you can build incredibly dense buffers without resorting to cascading a multitude of smaller FIFOs which eat up valuable board space and slow down your design.

Small FIFOs. Use our 64x4 & 64x5 FIFOs to build small buffers for a high-speed, tightly coupled computational engine.

Specialty FIFOs. Use our serial/parallel FIFOs for superb data handling flexibility.

Raw speed. All of our FIFOs are the fastest available today and will become even faster in the coming months. Our winning CEMOS™ technology puts you ahead today and tomorrow.

Architectural speed. All of our FIFOs are built with a dual-ported RAM array that gives you zero fall-through time.

Flexible system architecture. Thanks to innovative features like multiple flags and serial shifters.

Introducing the world's largest and fastest serial/parallel FIFOs.

The <u>IDT72104</u> 4Kx9 and <u>IDT72103</u> 2Kx9 FIFOs will compact your serial interface by allowing you to perform serial-toparallel, parallel-to-serial, serial-to-serial and parallel-to-parallel operations without any external circuitry.

Fast 50ns parallel port access time and 40MHz serial input/output rate.

Flexishift^{TM*} logic allows you to set serial word widths to be anything from 4 bits wide to as wide as you need.

Separate serial input/output clocks for true asynchronous operation. Simple depth and width expansion in both serial and parallel modes without any additional logic.

Six status flags, including almost full and empty, indicate well in advance how much data is available — thus giving your system plenty of time to react. The read retransmit capability enables you to resend data — a useful feature for telecommunications and digital filter applications.

These FIFOs give you superb data handling flexibility for serial-parallel data transfer applications such as digitized video and audio, high-speed data links, high-density media storage and local area networks.

Available in 40-pin DIPs and 44-pin LCCs and PLCCs.

Introducing the world's first 4Kx9 and 2Kx9 CMOS FIFOs.

The <u>IDT7204</u> 50ns (access time) 4Kx9 and <u>IDT7203</u> 50ns 2Kx9 are the world's largest FIFOs. Both are pin and functionally compatible with the <u>IDT7202</u> 35ns 1Kx9, the <u>IDT7201</u> 35ns 512x9 and <u>MK4501</u> 512x9 FIFOs. asynchronous and simultaneous read/write — can buffer any data rate, with or without system clock empty, full and half-full flags easily expandable — built-in hooks to make deeper and wider FIFOs without external logic retransmit capability in single device mode 28-pin DIP and 32-pin LCC and PLCC.

Introducing the world's fastest CMOS 64x4/5 FIFOs.

IDT72401/02/03/04 and IDT72413 operate at shift rates up to 35MHz.
I low power CMOS operates at 1/4 bipolar power I zero fall-through time RAM array.

High-density FIFO modules.

We also surface mount four IDT7203 or IDT7204 FIFOs, packaged in LCCs, on a co-fired multilayered ceramic



DIP substrate. The result is two extraordinarily dense, fast, rugged, low-power FIFO modules: <u>IDT7M206</u> 16Kx9 and <u>IDT7M205</u> 8Kx9.

May we be of assistance? Call your local IDT representative or 1-800-IDT-CMOS. Ask for a copy of our Application Note—explaining how to use deep, fast FIFOs and a Product Selector Guide on high-speed CEMOS products.



CEMOS and Flexishift are trademarks of Integrated Device Technology, Inc. *Patent pending.



Integrated Device Technology

3236 Scott Boulevard, Santa Clara, CA 95054-3090 (408) 727-6116 TWX: 910-338-2070

Introducing twelve new CMOS FIFOs
the biggest FIFOs



□ the fastest big FIFOs □ the fastest small CMOS FIFOs □ the only parallel/serial FIFOs.





Standard DIP packages: (a) 28-pin, 600 mil wide plastic DIP Surface mount packages: (b) 32-pin PLCC (c) 44-pin PLCC (d) 20-pin SOIC Space saving packages: (e) 28-pin, 300-mil wide Sidebraze THINDIP

HOW TO END THE OPTICAL ILLUSION



People have been talking about optical drives for years. But have you ever actually seen one work?

Well, now you can. Because while others were talking about optical drives and solutions, Maxtor was developing them. And now we're shipping our 800MB 5¼-inch optical WORM drive in volume.

It's the first in our family of optical drives. And it's perfect for high-volume back-up, image or archival storage.

It's offered with a full complement of integration software and hardware, including media, cable and host adapter. Or it's available as a fully-configured plug-and-play mass storage subsystem.

Either way, it's fully compatible with most popular computers.

So don't wait to make optical drives a reality for your system.

Contact the Maxtor distributor or sales office listed below for complete technical and ordering information.

Because seeing is believing.

Sales offices: Atlanta (404) 455-4226, Austin (512) 345-2742, Boston (617) 872-8556, New Jersey (201) 747-7337, Orange County (714) 472-2344, San Jose (408) 435-7884, Woking, England (44)/4862-29814, Tokyo, Japan 81-3-431-8940. Distributed by Anthem Electronics, (714) 768-4444, (408) 295-4200, (617) 657-5170, Future Electronics, (514) 694-7710, Pioneer Standard Electronics, Inc., (216) 587-3600, (301) 921-0660, Quality Components, Inc., (214) 733-4300, Storex Corporation, (617) 769-3400, Storage Dimensions, Inc., (408) 395-2688. © 1987 Maxtor Corporation

EDITORIAL

The service-economy myth



The economists and consultants who see a service-based economy as the salvation for the US haven't faced reality. It's obvious they haven't taken a car in for servicing, stood in line at a bank, or tried to have an electrician make a house call. There are many reasons why an economy based mainly on services is headed for rough times. Here are several:

Most service jobs offer low pay, little chance for advancement, and few benefits. In fact, some service businesses hire only parttime workers just to avoid paying for benefits that would be available to full-time employees. In short, many service jobs are a dead end. Few customer-service representatives or muffler-replacement workers have the chance to become store managers-and they know it. So, with few benefits and little chance for advancement, service jobs attract just the people who shouldn't be in those positions.

Besides offering few monetary and professional rewards, many companies offer service employees little training, scant motivation, and no sense of mission or importance. Most managers view service people as disposable resources. If these "throwaway" employees don't work out, there are usually others who want the jobs.

There are notable exceptions. A chain of lumber and hardware outlets in the greater Boston area provides employee benefits that include pension and profit-sharing plans. Employees are loval, have low absenteeism, and know the products the company sells. Service people are abundant, helpful, and cheerful, even on Saturday morning.

Unlike a manufacturing endeavor, a small service business is easy to start, so some people view such businesses as an easy way to make money. Unfortunately, those businesses often leave behind distressed customers and much ill will. For example, if after six months the accounting software you got as a bargain from a consultant goes havwire, it may be impossible to locate the programmer or the consultant, despite a contract and guarantees. Because many service businesses require little investment, it's difficult to hold the owners financially responsible for their workor the lack of it. There's little gain in tracking down and suing someone who has limited resources.

Certainly, businesses that manufacture products can have problems, too. However, the potential for poor quality seems higher in service industries. Before we treat service businesses as an economic panacea, let's examine how we're treating service people, how they treat customers, and how we can hold small service businesses accountable to customers.

Jon Titus

Editor

The time and space saving Signetics PLHS501.

Our instant gate array blows away your development bottleneck.

No ifs, AND/ORs or buts!



An "instant gate array" with no "gate-a-risk." The high-speed (t_{PD} = 22ns) Signetics PLHS501 Programmable Random Logic unit blows away your gate array development time. And with it your NRE, inventory problems and quality concerns. It's programmable or reprogrammable within hours—not weeks. And delivered on schedule, fully tested.

No interconnect restrictions. The unique single NAND array architecture of the PLHS501 eliminates the design constraints of AND/OR gates by delivering more utilization of on-chip resources. There are no interconnect restrictions because any NAND gate connects with any other NAND gate.



Third generation single NAND array architecture with NAND foldback paths. The direct internal foldback supports multiple levels of logic without wasting I/O resources or suffering routing channel congestion.

Single-chip space saver. The PLHS501 provides 1300 effective gates—a complete solution on a single 52-pin PLCC package.

Powerful software support. All Signetics Programmable Macro Logic devices, including the PLHS501, are supported by our powerful AMAZE software that makes complex designs easy by simplifying logic entry, simulation and device programming.

Break your bottleneck. When you want your gate array development time blown away in an instant—call Signetics. (800) 227-1817, ext. 978D. Or mail the coupon below for the PLHS501 Development Kit, including a **free sample**. We have only one standard—zero defects. And one goal—customer satisfaction.

One standard.	defects.
Signe	tics
a subsidiary of U.S. Philip	os Corporation

 Please send me the PLHS501 Development Kit Please send me the Signetics Programmable Logic Data Manu Please have a salesperson call me 	EDN 121087
My application is	
Name	
Title	
CompanyPhone()	
Address	
CityStateZip	
Send coupon to: Signetics Corporation, 811 E. Arques Ave., PO. Box 3409, Sunnyvale, CA 94088-3409 Attn: Publication Services, J	M/S 27

© Copyright 1987 Signetics Corporation

First, we cre most innovative des introducing tomo



ated today with the formation of t

into the future. Two years of research, development and strategic planning have culminated in a significant breakthrough in electronic design. Concept 3 is a standard platform from

Sun Microsystems* and a whole lot more. It's a new world of system design capability.

Emerging technologies demand a new set of design solutions. Advances in ASICs, highfrequency components and fine-line design are creating new challenges in engineering, design and manufacturing. A new level of CAE/CAD/CAM sophistication is required to get the job done, and stay competitive. Companies must have even tighter integration between engineering, design and manufacturing, plus open access to all the equipment that's needed to produce a product quickly.

That's why we developed Concept 3, the convergence of advanced design tools and open systems, and more. We've redesigned our tools from the database up, to meet your design future.

Concept 3 is Flexible Field[™] routing and high--frequency design. It's a global data structure designed to handle off-grid components. It's RISC-based simulation acceleration, extraordinary ease-of-use and a seamless data path from schematic to manufactured product.

Concept 3 is also Cadnetix and Sun. Front-to-- back system design on an industry-standard workstation. It's a perfect fit. Both companies have established reputations for delivering advanced technology. Both are committed to open systems

industry standards such as UNIX[®] Ethernet and NFS.™

Now you get ease-of-use, state-of-the-art design, and a UNIX workstation that runs all Sun third--party software. We take full advantage of an open environment, so that Sun Workstations can share





the network with Cadnetix systems and DOS PCs. It's the best balance of cost and performance available. Moreover, every workstation has access to the advanced capabilities of multiprocessor, RISC Engines for accelerated simulation, physical modeling or accelerated 100% routing.

The Cadnetix CAE Sun Workstation is a complete desktop

solution, with tools for schematic creation, analog and digital simulation and ASIC design. The CAD/CAM Sun Workstation includes Cadnetix' industry--famous tools for PCB layout, routing, tooling, assembly and test. Cadnetix front-to-back CAE, CAD and CAM eliminate netlists, data conversions and design to manufacturing hold-

-ups. It's a level of integration unmatched in the industry.

Take a look at Cadnetix Concept 3. Because it isn't enough to solve today's system design problems. You have to be ready for tomorrow's.

Because tomorrow's design problems demand solutions today.

Boulder, CO (303) 444-8075

LFG-1300S 0.002 Hz-2 MHz LBO-518 100-MHz Four Channel Oscilloscope

> LFG-1310 0.01 Hz-10 MHz



Sweep-Function Generators

LEADER

Leader 10-MHz and 2-MHz Sweep-Function Generators are exceptionally durable and versatile. They have every important feature, and every required waveform including: • Sine, square, triangle, sawtooth, ramp, pulse and TTL outputs • 1000:1 and 100:1 ranges • Adjustable waveform symmetry • AM or FM modulation • VCO and GCV • Linear and log sweep • Plus CW, triggered, gate and burst modes (1310 only) • And lots more!

(800) 645-5104

In NY State (516) 231-6900

Request an evaluation unit, our latest Test Instrument Catalog with over 100 outstanding products, the name and address of your nearest "Select" Leader Distributor, or additional information.



380 Oser Avenue Hauppauge, New York 11788 Regional Offices: Chicago, Dallas, Los Angeles, Boston, Atlanta In Canada call Omnitronix Ltd. (514) 337-9500

CIRCLE NO 62

PRODUCT UPDATE

CMOS FIFO memory has 15-nsec access time and two free-running clock inputs



This edge-triggered, latched, expandable, and cascadable FIFO buffer, the MK4505 from Thomson-Mostek, offers a 15-nsec access time.

You can now purchase a clocked $1k \times 5$ -bit FIFO memory with a 40-MHz cycle rate and a 15-nsec access time. The MK4505 has two independent, asynchronous, freerunning clock inputs. These inputs provide automatic read- and writeprotection logic for the device by creating an input stage that's similar to a rising-edge-triggered, D-type flip-flop. The clocked interface eliminates any need for external registers, buffers, or pulse-shaping circuits.

In addition, several status flags warn you when the buffer is full, empty, half-full, almost full, or almost empty. The almost-full and almost-empty flags warn you when only eight bytes remain before the device is completely full or empty. The device also provides Data Ready and Output Valid status flags. The MK4505 latches all the status flags, and it won't change states until it's triggered.

You can order the MK4505 in either master (MK4505M) or slave (MK4505S) versions. You can't read the master when it's empty or write to it when it's full. However, you can force the slave to read and write continuously regardless of the FIFO buffer's status, so you can take advantage of the slave's edge-triggered 3-state output. Further, the MK4505M provides you with all the control necessary for width and depth expansion. You'll need an MK4505M for each 1k bit of depth you add to your FIFO array, and you'll require an MK4505S for each additional 5 bits of width. The practical expansion limit, however, is 40 bits: Beyond that point, you'll encounter drive-capability problems.

Because the MK4505 contains dual-port RAM, the device isn't susceptible to the ripple-through delay times that plague shift-register FIFO buffers. The device's separate read- and write-enable inputs let you enable or disable read and write operations on command in the presence of a continuous periodic clock. Internal read and write address pointers automatically provide the RAM with correct addresses, but data moves only on the rising edge of the clock pulses. If a clock is turned off, the MK4505 latches the previous cycle, regardless of any further input changes. Besides allowing simultaneous read and write activity, the FIFO memory's asynchronous design lets you stop either the read or the write clock without disrupting the other port's activity.

You can use the MK4505 as a digital delay by using one free-running clock and one control clock that has a programmable counter for determining the duration of the delay. The delay can last from two to 1022 cycles. Because of its pipelined architecture, the MK4505 is suitable for use in high-speed data links, fiber-optic circuits, and digitized video/graphics applications.

You can order the MK4505-25, a version with a 25-nsec cycle time and a 15-nsec access time, for \$48.43 (100). A slower version, the MK4505-50, specs a 50-nsec cycle time and a 25-nsec access time; it sells for \$33.67 (100). Both parts come in 300-mil DIPs with TTL-compatible inputs and outputs.

-J D Mosley

Thomson Components-Mostek Corp, 1310 Electronics Dr, Carrollton, TX 75006. Phone (214) 466-6000. TLX 730643.

IF YOU'RE DESIGNING DISK DRIVES AND HAVE ONLY USED OUR READ/WRITE CIRCUITS-THIS CHART IS FOR YOU.

Our Extended Family

If you're designing disk drives, you're probably already familiar with Silicon Systems. Chances are good that you are presently using one or more of Silicon Systems' Read/Write amplifier IC's in your HDD designs. But maybe you don't know that we also offer the industry's most extensive line of mass storage ASIC's.

The adjacent chart illustrates that Silicon Systems can also provide more than a score of circuits for pulse detection, data recovery, head positioning, spindle motor control, and controller electronics. And the list continues to grow.

The Mix-and-Match Design Approach

With Silicon Systems growing families of IC's for all the electronic functions in hard disk drives, many leading HDD designers are finding they can now easily mix-andmatch SSi products to implement their specific design features. This powerful design approach allows them to reduce board area, eliminate external passives, and lower costs by simplifying their designs.



For more information, send for our Disk Drive mailers. **Silicon Systems**, 14351 Myford Road, Tustin, CA 92680.



SSI Device	Numbers	Head Type	# of Channels	Input Noise	input Capaci-	Read Gain	Write Current	Power Supplies	Read/Write Data Port(s)
New	Old			nV/√Hz	tance (pf)	(typ)	Range (mA)		a di dina di anti a
IDD READ/	WRITE AMP	LIFIERS							
32R104B	104	Ferrite	4	2.4	23	35	15 to 45	+ 6V, -4V	Differential, Bi-direction
32RIO4BLN	104L	Ferrite	4	1.7	23	35	15 to 45	+ 6V, -4V	Differential, Bi-direction
32R114	114	Inin Film	245	1.1	65	123	55 to 110	±5V	Differential/Differentia
32R117	117	Ferrite	246	21	23	100	10 to 50	+5V + 12V	Differential/TTI
32R117A	117A	Ferrite	2, 4, 6	1.7	20	100	10 to 50	+ 5V,+ 12V	Differential/TTL
32R188	188	Ferrite	4	2.4	18	43	35 to 70	+ 6V, -5V	Differential, Bi-direction
32R501	501	Ferrite	4, 6, 8	1.5	23	100	10 to 50	+ 5V,+ 12V	Differential/TTL
2R510A	510A	Ferrite	2,4,0	1.5	20	100	10 to 40	+ 5V,+ 12V	Differential/TIL Differential/TIL
2R512	512	Thin Film	8	0.9	32	150	10 to 40	+ 5V,+ 12V	Differential/TTL
32R514	514	Ferrite	2, 4, 6	1.5	20	150	10 to 40	+ 5V,+ 12V	Differential/TTL
32R520	520	Thin Film	4	0.9	65	123	30 to 75	±5V	Differential/Differentia
2R521 2R522	521	Thin Film Thin Film	6 4,6	0.9	65 32	100	20 to 70 6 to 35	+5V,+12V +5V,+12V	Differential/TTL Differential/TTL
SSI Device	Numbers	C	ircuit Funct	tion				Features	
HDD PULSE	DETECTION								
220540	540	Dond Date	Drassage		Time Dom	nin Filter		SIL	
32P540 32P541	540	Read Data	Processor		Time Domain Filter AGC, Amplitude & Time Pulse Qualification, RLL Compatible			Compatible	
HDD DATA	RECOVERY								
32D531	531	Data Sync	hronizer		Data Synchronizer/Write Precompensation				
320532	532	Data Sepa	rator		Data Sync	hronizer	/2, 7 RLL ENDEC	neation	
320533	534	Data Sepa	rator		Data Synchronizer/Write Precompensation			ensation	
32D535	535	Data Sepa	irator		Data Sync	hronizer	/2, 7 RLL ENDEC	/Write Precor	npensation
HDD HEAD	POSITIONIN	G					36. 19		Same and
32H101A	101A	Preamplifi	er-Ferrite He	ad	AV = 93,	BW = 1	$OMHz, e_n = 7.01$	nV/√Hz	
32H116	116	Preamplifi	er-Thin Film	Head	AV = 250	, BW =	$20MHz, e_{\Pi} = 0.$	94nV/√Hz	
32H567	567	Servo Den	troller		Di-bit Quar	drature :	Servo Pattern: PL	L Synchronize	ation
32H569	569	Servo Mot	or Driver		Head Park	ting, Spi	ndle Motor Brakin	ng	menuce
HDD SPIND	LE MOTOR C	ONTROL							
32M590	590	2-Phase M	otor Speed (Control	± 0.035%	Speed	Accuracy; Unipol	lar Operation	
32M591 *32M593	591 593	3-Phase N 3-Phase N	lotor Speed (Control Control	± 0.05% 9 ± 0.037%	Speed A Speed	ccuracy; Unipola Accuracy; Bipola	r Operation	
HDD CONT	ROLLER/INT	ERFACE				1.114			HARRING THE CO
·328450A	450A	SCSI Cont	roller		Async tran	nsfer to :	2MBPS; Initiate/T	arget Modes;	Internal Drivers; CMOS
32C452	452	Storage C	ontroller		20Mbits/sec; CMOS; Programmable; AIC-010 Compatible				compatible
	453 545	Buffer Cor Support Lo	itroller ogic		Non-mux o Includes S	address ST506 B	ing to 16K; CMOS us Drivers/Receiv	s; AIC-300 Co vers	ompatible
320453 328545								A. 1942	
320453 328545	K DRIVE CI	RCUITS							
320453 328545 FLOPPY DIS	SK DRIVE CI	Data Send	rator		High Perfo	rmance	Analog Data Ser	parator NEC	765 Compatible
32C453 32B545 LOPPY DIS 34D441 34P570	570	Data Sepa Read Data	rator Path		High Perfo 2 Channel	Read/V	Analog Data Se Vrite With Read D	parator, NEC Data Path	765 Compatible
32C453 32B545 LOPPY DIS 34D441 34P570 34R575	441 570 575	Data Sepa Read Data Read/Writ	rator I Path e		High Perfo 2 Channel 2, 4 Chann	Read/V	Analog Data Se Vrite With Read D /Write Circuit	parator, NEC Data Path	765 Compatible
320453 328545 LOPPY DIS 34D441 34P570 34R575 34B580	441 570 575 580	Data Sepa Read Data Read/Writ Support La	rator Path e ogic		High Perfo 2 Channel 2, 4 Chanr Port Expar	rmance Read/V nel Read nder, Inc	Analog Data Se Vrite With Read D Vrite Circuit Iudes SA400 Inte	parator, NEC Data Path erface Drivers	765 Compatible s/Receivers
322453 328545 LOPPY DIS 34D441 34P570 34R575 348580 APE DRIVE	441 570 575 580 ER CIRCUITS EXAMPLE EXAMPLE	CUITS Data Sepa Read Data Read/Writ Support La	rator Path e ogic		High Perfo 2 Channel 2, 4 Chanr Port Expar	rmance Read/V nel Read nder, Inc	Analog Data Se Vrite With Read D /Write Circuit Iudes SA400 Inte	parator, NEC Data Path erface Drivers	765 Compatible s/Receivers

MICROPERIPHERAL IC SELECTION CHART

"Where we design to your applications."

PRODUCT UPDATE

High-density ASIC family achieves 100k-cell arrays



Three layers of metal carrying signals and power (labeled M1, M2, and M3) allow the Max HDC100 family of macrocell arrays to use about 75% of the available transistors on arrays with as many as 104,832 8-transistor cells.

By using 1- μ m drawn gate lengths, 1.2- μ m design rules, and three metal layers to route signals and power, the vendor has developed the Max HDC100 family of ASICs, which are CMOS macrocell arrays that encompass as many as 100,000 cells. The largest chip in the family measures only 483 mils per side. In addition, the ASICs feature internal gate speeds of 400 psec (with a fanout of 2) and offer as many as 512 configurable I/O cells.

You can use the vendor's \$7500 Modular Design System software and \$500 HDC library to develop designs for the Max family on a Mentor Graphics workstation. The library contains several hundred macrocell designs, including designs from the company's existing BiMOS and CMOS ASIC libraries, as well as ALUS, UARTS, timers, and several designs equivalent to AMD's 2900 family of bit-slice parts.

You execute the first design phase by developing the schematic and performing functional and timing simulations on the workstation. The vendor then uses the resulting design files to place and route an HDC100 ASIC of suitable size on its DEC VAX 8800. This process takes about two days. Sample parts arrive 12 to 14 weeks after you approve the final chip layout.

Initially, the company plans to offer three members of the Max family: the HDC016, HDC031, and HDC100, which have 16,416, 31,290, and 104,832 cells, respectively. It estimates that nonrecurring engineering (NRE) charges for these arrays will be \$35,000 to \$250,000. Eventually, the vendor plans to offer 10 devices having 5670 to



31311131

MCI INTRODUCES ITS NEW SELF-RESTORING POLYMER FUSE!

Our new Poly Fuse guards against over-current conditions by switching from low resistance to high resistance when its rated current is exceeded. When power is removed, it automatically returns to its low resistance state. This cost-cutting, fool proof, self-restoring component is ideal in applications of 40 volts or less, including motors, solenoids, speakers, alarm systems, battery chargers, communication lines... anywhere older technologies are used now.

PHONE OR WRITE FOR YOUR "FREE ENGINEERING SAMPLE"

MIDWEST COMPONENTS I NC.

PO. Box 787 1981 Port City Blvd. Muskegon, MI 49443 (616) 777-2602 FAX NO. (616) 773-4307



True Grey Shades at High Speeds for Less than \$5000

Raytheon's TDU-850, Thermal Display Unit, produces photo quality images on an 83/4" x 200 ft. roll. The TDU-850 prints 16 shades of grey in less than 20 milliseconds per line; black and white images at 5 milliseconds per line. Price per unit from \$4950, depending on interface and application. (Slightly higher overseas). Discounts for OEM large volume quantities. Fixed thermal head assures perfect registration. Resolution better than 200 dots/inch. Direct thermal technology requires no toners or developers. Standard or custom interfacing. For details, contact Marketing Department, Raytheon Ocean Systems Company, 1847 West Main Rd., Portsmouth, RI 02871 Telephone (401) 847-8000 Telex 092 7787

Raytheon

CIRCLE NO 8

DID YOU KNOW?

EDN is distributed at every major electronics/computer show in the U.S., France, and Germany.



UPDATE

104,832 cells. Part costs range from about \$37 for the 16k-cell array in a plastic quad flat pack to approximately \$624 for a 100k-cell array in a multilayer, ceramic pin-grid array. Because it uses all three metal layers for both signal and power traces, the company believes that it can achieve an average cell utilization of 75% on the channelless array.

These three initial offerings also incorporate 136, 180, and 300 I/O cells, respectively, for devices placed in packages that require wire bonding, and 204, 280, and 512 I/O cells, respectively, for devices put in TAB (tape-automated bonding) packages. You can configure each I/O cell to be an input; an output driver with 2-, 4-, or 8-mA source and sink capability; or a bidirectional I/O pin. Although 512 I/O cells may seem like a very large number, the company points out that these cells have additional applications. You can gang as many as six cells to create a 48-mA (source and sink) I/O driver, and you can use an I/O cell as an internal buffer for heavily loaded signals such as a clock line.

The Max arrays feature an 8-transistor primary cell. You can construct gates or bits of ROM and RAM with each cell. A bit of RAM requires six transistors; a bit of ROM requires only a single transistor. The memory achieves a 10-nsec access time for blocks having less than 1k bits and a 30-nsec access time for blocks with as many as 32k bits. You can merge bits of RAM and ROM in a primary cell; one cell can be used to build a RAM bit and two bits of ROM or as many as eight ROM bits. This interleaving scheme also allows memory-address decoders and drivers to perform double duty by simultaneously driving both RAM and ROM arrays.

-Steven H Leibson

Motorola Inc, Box 52073, Phoenix, AZ 85072. Phone (602) 821-4426.

Circle No 727

WE TAUGHT THE WORLD TO DRIVE WITH OUR FULL-SIZE MODELS.



FREE Demo Disk DSP Software Call 404-892-7265

DIGITAL FILTER DESIGN PACKAGE DFDP2

for your IBM PC, XT, AT or compatible & IBM's **NEW PS/2** machines priced from \$1,195

DFDP2 designs FIR and IIR filters with Code Generation (CGENS) for Texas Instruments TMS320 family

NEW Code Generators for AT&T's DSP32 and DSP32C

TWO NEW BOARDS

Algorithm Development Packages for



for your IBM PC, XT, AT or compatible



Atlanta Signal Processors, Inc. 770 Spring St., Atlanta, GA 30308

PRODUCT UPDATE

Internal 19,200-bps modem speeds PC communications

Permitting a range of communication speeds from 300 to 19,200 bps on a single IBM PC-compatible plug-in expansion card, the PC-Race 24/96 internal PC modem provides error correction, autodial, auto-answer, and full-duplex operation. The modem is compatible with the Hayes AT command set as well as with the manufacturer's extended communication commands.

The PC-Race 24/96 costs \$995. If you need only CCITT V.22 compatibility for 300-, 1200-, and 2400-bps communication, you can purchase the PC-Race 24 for \$595. If you want faster speeds and don't need V.22 compatibility, you can buy the \$795 PC-Race 96, which gives you 9600-bps communication and a 19,200-bps BMX file-transfer mode.

Because of the modem's modular design, you can begin with the PC-Race 24 card and upgrade to a PC-Race 24/96 by plugging in a daughter card. Similarly, if you begin with the PC-Race 96 and decide later to add V.22 compatibility, you can plug in a daughter card to do just that.

Each version includes built-in error correction, which reduces data-transmission overhead between your PC and host computers by eliminating any need for special error-protection protocols. For PCto-PC and PC-to-host communication over standard phone lines, you can use popular MS-DOS communication software such as Crosstalk, Carbon Copy, and Mirror.

The PC-Race 96 uses full-duplex asymmetrical frequency division to divide the voice telephone band into a high-speed, wideband CPU-toscreen channel and a slow-speed, narrowband keyboard-to-CPU operator input channel. It achieves 9600bps operation over dial-up lines. If



The modular construction of the PC-Race modem card from Data Race lets you upgrade your PC's file-transfer speed from 2400 bps to 19,200 bps by plugging a daughter board into the vendor's basic, PC-compatible expansion card.

the receiving modem is another Data Race high-speed modem, the company's proprietary data-compression algorithm lets the two computers communicate at file-transfer rates reaching 19,200 bps, with error protection and EIA or X-On/ X-Off flow control. This modem also accepts half-duplex, block-mode file transfers.

An internal speaker with external volume control lets you monitor the progress of your data transfer. The board interfaces with your IBM PC or compatible computer via a COM1 or COM2 bus assignment; COM3 and COM4 bus assignments are available by special order.

-J D Mosley

Data Race Inc, 12758 Cimarron Path, Suite 108, San Antonio, TX 78249. Phone (512) 692-3909.

Circle No 730

OUR COMPACTS HAVE SOLD MILLIONS.

CIRCLE NO 60



Tauber and Kodak. For the World's 1st 9-volt Lithium Power Cell.

Introducing the new Kodak Ultralife 9-volt lithium power cell. It lasts 200% as long as high performance alkaline batteries. Because it loses less than 2% of its service capacity a year when not in use, it has a shelf life of up to 10

years. Its longer life, consistent discharge qualities, dependability, and performance make it very cost effective. Call today to learn more.



TAUBERELECTRONICS

4901 Morena Blvd, ste. 314 San Diego, CA 92117 **619/274-7242 FAX 619/274-2220**; LA 213/416-9000 OC 714/667-0177; N CA 408/737-9408

CIRCLE NO 9



PRODUCT UPDATE

ASIC verification tester has 100-MHz clock and data rates

The Logic Master XL100 allows you to perform verification testing of devices at 100-MHz clock and data rates. Testing devices at these speeds requires more than just fast clock rates, however. You need to be able to place timing edges accurately in order to test timing margins. The XL100 can place timing edges with 100-psec resolution; the manufacturer claims that a calibration routine keeps the channel-to-channel skew levels within ± 1 nsec.

It's also important for ASIC verification testers to provide a flexible environment for developing test programs. You need to be able to make test-program modifications quickly without being constrained by the test system's hardware. The XL100 uses a shared-resource architecture that gives you four drivehigh voltage levels (-0.8 to +5.5 V), four drive-low levels (-2 to +3.5V), and four compare levels (-2 to)+5V). The XL100 also provides 12 timing sets that support two edges each. The resources are not constrained by channel; in other words, any or all of the channels can select a particular time set, drive level, and so on.

The modular design of the XL100 supports as many as 224 I/O channels or any combination of input and output channels to a maximum of 448. Each channel has 16k bits of drive-pattern memory and 16k bits of response memory. An optional dc parametric measurement system is available.

To help you develop test programs, the vendor provides software that converts the functional and timing data from your ASIC simulation into pattern-generation and expected-response data for the XL100. When you're ready to begin



Providing as many as 224 I/O channels, the Logic Master XL100 ASIC verification tester —from Mentor Graphics' recently acquired Integrated Measurement Systems Div—can operate at 100-MHz clock and data rates.

production of your ASICs, you can use the vendor's software to convert the test vectors you've generated into a format that's compatible with production testers.

The XL100 uses 6000-gate ECL arrays to perform timing generation and formatting. The channel drivers and receivers of the XL100 are implemented with linear arrays. A typical system with 128 I/O pins costs about \$250,000. Delivery is 12 weeks.—*Doug Conner*

Mentor Graphics Corp, Integrated Measurement Systems Div, 9525 SW Gemini Dr, Beaverton, OR 97005. Phone (503) 626-7117.

Circle No 728

NOW YOU CAN DRIVE OUR SUBCOMPACTS.

Seagate's family of $3^{1/2}$ " hard disc drives.

As computers grow smaller, the demand for high-quality drives grows larger. But if you're looking for $3\frac{1}{2}$ " drives for your small computer systems, you don't have a lot to choose from.

Except at Seagate. We offer six 3¹/₂" drives with 21, 32 and 48 MB formatted capacities. You also have a choice of interfaces: SCSI or ST412 with RLL or MFM encoding. All with 28 msec access time.

Our 3¹/₂" drives use Seagate's field-proven, proprietary stepper motors to achieve fast access times normally found only with more expensive voice coil actuators.

Seagate's 31/2" drives are not only fast -they're power savers, using as little as 8 watts. And for added data integrity, the drives feature autopark with a balanced positioner. All of Seagate's 31/2" drives are built with the precision and quality that have made us the world's leading independent manufacturer of 51/4" full-height and half-height hard disc drives. Only Seagate has the worldwide, high-volume manufacturing efficiency to meet the growing demand for

3¹/₂" drives. Once you evaluate Seagate's subcompacts, you'll be ready to go for a little drive. Call us today. 800-468-DISC.





CIRCLE NO 61

MILITARY 16-BIT A/D's FIRST IN THEIR CLASS

MIL-STD-1772 CERTIFIED MN5295/MN5290 & MN6290

High Speed:

MN5295: 17μsec Max. Conversion Time MN5290: 40μsec Max. Conversion Time MN6290: 20kHz Min. Sampling Rate
Small 32-Pin Double-Wide DIP
14-Bit "No Missing Codes" – 55°C to + 125°C Operation
MIL-STD-883 Screening

In the two speed classes of 16-bit A/D's that have emerged, only one supplier designs its devices to meet all of your military and aerospace requirements: Micro Networks.

In the high-speed (15-20 μ sec) class, our MN5295/96 are the fastest (17 μ sec), smallest (by 31%), and only devices to offer - 55°C to + 125°C operation and MIL-STD-883 screening.



In the general-purpose (40-50µsec) class, our MN5290/91 offer these same advantages; while our MN6290/91 add an internal T/H, plus FFT testing for improved performance, ease of specification, and significant space savings.

And most critical to your designs, these are the only devices that operate over the extended military temperature range with full military screening.

MN5295/MN5296

The newest in our expanding line of highperformance, military, 16-bit A/D's are at the top of their class.

Fastest Conversion Time: 17µsec Max. (16 Bits) Smallest Package by 31%: Double vs. Triple DIP Widest Temperature Range: -55°C to +125°C Only Devices Available with 883 Screening

In the top speed class, our MN5295/96 excel, providing outstanding 16-bit performance in a DIP package that is fully 31% smaller than any competitor's. No other supplier can meet your requirements for high-speed, highresolution, military A/D's. When your design demands the best, demand Micro Networks MN5295/96.

MN5290/MN5291

They're the best in their speed class of workhorse 16-bit A/D's. Specify them for all your applications that don't require the added performance of our MN5295/96.

Fastest Conversion Time in Their Class: 40µsec Max. Smallest Package by 31%: Double vs. Triple DIP Widest Temperature Range: -55°C to +125°C Only Devices Available with 883 Screening

Like our MN5295/96, our MN5290/91 A/D's are ideal for any design where you need *true* 14 or 13-bit performance over an extended temperature range. These devices were the first 16-bit military A/D's. Since their introduction, their broad acceptance and proven performance have made them industry standards.

MN6290/MN6291

In a class by themselves, these FFT-tested sampling A/D's are ideal for traditional data acquisition and DSP applications.

Single Package Sampling A/D High Resolution/Sampling Rate: 16 Bits @ 20kHz Signal-to-Noise Ratio: 84dB Harmonics: - 88dB Temperature Range: - 55°C to + 125°C Available with MIL-STD-883 Screening



These devices eliminate the hassle of evaluating T/H specs that are difficult to understand and often don't relate.

For more detailed information, send for our comprehensive data sheets. For rapid response, call Russ Mullet at Ext. 208.

Micro Networks 324 Clark Street Worcester, Massachusetts 01606 (617) 852-5400

Micro Networks Advancing Data Conversion Technology



Regional Sales Offices: Worcester, MA (617) 852-5400; Dallas, TX (214) 991-8566; Santa Ana, CA (714) 261-5044.

CIRCLE NO 58

Your next destination:


The ACL Computer Age.

The future belongs to computers and peripherals built with RCA Advanced CMOS Logic (ACL).

The pressure is on to make your systems smaller, faster, cheaper.

Some of your competitors are doing just that by incorporating ACL into their new designs. If you want to stay on the fast track, you can't afford not to consider ACL for your new designs.

The computer of the future.

Imagine a computer with power dissipation so low you could eliminate all cooling systems. Or design a sealed system to prevent dust problems.

And get dramatically improved reliability, thanks to the far lower heat generated. As well as far smaller system size.

You'd also be able to use it in a far wider operating temperature range (-55°C to +125°C). Even in high-noise environments.

FAST* speed, CMOS benefits.

Advanced CMOS Logic gives you high speed (less than 3ns propagation delay with our AC00 NAND gate) and 24 mA output drive current.

But unlike FAST, it gives you a whole new world of design opportunity for computers, peripherals, telecommunications and other speed-intensive applications.

ACL dissipates less than 1/8 Watt while switching, compared to 1/2 Watt for a FAST IC (octal transceiver operating at 5 MHz). And quiescent power savings are even more dramatic: ACL idles at a small fraction of the power of a FAST IC. In addition, ACL offers balanced propagation delay, superior input characteristics, improved output source current, low ground bounce and a wider operating supply voltage range.

Latch-up and ESD protection, too.

Latch-up concern is virtually eliminated, because ACL uses a thin epitaxial layer which effectively shorts the parasitic PNP transistor responsible for SCR latch-up.

And a dual diode input/output circuit provides ESD protection in excess of 2KV.

A broad and growing product line.

Our line already includes over 100 of the most popular types (SSI, MSI and LSI). More are coming soon. And many are available in High-Rel versions.

All this at FAST prices.

Our ACL line is priced comparably to FAST. So you get better performance at no extra cost. Why wait, when your competition is very likely designing its first generation of ACL products right now?

Get into the passing lane, with RCA ACL from the CMOS leader: GE Solid State. Free test evaluation kits are available for qualified users. Kits must be requested on your company letterhead. Write: GE Solid State, Box 2900, Somerville, NJ 08876.

For more information, call toll-free 800-443-7364, extension 24. Or contact your local GE Solid State sales office or distributor.

*FAST is a trademark of Fairchild Semiconductor Corp.

In Europe, call: Brussels, (02) 246-21-11; Paris, (1) 39-46-57-99; London, (276) 68-59-11; Milano, (2) 82-291; Munich, (089) 63813-0; Stockholm (08) 793-9500.



GE/RCA/Intersil Semiconductors

These three leading brands are now one leading-edge company. Together, we have the resources — and the commitment to help you conquer new worlds.

"Sierra's new power supplies got VDE."































"Should they really be talking about something like that in an ad?"

Why not?! From 45 to 500 watts, every open frame switching power supply in our new wide line meets VDE 0806 for safety. And all have a TUV logo on the side to show they've been approved to these precise VDE standards; not "designed to meet." Of course, none of this should surprise you. After all, every switcher we've introduced since 1983 meets VDE.

In addition, these power supplies all meet VDE 0871, Level A for conducted noise. Some even meet the more stringent Level B requirement, including the new "10 to 120KHz" standard.

Oh, since we got VDE, we figured we ought to get approvals for UL and CSA plus conform to FCC, IEC and other international regulatory agencies as well.

So if your product needs a power supply PDQ that meets VDE, UL, CSA, ETC., call ASAP. Sierra Power Systems (formerly Sierracin), 6275 Nancy Ridge Drive, San Diego, CA 92121. Call toll-free (800) 423-5569. In California, (619) 458-1471.

CIRCLE NO 92



READERS' CHOICE

Of all the new products covered in EDN's October 1, 1987, issue, the ones reprinted here generated the most reader requests for additional information. If you missed them the first time, find out what makes them special: Just circle the appropriate numbers on the Information Retrieval Service card, or refer to the indicated pages in our October 1, 1987, issue.



▲ ANALOG I/O PORT

The AD7569 combines an 8-bit A/D converter, an 8-bit D/A converter, a track/hold amplifier, a buffer amplifier, and a 1.25V bandgap reference on a monolithic chip that includes both CMOS and bipolar transistors (pg 212). Analog Devices Inc. Circle No 601

PROJECT PLANNER

Project:Vision Level 2 is an enhanced version of the vendor's project-planning software package, which runs on IBM PCs and compatible computers (pg 232). Inmax Corp. Circle No 605



▲ HANDHELD SCOPE

The Scout SC01 is a handheld, multipurpose instrument that functions as a digital oscilloscope, a frequency counter, and a dual-channel DMM (pg 226).

Dolch American Instruments Inc. Circle No 604



◄ POWER MOSFETs

Designed for high-voltage applications, these power MOSFETs are available in TO-3 and TO-3P packages and have continuous-current ratings to 8.1A (pg 206). International Rectifier. Circle No 603

GRAPHICS ADAPTER

The VGA Extra is a plug-in board for the IBM PS/2 Model 30 as well as the IBM PC, PC/XT, and PC/AT. The adapter is compatible with all the modes of IBM's Video Graphics Array (VGA) standard (pg 216). STB Systems Inc.

Circle No 602



Metamorphosis

DSP designs take wing using new C program from Motorola, convert 320 software to powerful 56001 source code.

Now the power and efficiency of the DSP56001 can be incorporated into your designs without the cost or delay of rewriting outdated 32010 software. Motorola's new DSP320to56001 Translator Software opens new worlds by simply and inexpensively converting any 32010 code into 56001 source code. Now your DSP designs can truly stretch their wings while you save thousands of dollars worth of programmer hours.

Reach new heights in performance.

The DSP56001 is far more than a general-purpose Digital Signal Processor (DSP); it's a high-performance, fourth generation DSP that was created for speed and versatility. Built with Motorola's proven HCMOS technology, the DSP56001 features 512 words of fullspeed on-chip Program RAM (PRAM), 512 words of on-chip data RAM, two preprogrammed data ROMs, and special on-chip bootstrap hardware that permits easy dynamic loading of user programs into the Program RAM.

Motorola's '56001 leads the way in DSP technology. Not having to program ROM makes it an off-the-shelf item able to realize quick program development at low cost. The unusually large assortment of on-chip, MCU-style peripheral functions, and the memory expansion port, gives the '56001 a level of versatility its competitors only dream about.

Using the DSP56001, customers can do development work more easily, facilitate their speed-

critical programs onchip for real time performance, and

realize the full power of DSP without the expense and delay of ROM mask patterns. These features make the '56001 perfect for many applications in communications, speech, imaging, audio, computers, instrumentation, and highspeed controls.



Convert with ease.

The DSP320to56001 translator will convert any 32010 applications software into the '56001 source code that's necessary to utilize the industry's most advanced DSP technology. Using an IBM-PC with MS-DOS or PC-DOS you can translate to '56001 source code for potential optimization and assembly with the DSP56000SASMA or DSP56000CLASA software, without the expense and delay of rewriting old codes manually.

32010 code can also be run "as is" directly and immediately on Motorola's DSP560001 Applications Development System (DSP56000ADS) to speed and facilitate the designing of real-time DSP56001 signal processing systems.

A translator that works with you.

The one double-sided, double-density, 5¼ inch diskette includes not only the PC object code but also the C source code for the DSP320to56001 program. With it, users can modify the software for 32020 and 320C25 translations. A registration card is also provided so that users can obtain future, optimized versions of DSP320to56001 software, hand-coded macro routines, and other pertinent updates and information.

One-on-one design-in help.

Get an engineer-to-engineer update on the newest Motorola Digital Signal Processor technology.



Call toll-free any weekday between 8:00 a.m. and 4:30 p.m., MST, from anywhere in the U.S. or Canada. If the call can't answer your needs we'll have a local DSP specialist contact you.

For published data on Motorola's newest DSP technology, send in the completed coupon below.

Were
pnyour
design-in
icalli.



	To: Motorola Semiconductor Products, Inc. P.O. Box 20912, Phoenix, AZ 85036
NOTOROJA MILITOR	Please send me more information on Motorola's newest DSP technology.
DSP320to56601 Software Sommary DSP320to56601 Translator Software	Name
An EPRIAdded is notice and approximately and approximately a	Title
Charact state of GGF Underland, syngam is protein an ideality	Company
MOTORICLA DSP DEVELOPMENT SOFTWARE 30915 TO 560001 CODE CONVERSION	
The consistence dependences we define each of the display which, and display density 3.1.4 mars, for pay with and mark the form of here of the a finding data as a faund data. These because their enough data tapees in fault the deput of the constant futures films.	Address
The entropy to define a supervision to the accession program into MR PC, IF, AF, or provide our 2005 been of field and out \$1 of our from data from MR PC and all of 12 of our new	
The INFREED Application Divergence's Source (2019)(2004)(2) is resonanced as a new spinner too for despining our over (2019)(2011) spine promoting scatters	
We are approximately a first state for the first state of the state of	City State Zip
	Call me ()

Mega DRAMs. Mega options.

11111

M511000-10 OKI JAPAN 7442 NANALAAAAA

M211000-10 OKI JAPAN 1442

OKIJAPAN M514256-10

1111 1111 1111

772110

72010

1111

.....

1111

.....

Fast access from **OKI**: **CMOS 1 Meg DRAMs** in great working shape.

Maintaining a leading edge in CMOS technology and packaging. OKI meets your fast DRAM specs with unique flexibility.

Anyway you look at it, OKI's fast-track CMOS knowhow has got the one megabit DRAM shaped up to go. Now. No matter how demanding your parameters may be in performance or packaging, it's easy to work it out with OKI.

Need super high speeds? Tell us to jump, and all we ask is "how fast?" OKI is shipping megabit Dynamic RAMs stripped down to 85ns. (With 80ns on the way....and 60ns not far behind!)

Organization options? OKI offers both $1 \text{ Meg} \times 1$ and $256 \text{K} \times 4 \text{ single-chip DRAMs}$. Both from the same die. To cut qualification time and expense, we built a bonding option into our basic chip design. Qualify one die, and you've got every OKI option covered!

ſ		1M×1	Fast Page Mode	M511000
		1M×1	Nibble Mode	M511001
		1M×1	Static Column Mode	M511002
		256K × 4	Fast Page Mode	M514256
l		256K × 4	Static Column Mode	M514258

Want more space-saving package solutions? OKI maintains a high profile

SEMICONDUCTOR

CIRCLE NO 101

about any real estate

enhancements have been

through upcoming DRAM generations: from 1-mega-

developed to carry you

bit to the 4- and even

16-megabit memories.

problem. Today and tomorrow. OKI package

Need a tidier single chip than the DIP? Ask us about the new SOJ package that provides the megabit DRAM in J-lead surface mount. Or, get still more compactness with the OKI ZIP package's very narrow profile.

Also turning space problems on end: OKI's SIMM packages load 9 to 18 SIMM megabits onto a single easy-to-use module. An instant surface mount capability that packs up to

18 million bits into half the conventional space. And OKI's highly-automated production capabilities will be consolidating DRAMs in a TAB package too.

Mega DRAMs. Mega CMOS options.

OKI wouldn't have it any other way. Why should you?

in low profile memories — a complete range of package options to handle just Get a Byte of DRAM

	0-
EEE	01
	01

EDN 121087 ily from

State

Zip

ZIP

Limited Time Offer: To help you work up your DRAM specs, OKI offers you a BYTE with parity of 1 Meg \times 1 CMOS DRAMs (9 plastic DIPs, fast page mode, 120ns) for only \$186.00 per Byte Kit.

Please send Kits containing a Byte of 1 Megabit CMOS DRAMs. Price per Kit is \$186.00, plus \$3.00 for shipping/handling: \$189.00 Total/Kit, sales tax included. Offer limited to 3 Kits per customer.

for only \$186.00!

Check or money order for \$ enclosed. (Sorry, no company purchase orders please.)

Send complete data on OKI Megabit DRAMS.

Sunnyvale, CA 94086. (408) 720-1900. Offer limited to 3 Kits per customer and expires December 31, 1987. Available only for USA & Canada shipment.

Return to: Customer Service,

Name/Title

Company

Address

City

Tel: (



OKI-108-787

Sometimes, keeping a low profile pays off.

The survival of today's combat helicopter depends on keeping a low profile. Abbott's BC100 triple output, switching DC-DC converter helps the Lynx helicopter achieve this low profile.

The BC100's low 1.875" profile allowed 100 watts to fit into a tight space requirement. At the same time, the Lynx helicopter was able to take advantage of



the economy and reliability that come from using a standard product, the BC100.

Because the BC100 meets the requirements of MIL-STD-810C, and MIL-S-901C, the Lynx program's decision to go with Abbott's BC100 will also pay off in extra survivability. Plus the BC100 features low ripple/noise and EMI within the limits of MIL-STD-461B.

For other applications that call for small yet powerful converters, Abbott offers both 100 and 200 watt models. Each available in single and triple configurations. And all with a wide array of options available.



For more information and a copy of our 1988 Military Power Supply Product Guide, call or write today.

Abbott Transistor Laboratories, Inc. Power Supply Division, 2721 S. La Cienega Blvd., Los Angeles, CA 90034 (213) 936-8185. Eastern Office: (201) 461-4411, Southwest Office: (214) 437-0697, London Office: 0737-82-3273.

WHEN RELIABILITY IS IMPERATIVE®



LEADTIME INDEX

Percentage of respondents

ITEM



ITEM	4	S.	5	5	ŝ	5	9.	0.0
TRANSFORMERS Toroidal	7	29	28	36	0	0	8.7	8.6
Pot-Core	8	25	25	34	8	0	10.0	9.7
Laminate (power)	5	37	32	26	0	0	7.7	9.2
CONNECTOR	1.1							
CONNECTORS	0	20	20	20	14	0	11.0	0.0
Flat/Cablo	12	50	29	12	14	0	11.Z	9.9
Multi-pip circular	0	36	20	97	0	0	9.4	5.0
PC (2-niece)	17	12	25	16	0	0	5.8	5.8
BE/Coavial	11	58	20	10	0	0	51	5.6
Socket	39	38	15	8	0	0	36	4.1
Terminal blocks	27	41	23	9	0	0	4.5	43
Edge card	11	39	33	17	0	0	64	70
D-Subminiature	29	38	24	9	0	0	45	64
Back & nanel	0	46	31	23	0	0	74	89
Power	21	21	29	29	0	0	74	57
						-		
PRINTED CIRCUIT BO	DARDS	40	36	12	0	0	5.9	5.3
Double-sided	6	29	53	12	0	0	6.9	7.0
Multi-layer	5	20	60	15	0	0	7.7	9.3
Prototype	7	70	19	4	0	0	4.2	4.1
RESISTORS	1							
Carbon film	45	26	26	3	0	0	3.3	3.7
Carbon composition	35	17	39	9	0	0	5.0	3.3
Metal film	35	23	38	4	0	0	4.4	4.1
Metal oxide	33	17	44	6	0	0	4.9	6.0
Wirewound	21	29	38	12	0	0	5.8	7.2
Potentiometers	21	36	36	7	0	0	5.0	4.5
Networks	27	27	31	15	0	0	5.7	6.3
FUSES	42	29	21	8	0	0	38	42
CIMITOLIEC						-	0.0	
Pushutton	28	32	32	8	0	0	18	64
Posibulion	11	53	26	10	0	0	5.3	6.2
Bocker	28	28	33	11	0	0	52	64
Thumbwheel	12	44	25	19	0	0	6.2	9.3
Snap action	19	43	29	9	0	0	5.0	7.0
Momentary	11	33	45	11	0	0	6.3	7.1
Dual in-line	0	57	29	14	0	0	6.2	6.9
WIRE AND CARLE				-				
Coaxial	36	40	16	8	0	0	3.7	4.3
Flat ribbon	44	30	17	9	0	0	3.7	5.1
Multiconductor	25	45	20	10	0	0	4.5	6.2
Hookup	41	29	26	4	0	0	3.5	2.8
Wire wrap	31	31	31	7	0	0	4.4	2.3
Power cords	25	42	21	12	0	0	4.9	6.0
POWER SUPPLIES								
Switcher	15	15	39	31	0	0	8.3	6.2
Linear	7	36	29	28	0	0	7.8	6.7
CIRCUIT BREAKERS	15	40	15	30	0	0	7.1	5.6
HEAT SINKS	20	37	17	17	0	0	50	19
RELAYS	29	3/	1/	1/	0	0	3.0	4.8
General purpose	23	32	32	13	0	0	5.6	4.4

23

27

0 0 6.9 7.7

27

23



RELAYS								
Dry reed	12	38	25	25	0	0	7.0	8.0
Mercury	0	33	34	33	0	0	8.8	7.5
Solid state	7	21	36	36	0	0	9.0	7.5
DISCRETE SEMICONE	DUCTO	ORS						
Diode	36	25	22	17	0	0	5.1	4.8
Zener	32	32	18	14	4	0	5.5	5.4
Thyristor	18	18	35	29	0	0	7.9	8.0
Small signal transistor	29	28	24	19	0	0	5.7	7.5
MOSFET	14	29	9	48	0	0	9.0	7.9
Power, bipolar	6	38	25	31	0	0	8.0	8.4
		CITAI						
Advanced CMOS	4	39	35	22	0	0	73	84
CMOS	14	39	25	22	0	0	65	6.4
TTI	20	40	20	20	0	0	59	60
IS	20	48	16	16	0	0	5.2	61
			10	10	0	0	0.2	0.1
Communication/Circuit	5 , LI	A0	27	33	0	0	85	82
OP amplifier	16	20	27	24	0	0	71	70
Veltaga regulator	20	20	00	16	0	0	7.1	7.9
voltage regulator	20	30	20	10	0	0	0.0	0.C
MEMORY CIRCUITS								
RAM 16k	15	54	31	0	0	0	4.1	7.7
RAM 64k	18	27	37	18	0	0	6.5	7.1
RAM 256k	27	13	40	20	0	0	6.7	8.7
RAM 1M-bit	0	21	29	43	0	7	11.8	10.0
ROM/PROM	0	39	39	22	0	0	7.7	7.1
EPROM 64k	20	20	45	15	0	0	6.5	7.7
EPROM 256k	16	16	47	21	0	0	7.5	8.8
EPROM 1M-bit	0	8	54	38	0	0	10.5	8.3
EEPROM 16k	8	23	38	31	0	0	8.5	8.5
EEPROM 64k	7	20	47	26	0	0	8.5	8.0
DISPLAYS								
Panel meters	14	38	29	19	0	0	6.4	9.9
Fluorescent	0	27	36	37	0	0	9.4	12.5
Incandescent	7	43	29	21	0	0	6.9	8.6
LED	21	38	29	12	0	0	5.4	7.5
Liquid crystal	0	25	50	25	0	0	8.6	9.7
MICROPROCESSOR	Cs							
8-bit	12	29	42	17	0	0	6.8	6.8
16-bit	12	38	25	25	0	0	7.0	8.3
32-bit	12	19	19	50	0	0	9.8	12.5
FUNCTION PACKAGE	2							
Amplifier	8	23	46	23	0	0	80	94
Converter, analog to digital	12	19	44	25	0	0	79	93
Converter, digital to analog	7	21	50	22	0	0	80	86
							0.0	0.0
LINE FILIERS	15	23	39	23	0	0	7.3	7.9
CAPACITORS								
Ceramic monolithic	25	32	25	18	0	0	5.7	4.8
Ceramic disc	33	15	37	15	0	0	5.7	4.7
Film	29	21	33	17	0	0	5.9	5.0
Aluminum electrolytic	26	26	19	26	3	0	7.1	5.5
Tantalum	19	32	26	20	3	0	6.9	5.6
INDUCTORS								

15

PC board

40 25 20 0 0 6.3 6.3



for who

Not only do we know who it's for, we know who's calling and what the message is. That's because an NCR 286 CPU board is at the heart of an innovative new voice mail system. Handling the calls for as many as a thousand users, sixteen at a time. All in a single personal computer chassis. And the next call we take may be for you.

the bell The message we want to leave you here, of course, is that NCR PC technology is at work in many places beyond accounting and data processing. Like manufacturing control systems in factories everywhere. Diagnostic imaging equipment in clinics and hospitals. Even a new CD ROM jukebox at play in record stores.

What's behind this frenzy of applications activity?

A SMART FOUNDATION TO BUILD ON.

We know For some it's the versatility of split board architecture. For others it's the compact size and low power requirements of VLSI and surface mount technology. But for everyone it's the way we configure the pieces to meet the specific demands of the application. Without chewing up the calendar or your budget in the process.

> In short, we're easy to work with. Because we have the engineering knowhow and the manufacturing can-do to deliver the goods. Without hitches, without surprises, and without fail.

tolls So, as you look into developing new products, or improving your existing ones, look into NCR. For more details about how NCR PC technol-

nology can fit into your plans, call us at (513) 445-0670. Our response is sure to ring your chimes.

CIRCLE NO 94



NCR Corporation Personal Computer Division OEM/Technology Sales Dayton, Ohio 45479

Hot news from Calma.

Now you can layout in the Sun.



You can also layout with Apollo.[®] And on the DEC.[®]* With complete access to GDS II.[™]

Introducing the EDS III[™] IC Design System.

GE Calma's new Electronic Design System puts the automated IC design tools you need onto the industry's hottest platforms. Without sacrificing control or your investment in GDS II.

You see, we've linked the most popular engineering workstations to the GDS II library. So you can retrieve and work on any existing design.

Or create entirely new designs in such modern, easyto-use environments as Sun,^{*} Apollo and MicroVAX.[™]

Visit your GDS II library anytime.

EDS III provides a direct

CAE

library-level interface to any GDS II design on the network.

Just give the "OPENLIB." command and the GDS II library you want will appear on your workstation.Without going through time-consuming STREAM^{*}-level conversions.

Then make changes using the advanced EDS III features, including an upcoming high-level, GPL⁻compatible user programming language. You'll cut design time while making the most of your GDS II library and its powerful capacity for GaAs, hybrids and mixed analog/digital design.

And as upgrades for GDS II are released, EDS III will still be your standard platform access.

Route any block and cell automatically.

You can save more time by routing standard cells and blocks of all shapes and sizes automatically. And you have the same capability with standard cell placement and floor planning.

But even though the system is automated, you're still in charge. With control of die size, power and ground distribution, and placement. And you can document



your design as you go along. What's more, you can

customize the EDS III interface to fit your needs. Whether you prefer the latest pulldown menus and windows in EDS III, the familiar GDS II menus or your own personal setup.

And because EDS III is open, you can take advantage of database access routines to integrate your own tools.



Now everyone shines.

With design tracking that automatically reflects any change throughout the system,

EDS III keeps everyone on your design team informed. And you in complete control. No matter how many revisions are made.



For more hot news, call our hot line.

So if you're interested in connecting your industry standard workstations with the industry standard CAD system, ask for our free brochure. Call us at 1-800-GE-CALMA, ext. 430.

And start getting some Sun. *Apollo and MicroVAX platforms available early 1988.



and the second second

© 1987 Calma Company, EDS III, GDS II, STREAM and GPL are trademarks of Calma Company. Apollo is a registered trademark of Apollo Computer Company, DEC and MicroVAX are trademarks of Digital Equipment Corporation. Sun and the Sun logo are registered trademarks of Sun Microsystems, Inc.

NATIONAL ELECTRONIC PACKAGING AND PRODUCTION CONFERENCE

February 23-25, 1988 Anaheim Convention Center • Anaheim Hilton • Anaheim Marriott Anaheim, California

Attend NEPCON West and get on the high performance track to quality in electronics manufacturina.

If you are responsible for circuit and system design, NEPCON West is your best source for high performance technology and fast-track solutions to your manufacturing problems across the board.

across the board.

The Exhibition-**High Performance in Action**

See, touch, and compare the latest materials, components, devices, equipment, technologies and techniques used to create electronic products. Observe live product demonstrations by over 1,200 companies and divisions.

NEPCON West '88 Advance Registration Form

COMPLETE AND MAIL TO: Nepcon West '88, P.O. Box 7100, North Suburban, IL 60199-7100

MAILING DEADLINE: February 1, 1988. After February 1, 1988, do not mail. For free admission to exhibits only, bring completed form to a badge typist at the NEPCON registration center. (No one under 18 will be admitted)

PLEASE PRINT IN BLACK INK

1. G	ene	ral	Inf	orr	ma	tio	on	(Pl	ea	se	pr	int	cl	ear	ly)			Ir.			As.			Mr	s.)r.
L First	Nan	ne	1	1	1	1	1	1		L	И.І.	Ł	ast	I t Na	ame	e	1	1	1	1	1	1	1	1	1	1	1	-
	1		1	1	1	1	1	1	1	1	1	1	1	1	1	Ì	1	1	1	1	1	1	1	1	1	1	1	
Job	Title																											
			1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
Com	pany	у																										
	11	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
Divis	sion																		1									
	11		1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
Mail	ing A	dd	ress	5													C	ep	t. o	r N	lail	St	ор					
	11		1	1	1	1	1	1	T	1	1	1	1	1	1	1	1	1	1	T	1	1	1	- 1	1	1	1	1
City	1														S	tat	e	Z	ip							-	-	_
	11		1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	T	5
Cou	ntry											-		-		-	-					-				-	-	
11	11	- 1	1	1	1	- 1	1	1	1	1	1	1	1	1	T	1	1	T	1	1	1	1	1	1	1	1	1	
Tele	phon	e									-	Tele	x		(22												

The Conference-Fast Tracks to Solutions

The NEPCON West Conference Program offers solutions to problems in electronics manufacturing across the board. Learn from the experts in sessions that cover timely issues such as:

- Superconductivity Materials and Technology
- The Need for Standards for the Purpose of Moving Toward Automation in Electronic Packaging and Production
- Recent Advances in Tape Automated Bondina
- New advances in Achieving SMT Reliability and Manufacturability
- Introduction to New Technology Marketing

Register Now!

Keep pace with the products, the people, and the information you need to reach peak performance at NEPCON West. Pre-register and get free admission to the exhibition.

F

G □ Sales

H

□ Other

Corporate Management

□ Research/Development

H 🗆 Electronic Components

and Sub-Assemblies

Automotive Electronics

Independent Research,

Contract Manufacturing

or Appliances

Test. Design

Other

Consumer Elec. Products

Phone: 312/299-9311



Cahners Exposition Group 1350 East Touhy Avenue P.O. Box 5060 Des Plaines, Illinois U.S. Telex: 246148 CEGCGO DSP International Telex: 82882 CEG CHGO

2. Job Category (Check only one)

- A Circuit/System Packaging B
- Circuit/System Design C Production/Manufacturing
- D Quality Control, Test & Inspection
- F D Purchasing

Е

G

3. Business Category (Check only one)

- A Computers, Peripheral Equipment
- Office or Business Machine B C
- Communications, Systems/Equipment D Industrial Electronic Control
 - Systems/Equipment Medical Electronics
 - Aircraft, Missiles, Space, Military
 - □ Test and Measurement Equipment, Inst

4. Number of Employees in Your Company (Check only one)

A I 1-99 B I 100-499 C 500-999 D I 1000-2999 E 3000+

5. I'm interested in the following product categories. (Check all that apply)

A D PC Design B
PC Board Fabrication

C Circuit Assembly D Circuit Packaging

M

- E 🗆 Inspection and Test
- A D Please register me for exhibits only. Free admission with this form. Save \$15.00. B
 Please send more information and registration materials for the Conference
- Program. C
 Please send hotel information.
- D
 My company is interested in exhibiting at future events.

You told us what you wanted in digitizing oscilloscopes,



and we took your advice...

Introducing HP's new high-perfo

You told us what would best meet your measurement needs.

So in '84 and '85 we brought you digitizing oscilloscopes with pioneering features like full programmability, 1 GHz repetitive bandwidth, color displays, automatic answers, single-shot pulse reconstruction, infinite persistence, and instant hardcopy output.

And now, we bring you the new HP 54111D/54112D/ 54120T series.

These high-performance digitizing oscilloscopes let you measure what you've never measured before, with superb accuracy and ease of use. You'll find innovations

KAP UNIT

such as '20 GHz bandwidth, 4-channel simultaneous 400 MSa/sec with 64k memory per channel, time domain reflectometry (TDR) with normalization, 10 psec time interval accuracy, and more.

HP 54111D: the hot single shot.

The HP 54111D offers two simultaneous channels operating at up to 1 Gigasample per second...allowing you to capture high-speed single-shot phenomena such as high-speed pulses, plasma discharge, high voltage arcing, high frequency bursts, laser pulses and high energy events. You get the single-shot performance of analog storage oscilloscopes with all of the performance advantages of digitizing oscilloscopes.

The HP 54111D also offers a 500 MHz bandwidth, so it will perform admirably in a wide variety of repetitive as well as non-repetitive applications.

HP 54112D: 64,000 bytes times 4.

The HP 54112D offers you simultaneous 4-channel capture at 400 Megasamples per second with 64k of memory per channel. Just right for the long data streams found in serial data communication applications.

HP54111D

- □ 1 Gigasample/sec digitizing rate
- 500 MHz repetitive bandwidth
- 250 MHz single-shot bandwidth
- □ 8k memory per channel
- 1 mV/div sensitivity

HP 54112D

- 400 Megasamples/sec digitizing rate
- □ 100 MHz repetitive or single-shot
- 4 simultaneous channels
- 64k memory per channel

rmance digitizing oscilloscopes.

Four simultaneous channels enhance critical timing measurements on multiple test points...single-shot. And the HP 54112D's four channels are always real-time correlated for every trigger occurrence.

In automated test, four channels with 64k memory per channel boost your throughput by capturing 256k of data simultaneously.

HP 54120T: excels in high-speed applications.

With its 20 GHz bandwidth and 10 psec accuracy, the HP 54120T lets you measure propagation delays of ICs or switching times of high-speed diodes. Characterize microwave switches. Verify signal path impedances in computer backplanes and test fixtures. And more.

You get high sensitivity, resolution, and accuracy for repeatable time-interval and voltage measurements, with stability and ease-of-use comparable to lower-performance oscilloscopes.

The HP 54120T offers four channels for logic gate characterization. Time and voltage histograms to help you quantify noise and jitter. Normalization to correct for imperfect connectors in reflection (TDR) and transmission measurements. Probing to 6 GHz. And the list goes on.

Contact HP today!

For more information on our new high-performance digitizing oscilloscopes, fill out and mail the postage-paid reply card today. Call us direct at **1-800-367-4772**, Ext. **215L**. Or contact your local HP sales office listed in the telephone directory white pages. Ask for the electronic instruments department.



HP 54120T

- dc-20 GHz bandwidth with averaging
- 10 psec time interval accuracy
- 0.25 psec time interval resolution
- Time and voltage histograms
- Stable TDR with normalization
- 0.4% voltage accuracy
 4 channels

THE SACK

The specs you need, and the features you want.

In addition to their outstanding individual contributions, the new HP 54111D/54112D/54120T digitizing scopes offer you full programmability, automatic measurements, instant hardcopy output to printers and plotters, waveform storage, and multiple-color displays.

You also have HP's excellent reliability, documentation, and support to make you productive with your HP instrument quickly and ensure your satisfaction for years to come.



\$23,900.00*

2 chan & 2 trig

8 bit to 25 MHz.

7 bit to 100 MHz, 6 bit to 250 MHz

500 MHz

250 MHz

1 mV/div

to 5 V/div ac, dc; 50 Ohm &

1 MOhm

1 GSa/sec

10 psec

2 pixel.

4 rep wfm, 4 ss wfm

YES

8k

10

VERTICAL Rep. bandwidth S.S. bandwidth Inputs Resolution

Sensitivity

Coupling

HORIZONTAL: Digitizing rate (max)

Resolution Pre-trigger viewing MEMORY:

Acquisition/chan

Waveform storage

Nonvolatile instrument setups



HP 54112D

VERTICAL: Rep. bandwidth S.S. bandwidth Inputs Resolution Sensitivity

Coupling

HORIZONTAL: Digitizing rate (max) Resolution Pre-trigger viewing

MEMORY: Acquisition/chan Waveform storage

Nonvolatile instrument setups: 10

100 MHz 100 MHz 4 chan & 1 trig 6 bit to 100 MHz 5 mV/div to 5 V/div ac, dc; 50 Ohm & 1 MOhm

\$22,900.00*

400 MSa/sec 40 psec YES

64k 2 pixel, 4 rep wfm, 4 ss wfm



HP 54120T

VERTICAL: Rep. bandwidth S.S. bandwidth Risetime Accuracy Inputs Resolution Sensitivity Coupling

HORIZONTAL:

Accuracy Resolution Pre-trigger viewing Range

MEMORY:

Acquisition/chan Waveform storage

Nonvolatile instrument setups: 10 TDR

Pulse source Amplitude 35 psec Risetime Flatness 1% Normalization YES Waveform histograms YES

*U.S. list price only.

Varies according to options selected.

**U.S. list price only.

Includes both the HP 54120A and HP 54121A. Specifications subject to change without notice.



HP-IB: Not just IEEE-488, but the hardware, documentation and support that delivers the shortest path to a measurement system



we never 1 100

20 GHz NO 17.5 psec 0.4% 4 chan & 1 trig 12 bits 1 mV/div to 80 mV/div 50 Ohm

\$27.850.00**

10 psec 0.25 psec NO 10 psec/div-1 s/div

0.5k2 pixel (volatile), 4 rep wfm (nonvolatile)

0-200 mV

Discover Fluoronics Resources

Fluorinert[™] Liquids_products that power Fluoronics Resources

*Fluoronics Resources:

An exclusive 3M combination of innovative products backed by research and development, manufacturing expertise, technical data and service assistance built on more than 35 years' experience of pioneering in fluorochemistry.

3M has had a whole generation of experience in the development, manufacture and refinement of perfluorinated liquids. We first introduced these versatile liquids to electronics design, testing and production professionals in the fifties. Since then, Fluorinert Liquids have become the mainstays in electronic cooling, high reliability testing and vapor phase soldering.

Fluorinert Liquids, used as a direct contact heat transfer medium, offer a range of physical properties that make them particularly suitable for electronic uses. They are non-polar and exhibit no solvent action. They are colorless, low in toxicity, non-flammable and offer exceptionally high dielectric strength plus thermal and chemical stability. Most important, they have almost no chemical reactivity and they evaporate without leaving a residue on parts.

Buy the numbers

Our FC[™] numbers — FC-40, FC-70, FC-77, etc. — are used to identify Fluorinert Liquids that offer certain physical characteristics to meet specific application needs. These FC numbers are solely 3M designations for various fluorochemical products.

Fluorinert Liquids are being used cost-effectively in cooling, high reliability testing and vapor phase soldering operations. When you are interested in applying these versatile liquids in your own production, 3M can provide an abundance of technical information and support.



Technical assistance: the main benefit of Fluoronics Resources

3M offers prompt assistance to help you solve many production and testing problems. We provide comprehensive technical recommendations for specific fluids. We consult with you on the proper application equipment and help you evaluate production methods and results. Our service bulletins bring you up to date on the most recent advances in vapor phase soldering and high reliability testing. Ask us about 3M's audiovisual materials and on-site application training seminars.

Discover Fluorinert[™] Liquids' heat transfer capability

What are your needs? A precise degree of temperature control? Fast, uniform heat transfer? High dielectric strength? Fluorinert Liquids offer the broad range of physical characteristics required in most applications.

Fluorinert Liquids are an effective direct contact heat transfer medium whether used in a liquid or vapor state. Their unique properties enable you to use them in contact with sensitive components and substrates.

Major differences between the various products in the Fluorinert Liquids family can be seen in their boiling points. These can range from 56°C to 253°C. Should you need products with intermediate boiling temperatures, the 3M staff will work with you to fashion a product especially for your needs. It's an example of how 3M's Fluoronics Resources provide you with "customized" service to solve special problems.



Fluorinert™ Liquids achieve accurate high reliability testing

It's a small world you work in. Where time ticks in nanoseconds and dimension is measured in Angstrom units. And as circuitry becomes more complex, a greater demand is placed on testing capability — not only in speed, but in higher reliability and accuracy.

Fluorinert Liquids meet those requirements by providing a controlled temperature environment and a high degree of electrical protection. They offer maximum compatibility between





the heat transfer medium and the device under test. Fluorinert Liquids reduce testing costs by reducing testing time substantially. They do this by rapidly reaching test temperature and providing precise and uniform temperature control. You'll minimize the number of faulty units by detecting defects before they become rejects.

These liquids provide cost-effective tests such as gross leak, thermal shock, liquid burn-in, ceramic crack detection, electrical environmental, temperature calibration and failure analysis/short detection.

Fluorinert Liquids are specified in the MIL-STD's for thermal shock and gross leak testing.

THERMAL SHOCK TEST CONDITIONS

Military	Standard 8	83-1011	Military Approved Fluorinert Liquids					
Test Condition	Hot Test Step 1	Cold Test Step 2	Hot Test Step 1	Cold Test Step 2				
A	100°C	- 0°C	Water , FC-40	Water , FC-40, FC-77				
В	125°C	- 55°C	FC-40, FC-70, FC-5311	FC-77				
С	150°C	— 65°C	FC-40, FC-70, FC-5311	FC-77				
D	200°C	- 65°C	FC-70, FC-5311	FC-77				
E	150°C	- 195°C	FC-40, FC-70, FC-5311	Liq. N2				
F	200°C	- 195°C	FC-70, FC-5311	Liq. N2				

GROSS LEAK TEST CONDITIONS

	Military Approved Fluorinert Liquids											
Military Standards	Indicator Fluids	Detector Fluids	Absorption Fluids									
MIL-STD 883-1014	FC-40, FC-43	FC-72, FC-84	Do not apply									
MIL-STD 750-1071	FC-40, FC-43	FC-72, FC-84	FC-43, FC-75, FC-77									
MIL-STD 202-112	FC-40, FC-43	FC-72, FC-84	Do not apply									

Discover higher yields in vapor phase soldering

Fluorinert Liquids have been the industry's fluid of choice since the vapor phase reflow soldering (VPS) process was introduced in 1975. There are a number of good reasons for this universal acceptance. VPS with Fluorinert Liquids produces highly reliable solder joints. The system reduces reject rates, increases production, and lowers production costs. With Fluorinert Liquids, you can be assured that your products will never be exposed to a temperature higher than the selected liquid's boiling point. (See above)

liquid's boiling point. (See above) You'll avoid those problems usually associated with other systems shadowing, uneven heating, and overheating. The liquids are non-flammable. Their low surface tension helps them evaporate quickly from the work pieces without leaving a residue.

VPS with Fluorinert Liquids is especially suited for boards with high mass or complex geometries. The liquid vapors completely surround the assembly and penetrate remote recesses to heat all surfaces evenly. The vapors are 15 to 20 times heavier than air so they can be contained easily within the work area. The system offers an oxygen-free, non-corrosive environment to minimize rejects from oxidation contamination.

Some typical applications using Fluorinert Liquids in VPS include surface mounted leaded or leadless components, through-hole leads and wire-wrap pins, lead frame attachment, reflow of electroplated solder or tin and miscellaneous metal joining.

VPS SELECTION GUIDE

Fluorinert Liquid	Boiling Point	Typical Solders			
FC-43	174°C/345°F	70 Sn/18 Pb/12 In 100 In 58 Sn/42 In 58 Bi/42 Sn			
FC-70, FC-5311 FC-5312	215°C/419°F	63 Sn/37 Pb 60 Sn/40 Pb 62 Sn/36 Pb/2 Ag			
FC-71	253°C/487°F	100 Sn 95 Sn/5 Ag 60 Pb/40 Sn			

Discover the unique cooling benefits of Fluorinert[™] Liquids

As the package size decreases, your need for more efficient heat dissipation increases in proportion. 3M Fluorinert Liquids are very efficient as a direct contact heat transfer medium, with the added advantage of having the high dielectric characteristics needed to meet stringent demands of the diversified electronics industry. We offer 11 liquids with boiling points that range from 56°C to 253°C.

These stable liquids allow you to maximize power density and miniaturize your package. Yet they reduce failure rates and increase reliability.

Fluorinert Liquids are used in such demanding applications as:

- Radar transmitters Power supplies
- High voltage transformers
 Lasers
- Radar klystrons
 Computer modules
- Computer memories Fuel cells

Typical properties of Fluorinert Liquids used in cooling are:

Fluorinert	Lio	Liquid								
Liquid FC-77 (English Units)	Room Temp. (77°F)	Boiling Point (207°F)	Boiling Point 207°F @/ATM							
Density Ib./ft ³	111	100	0.85							
Thermal Conductivity Btu/(hr) (ft ²) (°F/ft)	0.037	0.033	0.008							
Specific Heat Btu/(Ib.) (°F)	0.25	0.28	0.23							
Viscosity c.p.	1.42	0.46	0.02							
Coefficient of Thermal Expansion ft ³ /(ft ³) (°F)	0.0008	0.0009	0.0015							

Discover heating/curing with Fluorinert[™] Liquids

Because they maintain their vapor temperature with absolute precision, Fluorinert Liquids can be used in many heating and/or curing operations. They serve as heat transfer media in solder mask and polymer thick film applications and for polymer processing. The non-corrosive vapors will not support oxidation. Ideal where solvent flash-off is a problem.



iscover - uoron ics Resources

3M presents a unique short course in the use of Fluorinert[™] Liquids for the electronics industry.

3M is now offering a series of "Applied Fluoronics" tapes demonstrating how Fluorinert Liquids are used in a num-ber of applications. See first hand how these remarkable products can im-prove overall electronic production.

Three cassettes are available:
1. "Applied Fluoronics: High Reliability Testing"
2. "Applied Fluoronics: Vapor Phase Soldering"
3. "Applied Fluoronics: Direct Contact Cooling" These informative VHS format tapes are available to qualified personnel in the electronics industry. Specify which cassette(s) you would like to view.

Write on your company letterhead, describing your general interest. Mail to: Fluoronics Resources, Industrial Chemical Products Division/3M, Build-ing 223-6SE-04, 3M Center, St. Paul, MN 55144-1000. For technical information or assistance on High Reliability Testing and Cooling, call 612/733-6282; for Vapor Condensation Heating assistance, call 612/733-7424.





7 REASONS WHY.

You've already invested quality time and budget in building the very best VME computer system for your application.

Now, interconnect your components with the very best backplane. Select from the full range of sizes and configurations offered by BICC-VERO.

BICC-VERO supports their VME Backplanes with a full line of card frames, enclosures, and connectors. Ask for the details.



Call us or your BICC-VERO Distributor for complete information.



BICC-VERO ELECTRONICS, INC. 1000 Sherman Avenue Hamden, CT 06514 (203) 288-8001 TWX: 510-227-8890



Fans and blowers (Torin Engineered Blowers)

Shrinking board size has changed the rules for thermal design: A surface-mount assembly that occupies only 40% of the space of its through-hole counterpart can nevertheless dissipate as much power. Achieving adequate reliability requires that you understand and apply the new rules.

Cooling devices take the heat from SMDs

Dan Strassberg, Associate Editor



Small fan suited to spot cooling (Indek)

Surface mounting is about the hottest technology in electronic packaging today, and if you don't heed the advice of fan and heat sink vendors, you might find that claim to be literally true. They advise you to consider thermal management early in the design cycle. Otherwise, your customers might be the first to know about thermally induced reliability problems.

Surface-mount technology (SMT) is moving reliability concerns well beyond the purview of packaging engineers, power-supply designers, and designers of the traditionally temperature-sensitive low-level analog circuits. Fortunately, vendors are offering products ranging from CAD tools to heat sinks to help you develop and implement a strategy to limit semiconductor junction temperatures to a level that delivers the desired reliability.

Thermal design is now part of logic design

Thermal considerations pervade every aspect of SMT-based circuit design. For example, if you design high-speed SMT-based logic circuits, then your concerns encompass not only propagation delays and reflections in signal lines but thermal management as well. IC vendors normally don't offer their highest power devices in surface-mount packages (see **box**,

EDN December 10, 1987

"High-speed logic: toward even hotter technology"). But compared with their through-hole counterparts, the logic surface-mount devices (SMDs) that vendors do offer dissipate just as much power, mount closer together, and transfer a larger percentage of the heat they develop out of their packages through the leads. Close spacing between devices and widespread use of multilayer boards, whose inner layers exhibit fairly high thermal conductance, make it likely that the temperature of an SMD will affect—and be affected by—that of nearby devices more than would the temperature of a leaded through-hole device.

Among the army of products that stand ready to help you battle high temperatures is PCB Thermal, a CAD software package from Pacific Numerix, which allows you to impose thermal as well as electrical constraints when determining where to place components on a circuit board. PCB Thermal presents you with a graphic interface; it runs on many 32-bit CAE workstations and performs a finite-element thermal analysis. When configured for a Sun 3, it costs \$15,000.

If your product is going to be manufactured in high volumes or will be quite complex, and if you feel that solving its thermal problems will take help from people who specialize in thermal management, you might SMT is moving reliability concerns well beyond the purview of packaging engineers and power-supply designers.

consider EG&G Wakefield Engineering. Wakefield is probably best known as a supplier of heat sinks, but its product line includes other types of cooling devices as well. The company's applications engineers will work with you to develop a comprehensive thermal-management proposal if your application has the potential for requiring more than \$25,000 worth of Wakefield products per year.

SMD heat sinks pose unusual design problems

You won't find a wide variety of heat sinks designed especially for SMDs. Those that do exist require you to mount the SMDs in leaded sockets that you solder into through holes, just as you would solder other conventional components. One reason for the scarcity of SMD heat sinks is the wide variety of SMD packages; no single package vet accounts for enough of the market to make it attractive for vendors to provide matching heat sinks. Furthermore, SMD packages make it difficult to attach heat sinks. Thermally conductive adhesives can be used, but applying them is a messy job, distasteful to supervisors of pc-board assembly groups. Worse yet, if you add the mass of a heat sink to an SMD, particularly one with J or gull-wing leads, you create a mechanically resonant system. During transit the device might vibrate severely enough to cause metal fatigue, which could weaken or fracture the leads or solder joints.

Attaching a heat sink to a component also increases the amount of heat you must deliver to it to solder it to a pc board. Prolonging the exposure of an SMD (or any other semiconductor device) to the high temperatures necessary to melt solder is likely to degrade its reliability. Therefore, if you attach heat sinks to SMDs, several IC vendors advise you to do it after the reflow-soldering operation. If you are using SMDs packaged in leadless ceramic chip carriers (LCCCs), heat sinks such as Thermalloy's 2313B (\$1.27 (1000)) teamed with AMP's 55159-1 or -2 socket and cover (\$5 (OEM gtv)), or EG&G Wakefield's 830-20B (\$0.31 (5000)) coupled with 3M-Textool's 268-5400-00-1102 socket (\$12.13), allow you to wait until after soldering to mount not only the heat sinks but also the SMDs themselves. You place the IC in its socket, put the heat sink on top of it, and snap the two into place. You can use thermal compound to improve heat transfer from the IC to the heat sink. When used in air moving at 600 linear ft/minute, heat sinks of this type can reduce the junction-to-air thermal resistance (and hence the junction temperature rise above ambient) of an IC packaged in a 68-lead LCCC by approximately 60% compared with that of a similar



Heat sink for an SMD, designed for use with an AMP socket (Marketed by Thermalloy and AMP)

device without a heat sink in still air.

Although the primary mechanism for heat transfer in solids is conduction (for instance, from a chip to its package, from the package to a pc board, and from one area of the board to another), air is not a particularly good conductor of heat, so the primary mechanism for heat transfer in air is convection—transfer of heat by air motion. With natural convection, temperature differences within your product will cause air to move and thus to transfer heat from the hotter parts to the cooler regions. If you use a fan or blower to increase the amount of air that passes by the heat sink, the heattransfer mechanism is called forced convection. Temperatures reached by electronic components normally aren't high enough for the third heat-transfer mechanism—radiation—to play a significant role.

You can use some simple rules of thumb to help determine the point at which natural convection becomes inadequate: If your pc board dissipates <0.5W/in², natural convection will almost surely be adequate. From 0.5 to 1W/in², natural convection might be adequate. From 1 to 2.5W/in², conventional forced convection, where airflow parallels the plane of the boards, is likely to provide sufficient cooling. Above 2.5W/in², you will probably have to resort to newer methods of forced convection, such as impingement cooling, in which you force air in a direction perpendicular to the plane of the board—directly at hot devices. At power densities greater than 5W/in² you will probably have to abandon forced convection and resort to techniques like mounting hot components against a plate chilled with a cold liquid.

Many factors affect choice of cooling mode

Factors affecting the point at which you change from one cooling mode to another include your product's maximum specified operating ambient temperature and its internal configuration. Products that have generous spacing between boards (>1 in. center to center) are likely to operate reliably with natural convection at pc-board power densities that require the use of forced convection in more densely packed products.

If you determine that you need forced convection, you

should not lightly approach the task of selecting the optimal air-moving device and the best scheme for moving air through your product. If you have to move air through the product from its surroundings, two of the problems you will face are noise and dust. Therefore, keep in mind that where cooling requirements are modest, you might not have to draw in air from outside the enclosure; you may be able to provide adequate cooling by stirring—using forced convection to move air from the warm interior of the product to the relatively cool inside surface of the enclosure. The enclosure is cooled, in turn, by the natural convection of the outside air.

Piezo Electric Products' LP Series air-moving de-

High-speed logic: toward even hotter technology

You won't find surface-mount versions of the logic devices that exhibit the highest dissipation. Many ECL gate arrays, for example, dissipate too much power for today's surface-mount packages, commercial-grade boards, and processes. LCCCs (leadless ceramic chip carriers) exhibit about the best heat-transfer properties of commonly used surface-mount packages. Their junction-to-case thermal resistance is approximately 30% lower than that of plastic leaded chip carriers (PLCCs) with the same number of leads. Because LCCCs have no leads at all, only solder holds them to the board (unless you place them in through-hole-mounted sockets, thereby surrendering the advantages of surface mounting). Because expansion coefficients of packages differ from those of most boards, increasing temperature causes stress to build up on the solder joints and make the connections between the package and the board unreliable.

On the other hand, with ICs in pin-grid-array (PGA) packages, if you don't use sockets, you solder the parts into through holes that have plenty of sidewall friction; because solder isn't all that holds the devices, retention is more reliable. Reliable retention is one reason that IC vendors prefer to package high-dissipation logic devices in PGAs rather than in LCCCs. Moreover, the vendors can get PGA packages with 300 pins; at present, the maximum pin count for LCCCs is 84.

One company, Texas Instruments (Attleboro, MA), has devised a solution to the problem of differing coefficients of expansion between boards and LCCCs. TI makes the clad metals now used in US coinage. Clad-metal technology makes it possible for TI to fabricate Invar-copper-Invar sheets that pc-board vendors can use as the embedded power and ground planes in multilayer boards. Because Invar has a much lower expansion coefficient than copper or glass-epoxy, by using the clad metal layers you can design boards whose expansion closely matches that of LCCC packages. TI will not design your printedcircuit boards for you, but it will assist you in selecting the cladmetal material that your board supplier can use to deliver the properties you want.

The Microwire process, developed by the PCK Technologies division of Kollmorgen Corp (Melville, NY), can take advantage of TI's clad metals as well as the extraordinary circuit densities possible with Microwire, a high-density version of Kollmorgen's older Multiwire process, to deliver boards that have controlled expansion and, because of their thinner insulating layers, heat conduction superior to that of boards with equivalent circuit density made either by multilayer or Multiwire processes.

One CAD software package allows you to impose thermal as well as electrical constraints when determining where to place components on a circuit board.

vices are well suited to stirring or spot cooling (cooling of a small number of hot devices in an otherwise cool unit). These 1.5×1.5 -in. low-profile units attach to your pc board close to the device you want to cool. They use a piezoelectric, rather than electromagnetic, transducer to convert electrical energy to mechanical energy and are so quiet in operation that you can't hear them above the ambient room noise. They are only 0.16 in. thick, and you space them another 0.25 in. from the board. You power them with either 12 or 24V dc. The volume of air they move is modest—less than 2 cfm, but the air velocity is respectable—as much as 1000 linear ft/ minute. Evaluation kits, which include a dc/ac inverter, cost \$250; production units cost from \$10 to \$25 (10,000).

Another device well suited to spot cooling is the FDC40-05H from Indek. Like the vast majority of fans, it's an electromagnetic device, but it measures only $1.5 \times 1.5 \times 0.79$ in. You can mount it on a pc board and power it from 5V dc. It consumes 3W, its free-air delivery is 8 cfm, and its noise rating is 45 dBA. It costs \$16.65 (500).

If you know how much power your product dissipates, the formula

AIRFLOW= $1.756 \times P/\Delta T$

(where airflow is measured in cfm, P is power in watts, and ΔT is temperature rise in degrees Celsius) tells you how much air you must move through it to limit the difference between incoming and outgoing air temperature to a specified rise.

For example, suppose that an IBM PC/AT work-alike computer has a power supply capable of delivering 220W. Further, suppose that the supply is 75% efficient, so that the power dissipated within the computer case is 1.33×220 W, or 293.3W, if the supply is fully loaded. According to the airflow formula, to maintain the exit air temperature at 15°C above the entry air temperature (that is, 15°C above ambient room temperature), 34.3 cfm must move through the case.

At first, the required flow sounds quite reasonable; several vendors supply fans with free-air delivery of approximately 50 cfm in a $3.62 \times 3.62 \times 1$ -in. package. However, with a very small back pressure—approximately 0.07 in. of H₂O—such fans deliver less than the required 34.3 cfm, and they rotate at 3300 rpm, which makes them quite noisy for the computer's intended office environment.

When deciding about the overall scheme for directing



Air mover incorporating a piezoelectric transducer (Piezo Electric Products)

air through a product, designers have traditionally considered two approaches—evacuation, where a fan pulls air through the product, and pressurization, where the fan pushes the air. Even though it adds the fan's own power dissipation to the heat load in the cabinet, pressurization is the more common of the two. A reason often given for selecting pressurization is that with a pressurized cabinet, dust doesn't enter through small openings; you can keep dust out by placing a filter over the opening directly in front of the fan.

Filters are a mixed blessing, however. Many designers believe that filters create at least as many problems as they solve. A filter clogged with dust severely restricts air flow, and users of electronic products are notorious for forgetting to clean or change filters. If you must use a filter, you should consider monitoring the temperature within your product so that you can warn the user, or shut power off, if the temperature becomes excessive.

When opting for cabinet pressurization, what many designers forget is that air moving at relatively low velocities picks up much less dust than does air moving rapidly. If the fan is not directly behind an air inlet, and air enters the product through many small, unfiltered openings, it will enter the enclosure slowly, thus minimizing dust buildup.

Because you can't easily control the path by which air

enters a fan, you will usually find the highest air velocities, hence the greatest heat-transfer capabilities, directly in front of the air discharge. You might be able to combine these good heat-transfer properties with low dust buildup and freedom from filter maintenance by placing a fan in the middle of your product, as **Fig 1** shows, so that it draws air past the elements that dissipate little power and discharges directly over the hottest components.

Use pressure/volume curves to select fans

Fig 2 shows the pressure-vs-volume curve of a $4.69 \times 4.69 \times 1.5$ -in. fan—in this case, EBM Industries' 5-bladed W2G110-AO48-31, a 24V dc unit that consumes 6W. (In production quantities—1000 to 50,000 pieces—a number of vendors sell dc-powered, ballbearing fans of this size for \$11 to \$17.) Overlaid on the pressure-vs-volume curve is the pressure-vs-volume curve of a product in which you might use the fan (for example, a cabinet filled with pc boards and power supplies).

Unfortunately, the only accurate way of establishing the pressure-vs-volume characteristic for *your* product is through airflow measurements on a mockup or an actual unit. Note that the volume of air that the fan can



Fig 1—Unusual fan placement, such as that depicted here, can make it possible to eliminate filters without inviting dust to build up within your product.

deliver is a function of the back pressure, and the back pressure is a function of the volume of air delivered. You can solve the simultaneous equations graphically—the operating point lies at the intersection of the two curves. Note also that the pressure-vs-volume curve of the cabinet is not linear; if you attempt to double the volume of air, the back pressure more than doubles. A nonlinear pressure-vs-volume curve is characteristic of turbulent flow. Although it's noisier than laminar flow, designers usually attempt to create turbulence because it aids in transferring heat from hot components to the moving air.

Choices you must make when selecting an air-moving device include whether to use a fan or a blower, whether to use ac or dc power to drive the air-moving device, whether to use an air mover with ball or sleeve bearings, and whether to control fan speed in response to changes in temperature of the components you are cooling.

Understand how blowers differ from fans

Fans deliver air along their axis of rotation; blowers usually deliver air in a direction perpendicular to their axis of rotation—either radially or tangentially. In general, for a given physical volume, a fan will deliver



Fig 2—Use pressure-vs-volume curves to get an idea of how much air a fan or blower will move. The operating point lies at the intersection of the fan's curve and that of the equipment you are cooling.

No single SMD package yet accounts for enough market share to make it attractive for vendors to provide matching heat sinks.

more air at zero back pressure than a blower, but a squirrel-cage blower will deliver air at higher velocities and will do so even at back pressures that would completely cut off airflow from a fan.

Squirrel-cage blowers, such as Comair Rotron's Biscuit (\$30.40), deliver air tangentially. At zero back pressure, the Biscuit delivers only 20% of the air volume of a fan with similar dimensions. However, because of the Biscuit's smaller discharge area, the exit velocity is more than twice as high, and the Biscuit can deliver air against back pressures nearly twice as high as those that would cut off airflow from a fan of comparable size. Their small exit area and high discharge velocity make small squirrel-cage blowers good choices for blowing air directly on very hot components.

The percentage of small fans and blowers sold that use dc power is growing rapidly. All manufacturers now offer dc-powered—typically 12 or 24V—fans as well as ac-powered ones. Despite slightly higher cost for dc (approximately 20% for the air mover itself, not including costs you incur if you have to increase the capacity of your product's dc power supplies) and occasional concerns about controlling the inverter ripple current that some dc fans inject into the dc supplies, the trend exists for good reason:



Three-bladed fan (Nidec-Torin)



Squirrel-cage blower (Comair Rotron)

- With dc power, your company can stock a single type of fan for use in products to be powered from any line frequency and any line voltage. With fans operated directly from the ac line, you usually have to install different units in products you ship to 120V and 220V areas. Furthermore, the rotational speed of dc-operated fans is independent of line frequency, so you don't have to select a fan whose rotational speed is too high at 60 Hz in order to have it turn fast enough at 50 Hz.
- You can get your product approved by regulatory bodies more easily if the fans don't connect to the ac line.
- You can control the speed of fans that employ dc motors more easily and over a wider range than you can those employing ac motors; hence you can operate such dc fans at a speed that minimizes mechanical noise.
- Small dc fans do not use mechanical commutators but instead use integral solid-state inverters based on the Hall effect; therefore, their reliability is as good as that of ac fans.
- The efficiency of dc fans is two to four times higher than that of ac fans; therefore, in applications where a fan pressurizes an enclosure, the reduced heat load imposed by the fan can be significant.

You're looking into the heart of the brightest new idea in AlGaAs technology.

Increase the brightness of the LED's you design into your equipment by as much as 300% with HP's new red AlGaAs products. The price? Only 25% more than our standard highefficiency red devices.

These brighter products are made possible by Hewlett-Packard's new opaque substrate, double heterojunction (DH) AlGaAs technology. This technology enables us to offer you entirely new families of lamps and displays that are significantly more efficient than single heterojunction (SH) AlGaAs devices.

What does this mean for you? More ways to meet your price/performance

targets. More ways to beat the competition. More ways to get the benefits of HP quality control. When you need LED brightness levels in the 50 to 1000 millicandela range...when you have an application that can benefit from displays that draw only 1 mA per segment...or need lamps that perform well at 1 mA, HP has a solution for you.

Brighten your day with free samples.

Evaluate this significant next step in solid state technology for yourself. To get your free samples, mail this coupon *and your business card* to: Hewlett-Packard, Components Group, 1820 Embarcadero Road, Palo Alto, CA 94303. cc08707

To order, contact your nearest HP distributor. In the U.S.: Almac Electronics, Hall-Mark, Hamilton/ Avnet, or Schweber. In Canada: Hamilton/Avnet or Zentronics Ltd.



we never

Keep in mind the effects of back pressure when calculating fan or blower performance requirements.

The majority of small fans and blowers sold today use sleeve bearings. They are quieter and, in production quantities, cost roughly 8% less than fans with ball bearings. Ball bearings, on the other hand, have a reputation for exhibiting longer life than sleeve bearings. Fan manufacturers don't argue about the greater longevity of ball-bearing fans operated at air temperatures greater than 40°C or in applications in which airflow direction is not horizontal. However, some vendors claim that if end-of-life ratings were established by noise level, then fans with sleeve bearings, operated with horizontal airflow at temperatures below 40°C, last at least as long as those with ball bearings. Indeed, the probability is greater than 90% that a fan with either type of bearing, operated according to its manufacturer's recommendations, will still be running after five years of around-the-clock service. Nevertheless, if you are buying power supplies with integral fans, you might want to pay your vendor a premium to provide units with ball-bearing fans because power supplies-even those with switching regulators-usually run hot.

If you need to minimize the audible noise created by the fans in your product, you can regulate the speed of the fans so that they turn only as fast as necessary to maintain the desired operating temperature. Reducing the fan speed usually also reduces the fan's power dissipation. You can control the speed of a dc-operated



Prepackaged fan-speed controllers (Smartfan)

fan simply by varying the voltage you apply to it. You can produce the voltage variations either by driving the fan with pulse-width-modulated dc or by using purely linear techniques, although the linear approach can introduce additional hot components into your product.

The solid-state commutators within dc-operated fans generate a pulse train whose repetition rate is proportional to the fan's rotational speed. For a modest additional charge (typically about 5% in production quantities), many fan manufacturers will bring the

For more information . . .

For more information on the CAD tools, fans and blowers, fan-speed controllers, heat sinks, and sockets discussed in this article, circle the appropriate number on the Information Retrieval Service card or contact the following manufacturers directly.

AMP Inc Harrisburg, PA 17105

Harrisburg, PA 17105 (717) 564-0100 TLX 842313 Circle No 692

Comair Rotron Sawyer Industrial Park Saugerties, NY 12477 (914) 246-3615 Circle No 693

EBM Industries Inc 525 New Britain Ave Unionville, CT 06085 (203) 674-1515 Circle No 694 EG&G Wakefield Engineering 60 Audubon Rd Wakefield, MA 01880 (617) 245-5900 Circle No 695

Indek Corp 2360 Qume Dr, Suite A San Jose, CA 95131 (408) 432-1199 TLX 176476 Circle No 696

Nidec-Torin Corp 100 Franklin Dr Torrington, CT 06790 (203) 482-4422 TLX 643963 Circle No 697 Pacific Numerix Inc 4180 La Jolla Village Dr, Suite 265 La Jolla, CA 92037 (619) 587-0500 Circle No 698

Piezo Electric Products Inc 186 Massachusetts Ave Cambridge, MA 02139 (617) 547-1777 Circle No 699

Smartfan Box 315 Harvard, MA 01451 (617) 456-8763 Circle No 700 Thermalloy Inc 2021 W Valley View Lane Dallas, TX 75381 (214) 243-4321 TWX 910-860-5542 Circle No 701

3M-Textool 1001 Fountain Parkway Grand Prairie, TX 75050 (214) 647-5939 **Circle No 702**

Torin Engineered Blowers Fasco Industries Inc 500 Chesterfield Center, Suite 200 St Louis, MO 63017 (314) 532-3505 Circle No 703

Products of Your Environment.



A field-use fiber optic connector so tough, you could roll a 5 ton truck over it. A Parallel Interconnect that allows a gas-tight interface in 60 seconds flat. A cabling assembly enabling a single connector to handle electronic signals, fiber optics and power supply.

These are but a few innovations in interconnections from ITT Cannon. But we couldn't have done it without you. Because success throughout our company relies on a thorough knowledge of your company's environment.

Take strategic partnering, for example. We don't create a custom solution by shaking your hand and jotting down a few notes. When we design-in, we get *inside* your environment.

Then there's Cannon's near-zero defect rate. It got that way, and stays that way, because we test each product in a carefully simulated environment.

As for delivery, we built a dependable system by studying the needs and scheduling realities of our customers' business environments worldwide.

And Cannon stays price competitive by always asking the question, "How will this connector be used?" Considering the connector's ultimate environment has taught us that keeping quality high ends up costing our customer less.

So if you'd like a partner who will take the time to learn about your environment, take a moment to contact ITT Cannon at (714) 964.7400.

Worldwide Headquarters 10550 Talbert Ave. Fountain Valley, CA 92708 Or call (714) 964-7400 CIRCLE NO 100





Maxconn Components Put Your System Ahead From The Very Beginning

Ahead on versatility, reliability and economy. Maxconn interconnection components give you the flexibility of creating thousands of different configurations. You get the power to develop versatile system solutions for a broad scope of telecommunication and computer applications.

computer applications. Plus, Maxconn offers offshore manufacturing for cost advantages and full testing for dependability.

Stocked for fast delivery and high availability,



- Molded cables
- HeadersModular jack
- Modular jacks
 D-sub connector
- D-sub connectorsStacked D-sub
- onnectorsMini Din connectors
- IDC connectors
- Ribbon connectors
- IC sockets
- PLCCs
- Telecom products

Get your system off to a great start. Call Maxconn for more information on the specific interconnection system you need.



 Cable and Connector Products

 for Telecommunications

 and Computer Systems

 1855 O'Toole Ave., DI02

 San Jose, CA 95131

 (408) 435-86660 In CA

 (800) 942-6446 Outside CA

 FAX: 408-435-0861

pulse train out on a third wire, enabling you to monitor for fan stoppage or to construct a feedback system that controls the fan speed. Of course, controlling fan speed isn't the optimum method of keeping temperatures within predetermined limits. If you place a temperature sensor, such as a thermistor, in the air stream or in contact with a temperature-sensitive component, you can construct a feedback system that controls the temperature by adjusting the fan speed even though you don't measure the speed directly.

Comair Rotron has built single-resistor speed programming into a new line of fans called Therma-Pro V. Fans in this series have four leads: two for power and two for a low-wattage programming resistor, which can be a thermistor. Voltage regulation is part of the design, so you can supply loosely regulated dc and not be concerned about the effect of voltage variations on fan speed. Comair Rotron suggests that the programmable-fan-speed technology can save on inventory costs for its customers even if they don't take advantage of the fans' closed-loop speed-control capability; resistor programmability allows users to stock a single type of fan for several applications, each of which requires different air delivery. The programmable version of the 4.7×4.7×1.25-in. Muffin-DC, which provides maximum free-air delivery of 100 cfm, costs \$26.50 in small quantities; the nearest nonprogrammable equivalent sells for \$19.10 in similar quantities. The percentage premium you pay for programmability decreases as you increase the quantity you purchase.

Smartfan provides controllers you can use to control the speed of dc- and ac-operated fans and blowers that, themselves, incorporate no special speed-control features. For example, Smartfan's PC-DC Series controllers, intended for fans operating from 12 to 26V dc, attach to fans with mounting-hole spacing of 1.969, 2.812, 3.250, and 4.125 in. An evaluation kit, which includes three controllers, costs \$38.44.

Acknowledgment

EDN thanks the following people who provided information used in this article: William Hamburgen of Digital Equipment Corp (Palo Alto, CA), Todd Hendrix of Amperex Electronics Inc (Slatersville, RI), Charles Hutchins of Texas Instruments Inc (Houston, TX), and Mali Mahalingam of Motorola Inc (Phoenix, AZ).

> Article Interest Quotient (Circle One) High 473 Medium 474 Low 475



Number 5 in a series from Linear Technology Corporation

December, 1987

Temperature Measurement Using the LTC1090/91/92 Series of Data Acquisition Systems

William Rempfer Guy Hoover

Introduction

Accurate temperature measurement is a difficult and very common problem. Whether recording a temperature, regulating a temperature or modifying a process to accommodate a temperature, the LTC1090 family of data acquisition systems can provide an important link in the chain between the blast furnace temperature and the microcontroller. Features of the LTC1090 family can make temperature measurement easier, cheaper and more accurate.

The features of the LTC1090 family members make them very useful in temperature measurement applications. High DC input resistance and reduced span operation allow direct connection to many standard temperature sensors. Multiplexer options allow one chip to measure up to 8 channels of temperature information. Single supply operation, modest power requirements (~5mW) and serial interfaces make remote location possible. Switching power on and off lowers power consumption (560 μ W) even more for battery applications. Finally, because few sensors have accuracies as good as

0.1%, the 10-bit resolution and 0.05% accuracy of the LTC1090 family are just right for most temperature sensing applications.

Thermocouple Systems

The circuit of Figure 1 measures exhaust gas temperature in a furnace. The 10-bit LTC1091A gives 0.5°C resolution over a 0°C to 500°C range. The LTC1052 amplifies and filters the thermocouple signal, the LT1025A provides cold junction compensation and the LT1019A provides an accurate reference. The J type thermocouple characteristic is linearized digitally inside the MCU. Linear interpolation between known temperature points spaced 30°C apart introduces less than 0.1°C error. The code for linearizing is available from LTC. The 1024 steps provided by the LTC1091 (24 more than the required 1000) insure 0.5°C resolution even with the thermocouple curvature.



Figure 1. 0°C-500°C Furnace Exhaust Gas Temperature Monitor with Low Supply Detection

Offset error is dominated by the LT1025 cold junction compensator which introduces 0.5° C maximum. Gain error is 0.75° C max because of the 0.1% gain resistors and to a lesser extent the output voltage tolerance of the LT1019A and the gain error of the LTC1091A. It may be reduced by trimming the LT1019A or gain resistors. The LTC1091A keeps linearity better than 0.25° C. The LTC1052's 5μ V offset contributes negligible error (0.1° C or less). Combined errors are typically 0.5° C or less. These errors don't include the thermocouple itself. In practice, connection and wire errors of 0.5° C to 1° C are not uncommon. With care, these errors can be kept below 0.5° C.

The 20k/10k divider on CH1 of the LTC1091 provides low supply voltage detection (the LT1019A reference requires a minimum supply of 6.5V to maintain accuracy). Remote location is easy, with data transferred from the MCU to the LTC1091 via the 3 wire serial port.

Thermilinear Networks

Figure 2 shows an 8 channel 0°C to 100°C temperature measurement system with 0.1°C resolution. The high DC input resistance and adjustable span of the LTC1090 allow it to measure the outputs of the YSI thermilinear components directly. Accuracy is limited by the sensor repeatability and precision resistors to 0.25°C.

Sensor input voltage (V_{IN}), not critical because of ratiometric operation, is set to around 1.5V to minimize self heating. The zero scale (COM pin) and full-scale (REF⁺ pin) of the LTC1090 are set by the precision resistor string to directly digitize the roughly 0.2V to 1V sensor output. The LT1006 buffers the 10k Ω reference resistance of the LTC1090. 0°C and 100°C





Linear Technology Corporation 1630 McCarthy Blvd., Milpitas, CA 95035-7487 • (408) 432-1900 FAX: (408) 434-0507 • TELEX: 499-3977 correspond to unipolar output codes of 0 and 1000 (decimal), respectively with an overrange of 102.3°C.

Thermistors

A thermistor is a cheaper alternative to thermilinear components in narrower temperature range applications. In Figure 2, CH7 is being used to digitize the output of a $5k\Omega$ thermistor. The resistor shown linearizes the output voltage around the 30°C point. The output remains linear to 0.1°C over a 20°C to 40°C range but gets nonlinear rapidly outside this range. By correcting for the non-linearity in software this range can be extended to 0°C to 60°C. Beyond that, the repeatability error of the thermistor increases above 0.2°C making correction difficult.

Silicon Sensors

Because of its high DC input impedance and reduced span capability, the LTC1090 family can directly measure the output of most industry standard silicon temperature sensors, both voltage and current mode. Popular sensors of this type include the LM134 and AD590 (current output) and silicon diodes.

Figure 3 shows a simple connection between the LTC1092 and industry standard 1μ A/°K current output sensors. Resolution is 0.25°C and accuracy is limited by the sensor and resistors. Standard 10mV/°K voltage output sensors can also be connected directly to the LTC1092 input in a similar manner.

For LTC1090/91/92 literature call **800-637-5545.** For help with an application call (408) 432-1900, Ext. 361.






GET US INVOLVED EARLY ENOUGH AND YOU'LL GET MORE THAN YOU BARGAINED FOR.

Call us anytime and you're in line for hundreds of immediate "off-the-shelf" answers to specific interconnect requirements.

That's what you expect from us. After all, we do have one of the most extensive OEM connector lines in the business.

But give us an "early" call—while you're still designing your product—

and see what happens. You get more than you bargained for.

First of all, you get the combined talents of a team of experts made up of specialists in connector technology, quality control, assembly techniques and delivery operations. When they attack an interconnect requirement, they mean business. They look at the total picture. Product design. Assembly



operations. Inventory requirements. The bottom line. Everything!

Result? You get a total interconnect solution instead of just a connector. And whether it's an "off-the-shelf" connector or a totally new design, it almost always means lower installed costs. Improved product quality. Reduced inventory requirements and fewer inspection requirements.

Little things like that can have a big influence on your bottom line.

So let's get involved. Early. Make us a part of your design team—and you'll get more than you bargained for. The nice thing about it is that it may actually cost you less in the final analysis. Just call: 1-800-633-0034 (Ext. 25), in Rhode Island: 401-751-7450. See how fast we respond.



CIRCLE NO 140

The one interconnect system

Thermoset rectangular connectors with 104 and 152 contact positions.

Pre-assembled thermoset MSM HYFEN™ rectangulars in 9 size (9-75 positions).

Reliable, low cost Thermoplastic QIKMATE™ plugs and receptacles in 10 sizes (2-36 contact postions).

> BANTAM[™] MIL-style at commercial prices with fixed thermoset inserts (4-48 positions).

you never outgrow! TrimTrio

Single contact system satisfies over 100,000 interconnect variations.

Designed for maximum flexibility, proven in millions of applications—Burndy's TRIM-TRIO contact/connector family lets you meet all your application needs no matter how often they change without changing your contact system! Your tooling! Or your installation procedures!

You simply select the contact/housing combination that best satisfies your current needs. Then, as needs change, you just change the combinations. Nothing else! Not your tooling! Not your operations. Nothing! And no matter what combination you choose—or how many you still enjoy all the advantages of standardization. Which means faster, more economical assembly and greater quality control—all along the line.

So make it easy on yourself. Standardize on the proven reliability of the Burndy TRIM-TRIO interconnect system. The one system that offers you thousands of

Versatile, quick disconnect cable splice.

variations. The one system you'll never outgrow. And to make things easier, all variations of the TRIM-TRIO family are available — off the shelf — at your local Burndy Distributor. For details, write: Burndy Corporation, TRIM-TRIO Product Manager, Norwalk, CT 06856. Or call: 203-852-8711.

THE TRIM-TRIO CONTACTS SYSTEM: Closed barrel Machined Contacts for both crimp and wire-wrap power applications up to 13 amps. Open barrel Precision Formed contacts for power and signal applications. Sub-miniature Coax (one-piece or 2-piece) for coaxial cable, shielded conductors and twisted pairs. These three basic types (with variations for different conductors, contact platings and termination options) make up the TRIM-TRIO contact system. All can be intermixed in any of scores of Burndy connector housings designed around this contact system.



METALOK™ THERMOPLASTIC CIRCULAR SERIES: with rugged metal bayonnet coupling. 9 sizes (4 thru 48 positons).

BANTAMATE II[™] low cost circulars — deliver up to 500 mating cycles. Positive polarization. Quick disconnect. 4 sizes (4 thru 30 positions).

CIRCLE NO 139



VACREL[®] lets you design more electrical

The performance of VACREL gives you the added design freedom you need when using surface-mount technology (SMT), the state of the art in printed wiring board and printed wiring assembly design.

Du Pont VACREL photopolymer film solder masks totally encapsulate fine-line circuits with a tough, uniform, high-resolution photopolymer film that provides excellent dielectric, mechanical, and electrical protection.

Because VACREL is uniformly thick, it consistently covers without skips, pinholes, or voids in a single pass—unlike screened or photoimageable liquid systems. Tighter designs, better use of real estate.

Tighter designs are possible due to accurate image registration and reproduction with masks of VACREL, even on large panels having two or more



VACREL photopolymer film solder mask (left). Total encapsulation means less damage in assembly, greater reliability in use, and reduced potential for field failures. Screen-printed solder mask (right) may leave voids, pinholes, and incomplete encapsulation.

circuit lines between pads and as little as 0.13-mm (5-mil) spacing between conductors. VACREL helps lower per-function cost by allowing more functions



functions into less real estate at less cost.

per board, with high first-pass assembly yields, less solder bridging, fewer retests and rejects, and less potential for field failures. Lower incoming inspection costs are possible, thanks to the accuracy of VACREL.

Accurate component location aids SMT design.

For surface mounting, VACREL goes beyond tighter designs and maximized real-estate utilization. It tents via holes to prevent solder wicking, bridging, and shorting. Components may be placed directly over tented via holes, with virtually no chance of contamination from the other side.

Because VACREL is photoimaged, a precisely shaped "well" for solder paste can be created, even

with closely spaced pads, to ensure proper placement and alignment of components. VACREL is compatible with wave, vapor-phase, and infrared soldering systems.

Send for VACREL design and productivity package.

Send today for more information on designing printed wiring boards with VACREL. Write to Du Pont Company, Room G51085, Wilmington, DE 19801. Or call 800-527-2601, Extension 311 VACREL photopolymer film solder mask is made only by Du Pont.

CIRCLE NO 138



SEE HOW YOUR CONNECTOR MEASURES UP TO OURS.

If your present I/O connector can completely cover the new Fujitsu Series 230 pictured on this page, you've got a large problem.

You're wasting valuable board space. Space you could use to cram in a few extra components. Or space you could eliminate entirely to reduce manufacturing costs.

Fact is, the Series 230's remarkably compact 1.27mm (.50") pitch and remarkably efficient 4-row, zig-zag terminal layout pack provides all the pinout you're used to in 40% less real estate.

Impressive.

But that's just one small accomplishment. The big news is that you don't have to give up full-size connector convenience or reliability. Every Series 230 connector includes features like a standard "D" shape polarization header, EMI shield, plug/ socket lock and minimum-pressure insertion/withdrawal fitting. All with no extra size.

So before you run out of space in your next compact or portable system design, call us at **(408) 562-1000**. Or for a complete list of local distributors and representatives write to Fujitsu Component of America, Inc., 3320 Scott Boulevard, Santa Clara, California, 95054-3197.

We'll keep you from coming up short.

CIRCLE NO 137





Aluminum enclosures help to dissipate heat as well as provide EMI shielding

The SL Series consists of seven small aluminum enclosures that vary in size from $3.5 \times 1 \times 3.7$ to $7.75 \times 3 \times 8$ in. The enclosures are built from flat, removable aluminum panels that you can easily punch, silkscreen, or laminate. The extruded aluminum sides have a variety of slots that accept pc boards. You can place the pc boards in various locations within the enclosures. You can also remove the top and bottom covers to obtain access to the subassemblies you place inside.

The enclosures offer such options as a mounting bracket, belt clip, pistol grip, and chassis. The injection-molded polycarbonate bezels conceal the front- and rear-panel screws. The enclosures also feature



pull-down, nonskid feet at no extra charge. The SL Series ranges in price from \$21 to \$26. Tracewell Enclosures. 7032

Worthington Galena Rd, Columbus, OH 43085. Phone (800) 848-4525; in OH, (614) 846-6175. Circle No 715

Enclosures for VME Bus and Multibus II are completely wired

The MaxChassis line of enclosures consists of 50 models: 34 for the VME Bus and 16 for the Multibus II. Each chassis includes a backplane and wiring appropriate for the bus system you choose. The enclosure comes with one or two card cages, a power supply, a fan, cabling, and wiring-control switches. Each card cage has 20 slots. The enclosures are available with either 20- or 26-in. depths. The 20-in. model can house cards as long as 280 mm; the 26-in. version holds cards as long as 400 mm.

The dual-card-cage enclosure holds cards as long as 220 mm; you mount the cards in the front and rear of the enclosure. The 8.75-in. MaxChassis houses single-height cards while providing an air-intake and exhaust area for cooling; the



14-in. model accommodates doubleheight cards. The company plans a 19.25-in. enclosure that will suit Futurebus, Nubus, and custom applications.

The enclosures come completely

wired and include ac and dc power connections, fans, a system-failure indicator, an ac-power-failure indicator, and a system-reset function. The MaxChassis comes with either a 400 or a 600W power supply. When you purchase two card cages for the enclosure, the vendor provides two 400W power supplies. The 400W supplies provide 60A at 5V and three channels of $\pm 12V$ at 8A. Each of these supplies includes its own internal fuse in addition to the fuse that's part of the enclosure. Each supply also includes an internal fan. The MaxChassis costs \$3295 to \$3929, depending on configuration.

Scanbe, Box 4159, El Monte, CA 91731. Phone (818) 579-2300. TWX 910-587-3437.

Circle No 717

Glass-epoxy leadless chip carriers eliminate thermal-expansion problems

Fabricated from glass-epoxy pcboard laminate, Epic leadless chip carriers (LCCs) eliminate TCE (thermal coefficient of expansion) mismatch problems when you surface-mount them on glass-epoxy pcboard substrates.

The chip carriers feature a double-sided glass-epoxy base that is metalized with leadouts and a bonding pad for the semiconductor die. A spacer laminated to the base provides a cavity for the die. Each chip carrier also has a lid that you attach with adhesive after you've mounted the die. The base metalization allows you to use standard wire-bonding techniques between the die and the carrier. You attach the die to the chip carrier with thermal epoxy that is loaded with metal to improve its thermal resistance. The standard package's total thermal resistance is around 92°C/W; carriers having a thermal resistance as low as 4°C/W are available as an option.



The leadout metalizations have a typical resistance of $<0.1\Omega$ and an inductance of <5 nH. Combined with a lead-to-lead capacitance of approximately 0.2 pF, these parameters provide lead-induced propagation delays as low as 25 psec. Epic chip carriers are available in versions with 8 to 256 leadouts. A typi-

cal 16-leadout carrier costs $\pounds 0.20$ (1000), and a typical 84-leadout carrier costs between $\pounds 1.50$ and $\pounds 2$ (1000).

Tectonic Products Ltd, Oxford Rd, Wokingham, Berks RG11 2YD, UK. Phone (0734) 782340. TLX 847569.

Circle No 716

Blowers use permanently lubricated ball bearings for long operating life

The Muffin DC, Sprint DC, Biscuit DC, Patriot DC, and Major DC are precision-aligned blowers. The latest models of these fans have permanently lubricated ball bearings that give them an operating life of 85,000 hours at 40°C and allow them to operate in temperatures as high as 72°C.

The fans take advantage of the manufacturer's ThermaPro-V technology, which allows you to program the fans, regulate their voltage, and thermally control their speed. The blowers' current-limiting features lower the start-up and rotor currents.



The ThermaPro-V controls internal temperature variations au-

tomatically; the fan's motor speed is controlled by a temperature-sensitive resistor that provides continuous temperature monitoring. Because the fan's speed is directly related to temperature, you can use a much smaller fan than your system would otherwise require. Muffin DC, \$19.10; Sprint DC, \$21.60; Biscuit DC, \$38.75. With thermal speed control, the Patriot DC and Major DC cost \$73.61 and \$75.40, respectively.

Comair Rotron, North St, Saugerties, NY 12477. Phone (914) 246-3615. TWX 510-247-1941.

Circle No 718

It doesn't take much to make an impression on our new mass airflow sensor.

Our new microbridge mass airflow sensor provides hairsplitting resolution of flow rates between zero and 200 sccm, with a response time of under five milliseconds. And thanks to batch chip processing and individual laser trimming, output remains consistent from sensor to sensor without recalibrating.

For medical applications, a unique design consisting of twin sensing elements on a micromachined, silicon-based chip enables the sensor to detect direction, as well as rate, of flow.

815-235-6600.

And its small package size, analog output, and 30 mW power consumption make the sensor compatible with microprocessors and other electronic devices like those used in environmental and process control systems. For more information, write The Sensor Consultants at MICRO SWITCH, Freeport, IL 61032. Or call

Together, we can find the answers.

a Honeywell Division CIRCLE NO 135



Two-piece connections for every itinerary.

Get on board now with the world's biggest selection.

Name your application—our two-piece connector schedule covers every stop on the map.

Need maximum reliability and flexibility in a medium-to-high pin-count application? AMP Box Contact Connectors and high-density AMP-HDI Connectors feature four-way contact on every pin. Very reliable. Very forgiving of pin angle during mating and unmating. And both also offer power and coax contacts—big design help in those crowded little corners.

Headed for design-wide compatibility? AMPMODU two-piece connectors are part of a complete, cost-saving, modular system, featuring shortened signal paths for high-speed designs. Or, go Eurocard. The European standard for over 10 years, now used everywhere. And now available everywhere—from AMP.

Whatever your destination, AMP has the twopiece connectors you need, engineered for quality, reliability, and—especially with our compliant-pin option—increased productivity.





AMP, AMPMODU, AMP-HDI and ACTION PIN are trademarks of AMP Incorporated. EDN December 10, 1987



How To Keep Your Messages From Being Repeated All Over The Place.

If your data communications network spans up to three kilometers, nothing will transmit information more reliably than Siecor's ODCL1—our optical digital communications link. Because unlike copper cable, our multimode fiber optic link lets messages go the distance without using repeaters. And since repeaters can compromise signal clarity, the link is superior for delivering data intact. So you don't have to re-send information.

Furthermore, the ODCL1 has a transmission rate from DC up to 2 MBd—many times faster than coaxial transmissions. And the ODCL1 is economical since it provides full duplex asynchronous transmission over one fiber optic duplex cable—cable that gives the greatest possible security.

In addition, the link can be used for RS232 DCE

or DTE devices. And we offer it for RS422, RS423 and TTL standards, too, with each providing either SMA or DIN optical connectors.

Fact is, no other electrical-to-optical modem offers faster, more reliable performance than the ODCL1. Because no one knows more about electro-optic products than Siecor. Our line includes high speed data links, fiber optic switches, clock recovery modules, clock oscillators and parallel/serial converters.

So find out more about the ODCL1 and all our products. Write Siecor Corporation, Electro-Optic Products, PO Box 13625, Research Triangle Park, NC 27709-3625. Or call 919 549-6571.



CIRCLE NO 133



LCC SOCKETS

The IC75 Series sockets are used with 68-pin LCC devices. An aluminum heat sink is optional. Two versions accommodate either a 68-pin JEDEC type A or a 68-lead JEDEC type B ceramic LCC. The sockets feature polyphenylene sulfide bodies, stainless-steel covers, and beryllium copper with gold-over-nickel-plating for the contact material. The maximum operating temperature is 150°C. \$4.01 (1000). Delivery, stock to six weeks ARO.

Nepenthe, 2471 E Bayshore Rd, Palo Alto, CA 94303. Phone (800) 637-3684; in CA, (415) 856-9332. TWX 910-373-2060.

Circle No 526

cycle, high-load industrial applications and in high-cycle, lowload furniture environments. The series features a ball-bearing design in a $\frac{3}{4} \times 2\frac{1}{4}$ -in. configuration. Load ratings for the series vary from 175 lbs in high-cycle applications to 250 lbs in low-cycle applications. Slide lengths of 12 to 30 in., with travels of 13 and 31 in. respectively, are available.

The slides incorporate cushion stops at both the open and closed positions. A closed position detent holds the drawer of the chassis closed, and sequential slide action enhances slide life. Optional locking provisions are offered on some versions. The slides are fabricated of C1010 cold-rolled steel for strength, and they feature a full complement of ball bearings. \$5 (OEM qty). Delivery, eight to 12 weeks ARO.

Jonathan Mfg Corp, Box 3J, Fullerton, CA 92634. Phone (714) 526-4651. TWX 910-592-1241.

Circle No 525



STEEL SLIDES

The 475/476 compact steel slide series accommodates the multipleload ratings required in both low-



HEAT SINK

The 5922B heat sink features spring-action clips that permit quick mounting to TO-218 semiconductor devices. Because of the tight metalto-metal contact provided by its spring-clip mounting, the black heat sink minimizes the problem of air gaps between the semiconductor device and the heat sink. Such air gaps decrease the efficiency of the device's thermal transfer. The device's dual-channel fins produce additional surface area for air circulation and heat removal. With an input of 8W, the 5922 has a thermal resistance of 8.75° C/W under conditions of natural convection. \$0.43 (1000).

Aavid Engineering Inc, Box 400, Laconia, NH 03247. Phone (603) 528-3400.

Circle No 528



BREADBOARDS

According to the vendor, the JE20 Series solderless breadboards provide a quick and efficient way to build circuits. They feature screenprinted coordinates that allow you to easily locate contact points, and slide-together strips that allow you to form larger-than-usual working areas. They are available with nickel-plated spring clips, which can withstand over 5000 insertion cycles; they are covered by a lifetime warranty. From \$2.49 for a 100contact breadboard strip to \$39.95 for a 3220-contact board with an aluminum grounding plate and four binding posts.

Jameco Electronics, 1355 Shore-



The new HP PaintJet color graphics printer. Great color is only ½ the story.



© 1987 Hewlett-Packard Co

Hardware and Interconnect Devices

way Rd, Belmont, CA 94002. Phone (415) 592-8097. TLX 176043. Circle No 527



HEADERS

The 609-xxxxx-x family of pin-strip headers provide an interface to Ansley female sockets, Flexpac female socket systems, and other connector interfaces. The devices are available in single- or double-row versions and can be cleaned and separated at any desired length. They are available in two pin lengths: 0.240 in. and 0.318 in. Two solder-tail pin lengths accommodate 0.062- to 0.125-in.-board thicknesses. The connector posts for the devices are 0.025-in² on a 0.1×0.1 in. centerline spacing. Straight- and right-angle post configurations are also available. The headers have a temperature rating of -55 to +125°C. \$1.29 (5000).

Thomas & Betts Corp, 920 Route 202, Raritan, NJ 08869. Phone (201) 469-4000.

Circle No 529

ENCLOSURES

The E Series enclosures feature a built-in fan-tray compartment that helps reduce design and fabrication costs. You can use them for 3U and 6U 19-in. subrack applications. Complete companion subracks and accessories that accommodate VME



Bus and Multibus II applications are also available. The enclosures are constructed of aluminum extrusions, sheet metal, and die-cast bezels. Retractable feet with nonskid rubber inserts are standard features. You can specify that from one to nine fans be installed in a variety of locations within the enclosures. A 3M filter media is also available in a variety of six densities to serve in different applications. The filters



CIRCLE NO 12

Hardware and Interconnect Devices

are available in snap-in modules. From \$160 to \$170.

Tracewell Enclosures, 7032 Worthington Galena Rd, Columbus, OH 43085. Phone (800) 848-4525; in OH, (614) 846-6175. Circle No 530

TEST SOCKETS

This line of sockets for either test or burn-in applications is available with 24, 28, 32, 40, or 48 pins. The sockets' contacts are tin- or goldplated beryllium copper for temperatures to 105° C (tin) or 150° C (gold) and for 200° C (50 µm NiBo over CuNiSn spinodal alloy). The sockets' broad contact area allows devices on 0.3-, 0.4-, and 0.6-in. centers to be tested in the same socket. The contacts are normally closed. This configuration provides consistent force of contact and prevents contact deformation due to over-



sized loads. It also eliminates dependence on plastic to sustain contact.

The socket bodies are UL94VOrated plastic, with 1000-M Ω min insulation resistance, 1000V ac min dielectric withstanding voltage, and a 1A contact rating. The devices can sustain more than 50,000 insertion cycles, and the socket contacts accept leads that are from 0.015- to 0.045-in. wide. The sockets can be mounted directly on a pc board on either 0.3- or 0.6-in. DIP hole patterns. A 24-pin tin-plated socket, \$3.87; a 24-pin gold-collet, tin-shell receptacle, \$3.62 (100).

Aries Electronics Inc, Box 130, Frenchtown, NJ 08825. Phone (201) 996-6841

Circle No 531

F-O CONNECTORS

Optimate ceramic-ferrule, singlemode connectors offer physical contact (PC) tip geometry to minimize connector loss and back reflections. The insertion loss averages <0.3dB; the return loss averages -36dB. The 2.5-mm threaded, 2.5-mm bayonet, and 2.0-mm threaded



styles are compatible, respectively, with most FC/PC, ST/PC, and D4/PC types. They provide accurate and repeatable fiber-optic termination for 125- μ m single-mode fiber in either a 2.5- or a 3.0-mm-diameter cable jacket.

The threaded styles are spring loaded. The spring loading and a cable-strength member crimp absorb cable stresses, thus maintaining undisturbed optical transmission during cable use. All three styles use a precision ceramic ferrule to maintain low insertion loss. These enhanced fiber-optic connectors are available as field-installable kits for fast termination, using the vendor's hand tools or as pigtails, jumpers, and hybrid assemblies. From \$27 to \$30 (100).

AMP Inc, Box 3608, Harrisburg, PA 17105. Phone (717) 564-0100. Circle No 532

BACKPLANE

The High Density Plus Two line of modular-backplane and daughterboard connectors is a 6-row version of the manufacturer's High Density Plus family. Each connector module, no wider than a conventional 4-row connector and measuring no more than 2-in. long, contains four rows of signal contacts on a 0.1-in. grid plus two additional rows of low-inductance contacts placed on the edges of the insulator housing. These additional contacts are useful for ground or power applications, and eliminate the use of signal pins for power and ground routing.

The modular continuous-grid architecture of the connectors allows



you to combine individual modules end to end in any high-density configuration. In addition to the standard signal modules, the system provides other modules for power distribution, polarizing, and guidance. From \$0.20 to \$0.26 per mated signal-contact pair. Delivery, eight to 12 weeks ARO.

Teradyne Connection Systems Inc, 44 Simon St, Nashua, NH 03060. Phone (603) 889-5156. TWX 710-228-1431.

Circle No 533



ARCNET INTERFACE

The S871P ArcNet network-interface module links STD PC-compatible computers to the ArcNet localarea network. It features an activity LED, which indicates proper network operation and remains lighted while the token is passed through the network. The device is also compatible with standard PC-network operating systems such as Novell's Netware and provides a low-impedance or fiber-optic output. The design is implemented in CMOS and features a 2k-byte data-packet buffer, which is memory-mapped. The control status ports are I/O mapped. The network provides a 2.5M-bit/sec token-passing protocol. \$495.

Contemporary Control Systems Inc, 2500 Wisconsin Ave, Downers Grove, IL 60515. Phone (312) 963-7070. TLX 314990.

Circle No 534



TERMINAL STRIPS

The 223 Series terminal strips provide a high-density printed-circuitsolderable terminal strip on 0.1-in. or 2.5-mm pin centers. Because they are modular, they can be quickly assembled to any desired length. The strips also incorporate an integral actuating lever that's used to open the clamp for wire insertion and removal. The stainless-steel cage clamp has high vibration, corrosion, and thermal resistance and can handle 28- to 20-AWG solid or stranded wire, or as high as 18 AWG, if the wires are not placed in adjacent positions. A version without an actuating lever is available, which can be factory or field wired with a small plastic tool or a smallbladed screwdriver. \$0.22/position (1000).

WAGO Corp, 6657 N Sidney

IF YOU'RE WASTING TIME LOOKING FOR THE BROADEST LINE OF SMD[®] PASSIVES,

CUT IT OUT!

												1
												7 8

Mail to: Mepco/Centralab, Inc., Attn: Corp. Advertising 2001 W. Blue Heron Blvd., Riviera Beach, FL 33404.

Mail this coupon today to request your personal copy of the new Mepco/Centralab Surface-Mount Device Catalog, containing important design, performance and speci-fying data on America's broadest line of SMD® passive components:

- Tantalum and monolithic ceramic chip capacitors
- Aluminum electrolytic capacitors
- Thick-film and precision metal-film resistors
- Power resistors

 High-performance trimmers Or ask for our valuable data book on leaded resistors and capacitors.

Please send me these specification guides: **1987 Surface-Mount Device Catalog Resistor/Capacitor Data Book**

Name	
Title	1.1.1
Company	
Dept. / Div.	
Address/MS	
City	
State/Zip	

DN 12/10

MEPCO	CENTRALA	8
	A NORTH AMERICAN PHILIPS COMP	AN

THE ACTIVE LEADER IN PASSIVE COMPONENTS

[®]SMD is a service mark of North American Philips Corporation.

Large, angled marking surfaces for easy labeling and readability.

Coding system protects against misconnection without loss of poles.

Funnel-shaped entry for easy installation of wiring. Non-burning, heat and humidity-resistant insulating material.

Available in 2 to 24-pin vertical and horizontal *configurations*.

Captive screws.

Introducing the Weidmuller BLA/SLA Plug and Socket Connector System.

For years Weidmuller ter-



minal blocks and connectors have set the standard all over the world in electrical and electronic connection systems.

engineers have come up with another brilliant solution. Our

compact new BLA/SLA System for machine and process control circuit boards.

Our new design makes it quick and easy to install and repair wiring at the factory and in the field without expensive

tools. Refinements include Optional cover with funnel-shaped wire entries. captive screws, and an improved

© Weidmuller, Inc. 1987 Patents Pending

ester insulating material of BLA/SLA connectors is non-burning (UL94V-O) and heat and humidity resistant to maintain pinoperating environments.

design for easy wire installation and removal. Now, our design



ease of labeling and reading. The design of BLA/SLA connectors prevents misalignment. And, thanks to our simple new coding system, the BLA/SLA System provides protection against misconnection of plug and socket when you're using more than one connector.

Marking surfaces on the

sockets are large and angled for

mechanism for a secure

connection.

All without loss of poles. Weidmuller BLA/SLA connectors are available in 2 to 24-pole modules. They come in



both vertical and horizontal configurations. A doubleheader version is available for applications requiring even greater wiring density.

With so many standard features and with such options as supplementary mechanical mounting

to-pin spacing in adverse Doubleheader version available for increased blocks and strain relief wiring density covers, we're confident you'll

> find BLA/SLA the best system available for connecting discrete wiring to printed circuit boards.



Optional mechanical Call or write mounting provides additional stability.

for more information about the Weidmuller BLA/SLA.

A system whose brilliance you'll appreciate even if you're color-blind.



Write Weidmuller, Inc., 821 Southlake Boulevard, Richmond, Virginia 23236. Phone (804) 794-2877. Telex: 828376. **CIRCLE NO 131**

Hardware

Pl, Milwaukee, WI 53209. Phone (414) 352-1035. TLX 260123. Circle No 535



TERMINAL STRIPS

The Beau Eurostyle Series 85 pcboard-mounted terminal blocks are constructed of thermoplastic and maintain center-to-center spacing when they're mounted end to end; they feature dead-front construction to prevent shocks and shorting. The manufacturer claims that the blocks' captive wire protectors provide better connection and hold wires more securely than other techniques.

The devices have a high-density, 0.197-in. contact spacing in the terminal blocks. They provide as many as 5 terminations/in. and have an estimated UL current rating of 15A. The strips also feature captive screws that won't fall out and damage your equipment; large-wire entry that accepts wire to 14 AWG; and a closed side that acts as a wire stop. \$0.12 per circuit (500).

Vernitron Corp, Beau Products Div, Box 10, Laconia, NH 03247. Phone (603) 524-5101. TWX 710-364-1843.

Circle No 536

DESKTOP ENCLOSURE

The Vario-Case desktop enclosure features sidewalls of extruded aluminum sections; the covers and rear wall are made of ABS plastic. ABS



is self extinguishing in accordance with UL 94 VI. The enclosure's design allows the mounting of either 19-in. subracks or modules, as well as direct modular assembly and insertion of pc boards.

The extruded aluminum sidewalls feature 0.49-in. vertical grooves that enable the 19-in. card frames and modular assemblies to be mounted at variable positions. The sidewalls also have tapped inserts at various depth positions.

The enclosure's feet, made of fiberglass reinforced polyamid, can be unfolded to ensure the safe stacking of several enclosures, without the risk of slipping. The feet cover the screw attachments when completely folded and can be unfolded to two positions, providing two angles of tilt with respect to the desk top. Vario-Case, \$109.31 to \$296.24; Vario-Rack, \$799.88 to \$1235.25.

Rittal Corp, Box 1284, Springfield, OH 45501. Phone (513) 325-1141. TLX 241354.

Circle No 537

TEST CLIP

According to the manufacturer, the Bug Catcher PLCC (plastic leadless-chip carrier), a test-clip adapter for integrated circuits, provides you with the first available method to help debug software and hardware in a PLCC. The device mates with a plastic leadless-chip carrier socket via the side pins and spacer block assembly. This interconnection scheme eliminates the need for long cables between the UUT and the test equipment, lowering the capacitance and inductance introduced in the circuit by the test setup.



NOW-PROTOTYPE IN SURFACE MOUNT

VECTORBORD plus[™] PRISM[™]

Combine surface mount devices

(SMDs) with thru-hole components.

For all VECTORBORD® and

VECTORBORD plus™Plugbords™

including IBM, Apple, and Eurocard.



800/426-4652 In CA 800/423-5659 Outside CA 128

127

Your Best Source for Test Clip Accessories is POMONA ELECTRONICS

DO-IT-YOURSELF MAXI-GRABBER™ TEST CLIP: **DO-IT-YOURSELF MICRO-DO-IT-YOURSELF SMD GRABBER™ TEST CLIP: GRABBER**[™]: MODEL 5243 MODEL 4233 MODEL 4225 **DO-IT-YOURSELF MINI-**PATCH CORD; MINIGRABBER GRABBER™ TEST CLIP: TEST CLIP BOTH ENDS: MODEL 3781 **MODEL 3925** 16 PIN DIP CLIP ** TEST CLIPS: MODEL 3916A (LEFT) STAN-DARD; MODEL 4236A (RIGHT) FREE 1987 GENERAL CATALOG SOIC CLIP[™] TEST CLIP: MODEL 5250 (8 PIN); 5251 (14 PIN); 5252 (16 PIN) SHOWN; 5253 (20 PIN); POMONA ELECTRONICS TEST ACCESSORIES **HIGH DENSITY** 5254 (24 PIN) 1987 TTT Pomona Electronics 1500 E. Ninth St., Pomona, CA 91766 Tel: (714) 623-3463

Our Products are available through your favorite electronics parts distributor.

Hardware



The device utilizes two doublesided circuit boards, one JEDEC standard PLCC socket, 68 test points that are each 0.025-in², 68 side pins, one spacer block, and one overlay template. The spacer block prevents the collapse of the side pins from the force exerted by the PLCC socket after the adapter is inserted in the socket, and it ensures a secure fit. The template aids in pin identification. \$160.

Emulation Technology Inc, 422 Ives Terrace, Sunnyvale, CA 94087. Phone (415) 960-0652. TLX 184817.

Circle No 538



MIXED CONNECTOR

Designed for an industrial ink-jet manufacturer, the Peek mixed connector combines fluidic/pneumatic contacts with coaxial, high-voltage, and standard signal contacts. The connector is housed in the vendor's size 5B shell. Four 50Ω coaxial contacts, two 5-kV contacts, eight signal contacts, and four fluidic contacts permit the fluid to be transmitted to and from the printheads. The Peek insulated connector is guaranteed for 5000 mating cycles and features a quick connect and disconnect self-latching system. The test voltage is 1800V, and the working voltage is 600V. The 8A rated current accommodates a 22-AWG max wire size, and the maximum working pressure is 10 Bar. The working temperature ranges from -40 to $+80^{\circ}$ C. The passage diameter for the fluidic connection is 1.3 mm and the tubing inside diameter is 1.6 mm. \$266.24 per mated pair (500). Delivery, 20 weeks ARO.

LEMO USA Inc, Box 11488, Santa Rosa, CA 95406. Phone (707) 578-8811. TLX 340-933.

Circle No 539



ENCLOSURES

The 508 Series enclosures come in $3\frac{1}{2}$, $5\frac{1}{4}$, 7-, and $8\frac{3}{4}$ -in. sizes with four to 10 available card slots in the enclosures. The units are constructed of aluminum with a brushed or polyurethane textured finish. The configurations include the desktop model with EIA mounting flanges that allow you to remove the front panel when it is loaded in the 19-in. rack.

All the units feature positive pressurized filtered plenum air cooling for controlled air flow throughout the enclosure, as well as even cooling for both the power supply and the card rack. You can reach the fans by removing just two screws, and because of the airflow design, you can slide-mount the fans without any loss in the cooling capabili-Text continued on pg 132



WHAT'S NEW FOR MAC II & MAC SE

Open architecture.

Expansion power: VECTORBORD PLUS."

High speed prototyping boards,

test extenders and accessories.

Eight models available now.

Vector-41 years industry standard.

High Density proto boards for DIPs and PGAs Multilayer power and ground planes. SMT caps and socket pins installed. Bracket w/ expandable I/O port available separately



Call for brochure.

VECTOR ELECTRONIC COMPANY 12460 Gladstone Avenue Sylmar, CA 91342 818/365-9661 FAX 818/365-5718

800/426-4652 In CA 800/423-5659 Outside CA

EDN December 10, 1987

Four competitors had no solution to this tough connector problem.



Working closely with customer engineers the RN "P/Q Team" designed, produced, tested and delivered a state-of-the-art connector that had never been made before. And they did it within the 16-week time frame required by this major OEM customer. Four major connector firms had already indicated that it could not be done!

The incorporation of this new RN connector enabled our OEM customer to reduce his product size by 80%...improve operating reliability by 300%.

This is the RN "Partners in Quality Team" in action. It brings all of our engineering, production and quality control resources together with customer experts to solve socket and connector problems with speed and efficiency. Call on the RN "P/Q TEAM" for *your* interconnect solutions.



This is the connector competition couldn't make! It is a state-of-the-art compression connector with contacts on 50-MIL centers. It features retent solder tails for robotic board placement and withstands IR reflow surface mount soldering. It also maintains contact integrity in extremely difficult operating environments.

CIRCLE NO 112



800 East Eighth Street, New Albany, Indiana 47150 • Phone: (812) 945-0211 FAX: (812) 945-0804 In Europe: Rue St. Georges 6, CH 2800 Delemont, Switzerland • Phone: (066) 22 9822 FAX: 011-41-622-9813

The RN "Partners in Quality Team" delivered a state-of-the-art connector in 16 weeks!



RN offers a wide variety of DIN Connectors. Half-size, standard and high density DIN connectors—120 or 150 positions. Completely repairable solderless FLEX PRESS™ contacts in male and female styles. Custom Early Mate/Late Break grounding pin location. Available in "better than gold" ROBEX® plating. Write for complete catalog.

CIRCLE NO 113

"The RN 'P/Q TEAM' concept brings all of our design, engineering and production skills to bear on your unique socket/connector problems. We work closely with your people to create solutions that are delivered on-time and defect-free. You have my personal guarantee on it."

R. A. Lindenmuth President/CEO





Write or call today for the comprehensive new brochure: "The RN P/Q Team in Action". You'll learn how smart companies are putting the brains, resources and experience of RN engineers to work to solve tough interconnection problems with speed and efficiency.

CIRCLE NO 114



The RN "P/Q TEAM"...your Partners in Quality

ty. The enclosures also accommodate any Mupac backplane for Multibus, Multibus II, and VME Bus systems. From \$1400.

Mupac Corp, 10 Mupac Dr, Brockton, MA 02401. Phone (800) 225-0398; in MA, (617) 588-6110. TWX 710-345-8458.

Circle No 540



CONNECTORS

The Lat-Con 2-row transition connectors are 0.05-in. flat-cable connectors. Designed for permanent attachment to pc boards. they eliminate the need for headers. They are furnished with a preassembled socket and cover but are open on one end for lateral cable insertion. The manufacturer claims that this arrangement significantly speeds and simplifies the mass termination of 28-AWG flat cable. They are available for 10 to 64 circuits, with 0.1-in. row spacing. You can get them with either 0.118- or 0.157in. solder pins plated with 315 µin. of tin. From \$0.53 to \$3.67.

Panduit Corp, 17301 Ridgeland Ave, Tinley Park, IL 60477. Phone (312) 532-1800.

Circle No 541

PROTOBOARDS

According to the manufacturer, the Protoboard Series prototyping panels have several advantages over wire-wrap prototyping panels. The boards are 100% tested on a bed-ofnails tester, allowing the debugging effort to concentrate on circuit design, rather than wiring errors; they feature a 0.1-in. hole pattern that allows you to use a variety of packaging types; the use of 38-AWG



wire provides high packaging densities; and you can mount the boards in single slots, allowing greater utilization of card racks. The boards' matrix of plated-through holes, all of which are drilled, makes it easy to add components at the bench. Four of the five new Protoboards are Mupac compatible and the other is Multibus compatible. Mupac 326-328-compatible Protoboard, \$850; the Mupac 347-compatible board. \$1500; Mupac 9U ×400-compatible board, \$1700; Mupac 9U ×220-compatible, \$830; and Multibus I-compatible, \$485.

Multiwire/East, 250 Miller Pl, Hicksville, NY 11801. Phone (516) 933-8300.

Circle No 542



DATA CABLES These 62.5/125-µm fiber-optic data cables for data and LAN applications are available in two performance levels: a high-performance 3.75 dB/km attenuation at 850 nm and a 160-MHz-km bandwidth; and a lower-performance cable that attenuates 5.0 dB/km at 850 nm and a 100-MHz-km bandwidth. The higher-performance cable's specifications meet the requirements of the IBM 3044 channel-extender system.

The cables come in both loose and tight buffer constructions with strength members of Kevlar, fiberglass epoxy rod, steel, or a combination of fiberglass, epoxy rod, and Kevlar. The number of fibers in each cable varies from one to 18. Standard lengths for the cables are 500, 1000, 3280, and 6560 ft. From \$218 to \$4321.

Belden Wire and Cable, Box 1980, Richmond, IN 47375. Phone (800) 235-3364.

Circle No 543



SOCKETS

The IC134 Series SOJ autoeject burn-in sockets are intended for use in high-density burn-in applications. The low-insertion-force sockets have two options for loading and unloading: manual or automatic. Using the sockets' autoeject feature, you can easily extract the device after testing. The side gaps provide thermodynamic airflow for efficient heat dissipation. The socket material is polyetherimide, and the contact material is beryllium copper with

PAPST

Choosing the right fan for your application is easy, when you choose PAPST. Simply because PAPST offers the broadest line of AC and DC tubeaxial fans in the world.

We also offer you some of the newest and most innovative. Like our new 48-volt DC MULTIFAN, our new sleeve bearing 80mm DC MULTIFAN, 6-inch DC fans with speed sensing or alarm circuitry, and our latest 25mm SLIM LINE series of AC fans.

All PAPST fans are designed to deliver high reliability, low noise, and low power consumption. They all feature the PAPST concept of Mechatronics - electronic commands efficiently converted into direct mechanical movement. And they're all backed by one of the largest sales and technical support organizations in the country.



So if you don't want to waste a lot of time finding the wrong fan, spend a little time and call or write for our free catalog. It will help you find the fan you need. Fast.

PAPST MECHATRONIC CORPORATION, Aquidneck Industrial Park, Newport, RI 02840. (401) 849-8810 Telex 952092 1-800-551-6245 (Continental USA except for MA) 1-800-262-5226 (MA only)

CIRCLE NO 129

There's a quiet revolution in cooling. And PAPST is the leader.



A SILCOME CURE FASTER THAN YOU CAN BEAD THIS AD.

Ready. Set. Go! By the time you've read this ad, Loctite's 30-second curing NUVA-SIL[™] silicone

could have already raced through your production line. No more curing racks. No more humidity chambers. No more overhead conveyors. No more assembly mess or production delays.

The secret to ultra-fast cure: a breakthrough in LIV-curing

breakthrough in UV-curing chemistry that

> gives you the full per-

formance





Ordinary silicones: L 90 min. cure time

Loctite NUVA-SIL: 30 sec. cure time, same performance without

the wait. And, combined with the new breed of automated UV curing equipment, you'll have the industry's most costeffective coating, potting, sealing,



bonding, gasketing, and strain relieving technology in your hands.

If you're spending \$5,000 or more a year on conventional silicone, let us get you up to speed on the newest production advantage. For details on NUVA-SIL, call (203) 246-1223. *Time's up!*



© 1987 Loctite Corporation, Newington, CT 06111. Loctite Canada. Inc., Mississauga, Ontario L4W 2S3. NUVA-SIL is a trademark and Loctite is a registered trademark of Loctite Co

gold-over-nickel plating. The operating temperature ranges from -40 to +175 °C. The 26-lead model, \$7 (1000). Delivery, stock to six weeks ARO.

Nepenthe, 2471 E Bayshore Rd, Palo Alto, CA 94303. Phone (800) 637-3684; in CA, (415) 856-9332. Circle No 544 panel provides you with direct access to connectors and displays. Version 5 performs a similar function for version 2 adapters. Versions 1 and 2, \$400; version 3, \$175; versions 4 and 5, \$565.

Dawn VME Products, 47073 Warm Springs Blvd, Fremont, CA 94539. Phone (415) 657-4444.

Circle No 545



ADAPTERS

These form-factor adapters for interface to Sun Microsystems Computers provide size conversion from a standard 6U VME Bus to a Sun 9U configuration. They are available in five different models. Versions 1 and 2 are used as direct replacements for Sun models 160A and 160B. They differ from one another in that version 1 passes the A and C row signals to the Sun P2 proprietary bus, but version 2 doesn't. Version 2 isolates the P2 connector A and C signals from the Sun backplane. Both versions connect P2 A and C row signals to a 64and a 50-position ribbon header.

Version 3 is a low-cost adapter for direct installation of a standard VME board into a Sun configuration. Version 4 is similar to version 1 except that it brings the front panel of your board forward to make it an integral part of the Sun front-panel system. This movement of the front



ACTIVE HUB

The 4012 rack-mounted active hub interconnects devices in an ArcNet local-area network and retransmits data to all nodes on the network. It supports various cabling schemes, such as coaxial, fiber-optic, and twisted-pair cabling. It supports these cabling schemes by using lowimpedance, high-impedance, and fiber-optic expansion modules that plug into the hub.

The device's master/slave design allows one master node to drive as many as 11 slave nodes. The hub is expandable from four to 48 nodes in groups of four: Twelve slots have four points/slot. The 7-in. panel height allows the hub to fit into a standard 19-in. rack. Further, you don't need to terminate any of the device's unused ports. \$1095.

Contemporary Control Systems Inc, 2500 Wisconsin Ave, Downers Grove, IL 60515. Phone (312) 963-7079. TLX 314990.

Circle No 546

CABLE

The Trans-E-Twist Interconnect cable features alternating lengths of 18-in. sections of twisted pairs followed by 2 in. of flat parallel wires.



The cable is UL listed for internal and external interconnections on electronic systems. The twisted pairs have alternating lay directions to keep crosstalk at a low level. The flat areas allow mass termination of the cable. The cable is compatible with standard insulation-displacement connectors. The cable is available with as many as 36 twisted pairs, using 26-, 28- and 30-AWG stranded tin copper. Low-loss highspeed insulation systems are also available. For each 1000-ft length of twisted-pair cable, \$50.

Brintec Corp, Brand-Rex Cable Systems Div, 1600 W Main Street Willimantic, CT 06226. Phone (203) 456-8000.

Circle No 547

CONNECTORS

The D3 (also called NFC) Series fiber-optic connectors are compatible both performance-wise and mechanically with the industry standard FC fiber-optic connectors. They are packaged as a kit with only three pieces: a ferrule, housing, and a rubber boot. Because the connector uses a glass capillary instead of a ceramic capillary, it can be polished with inexpensive alumina films and water, rather than diamond films and ultrasonic cleaning. The connector also features four keyways that are built-in, allowing you to easily select the lowest-loss key position. Multimode ferrule and housing, \$12; single-mode ferrule and housing, \$18; multimode 5m patchcord, \$93; single-mode 5m patchcord, \$169.

NEC Electronics Inc, Box 7241, Mountain View, CA 94039. Phone Text continued on pg 138 135



Plug new sales appeal into your system with Du Pont Latch-N-Lok Shielded Assemblies.



Any color.



Angled or straight.



"Click"-it's connected.



The smallest package.

Only Latch-N-Lok[™] modular interconnections offer so many attractive, functional combinations in cords, colors and connectors to give your system the sales appeal it deserves.

Now you can specify the most compact plugs and receptacles available, in straight, right-angle or combination designs, with the latch on top, bottom or side of the plug. Receptacles come with panel, chassis or board mounts. Order your cords coiled or straight, in any length, with any number of conductors, with foil, serve or braid shielding, and in a variety of jacket textures. All elements can be colorcoordinated to your system. You can even put your logo, trademark or pictogram on your connectors. Uses the patented PV[™] Receptacle and BergStik[®] Header.

The contact design used in Latch-N-Lok[™] has been proven in millions of applications. This means Latch-N-Lok[™] will stay on the job,



connection after connection, to keep your customer satisfied.

What's more, Latch-N-Lok[™] is the industry's only quick disconnect pin-and-socket system. An audible "click" tells you a positive plugto-receptacle connection has been made.

Even with all these benefits.

Latch-N-Lok[™] assemblies cost no more than standard types. Call toll-free **1-800-233-1173*** or write on your company letterhead to request a sample, our Latch-N-Lok[™] brochure, or a demonstration.

Latch-N-Lok[™] modular shielded interconnections: another development of Du Pont Electronics, 515 Fishing Creek Road, New Cumberland, Pa. 17070 *In PA, call 1-(800)-222-2194

Du Pont Electronics Share the power of our resources.



CIRCLE NO 127

(415) 965-6308. TWX 910-379-6985. Circle No 548

SOCKETS

The IC120 Series sockets are a group of low-insertion-force, autoeject PLCC sockets for use in highdensity, burn-in applications. Both dead-bug and live-bug versions are available. The sockets feature an insulation resistance of 1000 M Ω min at 500V dc, breakdown voltage is listed at 700V ac for one minute, and contact resistance is specified as 30 m Ω max at 10 mA/20 mV. The operating temperature ranges from -40 to +170°C. The typical socket life is specified as 10,000 insertions min. A 68-lead device, \$17.35 (250).

Nepenthe, 2471 E Bayshore Rd, Palo Alto, CA 94303. Phone (800) 637-3684; in CA, (415) 856-9332. Circle No 549



CONNECTORS

The DIN 41612 90°-connectors have right-angled press-fit pins for insertion in pc boards. The manufacturer has developed 64- and 96-place right-angle male connectors, female reversed Q, and female R rightangle connectors with compliant press-fit pins. A press-fit tool is used in conjunction with a standard hand-driven press that presses the connectors into place on a pc board. This tool eliminates the soldering process and also gets rid of the bonding and washing of the connectors that's usually required to prevent the soldering vapors from penetrating the connector. Male connector, \$2.18; female connector, \$5.67 (1000). Delivery, six to eight weeks ARO.

Erni Components, 520 Southlake Blvd, Richmond, VA 23236. Phone (804) 794-6367. TLX 559647.

Circle No 550

PROTOBOARDS

The JE400 Series prototyping boards feature a silkscreened legend on the component side which depicts the foil pattern and hole coordinate for the solder side of the board. The series covers a wide variety of sizes and applications that range from 2.7×4.5 in. to 5.0×13.25 in. It also includes a Commodorecompatible user-port interface pc board. The protoboards are made of laminated glass epoxy with 0.062in.-thick, 2-oz copper that's clad with a solder-tin finish; all holes have a 0.042-in. diameter on a 0.1×0.1-in. grid pattern. From \$7.95 to \$19.95.

Jameco Electronics, 1355 Shoreway Rd, Belmont, CA 94002. Phone (415) 592-8097. TLX 176043. Circle No 551



HEADER

Compatible with flat-cable femalesocket connectors, the Flex-Fit pliant contact header minimizes pcboard, plated-through hole deformation and conforms to the requirements of MIL-STD-2166. It can be removed and replaced without compromising the part's mechanical or electrical performance.

The header, with contacts on a 0.1×0.1 -in. grid pattern, is available in contact sizes from 10 to 64 pin positions, and it offers a number

of options such as lock/eject latches for positive-contact easy ejection. Polarization options include center key, dual key, and MIL-C-83503 (612 version). The header's insulation material is a glass reinforced thermoplastic. The contacts are plated in the contact area with gold over nickel. The header has a temperature rating of -55 to $+125^{\circ}$ C. \$1.15 (1000).

Thomas and Betts Corp, 920 Route 202, Raritan, NJ 08869. Phone (201) 469-4000.

Circle No 552

EXTENDER BOARDS

These two extender boards for the Apple Macintosh II consist of a multilayered design that offers high performance, low noise, and little crosstalk; and a 2-sided board for general-purpose use. The multilayered extender features a 5-laver design of copper-clad FR4 material with two 9-pin DIN connectors installed on the board. This board features decoupling capacitors and has a jumper field that allows each signal to be individually opened for testing. An additional DIN connector provides access to a bus analyzer, and a mounting bracket is available for attachment to the computer chassis. The 2-sided extender is constructed of 2-sided copper-clad FR4 material. Two 96-pin DIN connectors are installed on the board and a chassis mounting bracket is included. Multilayer version, \$295; 2laver version, \$69.

Vector Electronic Co, 12460 Gladstone Ave, Sylmar, CA 91342. Phone (818) 365-9661. TLX 269303. Circle No 553

SOCKETS

The company offers four versions of sockets for single in-line memory modules. These burn-in sockets accommodate $256k \times 8$ - or $\times 9$ -bit dynamic RAMs and $1M \times 8$ - or $\times 9$ -bit dynamic RAMs. The sockets are

Separate fan for motor cooling

> Brushless drive motor

Speed control (manual model) PWM controller and power supply Power input/speed control (remote model) Multiple-stage centrifugal fan system

Now, high performance vacuum/pressure blowers that operate from 120 VAC

Compact units feature brushless dc motors with integral controller and variable speed capability

These new Windjammer [®] blowers combine electronics, motor, and fan system in a compact, cost-effective package that operates from a standard 120 VAC input. An exclusive Lamb Electric design, they were developed for demanding, limited space applications such as business machines, medical equipment and



materials handling applications. Just 5.7" in diameter, the blowers have 1-, 2-, or 3-stage fans for performance from 50" H₂O vacuum at 0 CFM to 110 CFM at 0" H₂O. With one version, a 0 to 10 VDC signal from a sensor or other device will control motor speed and adjust air performance from 0 to 100%. Or, a second model provides manual speed control by means of a potentiometer located in the blower housing.

These blowers also feature low noise performance and are UL/CSA component recognized. Get complete details by contacting AMETEK, Lamb Electric Division, 627 Lake Street, Kent, OH 44240. (216) 673-3451. Telex: 433-2140. Cable: LAMETEK.

LAMB ELECTRIC DIVISION CIRCLE NO 126



available in 30, 35, and 72 pins (50and 100-mil spacing, single or double density). Actuation latches provide quick insertion and extraction of memory modules. The sockets' body material is polyethersulphone/ polyetherimide. The contact material is beryllium copper with goldover-nickel plating, and the operating temperature ranges from -40 to +170°C. 30-pin sockets, \$25 (1000).

Nepenthe, 2471 E Bayshore Rd, Palo Alto, CA 94303. Phone (800) 637-3684; in CA, (415) 856-9332. Circle No 554



TERMINAL BLOCK

The Dik 1.5 3-level terminal block is designed to save cabinet space and labor time when terminating 3-wire process control devices. The 3-level configuration allows for 12 terminations/in. The two lower levels of the terminal block serve as the positive and negative power supply terminals, and the top level is used to terminate signal lines. Wiring and busing of the voltage-supply lower levels is done with one screw/position. The device mounts on any conventional DIN rail and is rated for 25A at 600V. It can accept wire sizes to 14 AWG. \$2.30 (100).

Phoenix Contact, Box 4100, Harrisburg, PA 17111. Phone (717) 944-1300.

Circle No 555

COOLER

The Slimboy 17 Series air conditioner cools electronic controls housed in narrow enclosures. It features a cooling capacity of 2000 BTU/hr and has an overall package width of 12 in. The unit employs high-flow-rate ball-bearing fans and has built-in condensate evaporation. It's available in three mounting configurations: The standard model comes without mounting rails: a second model is available with top and bottom mounting rails; and a third model comes with side mounting rails. Its closed-loop design protects the sealed-in electronic controls and

At Corning, we engineer glass and glassceramics to meet your design needs. Here are a few applications that demonstrate the breadth of materials we offer:

A full line of CRT bulbs, ranging in size from .5" to 23", with the x-ray absorption and light transmission capabilities needed for high-reliability military and industrial applications.

FOTOFORM® glass and FOTOCERAM® glassceramic materials photochemically machined to precisely hold dimensional tolerances of ± 0.001" for use in interconnects and I.C. packaging.

Cladding glasses with excellent optical quality and dimensional stability for fiber optic applications, as well as the chemical stability required for microchannel plates used in nightvision devices.



Low-alkali glass sleeves to encapsulate highreliability diodes for military applications, electronic switches in VCR's, and other consumer electronics.

VYCOR® 96% silica glass with a thermal shock capability that can withstand the sudden and extreme temperature change of a defrost cycle —0° to 1000° F in seconds.

To find out how Corning glass and glassceramic materials can meet your design needs, write to us at this address:



CIRCLE NO 15

Materials Business Corning Glass Works

MP 21-3-4 Corning, NY 14831

HARD-TO-FIND SIGNALS A SOURCE OF DELAY?

Textronix 2465A CT

Look at the Tek 2465A with a 17-bit Word Recognizer. It's an easy, economical scope option that makes the critical difference when you need to trigger on data to monitor digital system performance. Parallel bus information triggers your display, so you can view up to four channels of real-time information. Add standard features such as 350 MHz bandwidth, on-screen cursors, 500 ps/div time base and trigger level readout, and you have a scope made for solving tough problems in digital design!

CUT IT OUT!

Please send me your free	
videotape introduction, "The	
2445A/2465A Family: From	
Performance to Productivity."	

Please send me your free 22-page brochure.

Please have a Tek representative get in touch with me as soon as possible to arrange a demonstration.

In a hurry? Call Tek direct **1-800-426-2200**

D888-6-38AX EDN

Yes! I want a closer look at the Tek 2445A/2465A Family.

Name			
Title Carter			
Company			-
Address			
City	State	Zip	
) Phone		Evt	



SCOPES CUT OUT FOR YOUR KIND OF WORK.

You can tailor the 2465A for spe-

cial needs. Or choose one of three multiple-option packages, the 2465A Special Editions. They are configured for specific application areas at a significant savings over the separately ordered options.

The 2465A CT with Counter/ Timer/Trigger offers crystalcontrolled timing accuracy plus the extra triggering power you need for digital systems.

Frequency and period can be measured with counter accuracy from any vertical channel directly. Or set up the scope to measure time intervals such as pulse width, rise time and propagation delay. Then store instrument setups in nonvolatile memory—for easy access and automatic execution.

Check Tek software development packages. They make it easy to generate automated and semiautomated test procedures, even without prior GPIB-programming experience. Use the simple, multi-

Key Features	2465A DV	2465A DM	2465A CT	2465A	2445A	
Probe Tip Bandwidth	350 MHz	350 MHz	350 MHz	350 MHz	150 MHz	
No. of Channels	4	4	4	4	4	
Horizontal Accuracy	2% (.001%*)	2% (.001%*)	2% (.001%*)	2% (.001%*)	2% (.001%*)	
Max. Sweep Speed	500 psec	500 psec	500 psec	500 psec	1 nsec	
Vertical Sensitivity	2 mV/div	2 mV/div	2 mV/div	2 mV/div	2 mV/div	
Trigger Frequency	500 MHz	500 MHz	500 MHz	500 MHz	250 MHz	
GPIB	Standard	Standard	Standard	Optional	Optional	
Counter/Timer/ Trigger/Word Recognizer	Standard	Standard	Standard	Optional	Optional	
Digital Multimeter	Standard	Standard	Not Available	Optional	Optional	
Video Trigger	Standard	Not Available	Not Available	Optional	Optional	
Probes	4	4	4	2	2	
Warranty	3 years on p	arts and labor.	including CRT			

*with Counter/Timer/Trigger

level menus to develop sophisticated test programs.

Software is available to operate with the Tektronix 4041 controller, IBM PC, XT,[™] AT[®] and compatibles. Get the full story! Return the reply card, or call your Tek Sales Engineer for a hands-on demonstration. To place an order or request product literature, call Tek direct: **1-800-426-2200.**



prevents shutdowns caused by heat, humidity, dust, or other contaminants. \$585 (25).

McLean Midwest, 4000 83rd Ave N, Brooklyn Park, MN 55443, Phone (612) 561-9400. TLX 290883. TWX 910-576-2951.

Circle No 556



CONNECTORS

These miniature DIN connectors offer pc-board and right-angle mount, a selection of four to eight pins, and male- and female-molded cable versions. They are available in either shielded or nonshielded models and have complete custom-design capabilities. From \$0.40 (OEM qty).

Shogyo International Corp, 287 Northern Blvd, Great Neck, NY 11021. Phone (516) 466-0911. TLX 12218.

Circle No 557



CABLES

The vendor's two low-loss miniature RGB coaxial cables are used with broadcast systems and color monitors. These 75Ω units eliminate the need for decoding equipment. They have a nominal capacitance of 17.3 pF/ft and a propagation-velocity factor of 78%.

The 1164A and 1167A Series consist of mini coaxial cables under an overall Mylar tape and black PVC jacket. Each cable has a Dataleneinsulated stranded 26-AWG silverplated copper-alloy conductor that is surrounded by a Duobond II foil tape and a tinned copper-braid shield. The 1164A Series has an RGB color-coded jacket, and the 1167A Series has a color-coded jacket of red, green, blue, and white. Per 1000 ft, in 500- and 1000-ft pullups, 1164A, \$1092; 1167A, \$1473.

Belden Wire and Cable, Box 1980, Richmond, IN 47375. Phone (800) 235-3364.

Circle No 558

F-O MODEM

The Series 9481-1G RS-232C fiber-

INTERCONNECT SYSTEMS DIVISION, MICRODOT INC. gives you a broad range of quality interconnecting devices.



The INTERCONNECT SYS-TEMS DIVISION-MICRODOT INC. has a longstanding worldwide reputation as a respected supplier of a broad array of electronic/ electromechanical connecting devices and specialty cable. The INTERCONNECT SYSTEMS **DIVISION** charter encompasses the engineering and manufacture of high-reliability MIL-Spec and commercial electronic/electromechanical connectors. CIA products include: MIL-Spec circular & custom hermetic connectors. MALCO manufactures an array of high density microminiature "D" connectors meeting MIL-C-83513, coaxial connectors & cable, high density circular connectors, backplane assemblies & headers QPL'd to MIL-C-28754, telephone module plugs & jacks, as well as "D" subminiature crimp and board side connectors & assemblies.

For additional information write: INTERCONNECT SYS-TEMS DIVISION, MICRODOT INC., 201 Progress Drive, Montgomeryville, PA 18936, (215) 699-5373. TWX: 510-661-8206.



"Helping Industry Put Things Together — With World-Class Products" ™



optic modem extends the range at which you can operate an RS-232C link to 2 km and links data-communication equipment (DCE) and dataterminal equipment (DTE) via fiber-optic cable. It accommodates either duplex plastic or glass fiberoptic cables and handles data rates as high as 19.2k baud (asynchronous). In addition to transferring data in both directions, the modem provides support for six control/ handshake lines via the same fiber.

You can apply power to the modem directly through the DB25 pin connector or the optional external plug-in-jack power supply. The unit is available with either male or female contacts, in DCE or DTE configurations, and is compatible with ST-type fiber-optic connectors. The use of fiber-optic cabling with these modems eliminates ground loops, and the use of these modems requires no modifications for existing RS-232C equipment. \$54 (500).

Thomas & Betts Corp, 920 Route 202, Raritan, NJ 08869. Phone (201) 685-1600.

Circle No 559

F-O KIT

The JE310 fiber-optic kit is an educational package, designed to give students and engineers hands-on experience with fiber-optic technology. It features separate transmitter-and-receiver circuit boards with separate test points for each signal on the board. The kit also includes fiber-optic cables and connectors, and requires a 6 to 9V power supply. \$19.95.



Jameco Electronics, 1355 Shoreway Rd, Belmont, CA 94002. Phone (415) 592-8097. TLX 176043. Circle No 560

EXTENDER BOARDS

The 3690-30 and 3690-31 extender boards are compatible with IBM PS/2 Series computers. The 3690-30 extender addresses PS/2 models 50 and 60; it's compatible with the PS/2's microchannel architecture and can be used with a 16-bit connector. The 3690-31 extender board is compatible with the PS/2 model 80, including a 32-bit connector, which you can use either with or without the matched-memory extension.

Both boards use a 3-layer design of copper-clad FR4 material. The inner layer is a crosstalk-reducing ground plane. The 3-layer design is impedance matched to the PS/2 backplane. The boards' edge-connector tabs are laid out on 0.05-in. centers on the backplane edge and an installed connector is located on the other edge of the board. Instructions and mounting brackets are included. 3690-30, \$195; 3690-31, \$248.

Vector Electronic Co, 12460 Gladstone Ave, Sylmar, CA 91342. Phone (818) 365-9661. TLX 269303. Circle No 561

SOCKETS

These test and burn-in sockets for fine-pitch plastic-quad flatpack (PQFP) packages come with hinged lids to accommodate naked in-house handling or as a socket/carrier combination for internal/external trans-



port. They have pin counts of 84, 100, 132, and 196. The sockets' body material is made of polyethersulphone/polyetherimide, and the contact material is beryllium copper with gold-over-nickel plating. The operating temperature ranges from -50 to +175°C. The insulation resistance is 1000 M Ω min at 500V dc. The dielectric withstanding voltage is 700V ac for 60 sec, and the contact resistance is $30 \text{ m}\Omega$ max at 10 mA/20mV. The rated current for the devices is 1A max, and the sockets can withstand 25,000 insertion cycles. 100-pin model, \$67.42 (100).

Nepenthe, 2471 E Bayshore Rd, Palo Alto, CA 94303. Phone (415) 856-9332.

Circle No 562



CONNECTORS

The Pre-Cap Series fiber-optic connectors are compatible with SMA, ST, and FC connectors. They combine the advantages of a composite polymer alloy with the precision tolerance of a glass capillary; as a result, insertion losses are <0.3 dB for multimode fiber applications. The connectors offer crimp and polish termination, and accommodate 125- and 140-µm multimode fibers.
MULTIPLE CHOICE

With Every Standard K

FEATURE BENEFIT

Standards Approval	Meets or exceeds all International standards approvals (UL, VDE, CSA, and TUV)
Product Range	Over 200 standard precision switching power supplies ranging from 25W to 1 KW
Price	Extremely competitive to meet your volume requirements
Warranty	2-year return to factory
Reliability	Consistently achieves less than 1/10th of 1 percent field returns
Size and Performance	Compact size with up to 100 KHz switching speed

It's easy to choose the exact KEC power supply to meet your requirements. Select from over 200 products or have KEC's engineers custom design a precision switching power supply just for you.

Choose from both open frame or modular styles, in a wide range of wattages. You also have a choice of 115 or 230 VAC inputs. KEC assures prompt delivery from its California warehouse.

When you choose a KEC power supply, you get over 70 years of design engineering experience dedicated to creating a standard for you.

Discover the real Multiple Choice in power supplies—Discover KEC!! Write for your FREE literature and information kit, or call KEC toll-free today.





KEC ELECTRONICS, INC. 20817 Western Avenue, Torrance, CA 90501

(213) 320-3902, FAX (213) 618-1197

"KEC—BRINGING MORE POWER TO YOU"

Europe's Finest Switch-Mode Supplies Now in U.S.A.

Powerline and Farnell, two of Europe's leading and most respected power supply manufacturers, announce the availability of their Switching Power Supplies in the U.S.A.



Hardware

In addition, they can be terminated on all styles of fiber-optic cables available from major cable manufacturers. The series includes connectors, couplers, factory-assembled cables, and all the tooling necessary for fiber-optic interconnection. \$9.50 (1000).

Thomas & Betts Corp, Technical Service, 920 Route 202, Raritan, NJ 08869. Phone (201) 469-4000. Circle No 563

CONNECTORS

The DL 50 Series ribbon connectors utilize 0.085-in. centerline contacts on both the mating end and the pc-board interface. They accept standard 28-AWG flat cable, which is terminated by the insulation-displacement method. The connectors are available in 24-, 36-, and 50position sizes. The series offers metal-shell straight and right-angle receptacles with ball locks, as well as mating plugs and receptacles for use with 0.050-in.-center cables.

The connectors spec a 3A current rating; the receptacles have a 500V ac voltage rating. Flat-cable limitations reduce current ratings for the plug and receptacles to 1A. Three contact options are available (8, 15, or 30 µin. of gold over nickel) for all the devices. \$3.23 (1000) for a 24position right-angle pc-board receptacle with 8 µin. of gold.

Molex Inc, 2222 Wellington Ct, Lisle, IL 60532. Phone (312) 969-4550.

Circle No 564

DRIVE ENCLOSURE

The SA-H163 enclosure is designed for applications that require removing, transporting, and storing dual 5¼-in. Winchester disk drives. It features pluggable drive capability along with a removable bracket (complete with power and data connectors) that you install on each drive. To remove a drive, you simply loosen two thumbscrews on the hinged cover, pull the handle on the bracket, and release the drive assembly from the docking connector.

No tools are required for drive installation or removal. The enclosure also includes a 100W supply, exhaust fan, write-protect switches, and LED indicators for each drive. The front-panel connectors provide daisy-chaining capability for the controllers that support as many as four Winchester disk drives. \$1431.

Sigma Information Systems, 3401 E LaPalma Ave, Anaheim, CA 92806. Phone (714) 630-6553. TLX 298607.

Circle No 565

BACKPLANE

This VSB (VME system bus) backplane is designed for use in µP applications in high-performance 32-bit VME systems. It permits faster, more effective memory expansion without overcrowding the J1 backplane, the vendor claims. The backplane is available in 2-, 3-, 4-, 5-, and 6-slot versions. It features 4-laver construction (signal/ 5V/ground/signal) and is impedance matched. The device plugs onto the standard wire-wrappable tails of the 96-pin DIN connector on the J2 backplane without interfering with the power terminals or harness on the J2. From \$123.

Mupac Corp, 10 Mupac Dr, Brockton, MA 02401. Phone (800) 225-0398; in MA, (617) 588-6110. TWX 710-345-8458.

Circle No 566

HEAT SINKS

The Series 6380 heat sinks are designed specifically to cool ICs housed in a single in-line package (SIP) or a zigzag in-line package (ZIP). They dissipate heat in the 10 to 15W range and feature standard solderable roll pins. Roll pins with standoffs are available as an option.

At a 75°C mounting-surface

Wind up with a new twist in twisted magnet wire.

TWISTITE

Magnet Wire gives you superior performance and tighter control over twisted wire construction. If you use twisted magnet wire in the production of custom toroid, ferrite or recording head coils, specialty audio and R.F. transformers, you'll be glad to discover TWISTITE Magnet Wire from MWS.

Millin

Only TWISTITE offers these advantages.

Because TWISTITE is custom produced by MWS, you get a wider range of twisting constructions. Manufacturing capabilities include:

- Up to 33 Twists Per Inch on fine wire.
- Twisting tolerance as tight as $\pm 1\%$.
- Tightly controlled capacitance, inductance and impedance characteristics.
- Up to 10 colors in some sizes for conductor identification.
- Huge selection of insulations: NEMA MW 1000, JW1177 105-220 °C (single thru quadruple film builds).
- Wide range of sizes: 24AWG and finer.

• Wide variety of conductor materials: copper, silver, plated conductors and special alloys. **Discover MWS today.**

Call or write for your FREE copy of the new MWS Technical Data Booklet. It's filled with useful information on all wire products produced and inventoried by MWS. You'll discover why MWS is

the industry leader in specialty wire products. Samples of TWISTITE Magnet Wire are available upon request.





31200 Cedar Valley Drive, Westlake Village CA 91362 CALL TOLL FREE 800 423-5097 In California 800-992-8553. In Los Angeles 818-991-8553 TWISTITE[®] is a trademark of MWS Wire Industries

Hardware and Interconnect Devices

temperature rise, the thermal resistance is 10° C/W for the 1-in. 6380B, 7.9° C/W for the 1.5-in. 6381B, and 6.5° C/W for the 2-in. 6382B. The devices are screw mounted through two holes on 0.78-in. centers in the device tab. The heat sinks are also available with optional self-clinching fasteners or threaded studs for easy assembly. \$0.56 (1000) for the 6380B.

Thermalloy Inc, Box 810839, Dallas, TX 75381. Phone (214) 243-4321.

Circle No 567

FAN

The type 412 electronically commutated brushless dc fan is housed in a frame that measures 41 mm². Operating from a nominal 12V dc supply and drawing a supply current of 120 mA, the fan produces an air flow of 4.24 cfm (7.2 m³/hour). It has an operating noise level of <30 dB(A), and its low level of RFI and EMI emission suits it for operation close to CRT displays. Ball bearings give the fan an operating life expectancy of 30,000 hours at 60°C. The fan weighs 65g. Approximately \$16 (100).

Papst-Motoren GmbH, Postfach 1435, 7742 St Georgen, West Germany. Phone (07724) 810. TLX 792413.

Circle No 570 Papst Mechatronic Corp, Aquidneck Industrial Park, Newport, RI 02840. Phone (401) 849-5930. TLX 952092.

Circle No 571

ENCLOSURES

The Chasseleon family of 19-in. enclosures is available in four standard depths of 220, 280, 380, and 480 mm, and in four case heights of 3U, 4U, 6U, and 7U. All the enclosures conform to sections 2 and 5 of the DIN-41494 specification. You can choose among five different frontpanel designs and add a keyboard cover or plexiglass hood to the front of the case. An RF-shielded version is also available.

All versions are available with either vertical, horizontal, or diagonal ventilation slots. From £40.

Knurr AG, Postfach 820369, Schatzbogen 29, 8000 Munich 82, West Germany. Phone (089) 420040. TLX 52960810.

Circle No 568

Dacobas Inc, 1830/A N Voyager Ave, Simi Valley, CA 93063. Phone (805) 526-7733. TWX 910-350-5103. Circle No 569



See us at: Taipei International Electronics Show, Oct. 6-12, 1987 (Booth 1171) Comdex Fall Las Vegas, Nov. 2-6, 1987 (Booth B338) CEBIT, Hanover, March 1988

Switch with Liton 20-1,000W- Meets FCC, UL, CSA, TUV and VDE Standards

TTL- Compatible Power-Good Signal!

Taiwan Liton Electronic Co., Ltd. produces a greater range of highperformance switching power supplies than most any other manufacturer anywhere: 20-1,000W. By customizing cost-saving standard models with an alternative component or two, available SPS configurations run into the thousands.

Design and production fully meets FCC class "B", UL, CSA, TUV and VDE standards. Applications include PCs and workstations, telecommunications equipment, as well as OA equipment like facsimile machines, copiers and



printers. PC models are electrically as well as physically IBM PC/AT, PC/XT compatible and are full-power rated and wired for hard-disk or tape drives, as well as other peripherals. We've built our reputation with top-quality components. With gigantic facilities and modern equipment, we design and manufacture computer and communications products which meet the highest international quality control and performance standards. Our R&D customizes a standard model or generates a 100% original design in a lead time worth switching for!



CIRCLE NO 149

 Taiwan Liton Electronic Co., Ltd.

 12th Fl., 25 Tunhwa S. Rd Taipei, Taiwan, ROC

 Tel: (02) 771-4321/8 Fax: 886-2-751-1962

 Tlx: 24514/20211 TW/LITON

 *IBM PC/AT and PC/XT are trademarks of the International Business Machines Corp.



Introducing the MK41H80 TAGRAM.™ The industry's first and fastest integrated 16K CMOS cache tag SRAM dedicated for use in all high-speed processor environments.

TAGRAM gives you a 4K \times 4 CMOS SRAM and a 4-bit comparator integrated on a single chip. It's optimum for interface with 16-25 MHz processors, and is backed by 1.2 μ double level metal full CMOS process technology– the same proven process used in all of our 16K VF SRAMs.

TAGRAM comes in three speed grades: 20, 25 and 35ns. And every MK41H80 cache TAGRAM is available in 300 mil, 22-pin plastic and ceramic DIPs. What's more, TAGRAM's fullspeed read access ensures that even copyback designs can be implemented without ever having to wait. And it features Flash Clear – the function requested most often by cache system designers. So your cache can be wiped clean to all zeros in 40ns. Max.

High-performance cache applications demand high-speed solutions. If you'd like to realize a 30% reduction in access time compared to discrete solutions – plus a substantial reduction in the cost of component real estate – start increasing your cache flow with the newest member of our family. The MK41H80 TAGRAM.



Actual MK41H80 TAGRAM Scope Trace Photograph



 $20ns = \tau_{ACA} = ADDRESS COMPARE ACCESS TIME$

Match Access Timing

U.S. and Canadian Sales Offices

Western Area:

Santa Clara, CA 408/970-8585 Irvine, CA 714/250-0455 Woodland Hills, CA 818/887-1010 Seattle, WA 206/632-0245 Longmont, CO 303/449-9000 Tigard, OR 503/620-5517

Eastern Area: Burlington, MA

Dalimgtoh, MJ 617/273-3310 Marlton, NJ 609/596-9200 Huntsville, AL 205/830-9036 Poughkeepsie, NY 914/454-8813 Dublin, OH 614/761-0676 Norcross, GA 404/447-8386

Central Area:

Carrollton, TX 214/466-8844 Schaumburg, IL

312/397-6550 Austin TX

512/451-4061

Canada:

Brampton, Ontario 416/454-5252 Western Canada 503/620-5517







Formerly known as Thomson Components-Mostek Corporation.

TAGRAM is a trademark of SGS-Thomson Microelectronics.



Source-level cross-debugger with windowing (Intermetrics)

Because of the increasing use of high-level languages and real-time operating systems, assembly-language debuggers no longer suffice. They're giving way to debuggers that can correlate target-system activity with high-level source code and ones that can manipulate real-time operating systems.

Debuggers help you perfect high-level and real-time code

Charles H Small, Associate Editor



In-circuit emulator and high-level-language debugger (Applied Microsystems and Microtec Research)

To help you adopt high-level languages and formal real-time operating systems, vendors are providing high-level-language debuggers that offer such features as breakpoints, program-trace capabilities, and memory-manipulation commands that accept the names of high-level-language constructs as arguments.

C is the language that debuggers cover most widely —followed by Pascal. However, Concurrent Sciences' Soft-Scope debugger works with Intel compilers for PL/M, Pascal, Fortran, C, and—amazingly enough— Jovial. The Tektronix Ada 68020 system includes a debugger for Ada code that you compile for the 68020 μ P.

Older debuggers (see **box**, "Evolving requirements for debuggers"), based on a target-system ROM monitor and a simple CRT human interface, are like reluctant but entirely truthful witnesses; they answer all questions you put to them faithfully but never volunteer anything. Such monitor-ROM programs and preprogrammed ROMs are still available from all μ P makers and from third parties like Allen Systems.

Genesis Microsystems' GeneScope ROM-based debug monitors for the 8086 family have a full-screen user interface, which comes in three versions. One is the

EDN December 10, 1987

company's standard interface. Two others mimic the interfaces of Applied Microsystems and Zax in-circuit emulators' interfaces. You can debug a target system with both the ROM monitor and an in-circuit emulator without having to contend with two different interfaces.

Newer, screen-oriented debuggers use multiple windows to display a wealth of information at each break in execution. Many, like Microtec Research's Paragon Xray debugger, allow you to set up your own windows to display any area of memory in any format you choose. Such capability proves useful, for example, when you are pulling data from one buffer, processing it, and writing the processed data out to another buffer. You could set up windows to display both buffers and then stepover (see **box**, "Glossary of high-level debugging terms") the data-processing routine repeatedly to observe its effect on the data.

Not just a passive window

Like many window-oriented debuggers, Sun Microsystems Inc's DBX has windows for source code, captured execution traces, and memory and register dumps. DBX's source-code window is more, however, Engineers will be adopting high-level languages and formal real-time operating systems simply because software projects continue to grow in size and complexity.

than just a passive window into the source code. You can also edit programs in this window without leaving the debugger. Most other debuggers do not have such a direct path back from the realm of finding bugs to the realm of correcting them.

Some of the software engineer's difficulties stem solely from working in a cross-development environment. Cross-development simply means developing programs on a computer other than the target—the one on which the code will execute. An example would be writing programs to control a microwave oven. Obviously, you cannot develop programs on a microwave oven, because it has no keyboard, screen, or mass storage.

If the high-level-language debugger is not intended as a universal debugger for a variety of high-level languages, then its vendor can make the debugger's command interface resemble a single high-level language. For example, the command language of both Oasys's C source-level debugger, CDEBUG, and Microtec Research's Paragon Xray debugger conform to standard C notation. TekDB from Tektronix has a strong expression evaluator that understands nearly any C expression.

Universal debuggers, on the other hand, force you to learn what amounts to another programming language if you are to take advantage of the debuggers' macro facilities.

High-level-language debuggers have commands that suit the style of high-level-language programming. In fact, using them resembles editing as much as it does classical debugging. For example, most have a so-called breakdown command that allows you to get out of a subroutine and back into your main program without stepping through the remainder of the subroutine. This command comes in handy when you inadvertently find yourself stepping through, or breaking into, an uninteresting subroutine.

Debuggers still come up short

Although new debuggers are more powerful than their forebears, they do have shortcomings. High-levellanguage debuggers purport to be symbolic debuggers, but not all so-called symbolic debuggers are equal. As a minimum, a symbolic debugger takes a symbol name as an argument for a memory reference. This simple-to-

Evolving requirements for debuggers

EDN surveys reveal that EDN readers do considerable cross-development of real-time programs for various target systems. Although many currently write their code in assembly language and handle the real-time chores with a control loop or a go-oninterrupt scheme, these ad hoc methods will have to give way as software projects continue to grow in size and complexity. Software engineers are more productive if they write their code in high-level languages; further, formal, real-time operating systems offer built-in protection against many of the common pitfalls of home-brewed real-time schemas.

But formal design methodologies, languages, and operating systems don't guarantee errorfree code. Moreover, surveys show that debugging real-time code takes five times as long as debugging ordinary applications programs (that are written in a high-level language and that will run on the host development system, thus taking advantage of the host's operating system).

Traditionally, debuggers have handled only assembly language, so software engineers programming in high-level language could debug their code in the target system only in assembly language. These engineers not only had to become familiar with the target system's μ P, they also had to learn the conventions their compiler used for such tasks as setting up storage for variables and passing parameters to procedures.

Further, to make sense of activity in their target system, software engineers had to be able to correlate assembly-language statements back to the high-level-language statements that generated them. They also had to determine which registers held which variables, decode the stack to find parameters, return addresses and local variables, and manually reformat memory dumps into high-level-language data structures.

It's only recently that debuggers, such as those discussed in the accompanying article, have begun keeping pace with advances in high-level languages and real-time operating systems. implement feature is a time saver: You needn't refer to your compiler's cross-reference table each time you want to access a program location in the target system.

But this so-called symbolic capability speaks not at all to the **data** at the named location; simple symbolic debuggers are of little help when confronting multiple levels of indirection. Suppose, for example, that you are trying to *de-reference* a pointer. Your debugger will accept the pointer's name in lieu of the pointer's hex address as the argument of an examine-memory command. The debugger will return the hex value of what the pointer points to. But that pointer could be pointed at a named object. Unless the debugger has the ability to correlate the symbol table with fetched data, you will not be able to avoid flipping through the symbol table manually yourself.

Systems & Software's SoftProbe II has a command format that, taking a cue from C-programming operators, allows you to go through as many as seven levels of indirection by appending a corresponding number of asterisks to a pointer reference. Similarly, Ready Systems' RTscope real-time operating-system debugger has a debugging command that traverses linked lists.

Name matching often fails

Further, not all symbolic debuggers can match an area in memory with the symbolic name for that area when fetching data from data structures. Suppose that your program is accessing an array. The compiler's symbol table will have an address only for the start of the array. The debugger will find an exact match, therefore, only between the address of the first entry in the array in the target system and the array's name in the symbol table.

Unless the debugger works like Computer Dynamics' RDSD debugger for the firm's line of single-board computers, the debugger will not be able to match a reference to the array's subsequent entries. RDSD attempts to find the nearest symbolic reference to a memory access (it displays the offset from the access to the symbol as well as the symbol's name). RDSD performs a similar match when decoding return addresses on the stack because the compiler supplies addresses for the entry points of a routine and not the exit points a routine calls other routines from.

Tektronix's debugger for its Pascal compilers can even format the contents of enumerated variables according to your Type declaration for the enumerated variables. For example, suppose you declare a variable STOPLIGHT that can only store enumerated variables



Debugger for stack-oriented high-level language (Concurrent Sciences Inc)

of the type RED, GREEN, and AMBER. If you interrogate STOPLIGHT, the debugger will reply with RED, GREEN, or AMBER as appropriate; debuggers for other compilers could not make this correlation without your first writing an elaborate conditional macro.

Four new forms

In general, the new debuggers come in four forms:

- Software simulators that run on the host computer;
- ROM-based high-level-language debug monitors that reside in the target system and communicate with the host computer;
- Hardware-based debuggers that integrate control software on the host computer with in-circuit emulators and logic analyzers that monitor and control the target system; and
- ROM-based real-time operating-system debug monitors that reside in the target system and communicate with the host computer.

These debuggers are not mutually exclusive; you can employ one or all of them on a given project (although having a high-level-language debug ROM and a real-



Hardware/software debugger package for IBM PC (The Periscope Co Inc)

Until recently, debuggers were not keeping up with advancements in high-level languages and real-time operating systems.

time operating-system debug ROM in the same target system can cause conflicts).

For years, the Boston Systems Office has supplied a powerful simulator, BSO/Debug, along with its VAXbased cross-development assemblers and compilers. The simulator was recently upgraded with a window interface that works with DEC's new color workstations and terminals. One user simulated an entire Intel iRMX real-time operating system, including simulated I/O and asynchronous interrupts, using BSO/Debug. Because of the wide diversity of target environments and emulators that the firm's customers use, BSO has only recently begun working on interfaces to common development hardware. Mecklenburg Engineering also makes μ P simulators that can run assembly-language programs.

Several companies already make debuggers that use the same command interface when overseeing programs running in the host computer on a simulator or in the target system. Systems & Software's SoftProbe II for 8086 μ Ps is one such combination. This high-levellanguage debugger works with C, PL/M, Pascal, and assembly languages that use the Intel OMF file-output format. It runs as a simulator on VAX computers and IBM PCs and runs in target systems with the aid of a ROM-based monitor. It cannot, however, trace register variables.

A target-system's ROM-based debugger cannot debug certain portions of code. Because debug ROMs (or monitors, as they are sometimes called) use a software-based breaking mechanism, they can trace execution only through RAM-resident code and not through ROM-resident code without the aid of an in-circuit emulator's emulation memory. Intel debugger ROMs, for example, set breakpoints by replacing the instruction at the breakpoint with a software trap instruction. Also, ROM-based debuggers usurp targetsystem facilities. Typically, the debuggers need exclu-

In-circuit-emulator makers do an about face

The problems associated with debugging cross-developed code that was written in a high-level language are reversing a longstanding trend toward standalone, unbundled emulators. The first emulators came as a part of bundled development systems from µP makers and large instrument firms. These development systems were expensive. When the personal computer emerged, smaller manufacturers not involved in semiconductor production seized an opportunity to break out the in-circuit emulator from the bundled development system. They started a trend toward stand-alone incircuit emulators.

The stand-alone in-circuit emulator is a good, low-cost approach for debugging small, cross-developed programs written in assembly language. But the pressure of big programs written in high-level languages is propelling third-party, standalone-emulator makers to link up with compiler and debugger vendors. For example, Applied Microsystems can now supply versions of two compiler/debugger combinations targeted for the firm's emulators: The Validate/ Xray debugger that works with Microtec Research's Paragon compiler and the Validate/Soft-Scope debugger that works with Intel compilers. Intermetrics now has versions of its XDB debugger that interface to common third-party in-circuit emulators from firms such as Applied Microsystems, Zax (Irvine, CA), and Microtek Labs (Gardena, CA), as does First Systems Corp for its MicroScope ROM-based, target-system debugger.

These pre-existing debuggers now have simple additions to their command languages that allow them to function as transparent terminals to the emulator's native command language. The debugger and emulator software continue to operate more or less independently. Despite the availability of these package deals, the debuggers and emulators are not as well integrated as the packages from Hewlett-Packard, Tektronix, and Arium.

Another example of a high-level-language debugger coexisting with a lower-level debugger is Andyne Computing's PCMascot real-time operating-system kernel. This system runs on the IBM PC and comes with a suite of debugging commands for the real-time operating-system constructs. If you enter the PCMascot debugger via the native MS-DOS debugger, keying in a Break command on the PC's keyboard returns you to the DOS debugger.

sive use of at least one software interrupt and also the use of a communications port.

Even a cursory examination of the triggering schemes of software-based versus hardware-based debugging tools reveals one essential difference: Software-based tools have only a single level of conditional triggering; hardware-based tools (in-circuit emulators and logic analyzers) feature multiple levels of sequential triggering.

A software tool breaks whenever the program reaches a breakpoint or alters a watchpoint: you can set up a hardware-based tool to break only after a certain sequence of events occurs. Thus, a hardware-based tool can filter out extraneous activity and focus on problem areas more closely than software-based tools do. For example, you could set up a hardware-based tool to break execution only after a real-time operating system's supervisor program activates a certain task and that task jumps to a portion of re-entrant code or accesses a common data structure. A software-based tool would break no matter which task used the reentrant code or accessed the data structure.

Once you've gotten into a procedure, you might want to find out how you got there, especially if this procedure has many different potential callers. A stack traceback command works directly from the current program stack; therefore, you need not have made any previous setup or issued any explicit trace-collection command, as you would have to do with a hardwarebased tool. Unless your target-system debugging hardware includes logic-analysis capability, you could not collect such linkage information without slowing down execution anyway.

Finding your way

Stack traceback commands come in two forms. Simple traceback commands print out the stack and show you the sequence of calls that preceded the activation of the routine you are currently debugging. These commands let you view the results of dynamic, run-time nesting of the program as opposed to static, lexical nesting in your source code.

More advanced traceback commands allow you to retrace your steps to a higher-level calling routine or to adjust the stack to bypass a called routine that isn't working properly without recompiling and downloading the corrected module. In this case, you would have to use the debugger's commands to manually perform the correct action that the malfunctioning subroutine isn't performing.



Real-time operating-system debugger (Andyne Computing Ltd)

For serious hardware-level debugging, you need an independent, non-intrusive window into the target system-in short, an in-circuit emulator.

Having special hardware evaluate conditional breakpoints speeds up the debugging session and points out one of the advantages of debugging with in-circuit emulators. For example, when Tektronix's TekDB is working with one of the company's emulators, the firmware in the emulator determines whether the breakpoint condition qualifiers are True each time the software under test reaches a breakpoint. The debugger running on the host computer gets no notification of the Stop unless the condition being checked is True. This system eliminates your checking a variable manually each time the program stops to determine when the variable's value goes out of bounds. Tektronix's hardware can evaluate approximately 90 conditional expressions per second (including the time consumed by restarting execution).

Arium's Echo µP-development system serves as an example of the benefits of a closely integrated host, compiler, debugger, and in-circuit emulator. The unit costs \$12,980 for 16-bit and \$8960 for 8-bit µPs. The Echo's computer has a pair of 68000s-one for display and one to run the Regulus operating system (a Unix look-alike with real-time extensions).

The unit has two high-speed links: one optional Ethernet link for quickly downloading large files from other host computers and a serial link to its companion in-circuit emulator. Because the Echo's main memory is expandable to 2M or 4M bytes, the computer can hold your entire source file in RAM for very quick correlations between captured traces from the in-circuit emuNot all symbolic debuggers can match up an area in memory with the symbolic name for that area.

lator and the corresponding portion of source code; most other such systems have to get the source code from disk. The unit can not only disassemble and decompile captured code using your labels, it even appends the appropriate comments from your source code to captured traces.

The Echo understands the conventions of the Green Hills (Glendale, CA) C and Pascal compilers. These single-pass compilers (ones that produce no intermediate assembly-language file) compile code faster than some other, two-pass compilers.

The in-circuit emulator can reload its event recognizers dynamically. Once armed with stack offsets for local variables, the emulator can add the offsets to the value of the stack-pointer at the point that the software under test enters a routine to be debugged. The emulator can thereby set up its event recognizers to trace and trap on local variables. Hewlett-Packard's 64000 system is the only other system on the market that can trace and trap on local variables in real time without halting program flow.

Nearly all vendors of real-time operating systems, such as Ready Systems (RTscope), JMI Software Consultants (CE-View), Intelligent Machinery Co (imx/51), and Software Components Group (Probe), offer debuggers that allow you to examine and change the state of

Optimization and what it does to your program

Optimizing compilers further obscure the correspondence between your source code and the compiled object code. If you write real-time programs in a high-level language, in order to meet response-time specifications you might find yourself having to switch on your compiler's optimizer and then be forced to debug optimized code.

Among the many techniques optimizing compilers employ is register allocation by coloring. Coloring keeps the most commonly used values in registers at all times. The compiler examines the entire subroutine to determine which local variables and parameters get used most often in the routine. It allocates them to registers.

Further, the register allocator can use data-flow analysis to find the lifetime of each variable. Using this information, it can increase the number of variables that get stored in registers by using the same register for several variables in the same subroutine. Also, because some compilers know the lifetime of each variable, they may even allocate several variables to the same register if there are no places in the program in which both variables hold a value that will be needed later.

In addition, if the lifetime of a variable does not include any function calls, the variable can be put into scratch registers that do not need to be saved and restored, thus reducing variable overhead even further. Using these schemes to keep variables in registers can speed program execution but can also confuse your debugger horribly because it does not know just where a variable is at a given time or, conversely, just what the contents of a given register mean at a given time.

By default, your compiler can consider any integral, floatingpoint, or pointer variable as a candidate for register allocation if it never gets passed by reference and its address does not get taken by the C "&" operator at any point in the routine.

In other words, don't be fooled by the C-language mecha-

nism that allows you to specify "automatic" variables; compilers will try to put as many variables as possible into registers. Conversely, if you specify more variables as automatic than there are registers in your target system's μP , the compiler may put your register variables on the stack. Worse yet, some compilers ignore the automatic-variable assignments altogether and put everything on the stack. The point here is that unless you are very familiar with your compiler's habits, you cannot be nearly as sure of just where your program's variables are as you would be if you were programming in assembler and making all the variable assignments explicitly yourself.

An optimizing compiler normally removes all dead code code that never gets executed. Such code could be subroutines that never get called. Dead-code removal also includes removing WHILE loops that never get executed and DO-FOR loops that get executed only once. Obviously, if you set a breakpoint on a the operating system's tables and also to manipulate the operating system's mechanisms for scheduling tasks and managing intertask communication. For instance, you can freeze one task while leaving the remainder of the tasks up and running. What these debuggers generally do not allow you to do is to debug the code that the individual tasks are running.

Tektronix's Ada debugger is one high-level-language debugger that allows you to qualify a breakpoint by task. In addition to selecting which program you want to debug, you can also select a task to be the current task under debugging.

On the other hand, if you use a conventional ROM-

based, high-level-language debugger to debug a task's code, jumping to the debugger ROM has the effect of changing context from the real-time operating system to the debugger. In other words, halt one process and you halt all task activity. Imagine that you're debugging a real-time system for a robot. Perhaps you want to halt the task that moves the robot's arm back and forth. If you use a high-level-language debugger instead of a real-time operating-system debugger, all the robot's software will halt. But just because you've stopped the arm doesn't mean it's okay for the robot to relax its grip.

Real-time operating-system debuggers, such as Soft-

line of dead code that has been removed from the executable code, the debugger could have trouble executing your command.

Optimizing compilers will also rearrange your code in several ways. One way is branch-tail merging, which refers to pulling common statements out of both branches of an IF-THEN-ELSE construct and putting just one instance of the common statements at the end of the construct. The compiler can also remove redundant jumps. That is, if you have a jump statement to yet another jump statement, the compiler will jump directly to the second jump statement's destination. Less obviously, if vou have nested WHILE statements, an optimizing compiler will jump directly to the outer WHILE when the inner WHILE fails instead of jumping first to the inner WHILE's exit point.

Optimizing compilers can violate some of the overly restrictive rules of structured programming, such as requiring all routines to have a single exit point. If you turn on your compiler's optimizer, your routines can have only one entry point but multiple exit points. For example, an optimized CASE statement will have an EXIT for each clause; an unoptimized CASE statement could end up performing all the tests in the CASE structure even if the first test succeeds because the statement has its EXIT after the last test. Multiple exit points can make decoding the return address on the stack difficult. Further, many software tools, such as software performance analyzers, assume that the entry and exit points of routines always come in pairs.

Optimizing compilers also perform the intriguingly named operation of "code hoisting." The compiler will skip writing out the results of a calculation upon a variable if the calculation is followed by further calculations on the same variable without any intervening references to the variable. This operation is quite mysterious to high-levellanguage programmers but perfectly clear to assembly-language programmers.

To perform a calculation on a variable, the µP must first load the variable into a register. There's no point in writing the result back out from the register to the variable's location in memory if the program will be pulling the variable back in shortly for further calculations. It's better to simply leave the result in the register and write it out after all calculations are completed. But if you were to examine the variable's location in memory at any program steps between the first calculation and the final writing out of the register's value, you would not find the correct, updated value at the variable's address; the correct value is in a register.

More well known is the optimizing compiler's trick of pulling invariant operations out of a loop so that they get executed only once and not repeatedly each time the loop executes. Several firms make debuggers that use the same command interface for programs running on the host computer or on the target system.

ware Components Group's Probe, do allow you to set breakpoints on addresses in your programs, but these simple facilities are a far cry from the power of highlevel-language symbolic debuggers.

Microware Systems Corp has a pair of debuggers for its OS-9 real-time operating system. One, sysdbg, is a system debugger that takes over the entire operating system and halts all tasks. It communicates using the normal system port and its associated device handler and operating-system calls. The other, Debug, runs as a task and invokes the task to be debugged as a child process of the debugger. Debug can also access the symbol table produced by the firm's OS-9 linker. Therefore, it combines both a high-level-language debugger and a real-time operating-system debugger in one.

Loading multiple debuggers into one target system can present problems if both debuggers use the same software trap to gain control of the target system. You would have to develop a software mechanism for saving and restoring the software trap's contents when switching contexts from one debugger to the other.

Despite their different implementations, the various debuggers have many similar strengths and weaknesses. Delving into how the debuggers accomplish

Glossary of high-level debugging terms

Programmers sometimes use old words in different ways, coin useful, but obscure, new words, or—confusingly enough—use several words to describe more or less the same thing, depending on which language they are using—subroutine, procedure, pragma, object, or module, for example. Here is a glossary of words you may encounter in the literature of high-level-language debuggers.

Automatic variable—Another name for *local variable* (see *Stack frame*).

Breakdown—Not a reference to the mental state of the software engineer. A breakdown command sets a breakpoint in the procedure that called the current procedure (that is, one frame down from the current frame on the stack). This breakpoint allows you to get out of a subroutine and back into the main program automatically with one command.

Coloring—The process of a compiler examining variables' usage over an entire subroutine and then assigning the most commonly used local variables to registers and the less commonly used ones to the stack. **Conditional breakpoint**—A breakpoint that distinguishes between two events: first, merely reaching a breakpoint, and second, a condition being true. If the condition is False when the program reaches the breakpoint, the program continues.

De-reference—Etymologically unsound (compare to "delouse," for example), but useful, neologism current among C programmers. It signifies getting the object pointed to by a pointer as opposed to directly referencing the pointer itself.

Disambiguate—Homing in on the specific instance of a specified name. It's a useful feature because many high-level languages allow you to use the same name in different parts of the program (see *overload*); thus, if you ask the debugger to find something for you, it may discover several different references.

Local variable—See *Stack frame*.

Maintenance—That portion of the software design and debug

process that continues after the program is shipped to a paying customer (as opposed to a betasite customer).

Overload—A condition in Ada attributed to a name that can refer to several things in different modules (called "pragmas"). See *disambiguate*.

Root—Used as a verb; for example: "For Ada programs, this name need not be fully *rooted* as in **standard.math.sin**—the simple name, **sin** may be used." It's derived from the notion of having a*-root* directory in a hierarchical directory scheme.

Scope—Delimits the portion of a program over which a given instance of a named program construct is valid. An example is a local variable that gets used only in a subroutine. Its scope does not extend beyond the subroutine, and hence you can use the name with impunity in other subroutines.

Stack frame—A variable-length data structure. Languages such as Pascal and C use the stack, instead of main memory, for storing variables that will be used only inside a given subroutheir tasks helps explain these characteristics.

Concurrent Sciences' Soft-Scope serves as an example; when Soft-Scope first opens a module of your source program, it searches the listing file to find the beginning of each line and records these file locations. At the same time, the debugger searches the executable load file to find and record the address of each executable line. The association between source and executable code makes displaying source code during program execution possible. The debugger stores this information in a temporary disk file, so it needs to make this correlation only once during a debugging session for a given module. Note that Concurrent Sciences' debuggers work only with Intel compilers; the firm maintains that other compilers do not produce enough cross-reference information to power a comprehensive debugger.

Debuggers cannot always resolve all ambiguities when matching up raw hex data with the compiler's symbol tables. If the program is jumping to an address, or accessing a given address, the debugger can unequivocally substitute the name it finds in the compiler's symbol table for the raw hex address. But suppose the program is moving a hex number into a register. That

tine. They also use the stack for passing parameters and pointers to data structures between routines. And, of course, the stack still has to do its normal job of holding return addresses of calling procedures. Therefore, the compiler sets up a stack frame each time the program enters a routine. If you know the structure of the stack frame, the exit points of calling routines, and the form (type) of the variables on the stack, you can decode the stack frame to determine the sequence of calling routines from the return addresses and the state of local variables both in the currently active routine and in the suspended calling routines.

Static breakpoints—Sometimes called sticky breakpoints. They are active no matter how many times the program halts at them. Some debuggers distinguish between static and dynamic breakpoints. These debuggers insert a temporary—or dynamic —breakpoint as a part of a Go command that takes an argument (Go until <argument>). When the debugger reaches the point in the program signified by the argument, it halts and removes the breakpoint. **Stepover**—An extension of the concept of single-stepping. A stepover operation allows you to execute subroutines in a single step while still single-stepping line by line through a higher-level routine.

Trigger and trap—Features that break program execution. Some debugger makers distinguish between *triggers* and *traps*. They use *trigger* to mean a hardware event recognizer in an in-circuit emulator or logic analyzer that can break execution, and they use *trap* to refer to a break in execution caused by a special instruction inserted in the program under test.

Viewport—Synonym for a CRT window that shows a formatted, predefined segment of memory. Visibility—A debugger's rule that determines which named variable, structure, and other program constructs are visible at a given point in the program's execution. Generally, debuggers, by default, comply with the high-level language's scoping schema. However, a good debugger will allow you to exceed the high-level language's scoping and accord you visibility beyond the current procedure if you desire it (see *scope*).

Watchpoint-A breaking mechanism. Some software-debugger makers distinguish between a breakpoint and a watchpoint. To them, a breakpoint is a command inserted in a program's commands that causes the program to stop and transfer control to the debugger. A watchpoint is a macro that first examines a designated memory location after each instruction cycle to see if the memory location has been changed and then stops execution if necessary. Because of the different breaking mechanisms, software-debugger makers think of breakpoints and watchpoints as being different entities; hardware debugging tools do not, of course, distinguish between the two because they are both definable states of the µP's address, data, and status lines.

No matter how powerful your debugger is, you will probably always have to use your creativity and imagination to debug your programs.

number could simply be data that will be used in an arithmetic or logical operation, or it could easily be an address or pointer. If the debugger finds that particular hex value in the symbol table, the match could be pure coincidence.

Periscope's debuggers handle this ambiguity by displaying possible matches in the comment field of a disassembled listing rather than by plugging in the match in the instruction field (Fig 1).

Not all programmers bother to put line numbers in their source code. Therefore, several debugger makers, including Systems & Software, supply utilities that insert line numbers in a file. Systems & Software also supplies utilities that print out Intel OMF files in a readable form so that you can study your program's symbol tables.

Oasys's CDebug high-level-language debugger comes with a utility program that goes even further than merely inserting line numbers into your source program. The firm's XPP preprocessor is an automatic editor (or stream editor) that will parse your source code, looking for anything a debugger might be interested in later on. When XPP finds something interesting, it sets up a pointer to it using the native C pointer mechanism and puts the pointer in a table.

Later, when you compile the preprocessed source file, the compiler will produce a custom-made symbol table in just the form the CDebug debugger is looking for. Thus, Oasys sidesteps the issue of accommodating different, and possibly incomplete, symbol tables from various compilers. The Periscope debuggers, for exam-

START:			
ØC73:Ø137 E817ØØ	CALL	GETMEM	
ØC73:Ø13A A133Ø1	MOV	AX.[TOTMEM]	
ØC73:Ø13D BF1001	MOV	DI,0110	: TMEMORY
ØC73:Ø140 E82400	CALL	CONVERT	
ØC73:Ø143 A13501	MOV	AX, [FREMEM]	
ØC73:Ø146 BF2CØ1	MOV	DI,012C	: AMEMORY
ØC73:0149 E81B00	CALL	CONVERT	
ØC73:Ø14C E834ØØ	CALL	DISPLAY	
DOSRET:	a la constante	Contraction of the	
ØC73:Ø14F CD2Ø	INT	20	; Program terminate
GETMEM:			
ØC73:Ø151 B106	MOV	CL,06	
ØC73:0153 BE0200	MOV	SI,0002	
ØC73:0156 8804	MOV	AX,[SI]	

Fig 1—Although most symbolic debuggers can decompile or disassemble a program's activity using the names of your defined memory references and subroutines in place of raw hex values, few can resolve ambiguous data fetches. Note the references to TMEMORY and AMEMORY that appear in the comment field of this Periscope Co Inc disassembly listing. The disassembler inserted these references as possible matches with the data in the argument of the corresponding MOV commands on the same lines.

ple, accept symbol information only from MAP files produced by Microsoft compilers.

No matter how powerful your debugger is, you will probably always have to use your creativity and imagination to debug your programs. Software engineers sometimes employ run-time schemata that pose the same problem to debuggers as the compilers' local and register variables do. Take, for example, overlays. If you load the overlays into the same area of memory every time, then you will be able to set up breakpoints within the overlaid code. Of course, if you're using a software-based debugger, you will have to set software breakpoints *after* your program loads the overlays, or else the software traps will get overwritten; conversely, you can set up hardware traps in advance.

If, however, your program determines the location of overlays dynamically, then you cannot determine memory locations in advance. The Intermetrics XDB has a mechanism for handling this problem. During the debugging session, you can extract the offset for the overlay and instruct the debugger to add the offset to all the addresses in the symbol table. Obviously, you cannot do this in real time.

Real-time systems pose problems similar to overlays —especially if they create and destroy tasks dynamically. Further, in real-time systems, different tasks can use the same piece of re-entrant code. If you set a breakpoint in the re-entrant code, you won't necessarily catch the task you are trying to debug. Generally, software-based debuggers offer no solution to this problem; luckily, hardware-based debuggers offer sequential triggering that can resolve this ambiguity.

Debuggers serve other uses

A high-level-language debugger's ability to relate the source code to the flow of execution makes it a useful tool when you must modify or debug code that someone else has written.

You can use a source-level debugger for learning the high-level language itself, and you can use it for maintenance and testing. If you choose to write your code with a high-level language, you may have planned to eventually port your software from one hardware environment to another. A debugger can help smooth the porting process. Further, you can use a debugger to demonstrate, document, and profile a program.

Many high-level-language debuggers can optionally keep a record, or journal, of your debugger commands in a file. You can edit this file and rerun the commands from the file. In this way, you can gradually build

For more information . . .

For more information on the debuggers described in this article, circle the appropriate numbers on the Information Retrieval Service card or contact the following manufacturers directly.

Allen Systems

2151 Fairfax Rd Columbus, OH 43221 (614) 488-7122 Circle No 613

Andyne Computing Ltd 544 Princess St, Suite 202 Kingston, Ontario Canada K7L 1C7 (613) 548-4355 Circle No 614

Applied Microsystems Corp

Box 97002 Redmond, WA 98073 (206) 882-2000 (800) 426-3925 TLX 185196 Circle No 615

Arium Corp 1931 Wright Circle Anaheim, CA 92806 (714) 978-9531 TLX 754903 Circle No 616

Boston Systems Office 128 Technology Center

Waltham, MA 02254 (617) 894-7800 TWX 710-324-0760 Circle No 617

Computer Dynamics

107 S Main St Greer, SC 29651 (803) 877-8700 Circle No 618

Concurrent Sciences Inc Box 9666 Moscow, ID 83843 (208) 882-0445 TLX 942758 Circle No 619

First Systems Corp 865 Manhattan Beach Blvd Manhattan Beach, CA 90266 (213) 546-5581 Circle No 620

Genesis Microsystems Corp 196 Castro St Mountain View, CA 94041 (415) 964-9001 Circle No 621

Hewlett-Packard Co Fort Collins Systems Div

Fort Collins Systems Div Customer Documentation 3404 E Harmony Rd Fort Collins, CO 80525 Phone local office Circle No 622

Intel Corp 5200 NE Elam Young Parkway Hillsboro, OR 97124 (503) 681-8080 Circle No 623

Intelligent Machinery Co 2400 Westwood Dr Longwood, FL 32779 (305) 869-8168 Circle No 624

Intermetrics Inc 733 Concord Ave Cambridge, MA 02138 (617) 661-1840 TWX 710-320-7523 Circle No 625

Introl Corp 647 W Virginia St Milwaukee, WI 53204 (414) 276-2937 Circle No 626

JMI Software Consultants Inc Box 481 Spring House, PA 19477 (215) 628-0840 Circle No 627

Mecklenburg Engineering Box 744 Chagrin Falls, OH 44022 (216) 338-1900 Circle No 628

Microtec Research 3930 Freedom Circle #101 Santa Clara, CA 95054 (408) 733-2919 TLX 4990808 Circle No 629

Microware Systems Corp 1900 NW 114th St Des Moins, Iowa 50322 (515) 224-1929 TWX 910-520-2535 Circle No 630 Oasys 230 2nd Ave Waltham, MA 02154 (617) 890-7889 Circle No 631

The Periscope Co Inc 14 Bonnie Lane Atlanta, GA 30328 (404) 875-8080 (800) 722-7006 Circle No 632

Ready Systems Box 61029 Palo Alto, CA 94306 (415) 326-2950 TLX 71510608 Circle No 633

Software Components Group 4655 Old Ironsides Dr Suite 250 Santa Clara, CA 95054 (408) 727-0707 TLX 757697 Circle No 634

Sun Microsystems Inc 2550 Garcia Ave Mountain View, CA 94303 (415) 960-1300 TLX 287815 Circle No 635

Systems & Software Inc 3303 Harbor Blvd, C-11 Costa Mesa, CA 92626 (714) 241-8650 TWX 910-695-0215 Circle No 636

Tektronix Inc Computer Aided Software Engineering Div Design Automation Group Box 4600, Mail Sta 94-485 Beaverton, OR 97076 (503) 629-1573 Circle No 637

Visual Age 642 N Larchmont Blvd Los Angeles, CA 90004 (213) 534-4202 (800) 732-2345 Circle No 638 A debugger's ability to relate the source code to the flow of execution makes it a useful tool when you must modify or debug code that someone else has written.

custom software tools that not only can save you time when repetitively performing complex debugging operations, but that can also serve as test programs for manufacturing and field service.

Many high-level-language debuggers, such as Introl's idb debugger for the firm's line of C compilers for single-chip μ Ps, have debugger variables that you can declare and use in debugger expressions. These variables reside in the debugger and not in your target system. Such variables prove useful as local variables in debugger macros.

Patch programs with debuggers

Using a high-level-language debugger's in-line assembler (or perhaps just jamming in a manually assembled set of machine-code instructions), you can patch programs without taking the time to recompile or reassemble. First, you replace the instruction at the beginning of the area you want to patch with a jump to a spare chunk of memory. You put the patch code in the unused area and finish it off with a jump back to the starting point or to the address just beyond the area you want to bypass. If your program doesn't have a scratch-memory area, you can reserve a portion of memory for patching by setting up a high-level data array that you do not use in the program. Your high-level language debugger can find the data array when given the array's name. You can then overwrite the data array with impunity.

You can also patch programs with a high-level-language debugger without bothering to go back to edit your source file and recompile it. You can use the debugger to break execution just before the section of code that needs patching. Then, you can execute a macro you have written that performs the correct operation on your data. Last, the macro can resume execution at the end of the code to be patched. If your debugger's command language mirrors that of your high-level language, you can later incorporate the patch in your source code with little effort.

Doing without source code

In some cases, you can trick the code under test into jumping to the debugger even if you do not have source code for it. For example, you could be calling your own assembly-level programs from another program written in a high-level language for which you have no source code. You could break on the entrance to your program and then use your debugger's backtrace feature to identify the calling routine. Then, using the examine and change routines in the debugger, you could replace the calling routine's jump command with a software trap to the debugger's entry point. That way, the next time you run the program, it will jump to the debugger just before entering your subroutine.

Generally, high-level-language compilers issue linenumber symbols at the end of each statement or each line, whichever comes first. Therefore, if you concatenate statements on a single line (using a semicolon in C, for example), you can't set a breakpoint between the two statements because the high-level-language debugger can only find the beginning and end of the line. And if you write multiline statements—for instance, an IF statement with several phrases on separate lines for clarity—the high-level-language debugger will only be able to find the beginning of the IF statement and the beginning of the THEN and ELSE clauses, not the individual phrases.

Possible new favorites

Some debuggers have unique features that may become industry standards once they are better known. For example, Visual Age's TurboSmith debugger for TurboPascal programs written on an IBM PC lets you assign breakpoints to groups by appending a number ranging from 1 to 98 to your breakpoints' definitions. Later, you can activate, or deactivate, an entire group of breakpoints, signified by a given number, at once rather than turning them on and off one at a time.

Periscope's debuggers have a set of editor-like search commands, which can look through a range of addresses for instructions that reference a given memory address. This command comes in handy if you are debugging your code by first finding the symptoms of a program bug in the form of corrupted data. Once you find a variable going awry, you then need to find which instructions are modifying it. The firm's debuggers have similar search commands for subroutine calls and return addresses as well as groups of assembly-language statements.

Under the heading of eliminating excessive flipping through related listings, some debuggers, such as Concurrent Sciences' Soft-Scope, can let you look at other files of source code besides the one being debugged.

> Article Interest Quotient (Circle One) High 470 Medium 471 Low 472

TekCASE: HOW TO BREAK A PROJECT INTO PIECES. AND PUT IT TOGETHER AGAIN. RIGHT.



You know how to maintain control and ensure quality of a complex systems project: first you divide it into parts and work on them concurrently, then you put it back together again. You also know how seldom a project survives this kind of reassembly intact —frequently, the final result barely resembles the original intent. Tektronix, a developer of complex systems for many years, now introduces a solution to the problem. This solution is TekCASE: a complete set of software engineering tools and services to guide you through the specification, design, and documentation of even the largest and most complex systems projects. Tektronix supports the entire software development life cycle.

Finally, a flexible and extensible tool set that gives you forward and reverse traceability and verification. Thanks to Analyst/RT and Designer, only TekCASE provides automatic transformation from specification to design and automatic conversion from code back to design. With the addition of Auditor, providing support for software developers complying with DOD-STD 2167, only TekCASE gives you uninterrupted visibility of your project from start to finish. And TekCASE runs on any VAX® configuration. **TekCASE is more than just a software tool**

TekCASE is more than just a software tool set—it's a strategic partnership. From project concept to code and beyond, TekCASE provides support, service, and frequent product updates. So, whether your project is in parts, back together, or somewhere in between, TekCASE is there to help you make sure the pieces fit. For more information, contact your local Tektronix representative or call 1-800-TEK-WIDE, extension 682. Tektronix, Inc., Computer-Aided Software Engineering Division, P.O. Box 14752, Portland, Oregon 97214.



**TekCASE is a trademark of Tektronix, Inc.
*VAX is a registered trademark of Digital Equipment Corp.
Copyright © 1987 by Tektronix, Inc. All rights reserved. MIA454.

REAL-TIME FLY

FRUNK FORTULE IRANK FORTULE IRANK FORTULE IRANK FORTULE INTEL '85

Now you can unleash all the raw power of the 80386 for real-time applications. All you need is our new iRMK[™] real-time multi-processor kernel. It's the lean, clean core of a full-featured operating system. Its blazing speed lets you keep up with the most demanding applications. Average interrupt response time is less than 10 microseconds. That's incredibly fast.

rating system. But more important is the iRMK VISIT US AT DEXPO WEST, ANAHEIM, CA. DEC. 8-10, BOOTH 801.

kernel's feature set. Which includes interrupt management, time management, mailboxes, semaphores, multitasking, and preemptive, priority-based scheduling.

And if you want more power, the iRMK kernel lets you use more processors. It's the only kernel that delivers multiprocessing support for the MULTI-BUS® II Message Passing Co-processor.

Besides running fast, your application will also run right. Because we offer more reliability features than any other real-time kernel. Like user-defined objects. And priority adjusting semaphores (regions) to avoid deadlock.

intel

And if your application requires features beyond what a kernel can deliver, we offer the iRMX® 286. A complete realtime operating system that runs on the 80386 without modification.

In addition to basic kernel functions, it

has reprogrammability, a human interface and on-target development.

iRMX 286 and the iRMK kernel are the latest developments in an operating system family we've been refining since real-time began for microprocessors. Currently, there are over half a million CPUs running iRMX, making it the most popular real-time O/S family in the world.

You'll also be glad to know that iRMX

MULTIBUS and iRMX are registered trademarks and OpenNET and iRMK are trademarks of Intel Corporation. © 1987 Intel Corporation

operating systems are solidly in touch with the rest of the real-time world. Our OpenNET[™] Network connects it to VAX/ VMS and even PC DOS compatibles.

F	REAL TIME	COMPARISON	1
	Interrupt Latency	Development Host	Regions
iRMK iRMX 286	10 µsec. 13 µsec.	PC-DOS self hosted	yes yes
VAXELN	33 µsec.	VAX/VMS	no

What's more, iRMK and iRMX are easy to get started with. Because they run on our industry standard family of open system MULTIBUS hardware. Including our new 20 MHz 80386

> MULTIBUS I and II boards.We even offer complete systems for OEMs like our new 80386-based System 320. And we top it all off with re-entrant compilers, debuggers, utilities, customer training and consulting. All designed to make your design task easier and faster. So why waste any

more time? For a realtime response from Intel, call our toll-free number: (800) 548-4725, and ask for Literature Department W-392. We'll mail a complete information packet within one working day. And you'll see how quickly time flies when Intel is on your side.

53.6 Reasons to Choose P-CAD for CAE and PCB design.



• End-to-end PCB design • Workstation performance • 53.6% market share* • New! SMT support



• Low cost schematic design • Auto place & route (45°) • Large board capacity • ASIC design kits



• 3000+ component library Operates on standard hardware
 Full range of system interfaces



• Design rule checking • Absolute data security • 3rd party software & services • 24-hour on-line support







To find out why 53.6% of engineers using PC-based CAD systems choose P-CAD® for workstation level performance, call toll-free:

800-523-5207 U.S. 800-628-8748 California

Personal CAD Systems, Inc. 1290 Parkmoor Avenue San Jose, California 95126 USA Telex: 371-7199 FAX: 408-279-3752

*Source: Dataquest, Inc. P-CAD is a registered trademark of Personal CAD Systems, Inc. Generation 2.0 is a trademark of Personal CAD Systems, Inc.

CIRCLE NO 144

User interface integrates incompatible computer-aided software-engineering tools

The Software Backplane, an integrated project-support environment (IPSE), provides a common user interface for software-development tools with different requirements and which run on network nodes that may have different architectures. It runs on Sun 3 workstations under Unix, or on any VAX workstation under VMS or MicroVMS.

The Software Backplane is a collection of software libraries that are organized into four layers. The monitor layer, based on the X Windows standard, provides each application with a consistent user interface. Forms, menus, icons, windowing functions, and mouse operations are the same regardless of the softwaredevelopment tool.

The management-control layer provides version control and configuration management, and it establishes cross-reference relationships among arbitrary components that represent various phases in the life cycle of the software under development. The object-management layer provides tools and application programs with a common data repository for all project-related data.

Finally, the portability layer provides all tools and applications with a generic operating system that translates service requests into the form required by the native operating system, and it also translates operating-system responses to the form required by the tool or application. Once you integrate a tool into the portability layer, you can run it on any computer with which the Software Backplane can operate. Prices start at \$5000.

Atherton Technology, 1333 Bordeaux Dr, Sunnyvale, CA 94089. Phone (408) 734-9822.

Circle No 640

CASE tools facilitate the design of real-time, embedded systems

Cardtools, a set of software-design and -development tools for CASE (computer-aided software engineering), provides the facilities to develop real-time, embedded systems. The tools automate the early, critical phases of software development such as high-level design, detailed design, documentation, and the analysis of system and software requirements.

Using the Control Maps Builder (CMB), you can define functional and data specifications and verify that the definitions are complete and consistent. From these definitions, you can use the Data Flow Diagram (DFD) Builder to define data flow through the system. You can use the Package Definition Facility to build a component library.

If you don't wish to construct your own DFDs, the Taskbuilder tool will do it for you automatically, using the specifications that you generated with the aid of the CMB. The Taskbuilder provides you with diagrams representing the required real-time, multitasking components such as hardware devices, tasks, mailboxes, semaphores, and queues; it also shows the intertask synchronization and communication requirements.

The Real-Time Performance Verification tool analyzes the synchronization and communication overhead. The Software/Hardware Interface facility prompts you for complete, detailed specifications of all signals and data that are processed both by hardware and software.

The specifications and definitions that the tools create are stored in a central database, Cardbus, from which the documentation tools can generate various reports, including reports that conform to DoD-STD-2167. Cardtools runs under VMS on VAX machines and under PC-DOS on IBM PCs and compatibles. Prices range from \$10,000 to \$60,000.

Ready Systems, Box 61029, Palo Alto, CA 94306. Phone (415) 326-2950. FAX 415-326-1427.

Circle No 641

PC-DOS extension lets C and assembly languages address 16M-byte RAM

DOS/16M lets C and assembly-language programs run in protected mode on 80286- or 80386-based computers. Programs written for DOS can address as much as 16M bytes of RAM without using code overlays, EMS bank switching, or data paging. The program and its data can reside in RAM, eliminating frequent disk accesses and speeding execution. DOS/16M switches to real mode only to process DOS functions or hardware-interrupt requests for which protected-mode handlers do not exist.

The package's run-time library contains routines for managing extended memory and for running programs in protected mode under PC-DOS version 3; a separate component allows you to start programs in protected mode. The package also includes a symbolic debugger for protected-mode programs, source code for the run-time library and start-up code, and a program to convert a real-mode .EXE program to a protected-mode .EXE program.

DOS/16M first adjusts your program for protected-mode addressing, then switches the computer into protected mode before executing the adjusted program. You don't usually need to rewrite or recompile your programs to use DOS/16M; you need only relink them with the runtime library. For example, you don't have to modify programs to omit EMS bank switching, and DOS/16M handles direct I/O and writes directly to video RAM without switching to real mode or adding overhead. You may have to modify any arithmetic operations that your program performs on segment-register values, and any parts of your program (such as interrupt handlers) that write into code segments of memory. If you have to recompile modified programs, you can use Microsoft C version 4.0, or a Lattice compiler, versions 2.15, 3.1, or 3.2. For linking object modules to the run-time library, you can use either Microsoft's Link or Phoenix's PLink86.

An initial-development license costs \$5000 and includes replacement libraries for the supported compilers, the protected-mode debugger, and the .EXE file converter. The license confers the right to distribute as many as 200 copies (in .EXE form) of a program you have developed with DOS/16M. A royalty-free, 1-time fee of \$29,000 allows you unlimited use and distribution and a source-code license.

Rational Systems Inc, Box 480, Natick, MA 01760. Phone (617) 653-6194.

Circle No 639

Expert system performs structured analysis of real-time software

Prosa, an expert system for software development, supports the structured analysis and design of data-flow, state-transition, and entity-relationship diagrams. It runs on an IBM-PC/AT or compatible and allows you to analyze real-time or data-processing systems. The system interactively maintains consistency between hierarchical dataflow diagrams and control transformations and their associated state-transition diagrams.

You can use Prosa to produce hierarchical designs. Its push-and-pop functions and consistency checking

allow you to produce or evaluate systems on a top-down or bottom-up basis. Pop-up menus provide you with only functions that are legal in the context of the current design phase. The system's editing facilities include the placement, movement, and scaling of diagram elements, as well as on-the-fly text editing. You can store user-defined elements in a data dictionary for future use, and you can pan and zoom the display to support diagrams with page sizes equivalent to ISO standards A4 to A0, or ANSI standards A to E.

To ease the transfer of design information to other development tools, Prosa establishes a graphics database in ASCII files and a knowledge database in Prolog format. PC/AT add-ins required include an EGA card, two RS-232C ports, and either Mouse Systems' PC mouse or Logitech's mechanical mouse. Output is to an HP7475 or HPGL-compatible plotter. \$3700.

Insoft Ky, Ilmarinkatu 16B, 90120 Oulu, Finland. Phone 981-226128. TLX 32004.

Circle No 642

AUTOCAD[®] Release 9. Its enhancements are Evident.

AutoCAD's new release builds on the strengths of its eight predecessors. Here's how:



PULL-DOWN MENUS.

Release 9's pull-down menus let you choose all of AutoCAD's fundamental commands with a click of your mouse or digitizer. You can also customize menus to provide your own frequently used commands. Pull-down menus are compatible with AutoCAD's proven system of screen and tablet menus.



ICON MENUS.

When you wish to select 3-D objects, text fonts, or hatch patterns, for example, you can pick them from an icon menu that appears on the screen. You can do the same thing with objects you create on your own. Icon menus make it easier and faster to choose the option you want.

DIALOGUE BOXES.

These let you converse with AutoCAD; give it instructions by "filling in the blanks." They can simplify many of your tasks—entering layer information, for example.

FILE PORTABILITY.

With Release 9, drawing files are directly compatible without any conversion steps across four different operating systems on four different machine architectures: PC-DOS/MS-DOS, Apollo AEGIS, DEC VMS, Sun UNIX.*

On a network with different types of computers you can access a single copy of a drawing from any machine.

MORE NEW FEATURES.

Release 9 also offers you twenty additional text fonts from the industry standard Hershey library, B-spline curve generation, and a direct link to the newly released AutoShade.[™]

RELEASE 9 = MORE POWER + EASIER ACCESS.

If you think CAD would boost your productivity, but you worry that a serious professional CAD package will take forever to learn, Auto-CAD Release 9 is for you.

You'll be able to put its extraordinary capabilities to work faster than you ever thought possible.

AutoCAD is registered in the U.S. Patent and Trademark Office by Autodesk, Inc. AutoShade is a trademark of Autodesk, Inc. 2320 Marinship Way, Sausalito, CA 94965

AUTOCAD the standard.

CAD is an essential productivity tool today, as essential as drafting boards and T-squares were yesterday.

With over 100,000 packages sold in seven languages around the world, Auto-CAD is the CAD software of choice among architects, engineers and designers.

Call 800/445-5415 for details.

We'll put you in touch with an authorized dealer who will show you the unprecedented power and ease of use of AutoCAD Release 9.

Your dealer will also show you which graphics systems can support our new display capabilities.

*PC-DOS is a registered trademark of International Business Machines Corporation. MS-DOS is a registered trademark of Microsoft Corporation. Apollo AEGIS is a trademark of Apollo Computer, Incorporated. DEC and VMS are trademarks of Digital Equipment Corporation. Sun is a trademark of Sun Microsystems Incorporated. UNIX is a trademark of AT&T Bell Laboratories.





Now The Only Limit Is Your Imagination.

Introducing TeleSTAR, the first open system 386 engineering workstation.

The new TeleVideo® TeleSTAR/386™ Engineering Workstation is the first workstation to give you 16 MHz 80386 power, high resolution graphics and Ethernet[™] networking. It even comes with an affordable price: just \$10,995. The new TeleSTAR/386 is an

68020-based workstation. It's the only way to get all the flexibility, portability and connectivity you need. It uses Microport[™] DOSMerge

386[™] for concurrent UNIX[®] system V.3 and MS-DOS[™] operation to give you access to the widest range of technical and business software. It also features MIT's X Window,[™] the de facto standard user-interface system for multitasking on one screen, plus GKS software for stan-

"open system," with all the features you expect to find on a Motorola

© 1987 TeleVideo Systems, Inc. TeleSTAR/386 is a trademark of TeleVideo Systems, Inc. MS-DOS is a trademark of Microsoft Corp. UNIX is a registered trademark of Bell Laboratories.



dard graphics applications.

To present your work at its best, there's a 1280 x 1024 pixel high-resolution display and 256 simultaneous colors from a palette of 4,096 (with 16.7 million colors optional), and a monochrome display with the same high-resolution and four grey levels. There's even a mathematical co-processor to help speed up your calculations.

And to help you share the wealth, there's a built-in Ethernet interface with TCP/IP and RFS software under UNIX system V.3 supporting NFS[™] from Sun Microsystems. Together, they let you network heterogeneously with mainframes, stand-alone workstations and PCs.

Our TeleSTAR/386 Engineering Workstation comes with features you might not expect at such a low price. Including a 17-inch color monitor (a 19-inch monochrome monitor is optional). A 3-button optical mouse. And 4 Mbytes of 32bit RAM memory that's expandable to 16 Mbytes.

If you're ready for a worksta-

tion that gives you the power you need at a price you can afford, you're ready for the new TeleSTAR/386.

Call us toll-free or write today, for more information.

TeleVideo Systems, Inc., 1170 Morse Avenue, Sunnyvale, CA 94088-3568. CIRCLE NO 142





SOME PEOPLE ASK LIFE & DEATH QUESTIONS WITH OUR MICROPROCESSOR DEVELOPMENT TOOLS. Multiply your productivity Multiply your productivity

What you see above isn't the late-night vision of an overworked design engineer.

Rather, it's blood-ready to be computer assayed at the touch of a button in a hospital operating roomon a new blood gas analyzer that works twice as fast as ever before. All to save time, money, error-and lives.

This breakthrough for anesthesiologists was created by NOVA Biomedical. And made possible by AVOCET, acclaimed as the best source for professionalquality assemblers, simulator/debuggers and crosscompilers for microprocessor and microcontroller software development.

Let Avocet turn your PC or VAX into a fast, powerful, integrated development system in 48 hours, even overnight.

Avocet can help you turn more good ideas into more real products in less time.

Just call us now and we'll get you up and running with what EDN calls "the most flexible, easy-to-use, high-speed development tools"-everything you need to turn your computer into a sophisticated personal development system.

All at a modest price. From a single source. Backed by the reassurance of a technical hotline. So friendly, knowledgeable, immediate-response support is always as close as your phone.

Start with the industry standard: Avocet AVMAC[™] Assemblers.

The latest AVMAC Version 2.0 offers you lightningfast assembly. Plus, enhanced compatibility with Intel, Hitachi, Motorola & other chipmakers. Each AVMAC package comes complete with our AVLINK" linker, AVLIB[™] librarian, AVREF[™] cross-reference generator and 200+ pg. User's Guide-all the tools you'll want and need.

with NEW Avocet C."

Introducing Avocet C-professional-quality optimizing cross compilers for the Z80, 64180, 8096, 8051 and more.

Avocet C gives you quick compilation and compact, fast-running object code. And yes, it supports the full C language, including many ANSI extensions.

Of course, Avocet C is also compatible with our AVMAC assemblers. So you can drop into assembly language when you need to work magic at the bits-andbytes level.

Test with the best: AVSIM[™] Simulator/Debuggers.

NOVA™ Biomedical design engineers rate AVSIM "Number One" for checking programs-quickly and reliably.

AVSIM test target $\mu P/\mu C$ code right on your PC, with no special hardware. It can't be crashed by program bugs. And the full-screen display gives you instant visual access to the entire CPU: flags, registers, memory, I/O ports and on-chip peripherals Highlyrated by EDN, "only AVSIM is sophisticated enough to let you set unlimited breakpoints and traps."



Target Microprocessor

	rami	lies Supported	
1802/1805	6	8000/68010	COP400
6502/65C02	6	8020	HD64180
5801/6301	8	048/8041	NEC 7500
5804	8	051/8052	TMS-32010
5805/6305	8	085	TMS-32020
5809	8	096	Z8
58HC11	F	8/3870	Z80
	Host C	perating Systems	
CP/M	DOS	PC Xenix	VAX Unix
AVMAC Macr AVSIM Simul	ro Assembler ator/Debugg	S	from \$349

Call now about new Avocet C Cross Compilers from \$895

CALL TOLL-FREE 800-448-8500*

to order, inquire about other development tools or receive our latest microprocessor development tool catalog

Try before you buy.

Order your AVMAC assembler and AVSIM simulator/debugger today and we'll include a special demo kit for both. Try the demo for 30 days. If you're not satisfied for any reason, return unopened products for a full refund, less the \$35 demo/documentation kit which is yours to keep.

Avocet Systems. With our development tools, the diagnosis for your project is a smooth finish-on time and on budget.

Avocet Systems, Inc., 120 Union Street P.O. Box 490BL, Rockport, Maine 04856

*Outside U.S. and in ME, call (207) 236-9055 TLX: 467210 AVOCET CI FAX: (207) 236-6713

Avocet delivers all the tools you need in 48 hours or less. Ask about our NEW Cross-Compilers, our AVPROM" and AVPAL" programmers, our 8051 in-circuit emulator, devel opment boards, the AVPAS 51" cross-compiler-and AVKIT,™ the total Unix toolbox for DOS, including the incomparable VI editor.

© 1987 Avocet Systems, Inc. All rights reserved. VAX is a trademark of DEC Unix is a trademark of AT&T. Xenix is a trademark of Microsoft, CP/M is a trademark of Digital Research.

SYSTEMS, INC THE SOURCE FOR QUALITY PERSONAL µP DEVELOPMENT TOOLS.

CIRCLE NO 141

TEXAS INSTRUMENTS REPORTS ON DOSP

IN THE ERA OF INTHE ERA OF INTH

DSP in the Era of MegaChip Technologies:

Digital signal processors are turning up winners



TI's TMS320 DSPs add high performance at costs low enough to open new worlds of applications — from a high-performance Formula 1 car suspension to an intelligent doll and everything in between. ©1987 Worlds of Wonder, Inc. All rights rese

he results are in. You can add more performance at lower cost design ing with the standard in digital signal processors (DSPs), TI's TMS320 fami There are now even more reasons tha ever to get the advantages of TI DSP performance in applications wherever realtime number crunching is essentia

from Texas Instruments n all sorts of places.



nese advantages can make a differce in applications as wide ranging as odems, disk servo controllers, sonaoys, and voice multiplexers to ectrum analyzers and graphics orkstations.

Getting started in DSP design is sier with Texas Instruments training

and support. But once you see what the TMS320 family can do, you'll want the features TI DSP can give your designs.

"Handling performance is up there next to speed in Formula 1 racing. TI's TMS320 gives us a real advantage - enough to win a Grand Prix." Peter G. Wright, Technical Director, Lotus Engineering Lotus designed the active suspension in their Camel-Lotus-Honda Formula 1 car to approach the theoretical maximum-control point which gives the best balance between handling and performance. At racing speeds, each wheel is positioned by the TMS320controlled hydraulics. A single TMS320 chip measures wheel forces and displacements and reads data from a body-mounted inertial platform. Then, in real time, the chip computes wheel position and controls actuators that adjust the suspension components to precise settings.

The TMS320 can also handle closed-loop engine control and more responsive braking systems, as well as many other automotive applications.

"The TMS320 helps us with one of our toughest tasks — designing toys with exciting features at prices that will sell." Dave Small, VP Engineering, Worlds of Wonder, Inc. Worlds of Wonder is a pioneer in developing interactive toys and now has an innovative new doll named Julie[™] Using a single TMS320 chip, Julie's designers are able to give her voicerecognition ability, coupled with synthesized speech and coordinated facial movement.

The TMS320 design expands the applications for affordable consumer products like solid-state answering machines, cellular phones, improved hearing aids, and animated electronic games.

TI's MegaChip Technologies

Our emphasis on volume manufacturing of high-density CMOS circuits is the catalyst for ongoing advances in how we design, process, and manufacture semiconductors and in how we serve our customers. These are our MegaChip[™] Technologies. They are the means by which we can help you and your company get to market faster with better, more competitive products.

Winning designs come from a family of winners

There are 15 compatible members in the TMS320 family (*see the road map below*), featuring two new DSPs with on-chip EPROM, the TMS320E15 and the TMS320E17. For applications requiring off-chip memory, there is the new CMOS EPROM, the TMS27C292, with 35-ns speed.

New interface alternatives include the low-cost CMOS TCM29C18/19 Combo Codecs with A/D, D/A, and filters all on a single chip.

The high-performance TLC32040 Analog Interface Circuit has 14-bit A/D and D/A and programmable filters.

For higher performance in digital signal processing, you can use buildingblock products like TI's microcodable ACT88XX 32-bit processor family.



From \$5 to 33 Mflops: With three generations covering 15 products, the TMS320 family offers software compatibility to protect your development investment and provide a smooth path to future applications.

For more information on support for the TMS320 family, please turn the page.

From hands-on training to a "C" compiler, TI has the tools you need to get your designs to market fast.

Whether you're moving into DSP or moving up in DSP, Texas Instruments can help you move your design into production faster. Hands-on DSP Workshops using the TMS320 development tools cover all you need to know from architecture to software. Courses are scheduled at **TI** Regional Technology Centers. Get Started in DSP with the TMS320 Design Kit, which contains data sheets, chip samples, and applications notes to make starting easy. Count on EPROM DSPs for realtime code development, form-factor emulation, and early production runs, with the option for last-minute changes.



Applications Notes and Textbooks contain literally thousands of pages that are readily available to give you assistance in application concepts and designs.

Optimizing "C" Compiler reduces your time to market and preserves your software investment.

The Assembler/Linker and Simulator speed software development for you. Realtime In-circuit Emulators allow you to integrate software and hardware and give you a final check.

For more information on the Julie doll from Worlds of Wonder, Inc., call (415) 656-3171.

[™]MegaChip is a trademark of Texas Instruments Incorporated. Julie is a trademark of Worlds of Wonder, Inc. More than 80 Third-party Hardware Suppliers and Consultants are featured in our TMS320 Family Development Support Reference Guide and in our DSP newsletter Details on Signal Processing. TMS320 Bulletin Board is an on-line service that provides you with the latest technical and application information. The TMS320 Technical Hotline is staffed by applications experts and is ready to take your call.

How to get a fast start For more information on TI's TMS320 DSP family, call 1-800-232-3200, ext. 3508. Or use the coupon below.

SPR173ED7ØØ

Texas Instruments Incorporated P.O. Box 809066

Dallas, Texas 75380-9066

YES, please send me information on the following TI Digital Signal Processing products and support services:

- □ PRØ1: TMS320 DSP Products
- □ PRØ2: Analog Interface Devices
- PRØ3: ACT88XX 32-bit Processor
- □ PR04: TI Regional Technology Center Workshops

NAME			
TITLE			
COMPANY			
ADDRESS			
CITY		STATE	ZIP
AREA CODE	TELEPHONE	FXT	

TELEPHONE EXT.



REAL-TIME OS

VRTX32 is a real-time, multitasking operating-system kernel intended for use with embedded computers based on the Motorola 68020 or Intel 80386 µPs. The kernel employs a pre-emptive, prioritybased scheduler that lets you create, delete, resume, and suspend tasks. It also handles all service calls, including those for task services, intertask synchronization and communication, memory allocation, real-time clock services, character I/O, and interrupt handling. You can combine the kernel with the vendor's IOX (Input-Output Executive), which provides advanced device-level I/O facilities for character, disk, and general-block peripherals. You can also combine the kernel with FMX (File-Management Executive), which implements the PC-DOS file system. The system is position-independent; it uses program-counter-relative and base-relative addressing, and you can locate it anywhere in the available address space without modification. The vendor guarantees that interruptsoff time will never exceed 15 µsec on a 16.7-MHz 68020 processor. Versions are available for 68000, 68010, 68020, and 80386 µPs; \$6775 each.

Ready Systems, Box 61029, Palo Alto, CA 94306. Phone (800) 228-1249; in CA, (415) 326-2950. TLX 711510608.

Circle No 404 Ready Systems SARL, 16 bis Rue Grange Dame Rose, 78140 Velizy-Villacoublay, France. Phone 33-1-3946-89-86.

Circle No 405

PASCAL COMPILER

The Pascal-2 compiler runs on and generates code for 68000-, 68010-, and 68020-based computers. Two versions are available. One runs under the vendor's VersaDOS realtime, multitasking, multiprocessing operating system; the other runs under System V/68, which is the vendor's version of Unix System V,

release 3. The compiler, developed for the vendor by Oregon Software Inc (Beaverton, OR), is configured so that the same package runs on any of the three µPs; you use a compiler directive to select the target machine for which the compiler will generate code. Both versions can generate code that makes use of the 68881 FPU. The compiler can generate ROMable code for both VersaDOS and System V/68 target machines; it can also generate position-independent code (PIC) and code for targets that don't have memory-management units (MMUs). System V/68 can't use PIC and doesn't run on non-MMU targets. The compiler provides new string-handling capabilities and I/O switches, and the package includes an assembler interface, an execution profiler, and several cross-reference utilities. If a run-time error occurs, the compiler's error-walkback feature generates a special listing showing (in Pascal notation) each procedure call that was performed, from the point of failure back to the main program. Each version, \$2800.

Motorola, Microcomputer Div, Box 20912, Phoenix, AZ 85036. Phone (800) 521-6274.

Circle No 406

OS/2 DEVELOPMENT KIT

The OS/2 Software Development Kit allows you to start developing applications software to run under OS/2 on 80286- and 80386-based machines. The tool kit consists of a prerelease version of the OS/2 system kernel and technical specifications for the kernel and for the OS/2 LAN manager. It also includes new versions of the vendor's macroassembler (MASM) and C compiler, the CodeView debugger, and other software-development tools, including a programmer's text editor. The price of the development tool kit includes one year of technical support via the vendor's DIAL (Direct Information Access Line) electronic mail service and a subscription to the *Microsoft Systems Journal*. Updates will include the OS/2 Windows specification and software, as well as the LAN Manager software and associated utilities. \$3000.

Microsoft Corp, Box 97017, Redmond, WA 98073. Phone (206) 882-8080. TLX 328945.

Circle No 407

C COMPILER

Turbo C is a C editor, compiler, and linker that runs on the IBM PC and compatibles. The compiler conforms to the Kernighan/Ritchie and proposed ANSI standards and is compatible with other compilers that follow these standards. The compiler can compile code for six memory models: Tiny, Small, Compact, Medium, Large, and Huge. Its use of near and far pointers lets you take full advantage of the 8086 µP's architecture by means of a mixedmodel technique. The vendor claims that Turbo C has a compilation speed of 10,000 lines per minute. The run-time library contains more than 300 functions that you can call from within your C programs. The math functions conform to the IEEE floating-point standard, and they emulate an 8087 math coprocessor if one is not present in the system. The vendor offers complete source code for the run-time library at \$235. The package includes a built-in editor, linker, and Lint error checker. Within the integrated environment, you can switch from one facility to another without returning to the OS. \$99.95.

Borland International, 4585 Scotts Valley Dr, Scotts Valley, CA 95066. Phone (408) 438-8400. TLX 172373.

Circle No 408

EMULATOR

The Mime-600 emulator connects to a PC or host computer to provide program debug facilities for most popular 8-bit μ Ps. In addition to

The origin of new life...

Software

four breakpoint/trigger control tag bits for each of the µP's memory locations, the emulator has four 48-bit hardware breakpoint comparators. You can break on the nth occurrence of a comparator's break condition, or on logical combinations or logical sequences of breakpoint conditions. The emulator has an 8k×48-bit trace memory, which you can reconfigure to $4k \times 96$ bits for time-stamped trace results. The emulator has a total memory map of 16M bytes, with 256k bytes of relocation RAM, and another 256k bytes of shadow memory. During program development on the host computer, the emulator provides a transparent link between the computer and a terminal. After developing your program, you can download program code and symbol tables to the emulator for use in debugging. £4300, including a target adapter board for one µP; additional target

adapter boards, £1790.

Pentica Systems Ltd, Station Industrial Estate, Oxford Rd, Wokingham, Berks RG11 2YQ, UK. Phone (0734) 792101. TLX 848210.

Circle No 409

OPERATING SYSTEM

Suitable for use on IBM PC/AT and compatible computers, the RT/iX operating system allows you to execute real-time multitasking operations under MS-DOS (version 3.0 and up). The operating system controls application programs written in C, and after program execution MS-DOS remains available for the user without any rebooting. All access to mass storage remains under the control of the MS-DOS file manager, allowing you to transfer data from the application program to standard MS-DOS-based programs. The system comes on a 3¹/₂- or 5¹/₄in. disk, and includes source code for sample drivers, which you can use for interrupt-driven or polled systems. Around DM 1000.

Kontron Messtechnik, Oskarvon-Miller-Strasse 1, 8057 Eching/ Munich, West Germany. Phone (08165) 77601. TLX 526719.

Circle No 731 Kontron Electronics Inc, 630 Clyde Ave, Mountain View, CA 94039. Phone (415) 965-7020. TWX 910-378-5207.

Circle No 410

DATA ACQUISITION

Laboratory Workbench software greatly simplifies the setup and control of high-performance dataacquisition modules operating under the Unix OS on the vendor's Series MC5000 real-time signal-processing computers. A file menu allows you
Software



to save or to select previously created command files that control the sequence of operations; a timebase menu lets you choose timing and synchronization parameters; a hardcopy menu permits you to direct output to any one of a variety of printers and plotters; and a help menu lets you select on-line help screens. The package includes builtin signal-processing modules such as FFT, inverse FFT, and filtering functions; signal averaging; and power-spectrum calculations. You can also process data through a Fortran expression that you write into a window on the screen. You can display data as an X-Y plot or an oscilloscope trace, or, if you are dealing with slowly changing data, as a number that the program updates at specified intervals. Prices range from \$3000 to \$4500, depending on the host system configuration.

Masscomp, 1 Technology Park, Westford, MA 01886. Phone (617) 692-6200.

Circle No 412

PROCESS CONTROL

K-SCAN utilities configure processcontrol systems that run the vendor's Forum system on DEC computers. The utilities let you define the I/O devices to be read or controlled; these devices can include sensors, alarms, operator displays, data recorders and plotters, and



controlling elements. You can logically relate digital I/O bits with AND, OR, or Exclusive-OR functions and write programs for GPIB communications and device protocols. The menus also allow you to define the dynamic relationships between inputs, outputs, and storage elements by means of mathematical functions. The utilities store your definitions in a central database, together with calculations for PID loops, ramping functions, polynomial conversions, lead/lag functions,

WINS/Streams." The natural solution to UNIX connectivity.

Transparent. Portable. The natural evolution of TCP/IP for UNIX.[™] Such a natural, in fact, WINS/Streams is *the* UNIX V.3 communications

standard. Truly life-sustaining. For more information, call 800-872-8649 (in California 800-962-8649) or send us this ad with your business card. The Wollongong Group, Inc., 1129 San Antonio Road, Palo Alto, Ca. 94303. WOLLONGONG We are the standard.

© 1987, The Wollongong Group, Inc. WINS/Streams is a trademark of The Wollongong Group, Inc. All other product names are registered trademarks of their respective manufacturers.

Software

and other relational functions. A sequencer-control utility lets you define sequential operations in steps; each step can compare as many as nine variables to each other or to constant values. Prices range from \$15,000 to \$25,000, depending on the host configuration and the options selected.

KineticSystems Corp. 11 Maryknoll Dr. Lockport, IL 60441. Phone (815) 838-0005.

Circle No 413

OS FOR 80386

PC-MOS/386 version 1.02 is a multitasking, multiuser operating system for 8088-, 8086-, 80286-, and 80386based computers, and it takes advantage of all the 80386's features. Those features specific to the 80386 CPU are isolated in a single systemdriver file used only when an 80386 is present in the system. Systems based on the other chips in the family can use the extended-memory facilities of the OS, provided that the systems include extended-memory hardware. The OS provides software tools that let you assign 640k bytes of RAM to each task or user, including "ill-behaved" tasks that write directly to video hardware. You can also run multiple tasks in systems that don't have extendedmemory-management hardware, but you are then limited to a total of 640k bytes (minus system overhead) for all tasks. Single-user version, \$195; 5-user version, \$595; 25-user version, \$995.

The Software Link Inc. 3577 Parkway Lane, Atlanta, GA 30092. Phone (404) 448-5465. TWX 4996147.

Circle No 411

DATA ACQUISITION

LabWindows software helps you use your PC to develop software for



data-acquisition, data-reduction, data-analysis, data-presentation, and instrument-control applications. The package consists of an interactive, menu-driven module that lets you select either Microsoft C or Microsoft QuickBasic as your programming language, and of libraries that contain routines for instrument control, data analysis, graphics, data formatting, and GPIB control. If you plan to work on complex applications, you can obtain other modules containing routines



A WORLD OF DIFFERENCE

GTEK* , Inc. has made a world of difference with their Model 2010B Single Board Computer. In fact, the 2010B has put an end to all the rigamarole involved in using a computer. This powerful board is multi-faceted to perform any industrial control application you desire **BIG THINGS-SMALL PACKAGES**

Big things do come in small packages. The Model 2010B is all the proof you need. Its features include

A solid state EEPROM DOS for programs

-40 I/O lines, each individually programmable -64K bytes RAM for data and/or programs -Enhanced version Intel control BASIC v1.1 RS232 with handshake, onboard EIA voltages -EEPROM storage for floating point constants -Single power supply 9-15v, onboard regulator Expansion bus, for even BIGGER things!



GTEK* . Inc. has turned the dawn of a new era in computing into the age of difference...the age to make a difference. So call or write us today. Distributor and OEM inquiries welcomed. Also available, 2010M Machine language version

CIRCLE NO 20

ORDER TOLL FREE 1-800-255 GTEK (4835) TELEX 315814 (GTEK UD) MS & Technical Support 1-601 467-8048

DEVELOPMENT HARDWARE & SOFTWARE Drawer 1346 Bay St. Louis. MS 39520 U.S.A.



For further information, contact Lauren Fox, EDN Info Cards Manager, at (203) 328-2580. * Numbers represent actual

responses

182

"I'll call you right back".

The check's in the mail'

"It debugs in C like ECHO."

Promises, Promises.

Everybody promises, but nobody delivers a realtime, emulator-based C-debug environment like Arium's ECHO. 16-bit, true multitasking and UNIX-based, ECHO gives you more power, speed and menu-driven features to handle the 68000 and other μ Ps better than the HP 64000, or anything else.

Prove it to yourself. Read the screens below. Then ask any other development system-standalone or host control-to match them. We'll wait.

Now you know a few reasons (and there are plenty more) why ECHO should be your emulation tool for today's increasingly complicated software debugging.

Just words, you say, promises like all the rest?



Code Preview[™] lets you see where your code is going. You can follow calls and branches (to 99 levels) on the screen, to select the source line on which to trigger, then set and break in one keystroke! The highlighted trace display (in source) and stack trace window show the path your program took.

For a demonstration call 800/862-7486 (CA 714/978-9531)

Stack-Relative Trigger lets you trigger on the addresses and values of stack-relative variables-a "must" for effective C-debug where the address of an automatic variable is different each time the function is called and is determined at execution. Here, a read of the local variable "nrecur" is included in the trigger sequence.



1931 Wright Circle, Anaheim, CA 92806

CIRCLE NO 125

TimeStamp™ and variable display are two further features that are a must for real-time C-debug. Note the display of two instances of a structure in array "starray." The contents of these structures, as for any C variable, can be changed right on the screen.



Software

for advanced analytical and processing functions and advanced graphics. The function menus let you construct and interactively execute function calls by selecting the function and entering the parameters; after you've done so, the Lab-Windows module automatically generates source code in the chosen language. The compiler creates a list of all errors that it detects during compilation; using the editor, you can correct all of these in one pass before recompiling. The package also provides run-time debugging tools. When you have created and debugged your program, you can save it as a QuickBasic or C source-code file; with an external compiler, you can compile this code and link it to the appropriate library modules to produce a stand-alone executable program. \$495.

National Instruments, 12109 Technology Blvd, Austin, TX 78727. Phone (800) 531-4742; in TX, (800) 433-3488.

Circle No 414

C COMPILER

SC-C is a C compiler that runs on the vendor's PC4000-a RISC coprocessor card that plugs into IBM PCs and compatibles. The PC4000's CPU is a Novix NC4016 RISC µP with 512k bytes of onboard memory, which delivers processing speeds in the 4- to 8-MIPS range. The C compiler provides all the features of the Kernighan and Ritchie standard, along with newer extensions of the language, such as void and enum data types, functions returning structures, structure assignment, const and volatile attributes. and others. The compiler generates a mixture of in-line and threaded code to improve efficiency; you can adjust the proportions of the mixture to optimize your program either for greatest execution speed or

for smallest code size. The library includes routines that interface to the vendor's PCX executive; you can substitute other routines for use in a different run-time environment. PC4000 coprocessor board, from \$1295; SC-C compiler, \$595.

Silicon Composers, 210 California St, Palo Alto, CA 94306. Phone (415) 322-8763.

Circle No 415

CROSS-COMPILERS

The InterTools line of C and Pascal cross-compilers and cross-assemblers runs on IBM PC/XT or PC/AT hosts, as well as on a variety of workstations, and generates code for Intel and Motorola μ Ps and other 8-, 16-, and 32-bit target μ Ps. The most recent additions to the line are compilers, assemblers, and debuggers for 68020 target μ Ps; these compilers let you use all of the 68020's addressing modes and bit-



FUJITSU AMERICA. INC 3055 Orchard Drive San Jose, CA 95134

FUJITSU'S 1/2" CARTRIDGE TAPE DRIVE

Announcing an important development in $\frac{1}{2}''$ cartridge tape drives.

Immediate delivery.

We're shipping ½" cartridge tape drives in any quantity. Today. To give you an alternative to full-sized ½" reelto-reel technology.

When you want it now, get it from Fujitsu America.

Small Size. Big Performance.

You'll get all the performance you need in a $5\frac{4''}{2}$ form factor. Our $\frac{1}{2''}$ cartridge tape offers 130 MB of formatted storage.



Back-up operations in a streaming mode at either 50 or 75 inches per second (ips). File management operations in

Get $\frac{1}{2}$ " reel-to-reel performance in a 5 $\frac{1}{4}$ " form factor.

the start/stop mode at 50 ips. Transfer rates of 225 KB/S. And an outstanding bit error rate of 1×10^{-12} .

Plus 15,000 hours MTBF. Design in the power and reliability of Fujitsu America.

Easy to Integrate.

For SCSI systems, optional high-performance M1008A SCSI controllers are available, too.



So don't settle for less. Call today for an evaluation unit. Or for more information on any of our world famous family of data storage products, including Winchester, tape, optical and flexible drives. 800-626-4686.

Or write Fujitsu America, Computer Products Group, 3055 Orchard Drive, San Jose, CA. 95134-2017. Solve your tape problems today.



A COMPANY WITH CHARACTER AND DRIVE

FUJITSU

FUJITSU AMERICA Computer Products Group

Some of the best reasons for buying an Archimedes C Compiler have nothing to do with its amazing speed

Speed is one thing. But most programmers like the way Archimedes ANSI-C runs and debugs generic Ccode with host C-compilers and debuggers, like Microsoft's C-86 and Code View.

Writing your own library routines can be frustrating. Except with Archimedes, which supports advanced math functions and lets you skip writing your own routines.

Compatibility with standard equipment means a great deal to those making purchasing decisions. Tell them that Archimedes runs on hosts like the IBM PC, MicroVAX and VAX systems. Another reason to use C instead of assembly: You can easily update code, even if you're not the original programmer.



Archimedes also takes the trouble out of big projects: You can easily integrate code from several programmers via a special LINTtype feature.

Even the fastest programming language can be made faster if the code is reusable for other microcontrollers. And Archimedes is.

Speed is useless if you can't apply it to your favorite microcontrollers. And Archimedes supports the most popular: Intel 8051 and 8096 families, Motorola 68HC11 and 6801, Zilog Z80, Hitachi 6301 and HD64180, and more.

As you can see, there are many advantages of programming microcontrollers in C other than speed. But when it gets right down to it, speed is why you'll buy Archimedes Microcontroller C. Because C-Code is cleaner, clearer, easier to use-and using it is guaranteed to cut your development time by at least 50% over assembly.

Call Archimedes now at (415) 567-4010 for a free demo diskette and product guide on Archimedes Microcontroller C. So you can hurry up and start programming faster than ever. © 1987 Archimedes Software, Inc. Archimedes and Microcontroller C are trademarks of Archimedes Software, Inc. MicroVAX and VAX are registered trademarks of Digital Equipment Corp. IBM is a registered trademark of International Business Machines. CodeView and Microsoft are registered trademarks of Microsoft Corp.



Archimedes Software Inc. 2159 Union Street San Francisco, CA 94123

CIRCLE NO 123

Software

manipulation features. The package also lets you use either the 68881 numeric coprocessor or software routines for floating-point operations, and it includes a library of mathematical functions for both modes. The compilers produce reentrant, ROMable code and come with librarian, linker, locator, formatter, and Romp utilities for use in the creation of ROMable code. Prices depend on the host machine; they start at \$1000 (compilers), \$800 (assemblers), and \$1500 (debuggers) for an IBM PC or compatible host.

Intermetrics Inc, 733 Concord Ave, Cambridge, MA 02138. Phone (617) 661-0072.

Circle No 416

C FOR 8096 µC

The C cross-compiler C-8096 runs on a variety of hosts, such as the IBM PC and compatibles and VAX and MicroVAX machines, and generates code for applications that will run on an embedded Intel 8096 microcontroller. The compiler provides all of the standard Kernighan and Ritchie features of the language, as well as the enhancements in the proposed ANSI standard. To simplify the development of embedded systems, the compiler also provides some 8096-specific enhancements such as enable interrupt and disable interrupt. The compiler supports the IEEE 32-bit floating-point arithmetic standard, and the library includes functions for trigonometric, logarithmic, and exponential functions, as well as the most important I/O functions for embeddedcontroller applications. All of the library functions are re-entrant to allow recursive code and interrupt handlers. The compiler provides the features necessary for generating ROMable code, including statically initialized variables. IBM PC hosts must have at least 512k bytes of RAM and MS-DOS 2.0 or later: MicroVAX and VAX versions will run under Unix or VMS. IBM PC version, \$995; MicroVAX version,

\$3995; VAX version, \$5995.

Archimedes Software Inc, 2159 Union St, San Francisco, CA 94123. Phone (415) 567-4010.

Circle No 417



CONTROL LANGUAGE

The HP Basic instrument-control language embodies many enhancements of the Basic language. These enhancements provide advanced I/O capabilities and facilitate the control and acquisition of data from instrumentation equipment. A new version of the instrument-control language is built into the HP 82300A Basic card, a 68000-based languageprocessor card that plugs into the vendor's Vectra PC or into an IBM PC or compatible. You can easily switch back and forth between HP Basic and applications such as Lotus 1-2-3 or a text processor. The features of the language card include a syntax-checking editor for writing or correcting programs, control structures that allow structured programming, and single-statement commands. The language-processor card includes 512k bytes of RAM (expandable to 4M bytes), an interface that provides access to an optional GPIB interface card, and a shared-resource manager that allows the host access to the vendor's workstation networks. \$1320.

Hewlett-Packard Co, 1820 Embarcadero Rd, Palo Alto, CA 94303. Phone local office.

Circle No 418

PROLOG INTERPRETER

The interactive Prolog interpreter WProlog runs on IBM System/370 mainframes under the VM/SP CMS operating system. It provides command-line editing. You can use its CMS editor to edit your programs. The interpreter provides extensive syntax-checking and diagnostic features, and includes a built-in trace facility for debugging. This facility allows you to view the operation of selected predicates, even if these predicates are activated from within the body of a "hidden" predicate. Modules are independent; you can change and reload them individually. They are simple to use, because you need only declare the name and number of arguments of exported predicates-you don't have to make statements about the symbols within a module. The interpreter's programs use conventional CMS filesupport statements to open, close, read, or write files, and they can directly execute any CMS Subset commands. Yearly license fees, \$900 for educational users. \$1800 for commercial users, and \$3600 for thirdparty users.

Watcom Products Inc, 415 Philip St, Waterloo, Ontario N2L 3X2, Canada. Phone (519) 886-3700. TLX 06955458.

Circle No 419

MULTIUSER OS

The multiuser, multitasking operating system Wendin-DOS will run on any IBM PC or compatible and on 80386-based machines, but requires at least the computing power of a PC/AT to provide effective multiuser operation. The OS provides all of the PC-DOS commands and switches, and will run most popular MS-DOS application programs. Moreover, it provides many additional facilities that make operation easier. Among these are the Alias command, which lets you initiate a complex sequence of DOS commands with a single command name; the assignment and display of your

Software

access rights; a log-in command that grants you the privileges and attributes associated with your user name; a log-out command that resets these privileges and attributes; and many other features derived from the VAX/VMS operating system. The OS has a windowing facility. You can order an optional application-developer's kit to help you develop multitasking applications. Wendin-DOS, \$99; Application-Developer's Kit, \$99.

Wendin, Box 3888, Spokane, WA 99220. Phone (509) 624-8088.

Circle No 420

REAL-TIME OS

D-Nix/MP is a multiprocessor version of a real-time operating system that is fully compatible with Unix and conforms to the System V Interface Definition (SVID), yet offers features that make it particularly suitable for on-line transaction processing (OLTP). The OS runs on 68020-based machines; implementations for other processors are planned. A small and efficient kernel, a pre-emptive scheduler, and memory-resident processes allow the OS to provide the fast, predictable responses essential in real-time systems. The system provides extensive networking and data-communications facilities. It uses a bit map for file allocation, a technique that permits the creation of files with completely contiguous disk space and thereby reduces diskhead movement. According to the vendor, this technique also results in faster disk I/O and more predictable access time. A mirror-disk feature guarantees data integrity by writing all data to two disk drives simultaneously. Price depends on host configuration and other factors; licensing, from \$25,000.

Diab Systems Inc, 323 Vintage Park Dr, Foster City, CA 94404. Phone (415) 571-1700. TLX 516020. Circle No 421

ADA COMPILER

Tandem Ada runs on all the vendor's NonStop systems and has been validated by the Ada Joint Program Office (AJPO). The compiler meets all the requirements of the current ANSI/MIL-STD-1815A and ISO/ 8652-1987 Ada standards. It generates code that is native to the vendor's NonStop architecture and Guardian-90 operating system. The compiler supports as much as 4M bytes of code space and 128M bytes of user-data space in main memory. Because NonStop systems have multiple processors, compilations can run concurrently and can put object code into different libraries, thereby reducing the total compilation time for many programs. The Ada package consists of the compiler, a library manager, a binder that



CMOS is fast becoming the chosen technology for developing integrated circuits. That's because CMOS ICs are able to implement ultra-complex system-level functions on a chip!



Now you can meet the special challenges posed by this new breed of ICs with *A Designer's Guide to CMOS ICs*. You'll learn the advanced design and fabrication techniques required. Plus the latest linear and digital CMOS ICs available.

Mail coupon to: CMOS IC reprints - EDN Magazine	March States and States	EDN 121087
Cahners Building	NAME	a area and a source of the second
Newton, MA 02158-1630 Please send copies of <i>A Designer's Guide to</i>	TITLE	And a second
CMOS ICs (92 pages) \square \$6.95 UPS \square \$10.95 non USA (BANK DRAFT ONLY)	COMPANY	at all the second second second
Check or money order made out to EDN REPRINTS must accompany each order. No COD. Mass.	ADDRESS	and the second second
residents add 5% sales tax. Please print clearly. This is your mailing label.	CITY	STATE ZIP

CHINON: Scanning the future.



Chinon's design engineers have a serious commitment to produce the most technologically advanced products that the mind of man can imagine.

That commitment has created subsystems, peripherals and components that could change the way we think about computers–and change the way computers are used.

The Scanner and the CD-ROM units pictured here are the types of products that continually move the leading edge forward. The Scanner could change the way business works by making true OCR technology more affordable and easier to use than ever before. The unique scanning head design means that the document to be scanned remains fixed, unlike other scanners that can only accept a single sheet fed through the unit. It is also extremely compact and lightweight, and is designed to set new standards of cost-effectiveness.

CD-ROMS can provide users with access to databases that, only a few years ago, were possible only with a mainframe system.

Technology is still moving as fast as the best minds can advance it. At Chinon, our commitment to that progress keeps our products at the very forefront of the leading edge. We're bringing the future of computing to the needs of today.



Chinon America, Inc., 6374 Arizona Circle Los Angeles, CA 90045 (213) 216-7611 FAX: (213) 216-7646

CIRCLE NO 121

Software

links compiled modules together into an executable program, and a symbolic debugger. Prices start at \$10,475 per system, with a monthly license fee of \$400, for NonStop EXT'and CLX systems.

Tandem Computers Inc, 19191 Vallco Parkway, Location 4-40, Cupertino, CA 95014. Phone (408) 725-6000.

Circle No 422

C COMPILER

Optimum-C runs on the IBM PC and compatibles and provides two modes of operation. During program development, you can increase compilation speed by running the compiler without optimization. The built-in EZ editor allows you to compile, link, and execute your program without leaving the editor; further, the editor will step through the errors detected by the compiler and allow you to correct them before

recompiling. When you achieve error-free compilation, linking, and execution, you can switch to command-line operation and recompile the program using the global-optimization feature: because both compilation and linking in this mode require more free memory, you may not be able to work from within the editor. The resultant program will, according to the vendor, execute 30% faster than will corresponding code generated by any other compiler. \$139.

Datalight, 17505 68th Ave NE, Suite 304, Bothell, WA 98011. Phone (206) 367-1803.

Circle No 423

CICS EMULATOR

UniTECS runs on Unix systems and emulates the major features of IBM's widely used transaction monitor, CICS (Customer Information Control System). On an IBM machine, CICS supplements the functions of the DOS or MVS operating system in order to facilitate the development and operation of transaction-processing systems. In a similar way, UniTECS supplements Unix by providing an environment that emulates CICS. This emulator allows you to transfer much of the program-development and -maintenance load from your IBM mainframe to a Unix machine. On the Unix machine you can develop or maintain any application program that is written in Cobol, uses command-level CICS Release 1.6/1.7 standards, processes files organized under VSAM/DL1, and handles 3270-type displays through Minimum-Function BMS. During the development/maintenance, you have complete access to Unix development tools such as SCCS, Shell scripts, file-comparison programs, and Make facilities. Upon completion of the work you can transfer

Ultra-Speed Memory: **CAPTURE 640 MB IN 3.2 SECONDS**

Cluster units to 80 GB

From Dataram: high-speed data acquisition and management for signal/image processing, logic analysis, AI, other advanced applications.

- FAST: 200 MB/sec bidirectional
- FLEXIBLE: up to 8 I/O ports
- ADAPTABLE: interfaces for VAX, MicroVAX, Gould, Star, Numerix, VME, and others
- EXPANDABLE: 8-640 MB/unit

FOR BROCHURE:

Number, or contact us

Dataram Corporation

609-799-0071 • 800-822-0071

P.O. Box 7528





Brushless DC fans use advanced IC technology for greatly improved reliability and control.

A single chip incorporating "Hall" sensing and power electronics performs all commutation functions, replacing the printed circuit board assembly. Starting inrush current requirements are reduced for power supply savings-and various speed control methodologies can be accommodated to tailor output to thermal and acoustic variables. In fans from 2" to 41/2". Only from Nidec-Torin. For additional information, please call (203) 482-4422, ext 502. Or write: The Nidec Corporation, 100 Franklin Drive, Torrington, Connecticut 06790.



CIRCLE NO 25

COMPUTERVISION CAD/CAM SYSTEMS CAN MAKE YOUR IDEAS FLY.

Only Computervision Offers the best CAE CAD CAM software on a full range of industry standard plat-

forms. From our Personal Designer[®] series for simpler design tasks to CADDStation Systems[™] which en-

> able you to design, engineer and manufacture the most complex products.

> > Computervision can also help a company build, manage and protect

its investment in its complete database through a series of modularized Product Data Management systems.

Left: Geometric modeling software enables designers to precisely define surface areas of

the most complex products. Right: Newly available AUTOBOARD SMT is designed

for the rigors of surface-mount

technology. You can design PCBs

The newest generation

tems combine advanced

engineering and design

finite element modeling and

analysis and para-

metric component libraries. Other features such as 2, 3 and 5 axis machining carry designs forward

OSEA@

GOD

capabilities, including production solid modeling, NURBSurface Design,"

of CADDStation svs-

using blind and buried vias and create them with components on

both sides of the boards.

range of fully integrated PCB design software including schematics, simula-

through manufacturing.

For electronics, CADD-

Station provides a wide

tion analysis, design rule checking, AUTOBOARD[®] SMT and wiring diagrams. So if you design, engineer or



manufacture a product and want to get it off the ground faster, better and for less, come fly with us.

F or more information,

call or write: Computervision Corporation, Dept. 425B, 100 Crosby Drive, Bedford, MA 01730, (617) 275-1800.



Courtesy of Airbus Industrie

Software

your application back to the mainframe for normal production use. UniTECS also allows you to run a mainframe application on a Unix machine at a smaller site where the installation doesn't justify the cost of a mainframe. Price depends on the Unix machine configuration, and starts at \$8000 for a system in which the combined cost of the processor, disk, and memory is less than \$20,000. Versions are available for a number of different machines, including the Sequent Balance, NCR Tower 600, IBM 6150, and Hewlett-Packard systems that run HP/UX.

UniSoft Corp, 6121 Hollis St, Emeryville, CA 94608. Phone (415) 420-6400.

Circle No 426

FORTH DEVELOPMENT

The M/E260 is a standard 8080 fig-Forth system contained in an EPROM that plugs into the vendor's M/E200 or M/E300 Z80-based, STD-Bus, single-board computers. The system provides the following facilities: a system for editing source code and providing hard copy for documentation; a simple means of compiling ROMable code; and a means of linking the new code to the system on power-up. In developing your program, you can mix highlevel language with assembly-language code for words that must execute at top speed (such as interrupt service routines). The Forth 8080 assembler is compact, simple, and well-known; you can poke in any Z80-specific instructions that you need, or define them and add them to the assembler's vocabulary. The Forth system contains words for performing GPIB controller, talker, and listener functions; you can add Forth words for nonresident GPIB functions. You can also route console input and output streams to the GPIB port. When you've completed your program development, you can use the included Forth utilities to download the code to an EPROM programmer. \$125.

Mitchell Electronics, 8481 Rock Riffle Rd, Athens, OH 45701. Phone (614) 594-8532.

Circle No 428

GPIB DEVICE DRIVER

The memory-resident, BIOS-level device driver ROUTE-488, which runs under MS-DOS on the IBM PC and compatibles, lets you transfer data at high speed between a PC and devices connected to it via an IEEE-488 bus interface. In order to use the device driver, your system must have 96k bytes of free memory and must be running DOS 2.0 or higher. According to the vendor, the driver operates at least four times as fast as the DOS Device Handler. Moreover, the DOS Device Handler can transfer only one character at a time, whereas the vendor's driver allows DMA block transfer to and from the GPIB. Programs written in any language that runs under DOS can make use of the GPIB device driver by virtue of a multilanguage software interface. Although designed primarily for use with the vendor's LabPac software and IEEE-488 interface cards, the driver is also compatible with other vendors' IEEE-488 cards. \$125.

Scientific Solutions, 6225 Cochran Rd, Solon, OH 44139. Phone (216) 349-4030.

Circle No 424

PL/M COMPILER

The PLM8051 cross-compiler runs on VAX machines and compiles PL/M source code to 8051 assembly language, using standard Intel mnemonics. The compiler provides the standard features of Intel's PL/M-51 compiler and lets you exercise the 8051's functions, such as indirect addressing, bit manipulation, and direct I/O; in addition, both the compiler and the assembler take into account the 8051's multiple address spaces and very small stack, and generate fast, efficient code. The full package consists of the compiler; an assembler with linker, librarian, and format converter to match the downloading requirement of various in-circuit emulators; and a debugger. Prices depend on the configuration of the VAX host, starting (for a VAXStation) at \$3750 for the compiler, \$1500 for the assembler package, and \$2000 for the debugger.

Boston Systems Office, 128 Technology Center, Waltham, MA 02254. Phone (617) 894-7800. TWX 710-324-0760.

Circle No 427

GRAPHICS SOFTWARE

This GKS development kit operates under the MS-DOS operating system and features a language interface between the Alsys ADA programming language and the vendor's GKS graphics kernel. The development kit includes the GKS kernel and its associated device libraries, and permits programs written in Alsys ADA to use the peripherals supported by the kernel.

The GKS kernel supports display controllers ranging from CGA-level to 1280×1024 -pixel resolution; A3 and A4 digitizers and plotters; and a mouse. The kit also contains a configuration utility that allows you to install your application program on a particular workstation.

Together, the kernel, display-controller library, and input/output device libraries occupy about 100k bytes of RAM. Options include a device driver for A0 digitizers and plotters, and an interactive graphics editor. The MS-DOS environment requires 640k bytes of RAM and a math coprocessor. \$995.

Metadesign SA, 2 Avenue Salomon, 59800 Lille, France. Phone 20740124.

Circle No 429

HAND-HELD TERMINALS FIND OUT ABOUT OYSTER BEFORE YOUR BOSS DOES...

 Image: Image:

You concentrate on the core elements of your project, and we'll supply the terminal – saving you time and resources.

Give us a call, return the coupon, even send us your spec. At least find out the facts . . . before someone else does.

allin

TAKE TOOK FICK	dillin.	Case design
Display type and size		Protocol
Keyboard type and layout		Interface

TAKE VOUD DICK

Tell me more quick.	EDN 12108
Name	
Position	
Company	
Address	
Tel No	
301 Daniel Webster Highway, Merrimack, NH 03 Tel: (603) 429-2566.	054,
1640 Fifth Street, Santa Monica, CA 90401.	

Tel: (213) 395-4774. Telex: 65-2337. Facsimile: (213) 393-6040.







PC-board-mountable dc/dc converters (Calex Mfg Co Inc)

Although practically every electronic circuit requires a dc power source, not all can operate from the same dc level. For systems that require multiple dc voltages, you may have to design complex power-distribution schemes. Point-source power devices—dc/dc converters—can ease your power-distribution design task.

DC/DC converters simplify system power distribution

Tom Ormond, Senior Editor



5W dc/dc converters (Reliability Inc)

Today's dc/dc switching converter modules significantly simplify the task of powering electronic systems. These pc-board-mountable converters provide the necessary power exactly where it's needed, so you don't have to design a complex power-distribution network for your system. Neither do you have to worry about intricate grounding and filtering systems. And although you must still take your system's noise performance into consideration, dc/dc converter modules can help minimize noise problems.

DC/DC converters come in various designs; which design you select depends upon the requirements of the circuitry you need to power. Most off-the-shelf dc/dc converters offer very similar performance. Although the available models do exhibit some differences in specifications—notably size, switching frequency, output power, and regulation—your choice of a converter will depend for the most part on your application. You might have to make a few tradeoffs among these features, but those tradeoffs will depend strictly on the system you're designing. Consult **Table 1** for the salient parameters of a representative selection of available off-the-shelf dc/dc converters.

As you peruse the **table**, you might want to give special consideration to the converter's size and its input voltage requirement. Both these items can severely limit your choice of a converter. No matter how well a particular converter suits your system's other requirements—such as output voltages, regulation, and isolation, for example—if it occupies too much pc-board space or if it requires an input voltage that's not available in your system, you may have to choose another converter.

As **Table 1** shows, today's dc/dc converter modules are very compact point-source power devices: Most require only 3.2 to 11 in.² of pc-board space. Some manufacturers offer converters that require even less board area. Conversion Devices, for example, offers converters that require only 2 in.² of board space. And International Power Sources and Melcher Inc offer converters that require even less pc-board area—only 1 and 1.07 in.², respectively. These numbers represent fairly significant reductions in board-space requirements. Note, however, that these converters provide fairly low output power, so you face a tradeoff of space vs power.

Converters offer input-voltage flexibility

When you go shopping for a dc/dc converter module, you'll find that a number of standard devices call for

DC/DC converters simplify the task of power distribution by providing power right where it's needed.

very specific input voltage requirements; they may need 5, 12, 15, or 24V, for instance. This requirement isn't necessarily a problem as long as the voltage in question is available in your system. But if that voltage isn't readily available in your system, your choice of a converter may be limited.

Fortunately, not all converters place such specific limits on their input voltage parameters. Power General and Wall Industries, for instance, offer converters with 2:1 input voltage ranges. Computer Products and Converter Concepts offer converters having input voltage ranges of 3:1. Converter Concepts also produces converters with a 4:1 range, and the input voltage range of converters from Calex is greater than 5:1. (**Table 1** gives the exact ranges for the converters listed.)

These wide-input converters offer you a little more flexibility than models that require very specific voltages. For example, a converter with an input voltage range of 9 to 18V dc will accommodate either 12 or 15V inputs—very popular voltage levels in today's systems. As a result, one converter can satisfy two different applications.

Radiation-hardened dc/dc converters

Some dc/dc converters also provide features that are useful in specific applications. The Model HPS-3015 dc/dc converter from IRT Corp, for example, is hardened against high radiation levels. It can deliver operate-through power in the presence of gamma-radiation rates as high as 5×10^{10} rad(Si)/sec, and it can survive as much as 1×10^{12} rad(Si)/sec without damage.

The converter continues to meet all its performance specs after exposure to a neutron flux of 1×10^{13} neutrons/cm² and a total gamma-radiation accumulation of 1×10^5 rad(Si). To certify each converter's operatethrough characteristic, the vendor tests each device

MANUFACTURER	MODEL	INPUT VOLTAGE	OUTPUT VOLTAGE	TOTAL OUTPUT POWER	TYPICAL	ISOLATION
BURR-BROWN CORP	PWR5104, 5105	5V	±12V (5104), ±15V (5105)	9W	75%	750V DC
CALEX MFG CO INC	12S5.5000UW	7 TO 40V	5V	25W	91%	NS
COMPUTER PRODUCTS INC	LPS SERIES	20 TO 60V	5, 12, 15, ±12, ±15V	15W 80 to 85% 500V DC		
CONVERSION DEVICES	E SERIES	5, 12, 24, 28, 48V	5, 12, 15, ±12, ±15V	2 TO 3W	60%	500V DC
CONVERTER CONCEPTS	VT15/VX15	10 TO 40, 20 TO 60, 100 TO 350V	5, 12, 15, -5, -12, -15V	15W	70 TO 75%	250V DC
INTERNATIONAL POWER	BA/BC SERIES	5, 12, 24, 28, 48V	5, 12, 15, ±12, ±15V	BA: 1.5W BC: 6W	65%	500V DC
IRT CORP	HPS-3015	18 TO 32V	5±15V	30W	70%	500V DC
MELCHER INC	1WR1	5, 12, 15, 24, 28, 48V (2 INPUTS MAX)	5, 12, 15V (4 OUTPUTS MAX)	1W, 2W	58%	3000V P-P
POWER GENERAL	720 SERIES	9 TO 18, 18 TO 36, 36 TO 72V	±12, ±15V	30W	86%	NS
	7	42 TO 56V	5, 12, 15V (POSITIVE OR NEGATIVE)	5W	NS	500V DC
WALL INDUSTRIES INC	SI SERIES	12, 24, 48V	5, 12, 15V (SINGLE, DUAL, TRIPLE OUTPUTS)	15W, 30W	80%	500V DC

TABLE 1-REPRESENTATIVE DC/DC CONVERTERS

with simulated ionizing radiation.

Most switching converters have some sort of isolation between the input and output. Typical designs consist of an input circuit (filter and modulator), a transformer, and an output circuit (demodulator and filter).

The available dc/dc converters perform the conversion task by using one of three schemes: Royer, flyback, or forward conversion. In the classical Royer circuit, the transformer's secondary windings drive switching transistors (or FETs) that are configured in a push-pull arrangement. A voltage applied to the converter input causes one of the transistor switches to turn on. The transformer provides positive feedback, which turns this transistor on hard. The transformer saturates. The saturation causes the transformer voltages to reverse, turning off the first transistor and turning on the second one. The resultant square wave is rectified and filtered, and then it passes through an output regulator. In addition to developing a constant output voltage, the regulator also provides current limiting and shortcircuit protection for the converter's output.

To achieve a wide input voltage range ($\pm 20\%$ min), today's switch-type dc/dc converters typically employ pulse-width-modulation techniques with a flyback- or forward-conversion circuit. Both types of conversion circuit use an IC-driven, switching-circuit signal. The flyback converter stores energy in the transformer's output winding. This energy transfers to the output when the modulator's switch is not conducting. Although the flyback converter is more cost-effective for the manufacturer than are the Royer or forward converters, it has the highest ripple of the three schemes.

In the forward converter, the output inductor stores the energy. This design provides a low-noise, full-wave

REGULATION	SWITCHING FREQUENCY (kHz)	PROTECTION	INPUT	SIZE (IN.)	COST	COMMENTS
0.02% LINE, 0.04% LOAD	50	SHORT CIRCUIT	YES	2×2×0.41	\$29.75 (1000)	SIX-SIDED SHIELD, -40 TO +100°C OPERATING RANGE
0.02% LINE AND LOAD	75	OVERVOLTAGE, SHORT CIRCUIT	NS	3×2.56×0.83	\$130	SIX-SIDED SHIELD, REMOTE ON/OFF CONTROL, AD- JUSTABLE OUTPUT
SINGLE OUTPUTS: 0.5% LINE AND LOAD: DUAL OUTPUTS: 0.5% LINE, 1% LOAD	200	OVERVOLTAGE, OVER- CURRENT, OVERTEMPERATURE	NO	1.6×2.0×0.46	\$62.70 TO \$65.35 (100)	REMOTE ON/OFF CONTROL
±0.3% LINE AND LOAD	200	OVERVOLTAGE, SHORT CIRCUIT	YES	1×2×0.35	\$45 TO \$54	SIX-SIDED SHIELD
0.3% LINE, 1 TO 1.5% LOAD	20	OVERLOAD, SHORT CIRCUIT	NS	VT15: 2.06×4.19×4.56 VX15: 2.13×3.58×4.50	\$56 (100)	SINGLE, DUAL, OR TRIPLE OUTPUTS
BA: 0.3% LINE; 0.5% LOAD BC: 0.05% LINE; 0.1% LOAD	25	SHORT CIRCUIT	YES	BA: 0.8×1.25×0.4 BC: 2.0×2.0×0.4	\$18 TO \$29 (1000)	-
NS	125	OVERVOLTAGE, SHORT CIRCUIT	YES	3.6×3.0×0.6	\$3500	RADIATION HARDENED
0.2% LINE, 0.1% LOAD	25	NS	YES	1.3×0.83×0.4	\$53 TO \$83	-
±0.2% LINE, ±1% LOAD	100	OVERVOLTAGE, SHORT CIRCUIT	YES	2.56×4.56×0.83	\$169	REMOTE ON/OFF CONTROL, SIX- SIDED SHIELD
NS	NS	SHORT CIRCUIT	YES	2.0×2.0×3.75	\$48.50 (1000)	
±0.5% LINE, ±1 TO ±5% LOAD	100	OVERVOLTAGE, SHORT CIRCUIT	NS	15W: 2.56×3.0×0.83 30W: 2.56×4.56×0.83	15W: \$80 TO \$110 (100) 30W: \$96 TO \$110 (100)	REMOTE ON/OFF CONTROL

Although you must still take system noise performance into consideration, dc/dc converter modules can help minimize noise problems.

output. With the addition of a push-pull input, the circuit becomes a high-efficiency modulator circuit.

Transformer provides isolation

Today's dc/dc converters employ high-frequency ferrite materials for the transformer, which provides isolation and voltage translation. Because these ferromagnetic elements have high resistivity, ferrite-core transformers have much better loss properties than do laminated and powdered-iron-core transformers.

Bobbin and toroidal transformers are the two most common types of transformer used in today's converters. Because the bobbin lends itself to machine-automated winding, it is the more economical choice. To construct a transformer, the manufacturer typically lays the windings one over the other; isolation is provided by the wire insulation or a barrier molded into the bobbin.

Toroidal transformers have much better isolation and much closer coupling than bobbin transformers do. To provide isolation for a toroidal transformer, the manufacturer forms a barrier by physically separating the primary and secondary windings on the toroid. For applications in which isolation is critical (medical applications, for example), the toroidal transformer is the only practical choice. It does have one drawback, however—small-diameter toroids often must be handwired.

The converter's output stage includes demodulators and filters. The rectifier (either a full- or a half-wave



Low-profile dc/dc converters (Computer Products Inc)

type) is the most common type of demodulator. Once rectified, the transformer's signal is then filtered to minimize the output ripple or the EMI/RFI generated by the switching operation. The filter employed in modern converters can range from a simple capacitive design to a more complex pi-type circuit. Besides incorporating filtering, most switching converters come in a metal box that's shielded on all six sides to further minimize radiated interference.

Cleaning up converter outputs

As noted, modern dc/dc-converter modules do moderate system noise problems: Many include output filters that curtail noise. However, in noise-sensitive applications such as medical electronics, you'll probably have to provide some external filtering as well.

By their very nature, switching dc/dc converters represent an inherent source of system noise. The noise appears as switching-frequency-related spikes on the converter's output voltage. Although considerations of size and cost can limit the amount of filtering it provides, a converter's internal filtering is usually adequate for most applications. If the inherent filtering capability is inadequate, one of two types of external filter—an LC filter or an output filter capacitor—can help.

If your application demands high accuracy, it's best to employ an LC filter on each converter output channel to attenuate high-frequency noise. Most converters feature an internal output filter capacitor, so adding an external inductor and capacitor creates a low-cost pi filter. You must select the filter components carefully, however.

For example, the inductor's wire size must be able to carry the load current (plus a safety factor), and its core must not saturate under the expected load conditions. Note also that the inductor's dc resistance is outside the feedback loop of regulated converters, and that it can degrade the units' inherent regulation.

LC filters provide superior performance in applications that require very accurate analog measurements or that exhibit poor power-supply rejection at the ripple frequency. However, a much more common way to reduce noise is to use an output filter capacitor.

In selecting an output capacitor for a switching dc/dc converter, it's not a good idea to try to add some safety margin by overspecifying the capacitor, because the converter's basic design equations rule out any bruteforce approach. The most critical capacitor parameter is effective series resistance (ESR). ESR results from

HIGH POWER FROM POWER-ONE

THE ULTIMATE 1500W POWER SYSTEM

"Ultimate"... simply defined, it means the best! Without equal! And in the case of POWER-ONE's 1500W Power System, we think you'll agree the description fits.

Specify Up To 15 DC Outputs ... **From Stock.** Fully modular design allows the user to specify a proven multiple output power system from a wide selection of single, dual and

triple output power modules. Virtually any combination of output voltage and current ratings, including UPS capabilities, can be delivered from stock. No more time consuming and costly custom designs to contend with. **Industry's Highest Power Density.** POWER-ONE's International High Power Series represents the most compact multiple output power systems available today. Up to 1500 watts of multiple output power in an industry standard 5 x 8 x 11 inch fan-cooled package.

On-Board UPS Capability. Only POWER-ONE offers a completely self-contained on-board Uninterruptible Power System module providing unlimited battery back-up of up to 1000 watts of DC output power. Available off-the-shelf, these standard UPS modules mount entirely within the main enclosure of any POWER-ONE International High Power Series model.

A True World Market Power System. The International High Power Series meets the toughest safety requirements of VDE, IEC, UL and CSA, plus the EMI limits of VDE and FCC. Along with worldwide AC input capabilities, it is the clear choice for products marketed not only in the U.S., but internationally as well. And There's More. Call for details or return the reply card today! You'll see why the International High Power Series is the "ultimate."

INTERNATIONA

LITERATURE HOTLINE: (800) 235-5943 Ext. 113 From California: (800) 421-3439 Ext. 113

"Innovators in Power Supply Technology"



POWER-ONE D.C. POWER SUPPLIES 740 Calle Plano · Camarillo, CA 93010-8583 Phone: (805) 987-8741 · (805) 987-3891 TWX: 910-336-1297 · FAX: (805) 388-0476



CEED

Converters with wide input-voltage capabilities typically employ pulse-width-modulation techniques.

stray resistance inside the electrolytic capacitor, and is more critical at (and above) the switching frequency of the converter.

ESR is also a function of temperature, decreasing in value as temperature increases. A capacitor's temperature dependence is also very strong for temperatures below zero; capacitance value tends to decrease with decreasing temperature. This temperature dependence can severely degrade the performance of a converter that operates well at room temperature.

In effect, ESR combines with the converter's internal output resistance to form a voltage divider. A capacitor with very low ESR will perform best as an output filter. The capacitors' ripple current will increase as the load increases and causes a larger drop across the ESR (noise). One way to circumvent the ESR problem is to add capacitors in parallel to develop the needed filtering value.

Choose aluminum or tantalum capacitors

In implementing an external filter, you can choose from two basic families of electrolytic capacitors: aluminum and tantalum. Aluminum types are available in many different quality grades and fabrication techniques. Tantalum devices come in foil, solid, and wetslug types.

It's a good idea to avoid using low-cost (which might mean low-quality) aluminum electrolytic capacitors: In many cases, they'll actually generate, rather than attenuate, noise. If you must trade off cost against performance, high-quality aluminum electrolytics offer you the best compromise. Typically listed as "computer-grade" units, these capacitors are designed specifically for switching power supplies and converters. These devices are not inexpensive, but some are worth the premium because they employ a specialized construction that results in very low ESR.

High capacitance-to-volume efficiency is the outstanding feature of all tantalum capacitors, but particularly of the wet-slug types. Solid tantalum capacitors are the best choice for applications in which longevity (both shelf and operating life) is a critical design concern. Although the foil types are quite compatible with switching power supplies, they cost more than aluminum devices. If your system's switching frequencies will be high (1 MHz and above) and its current demands low, you can probably employ a nonelectrolytic capacitor for the filter. Such units are very effective at high frequencies, at which the equivalent series inductance (ESL) of electrolytics increases significantly.



Dual-output dc/dc converter (Burr-Brown Corp)



Radiation-hardened dc/dc converter (IRT Corp)

Setting the Standards

DC/DC Converters 25–40W Single

Dual Triple

Efficiency 79-85%

DC/DC Converters

- *Ultra Reliability MTBF 2,000,000 hours
- *Temperature Range 45 to +85°C, no derating
- *Isolated and Non-isolated versions available
- *Parallelable

AC/DC Power Supplies

*MTBF 75,000 hours

*Temperature range - 10 to +55°C, no derating

AC/DC Power Supplies

60-100W

Single

Dual

Triple

- *VDE 0871 Class B FCC 15-J Class B
- *Open frame and Eurocard versions available

RIFA, the innovative leaders in Power Products for over 40 years, have introduced a high performance line of AC/DC Open-Frame SMPS to complement their AC/DC Eurocard range and their industry-standard DC/DC Converter range. For your power needs, call RIFA Power Products.



quality for the future

CIRCLE NO 196

RIFA Inc., Greenwich Office Park 3, PO Box 3110, Greenwich CT 06836-3110 (203) 625-7300



Easiest IEEE 488 board for your PC-GUARANTEED!

IOtech Personal488*

10 OPEN "DEVJEEEOUT" FOR OUTPUT AS #1 20 PRINT #1, "ABORT" 30 PRINT #1, "CLEAR 16" 40 PRINT #1, "OUTPUT 16;R3T3X"

Typical IEEE board with "CALLS"*

10 CLEAR, 50000! 20 IBINIT = 50000! 30 IBINIT = 50000! 40 BLOAD "bibm", IBINIT1 50 CALL IBINIT (IBFIND, IBTRG, IBCLR, IBPCT, IBSIC, IBLOC, IBPPC, IBBNA, IBONL, IBRSC, IBSRE, IBSRV, IBPAD, IBSAD, IBIST, IBDMA, IBEOS, IBTMO, IBEOT) 60 CALL IBINIT2(IBGTS, IBCAC, IBWAIT, IBPOKE, IBWRT, IBWRTA, IBCMD, IBCMDA, IBRD, IBRAD, IBSTOP, IBRPP, IBRSP, IBDIAG, IBXTRC, IBSTA%, IBERR%, IBCNT%) 70 As="DEV16" 80 CALL IBFIND (AS, M195%) 90 CALL IBFIND (AS, M195%) 90 CALL IBSIC (BRD0%) 100 IF IBSTA%<0 THEN STOP 130 CMDS="R3T3X" 140 CALL IBWRT (M195%, CMD5) 150 IF IBSTA% <0 THEN STOP

- $\sqrt{\text{DOS}}$ installable device driver automatically loads at power up
- ✓ Compatible with all popular languagesnever any extra drivers to buy
- $\sqrt{\text{Hewlett-Packard style commands}}$
- $\sqrt{}$ Automatic error and timeout indication
- √ Built-in BASIC SRQ program vectoring
- √ Lotus Measure, Asyst, & TBASIC compatible
- $\sqrt{\text{DMA}}$ data transfers over 300K bytes/sec



IOtech products are backed by a 30-day money back guarantee and 2 year warranty



23400 Aurora Road • Cleveland, Ohio 44146 * Both programs clear the bus and configure a digital multimeter. If you already own a compatible IEEE board our **Driver488** software makes it *IEEE-Z*. Your filtering task doesn't end with capacitor selection. To get good performance from the filter you've chosen, you need to use good circuit-layout techniques. For example, inductance can become a problem if you fail to use good wiring techniques. You need to place the capacitor as close as possible to the load instead of to the converter. This scheme allows you to take advantage of the inductance of the pc-board traces (or wires) and the converter's internal output capacitor to form a small pi filter that optimizes noise reduction. You should also minimize the lead length (including circuit wiring) on both sides of the capacitor. It's best to use short, wide straps, and run them in parallel to further reduce self-inductance in the leads.

For more information . . .

For more information on the dc/dc switching converter modules discussed in this article, circle the appropriate numbers on the Information Retrieval Service card or contact the following manufacturers directly.

Burr-Brown Corp Box 11400 Tucson, AZ 85734 (602) 746-1111 Circle No 704

Calex Mfg Co Inc 3355 Vincent Rd Pleasant Hill, CA 94523 (415) 932-3911 Circle No 705

Computer Products Inc 7 Elkins St South Boston, MA 02127 (617) 268-1170 Circle No 706

Conversion Devices Inc 101 Tosca Dr Stoughton, MA 02072 (617) 341-3266 Circle No 707

Converter Concepts Inc Industrial Parkway Pardeeville, WI 53954 (608) 429-2144 Circle No 708

International Power Sources Inc 10 Cochituate St Natick, MA 01760 (617) 651-1818 Circle No 709 IRT Corp Box 85317 San Diego, CA 92138 (619) 450-9990 Circle No 710

Melcher Inc 10 Cochituate St Natick, MA 01760 (617) 653-9979 Circle No 711

Power General Box 189 Canton, MA 02021 (617) 828-6216 Circle No 712

Reliability Inc Box 218370 Houston, TX 77218 (713) 492-0550 Circle No 713

Wall Industries Inc 2 Franklin St Lawrence, MA 01840 (617) 688-1287 Circle No 714

Article Interest Quotient (Circle One) High 476 Medium 477 Low 478

202

.OGY. 54



Gates Energy Products has purchased GE's Battery Business Department, making us the world's largest source of sealed rechargeable batteries.

What does this mean to you? That Gates is dedicated to providing you with the best rechargeable batteries in the world.

Gates now has the technology and resources to offer the largest selection of rechargeable batteries including nickel cadmium, nickel hydrogen and sealed lead batteries-from .065Ah to 300Ah.

WESTERN U.S. 4063 Birch St. #130 Newport Beach, CA 92660 (714) 852-9033

CENTRAL U.S. 2860 S. River Rd. Suite 401 Des Plaines, IL 60018 (312) 827-9130

Leading the technological advancements at Gates is our new GEMAX™ Series of nickel cadmium cells. These cells are providing more run time and maximizing power delivery in all product applications by incorporating higher capacities and lower internal resistance.

As a result of GEMAX technology, Gates now offers the world's highest capacity, production-volume Sub C cell at 1.4Ah (1-hour rate). And more advancements are on the way.

Our commitment to supply batteries tailored to your specific applications is

SOUTHERN U.S. 1 Prestige Dr. Meriden, CT 06450 (203) 238-6840 1835 Savoy Dr. Suite 200 Atlanta, GA 30341 (404) 458-8755

EASTERN U.S.

yet another aspect of our determination to make sure that Gates batteries are superior.

No other rechargeable battery company in the world is taking such dramatic steps to perfect and expand their rechargeable battery products as the new Gates. It's time you discovered the difference.

For more information worldwide, contact one of the Gates Regional Sales Offices listed below.



PACIFIC AND ASIAN 3706 A, Shun Tak Centre 200 Connaught Rd. Central Hong Kong 011-852-5-403073

EUROPE Units 12/13 Loomer Rd. Industrial Estate Chesterton Newcastle-under-Lyme Staffs. ST5 7LB, Great Britain 011-44-782-566525

©1987 Gates Energy Products, Inc.



500 to 1600 WATT POWER SUPPLIES

NEW **1600W MULTI**

The industry's SMALLEST 1600W Multi output package. ACDC's JFM Series features unlimited flexibility of output voltage & current combinations. Any combination you choose will be delivered in 2 weeks.

NEW 1000W & 800W

Don't compromise on output voltage. ACDC's REV 1000/800W Series has the output combination your design requires.

And you can have it in 2 weeks!

NOT NEW 1500W, 1000W, 750W SINGLES

High performance, competitive pricing and 2 week delivery have made this the most popular "slot" supply in the industry. Unequivocably.



NEW FEATURES

- IEEE 587 input surge protection
- Current mode control
- Single wire paralleling
 On-board EMI filter (FCC Docket 20780, Class A and VDE 0871, Class A)
- Largest offering of standard options
- Active preload
- Dynamic soft-start International safety certifications

NOT NEW

Building quality, reliable power supplies that meet specifica-tions, is not new at ACDC Electronics. We've been doing that for over 30 years.

HIGH POWER COVERAGE

No one else offers such extensive coverage in high power. Check the chart below to solve your 500-1600W power requirements.

Our power supplies have been PROVEN and PROVEN. Our NEW power supplies are based on these PROVEN designs. Need more proof? Call for a DEMO TODAY. (619) 439-4200

1600w 1500w 1000w 800w 750w 500w 400w 300w 220w 175w 135w 70w 40w 15w ACDC'S POWER OFFERING CIRCLE NO 107

401 Jones Road, Oceanside, CA 92054 TEL: 619/757-1880. TLX: 350227. FAX: 619/439-4243



Uninterruptible ac power source protects data 100% of the time

The Lifeline is an uninterruptible ac power source that protects computers from power outages. The unit is always on line, so even when the utility fails, there's no chance of losing data while the computer waits for a standby system to switch over to battery power.

A maintenance-free internal battery handles the full power of the system for 5 or 10 minutes. An external battery may be used to extend operation for one hour or longer. When the utility comes back on, the unit will recharge the batteries automatically.

The unit accepts 120V ac at 60 Hz (with $\pm 10\%$ to $\pm 15\%$ tolerance) from a wall outlet and delivers 120V



ac at 60 Hz (with $\pm 3\%$ regulation). Its output power is rated at 200 VA, 600 VA, and 1000 VA. It also offers a load power factor from 0.8 to unity; 90% efficiency when the line is pres-

ent; a sine-wave output waveform with 5% maximum total harmonic distortion; and a NEMA 5-15R duplex output receptacle. It operates over 0 to 50°C.

Prices range from \$1235 for a 200-VA unit with 7 minutes of internal battery backup to \$2780 for a 1000-VA unit with 25 minutes of internal battery backup. A 200-VA and a 600-VA unit come with no internal battery but are ready for an external battery hook-up. They cost \$1180 and \$1570, respectively.

Instrumentation and Control Systems Inc, Electro-Pac Div, 520 Interstate Rd, Addison, IL 60101. Phone (312) 543-6200. TLX 271503. Circle No 719

Single-output ac-to-dc switching modules come in low-profile packages

FMP Series single-output switching modules come in low-profile plasticencased packages. The series consists of two groups that have 3W and 16W outputs, respectively, at 50°C. The 3W versions are rated at 5V at 0.6A, 12V at 0.25A, 15V at 0.2A, and 24V at 0.13A. The 10W models are rated at 5V at 2A, 12V at 0.85A, 15V at 0.7A, and 24V at 0.45A. Both groups measure $2.17 \times 0.75 \times 3.16$ in. The 3W units



weigh 0.15 lb; the 10W units weigh 0.2 lb.

The switchers employ flyback circuitry to achieve 68 through 81%efficiency at maximum load. Their switching frequency ranges from 40 to 75 kHz, and their switching ripple voltage ranges from <50 to <100 mV, depending on the model. The units accept power from a 115V ac source and provide built-in overvoltage protection and current limiting.

All models' output voltages are adjustable to 10% of the nominal output voltage. The units are UL recognized and CSA certified, and they meet the FCC class B specification for conducted EMI. Prices range from \$29 to \$32.

Kepco Inc, 131-38 Sanford Ave, Flushing, NY 11352. Phone (718) 461-7000. TWX 710-582-2631. Circle No 720

EDN December 10, 1987

1500W switching power supply accepts a 3-phase ac input voltage

The PM-2501B-2-3P is a switching power supply that delivers 5V dc at 300A (1500W) and 50°C. It accepts a 3-phase input voltage of between 184 and 250V ac within a frequency range of 47 to 63 Hz. The unit comes in a $5 \times 8 \times 11$ -in. enclosure and weighs 20 lbs.

The supply meets VDE 0806 Class I SELV, IEC 380 and 435, and CSA 22.2-142/143/154 specifications. It is UL recognized (to UL 114, 1012, and 478 requirements), and it meets VDE 0871, level A, and FCC Docket 20180 standards for EMI protection. The supply has foldbackcurrent overload protection at 105 to 120% of full output current: When the current exceeds that level, the supply reduces it to 65% of full output current. Overvoltage



protection shuts down the unit at $125\pm10\%$ of the nominal output.

The power supply's switching ripple and noise spec is 1% of the nominal output voltage measured in the bandwidth from 20 Hz to 20 MHz. The output voltage is brought out on a pair of $\frac{5}{16}$ -in., size 18 threaded-head studs. The ac inputs are on a terminal block that uses size 8-32 screws. The switcher's soft-start circuitry minimizes inrush surges at power-on. Options for the supply include a crowbar circuit for overvoltage protection, 5-msec warning of ac power loss, and control of current-foldback circuitry (which allows you to parallel supplies). Another option lets you use a logic signal to turn the supply on. The supply's output is adjustable to $\pm 10\%$ of the nominal output voltage. \$1200.

Pioneer Magnetics, 1745 Berkeley St, Santa Monica, CA 90404. Phone (800) 233-1745; in CA, (800) 848-1745. TWX 910-343-6249.

Circle No 721 Pioneer Magnetics, Kingswick House, Sunninghill, Ascot, Berkshire, SL57BJ, UK. Phone (990) 23491. TLX 848980.

Circle No 722

2 and 3.3V switching power supplies are suitable for use with IBM memory chips

Six different models of V Series switching power supplies provide dc outputs at 2 or 3.3V. Their low voltages make them ideal for use with IBM's memory chips and VLSI circuits. The six models are rated at 2V dc at 54A, 3.3V dc at 54A, 2V dc at 72A, 3.3V dc at 72A, 2V dc at 100A, and 3.3V dc at 100A.

The units accept 90 to 132V ac or 180 to 264V ac inputs in the frequency range from 47 to 440 Hz. They also have built-in overvoltage protection, remote sensing, and a softstart feature. They maintain their current specifications over 0 to 50°C. Above 50 to 70°C, the current should be derated by 2.5%/°C.

For cooling, the V501G and the V501H units require 60 cfm of forced air; the other four units require 30 cfm of forced air. An option



provides for current sharing and redundant parallel operation. No isolation diodes are needed. The V Series provides an optional powerfail monitor in the form of a TTL signal that occurs 2 msec prior to the loss of output power. Prices range from \$145 to \$210 in OEM quantities. Delivery, six to eight weeks ARO.

Deltron Inc, Box 1369, Wissahickon Ave, North Wales, PA 19454. Phone (215) 699-9261. TWX 510-661-8061.

Circle No 723

HIGH PERFORMANCE SWITCHING POWER SUPPLIES

KEY FEATURES

Small Size

High MTBF

Single & Multiple Outputs

High Efficiency
 Meet VDE, UL, CSA Safety Standards
 Wide Standard Product Line

50

Power General delivers PERFORMANCE. A full line of standard "off-the-shelf" switching power supplies that are small yet meet the toughest international safety standards. A variety of single and multiple output models are offered over a range of 25 to 200 watts. Standard features include input line filters, high efficiency operation, pulse load capability and tight output regulation.

Power General delivers RELIABILITY. All production switching power supplies are subjected to a 12 hour burn-in at 55 deg. C with input power being cycled on and off. 100% of production — no exceptions. Stringent work-manship standards and tough documentation control procedures are just some examples of a total commitment to quality that stretches from the Design Engineering Group to the Production Shipping Department.

Power General Delivers SERVICE. We deliver product on time. We deliver Information — Fast, accurate and courteous. We deliver technical support experienced Application Engineers that know how to solve your power problems.

Put Power General to work for you. Call us. Be demanding and watch us deliver.



A SUBSIDIARY OF **UNITRODE** CORPORATION 152 Will Drive, P.O. Box 189, Canton, MA 02021-0189 Tel: (617) 828-6216 TWX: 710-348-0200 FAX: (617) 828-3215



Multichannel, isolated dc/dc converter provides multiple-channel outputs

The PWS740 is a multichannel, isolated dc/dc converter with a 1500V ac continuous isolation rating. It consists of three integrated components: the PWS740-1, a 400-kHz oscillator and driver in a TO-3 package; the PWS740-2, a trifilar-wound isolation transformer with a ferrite core encapsulated in a plastic package; and the PWS740-3, a rectifier bridge in a plastic, 8-pin miniature DIP. A typical isolation system using the PWS740 would consist of a transformer and rectifier for each channel; the oscillator would drive as many as eight channels.

The Sync pin on the oscillator



module allows you to synchronize several oscillators. You can connect the Frequency Adjust pin to an external potentiometer to lower the oscillator frequency, thereby avoiding beat-frequency interference with other system signals. The Enable pin provides for output shutdown. Isolated dc outputs track the input voltage and can range from ± 7 to ± 20 V at currents as high as ± 30 mA.

Transformer impedance limits the converter's maximum input current to about 700 mA for a 15V input—a level that is within the unit's thermal limits. The unit operates over -25 to +85°C. Its typical efficiency for eight channels at rated loads is 80%. PWS740-1, \$12.75; PWS-2, \$2.50; PWS740-3, \$1.25 (100).

Burr-Brown Corp, Box 11400, Tucson, AZ 85734. Phone (602) 746-1111. TWX 910-952-1111.

Circle No 725

350W switcher offers 3.10W/in³, comes in a $9 \times 5 \times 2.5$ -in. package

The MAX-350 350W switching power supply comes in a $9 \times 5 \times 2.5$ in. package, which yields a power density of 3.10W/in³. The MAX-350 offers three models, all of which provide 5V at 50A, 12V at 8 or 12A pk, and -12V at 4A. The MAX-354-1205 provides an additional output of -5.2V at 2A; the MAX-354-1224 has an additional output of 24V at 1.5A. The supplies are compatible with VME Bus and Multibus specifications and are designed with an ac-power-fail circuit that exceeds the ac-power-fail requirements (48-mA sink capacity) of the standard VME Bus.

The supplies accept 90 to 132V ac or 180 to 264V ac inputs in the frequency range from 47 to 63 Hz. They come with thermal, brownout, and overload protection, and they require 30 cfm of moving air for cooling.

The units' typical efficiency is 75%, and the vendor specifies an

MTBF of 100,000 hours. Their ripple and noise spec is 0.2% rms, 1% p-p, or 100 mV, whichever is greater. The units retain their full ratings over 0 to 50° C. An optional TTL ac-power-fail command provides an indication 5 msec before the 5V out-

put goes out of regulation. \$336 (100). Delivery, stock to six weeks.

Todd Products Corp, 50 Emjay Blvd, Brentwood, NY 11717. Phone (516) 231-3366. TWX 510-227-4905.

Circle No 724



The latest Advance



New Powerflex 350-watt 5-output switching power supply

Go ahead. Design your microprocessor based equipment any way you want, and don't worry about the power supply. Whatever voltages you require, from 2V to 50V in either polarity, the Powerflex 350 switching power supply can provide them.

Because it's modular, we can easily configure the P350 for up to five outputs in standard or special voltages. And if your design changes, you can easily change outputs without changing your physical dimensions.

Just 2.9" x 7.5" x 11.8", this high efficiency (75% at full load) 350watt power supply takes both 110V and 220V inputs. Overvoltage and overcurrent protection on outputs is standard, along with margin testing (4.750V — 5.250V) on the main +5V 50A output. An optional signals board provides TTL compatibility.

> The magnetic amplifier and soft switching technique assure high reliability and enable regulated auxiliary outputs to function without any minimum load on the main +5V output. Filtering is to VDE 0871, Curve A. The P350 is UL listed, CSA certified and meets other VDE, EC and FCC requirements.

> Compare the calculated MTBF of over 52,000 hours with other power supplies in its class. There's no compromise on quality when you build around the P350 from Advance.

> > Contact your Advance Power Supplies representative for complete data on the P350 and other open and closed frame units from 25 to 1000 watts. Or call 1-216-349-0755 for more information.

Advance Power Supplies 32111 Aurora Road Solon, OH 44139



CIRCLE NO 105

703-001-1

Switch-mode power supplies offer 40W to 1-kW outputs

Series 190 open-frame switch-mode power supplies include single- and multiple-output versions that have power ratings of between 40 and 1000W. The vendor can also customize standard versions. All the supplies spec an MTBF of 40,000 hours under full load at 40°C. The five power ratings currently available are 40, 60, 150, 200, and 1000W; you can increase the power ratings of the 150 and 200W supplies to 220 and 300W, respectively, by using forced-air cooling.

The single-output versions of the 40, 60, and 200/300W power supplies each provide a 5, 12, or 24V output. (The user can adjust the 12V output to 15V.) The multiple-output versions of the 40 and 60W supplies



typically provide ± 12 or ± 15 V outputs, or a 5V output and ± 12 or ± 15 V outputs. The multiple-output 150/220W supplies and multiple-output versions of the 200/300W supplies typically provide a 5V output and two 12/15V outputs. In the 150/220W supplies, the two 12/15V outputs have a common zero; in the 200/300W supplies they are isolated. Some versions of the 150/220W and 200/300W supplies provide an addi-

tional 5, 12, or 24V output. The 1000W supply is an enclosed, fancooled single-output unit providing 5V at 200A.

Series 190 supplies operate from the 110/220V ac line. They incorporate overload and overtemperature protection and have overvoltage protection on the 5V outputs. All versions are UL approved, CSA certified, and VDE registered. Typical prices for the 40W power supplies range from \$80 to \$100; the 60W models are \$100 to \$120.

Philips, Industrial and Electroacoustic Systems Div, Box 218, 5600 MD Eindhoven, The Netherlands. Phone (040) 788620. TLX 35000.

Circle No 726

POWER PLUS Quality and Support You Can Rely On

The Panasonic® K Series of *low-cost* single output Switching Power Supplies. Their efficiency and reliability are clear from features like these:

- Single output; 95-132 VAC, 47-440Hz input
- 12 models 15, 30 and 50 Watt configurations: with 5-24 VDC, 0.1A to 10A
- 3-year limited warranty
- Off-the-shelf availability
- Versatile, inexpensive and compact
- Recognized by UL 114, 478; certified by CSA
- Meets FCC Class B and VDE Class B noise regulations
- Over-current protection
- Over-voltage protection



• Compact, light, durable and efficient. Ideal for use in process control and environmental equipment, computers and computer peripherals, robotics, and comparable applications.

Panasonic Industrial Compar

Power Supplies Department Two Panasonic Way Secaucus, NJ 07094 (201) 392-4290

1500W SUPPLY

The Model 6D Multimod is a 1500W modular switching power supply. It features a mainframe that houses six separately selectable output modules. The mainframe accepts 115 or 230V ac inputs and converts the ac power to 300V dc. Each module is a dc/dc converter that receives power from the 300V dc bus. The supply employs 100-kHz MOSFET switching components and meets international electrical safety and emission standards, such as VDE, CSA, and UL standards. You can choose single-output 300W modules ranging from 2 to 48V dc. Multipleoutput modules will be available soon. All of the output modules are capable of current sharing. Outputs are adjustable to $\pm 10\%$ of nominal voltage, and line and load regulation are each 0.2% of the rated output. Current limiting, overvoltage protection, reverse-voltage protection, and remote sensing are standard features. The entire supply measures 5×8×13.5 in. A supply equipped with six single-output modules costs \$1500.

Powertec Inc, 20550 Nordhoff St, Chatsworth, CA 91311. Phone (818) 882-0004. TWX 910-494-2092. Circle No 430 1500V, and they operate over 0 to 40°C. The output regulation is 5%. The supplies meet UL, CSA, and VDE requirements and feature short-circuit protection. The housings are made of durable fire-retardant plastic. \$40 (100).

Jerome Industries Corp. 730 Division St, Elizabeth, NJ 07201. Phone (201) 353-5700. TLX 132001. Circle No 432

DISK SUPPLY

Designed specifically for hard-diskdrive applications, the quad-output SQV350 350W switching supply provides power for two 8-in. drives or for as many as eight 5¼-in. drives. The unit features a 5V mainoutput rating of 10A. One of the three auxiliary outputs is rated for 12 or 24V at 16A peak to accommodate initial turn-on/spin-up loads. The remaining two outputs are rated at 5A each with 7A peak loads. The supply features built-in overload and overvoltage protection and remote sense capability. \$251 (100). Delivery, three to six weeks ARO.

Switching Systems International, 500 Porter Way, Placentia, CA 92670. Phone (714) 996-0909.

Circle No 431



25W SUPPLIES

The X and Y desktop linear power supplies provide 25W of output power and are available in singleand multiple-output versions. The standard outputs are 5, 12, and 24V dc. The supplies offer input voltage ranges of 105 to 130V ac or 220 to 240V ac. Their dielectric strength is



SWITCHING SUPPLIES

Pony Series switching power supplies come in 14 models that deliver 15 to 30W. The supplies are enclosed units and are UL recognized and CSA certified. Each model features an input EMI filter, a 115V ac input voltage rating, built-in overvoltage protection, and a typical efficiency of 65%. The line regulation, from low to high line, is 0.4%; the load regulation (from no load to full load) is 1%. All models provide a 20-msec min holdup time. \$24.90 (1000).

Computer Products Inc, 2900 Gateway Dr, Pompano Beach, FL 33069. Phone (305) 974-5500. TWX 510-956-3098.

Circle No 433

DC/DC CONVERTER

The 12Q15.050 operates from a 12V dc input and provides two ±15V dc outputs at ±50 mA each. Both dual output sections are isolated from the input and from each other. The unit has a 6-sided shielded case that eliminates RFI problems. The internal switching frequency (63 kHz free running) is unaffected by load or line changes. A switching-frequency synchronization pin lets you run the converters at frequencies ranging from 70 to 110 kHz. The input/output and output/output isolation equals 500V dc and the operating temperature range spans -25to +90°C. \$110. Delivery, stock to six weeks ARO.

Calex Mfg Co Inc, 3355 Vincent Rd, Pleasant Hill, CA 94523. Phone (415) 932-3911. TLX 338506. Circle No 435

SWITCH-MODE SUPPLY

The Model SA1000-3104 is a 1-kW switch-mode power supply that delivers 5V at currents as high as 200A. You can adjust the output voltage by $\pm 2\%$ with a potentiometer, or you can digitally program the output voltage from 4.2 to 5.75V. The supply's line regulation is 10 mV max over the full operating input-voltage range, and its zero- to full-load regulation is 20 mV max. The power supply operates from line input voltages ranging from either 90 to 135V or 180 to 265V, within a frequency range of 47 to 63 Hz. Its

thermal protection includes a hightemperature alarm output that is activated at 50±5°C, as well as an overtemperature alarm output that is activated when the power-supply temperature exceeds 75±5°C. The supply automatically shuts down within 10 to 30 sec of an overtemperature alarm. It also provides output overvoltage and overcurrent

protection. For applications requiring more than 200A, you can add slave units to the power supply. The device measures $8 \times 4.5 \times 11$ in. From approximately £500.

Astec (USA) Ltd, 2880 San Thomas Expressway, Suite 200, Santa Clara, CA 95051. Phone (408) 748-1200. TLX 6839191.

Circle No 434



These new TPS Series rocker-type power switches provide unmistakably clear "on" status signaling at 30% less cost than an LED or bulb. With Toko's "Wink" action, a bright color pops into in a small window when the switch is activated. TPS Series Switches also eliminate the added cost of LED wiring and the risk of lamp failure.

- Rated at 5A at 125VAC, and 3A at 250VAC
- UL listed and CSA rated; meets safety regulations VDE, BSI and SEMKO
- Wide range of color choices for indicator and rocker Also available without "Wink" feature, but with fixed color indicator Designed for snap-in panel mounting; Faston™ terminals or wire leads Solid durability. Quality roller bearing
- actuator for years of trouble-free service Guaranteed equal to or better than the quality and reliability of your current rocker switch

You've got to see it to believe it! For a free sample and application information, contact Toko America today. **TOK** TOKO AMERICA, INC.

1250 Feehanville Drive 1250 Feenanville Drive Mount Prospect, Illinois 60056 (312) 297-0070; FAX (Gill): (312) 699-7864 Western Branch (408) 996-7575 Eastern Branch (914) 694-5618 Southeastern Branch (205) 830-0952



DC/DC CONVERTERS

B Series converters are available in 15, 24, and 25W models and have outputs ranging from 5 to 12V dc. The units are nonisolated, accept inputs ranging from 9 to 36V dc, and are optimized for battery operation. Each model offers continuous shortcircuit protection, automatic restart, overvoltage protection, and remote logic on/off control. The 15 and 24W converters come in RFIshielded cases measuring $2.5 \times$ 3.0×0.4 in. \$53.90

Semiconductor Circuits Inc, 49 Range Rd. Windham. NH 03087. Phone (603) 893-2330. TWX 710-366-0505.

Circle No 436

SUPPLY SERIES

The Series-1000 Mk II range of power supplies includes 26 different models with output-voltage ranges of between 0 to 35V and 0 to 1000V and current ratings of between 10A and 30 mA. All the models are fully programmable, providing either constant-voltage or constant-current operation with automatic crossover between operating modes. Line regulation in both modes is $\pm 0.015\%$ for $\pm 10\%$ line-voltage variation. In constant-voltage mode, zero to full-load regulation is 0.015% or 5 mV, whichever is greater, and in constant-current mode, it's 0.05% or 3 mA for a 50% output-voltage change. Options provide 0.01% regulation in constant-current mode and crowbar output protection. Programming inputs allow you to adjust the output voltage via a 0 to 5V input signal, and the current via a 0 to 1V input signal. The power supplies are housed in 19-in. rack- or Text continued on pg 224

MILITARY POWER SOURCES



CUSTOM AND STANDARD MILITARY POWER SUPPLIES

DC/DC						
INPUT	NO. OF OUTPUTS	V/A	SIZE (IN)	FEATURES		
18-36VDC	SINGLE	5, 12, 15, 24, 28 (50W -150W)	4.64×2.81×0.84	HIGH EFFICIENCY, HIGH DENSITY STABILE 500KHZ CONVERSION		
18-36VDC	DUAL	±5, ±12, ±15, ±24, ±28 (80W-125W)	5.9×2.81×0.84	MILTYPE COMPONENTS HIGH GRADE		
18-36VDC	DUAL	±5, ±12, ±15, ±24, ±28 (150W-170W)	6.3×3.5 ×0.84	• I/O ISOLATION • MIL-STD-704A / D		
18-36VDC	TRIPLE	5V / 10A, ±12V / 1-5A 5V / 10A, ±15V / 1.5A	6.10×3.14×2.16	 MIL-STD-1275A (AT) MIL-STD-461 / 462 TEMP: -55° / +85°C BASE PLATE 		
6-100VDC	TRIPLE	5V / 5A, 2×12V / 2.5A 5V / 5A, 2×15V / 2.5A	5.7×4.68×2.75	• MIL-STD-810C		

AC/DC (115V / 3 Phase / 400HZ)						
	NO. OF OUTPUTS	V/A	SIZE (IN)	FEATURES		
115 +35% -15%	SINGLE	5, 12, 15, 22, 2 <mark>4, 28</mark> (200W-225W)	6×4.2×1.57	EXTERNAL OUTPUT ADJUSTMENT MIL-TYPE COMPONENTS		
115 +35% -15%	SINGLE	5, 12, 15, 22, 24, <mark>28</mark> (500W-600W)	10×6.2×1.57	MIL-STD-704 A/D MIL-STD-461 TEMP: _55°C / +85°C BASE PLATE		
115 +35% -10%	DUAL	±5, ±12, ±15, ±22, ±24, ±28 (120W-150W)	6×4.2×1.57	• MIL-STD-810C		





TEL. (603) 267-8865 (603) 267-7355 FAX: (603) 267-7258

P.O. BOX 657, BELMONT, NH 03220 CIRCLE NO 198



WIDE INPUT SWITCHING POWER SUPPLIES...A GOOD IDEA THAT WORKS WITHOUT MODIFICATION

A good idea is a powerful thing. It drives ordinary technology to the extraordinary. At Converter Concepts, ideas make our technology superior and our power supplies more reliable.

We specialize in wide-input AC/DC and DC/DC, high efficiency switching power supplies for worldwide OEM use. That means your product can operate anywhere in the world without modification.

Think about that for a moment. Too good to believe? Well, believe it. Because only Converter Concepts' power supplies operate on any

CONVERTER CONCEPTS

IDEAS THAT POWER TECHNOLOGY

voltage in the world WITHOUT SWITCHES, JUMPERS, TAPS OR OTHER MODIFICATIONS. This exciting technology is made possible due to the work and dedication of our people.

Our people are thinkers as well as doers pushing ordinary flyback technology beyond previous limitations. That's why we're an industry leader.

Since 1976, Converter Concepts has designed, manufactured and marketed power supplies which are revered for their quality and reliability. Find out what we can do for you. Contact the Converter Concepts' representative nearest you or call us directly. You'll discover that at Converter Concepts, the difference is people with ideas.



Industrial Parkway • Pardeeville, WI 53954 (608) 429-2144 • TWX: 910-280-2630 Toll-Free 800/253-5227

n e s e s e s e s e

bench-mounting enclosures. They operate from 200/250V line supplies. From around £1000 to £4000.

Hunting Hivolt, 1008 W 9th Ave, King of Prussia, PA 19406. Phone (215) 265-7462.

Circle No 437



FOUR-OUTPUT SUPPLY

The Model 510EU 200W switching power supply has four outputs. Transient suppression devices allow it to withstand the 6000V IEEE 587 voltage transient test. The unit employs 50-kHz MOSFET switching circuitry. It accepts 105 to 130 or 198 to 265V ac, selectable on the barrier strip. The device delivers 5V at 20A, $\pm 12V$ at 4A, and -5V at 0.5A. Its secondaries are adjustable to $\pm 15V$ at 3A. All its outputs are current limited and have continuous overload and ac-input protection, short-circuit protection, overtemperature protection, self-recovering overvoltage protection, and no minimum load requirement. You can specify a power-failure signal and logic-inhibit capability as options. \$395.

RO Associates Inc, 246 Caspian Dr, Sunnyvale, CA 94088. Phone (408) 744-1450. FAX 408-744-1521. Circle No 438

CONVERTER SERIES

Series BA and Series BC isolated dc/dc converters have five output voltage configurations: 5, 12, 15,



 ± 12 , and $\pm 15V$ dc. All of these outputs are available with nominal input voltages of 5, 12, 24, 28, and 48V dc. Series BA converters are housed in 24-pin DIPs and provide 1.5W of output power. Series BC converters come in industry-standard 2.0×2.0×0.4-in. packages and provide 6W of output power. Both series feature an input π -network filter; a 50-mV p-p ripple-and-noise specification; operation to 70°C without derating; and 500V dc isolation. The converters have a 25-kHz switching frequency and typical efficiency of 65%. Single-output Series BA units, \$18; dual-output units, \$19 (1000). Series BC singleoutput units, \$25; dual-output units,


Power Sources

\$27 (1000). Delivery, stock to eight weeks ARO.

International Power Sources Inc, 10 Cochituate St, Natick, MA 01760. Phone (617) 651-1818. FAX 617-655-7984.

Circle No 440

BUTTON CELL

The 4DK battery is a 1.2V NiCd button cell for solar-converter applications. The cell has a nominal capacity of 4 mAhr. It measures 2.1×9.5 mm and weighs 0.6g. The battery operates over -20 to +50°C. Its mass-plate construction allows it to retain 75% of its capacity when stored for 28 days at room temperature. You can charge the cell with 0.4 mA applied for 14 hours. The length-of-service-life specifications are 1000 IEC cycles within one year; 500 full cycles within two years; and 2000 shallow cycles within four years. You can trickle

charge the battery with 40 μ A for as many as six years, in the temperature range of 0 to 45 °C. A pressurerelief vent protects the cell under abusive conditions. \$0.87 (1000). Delivery, six weeks ARO.

Varta Batteries Inc, 300 Executive Blvd, Elmsford, NY 10523. Phone (914) 592-2500.

Circle No 439

DC SUPPLY

BPS Series regulated adjustable dc power supplies deliver 12 to 24V dc voltages. Their amperage ratings range from 1 to 15A for 12V dc models and from 1 to 10A for 24V dc models. All of the units in the series are UL and CSA listed, except the 1A versions, which use UL-recognized ac sections. Screw terminals are provided for line-voltage input and dc output. Faston battery clips are provided for attachment of sealed lead-acid (gel) batteries. The



supplies come in UL-listed hinged knockout boxes. All models with capacities greater than 1A include eight individual fused outputs for powering multiple loads; consequently, if a short circuit occurs on a load, only one of the eight fuses will blow. \$110.

Securitron, 1815 W 205th St, Suite 103, Torrance, CA 90501. Phone (800) 624-5625; in CA, (213) 618-0204.

Circle No 442



Now, POWEREX—a joint venture of GE, Westinghouse and Mitsubishi—has acquired the GE/RCA line of low-power triacs, SCRs and D66/D67 power Darlingtons. And added them to our already broad line of power semiconductors.

More evidence POWEREX provides what no one else has provided before.

Broadest line convenience versus narrow line restrictions. One-source compatibility versus multi-source doubt. Off-the-shelf availability versus back-order delays. Impartial advice versus biased opinions.

POWEREX versus the competition. Our advantages are obvious.



Nobody else now offers you GE/RCA low-power triacs and SCRs as part of the broadest line of power semiconductors available. Only POWEREX offers as complete a line of isolated power modules, triacs, power transistors, Mosfet (FETMOD[™]) modules, Mos-Bipolar (MOSBIP[™]) modules, rectifiers, thyristors, power hybrids, GTOs, RCTs, asymmetric SCRs and stack assemblies.

For more information, contact your POWEREX distributor or sales representative. For product literature, call 1-800-451-1415, Extension 200. In New York, call (315) 457-9334. For application assistance, call (412) 925-7272 or write POWEREX, Inc., Hillis Street, Youngwood, PA 15697.



CIRCLE NO 29

Power Sources



VME SUPPLIES

Series VMEP multiple-output switching power supplies comprise 104 models. The supplies are designed specifically for the VME Bus and include VME Bus ACFail and SYSReset signal lines. The series is divided into four groups according to power rating: 200, 400, 600, and 800W. Voltage outputs of 5, 12, 15, 24, and 48V dc are available in two VME Bus-height formats: 6U and 3U. Designed for operation in standard VME Bus card racks, the supplies also come in modified packages for universal mounting outside the rack. The supplies accept inputs

from 90 to 132V ac or from 180 to 264V ac over 47 to 63 Hz. Their switching frequency is 50 kHz, and all models provide three voltage outputs. Other features include load and line regulation to $\pm 0.2\%$ or 10 mV max; a 1% or 50-mV p-p noiseand-ripple specification: 70% min efficiency at full load: overvoltage and overcurrent protection for all outputs; and parallel power-sharing capabilities. \$450 to \$1200.

Power Pac Inc, Box 777, Norwalk. CT 06856. Phone (203) 866-4484.

Circle No 443

DC/DC CONVERTERS

Series E900VF² quad-output dc/dc converters (with an auxiliary ac filament output) are for use with vacuum fluorescent displays. They provide two dc anode and two ac filament voltages to power two-color vacuum-fluorescent displays or two



dissimilar displays requiring as much as 12W of total output power. The converters power standard displays from Noritake, Futaba, and NEC. You can order custom units for displays that require voltages not specified in the series. The units accept 5, 9, 12, 15, and 24V dc and have $\pm 10\%$ tolerance. They operate over 0 to 70°C and provide 600V rms I/O isolation at 60 Hz for one minute. The converters weigh 122g and come in aluminum pc-board mounts



You've chosen precision Airpax stepper motors before, so when you find yourself in the market for a linear actuator, here's something to remember. When we modify a stepper motor to become a linear

actuator, the change lies in the threaded shaft and resulting linear motion, not in the Airpax quality you've come to know. Our linear actuators come in an array of low, medium

and high force models with push/pull ratings of less than 21 ozs. to 25 lbs. in increments of .001 to .004" per pulse. Whenever rapid response and precision movement are called for, our engineers are ready to help you design the linear actuator for your specific application. Airpax linear actuators are the ones to depend on, for valve actuation, medical pumps, robotics, HVAC systems and much, much more.

To get your designs in motion, contact the Airpax Corporation, Cheshire Division, West Johnson Avenue, Cheshire, CT 06410.
(203) 272-0301. A North American Philips Company.



STE

ACT

CIRCLE NO 200

CONFIGURE-YOUR-OWN MIL SPEC • HIGH RELIABILITY POWER SUPPLIES

A HIGHER LEVEL OF PERFORMANCE

INTRODUCING EL 2000 SERIES Complete AC to DC and DC to DC multi output systems.

MORE BENEFITS

- **Save Space:** Completely protected AC-DC systems with rugged high density packaging to 8 watts/in³.
- Less Heat: Efficiencies to over 80% with next generation circuitry.
- **Higher Reliability:** MTBF to 500,000 hours with conservative design criteria including NAVMAT guidelines.

MORE CHOICES

- Up to 8 DC outputs to 500 watts.
- 1ø, 3ø and DC inputs.
- -55°C to +85°C operation.
- Mil-Std-704A-D, 1399 and 1275 input surge and spike protection.
- Meets many provisions of Mil-Std-810D, Mil-E-5400 and Mil-E-16400.

Call or write for our new EL 2000 Catalog today!



ARNOLD MAGNETICS CORPORATION

4000 Via Pescador, Camarillo, California 93010-5049 Phone: (805) 484-4221 • TWX 910-343-6468 • FAX: (805) 484-4113

CIRCLE NO 201

Power Sources

that measure $2.0 \times 2.5 \times 0.98$ in. \$29.72 (250).

Endicott Research Group Inc, Box 269, Endicott, NY 13760. Phone (607) 754-9187.

Circle No 444



EVALUATION BOARDS

Series VI-MEB modular boards are designed to evaluate the vendor's Series VI-100 and VI-200 dc/dc converters. The VI-MEB-LV accepts modules with input voltages to 100V dc. whereas the VI-MEB-HV handles modules with input voltages to 400V dc. Each board comes with a barrier terminal, output lugs, measurement test points, and fuse. The 10×12-in. boards accept one, two, or three modules; you can configure the boards as single-, dual-, or triple-output power supplies. The boards deliver as much as 400W when configured as single-output supplies. Triple-output configurations deliver as much as 200W per output. A 32-pg manual covers measurement techniques and provides application hints. \$295.

Vicor Corp, 23 Frontage Rd, Andover, MA 01810. Phone (617) 470-2900. TWX 910-380-5144. Circle No 445

SUPPLY SERIES

Mustang Series switching power supplies comprise 34 models at 25, 50, 70/80, 100, and 150W. Each model is encased and has a barrier screw-type terminal connector. Every power supply features an input EMI filter, inrush current limiting, $\pm 5\%$ minimum outputvoltage adjustment, 72 to 75% effi-



ciency typ, and overload protection. The units have line regulation of 0.4% from low line to high line, and their load regulation is 0.8% from no load to full load. All models provide a 20-msec min hold-up time. Their ripple-and-noise specification is 1% or 50 mV p-p max, whichever is greater. Multiple- and single-output models accept ac input voltages from 90 to 132V ac. In addition, the multiple-output models accept voltages between 180 and 250V ac. Their input frequency ranges from 47 to 440 Hz, and their switching frequency is 100 kHz. The units operate over 0 to 71°C, with derating between 50 and 71°C. The series is UL recognized and CSA certified. From \$59.50 (1000).

Computer Products Inc, 2900 Gateway Dr, Pompano Beach, FL 33069. Phone (305) 974-5500. TWX 510-956-3098.

Circle No 446



SWITCHER

The SPM5 is part of the International High Power series of switching power supplies. It provides 1500W in a $5 \times 8 \times 11$ -in. fan-cooled package. Its modular design lets you specify as many as 15 outputs

from a selection of off-the-shelf single-, dual-, and triple-output plug-in modules. This modular construction can achieve a power density of 3.4W/ in³. The unit accepts input ac voltages from 90 to 132V ac and from 180 to 264V ac, in the field-selectable range of 47 to 440 Hz. An optional UPS (uninterruptible power system) module provides loss-of-power protection via battery backup to 1000W of dc output power. You can use the UPS module with parallel, connected dc output modules for redundant-mode operation in fault-tolerant systems. The supply meets VDE, IEC, CSA, and UL safety standards; it also meets FCC and VDE emission standards, \$924 (250).

Power-One DC Power Supplies, 740 Calle Plano, Camarillo, CA 93010. Phone (800) 235-5943; in CA, (800) 421-3439. TWX 910-336-1297. Circle No 447



POWER CONDITIONER

This series of μ P-based electronic power conditioners (EPC) comprises models with 500, 1000, and 2000 VA output capacities. Each model regulates the output voltage to within ±5% of the nominal output for input voltage variations from +15 to -25%. The devices continuously measure output voltage and correct it every 16 msec. The units suppress to safe levels Class A and Class B input surge voltages of as much as 6000V peak per ANSI C 62 41-1980 (IEEE-587-1980). The units *Text continued on pg 233*

ACME'S LAW OF POWER SUPPLY AND DEMAND

TO ACHIE

Flexible Power At Your Fingertips

Flexible Power At Your Fingertips Acme gives you power by design – your design – with The Spectrum 400A. *Five* factory/user-adjustable outputs, unavail-able in the industry up until now, let you set the exact output ratings you need for virtually any application: computers, tele-communications, instrumentation, and industrial controls. A simple turn of the trim pot and you have the flexibility of 120 power supplies all from one stock unit... available through authorized *Standard* available through authorized *Standard Power* distributors. And, The Spectrum

Power distributors. And, The Spectrum 400A gives you 400 watts of switching power in a mere 13" x 5" x 2.5" package. For more information on The 400A - the first in the Spectrum Series - or on any of our standard, quasi or custom linear and switch-mode power supplies, contact Acme Electric. We're putting power supplies in a whole new light.



□ 400W air, 300W convection □ Five factory/user-adjustable outputs

Outputs		1	 2	3	: 4	:	5	
Vdc	:5	±5%	 12-24	5-15	: 5-15		5-15	
Current Air	:	50	 6	6	: 6		6	
Current Conv		40	 6	6	: 6		6	

±0.2% regulation on all outputs
 The most compact unit on the market -measures only 13"
 UL, CSA, IEC and TUV approved. FCC and VDE approved for noise level A.
 Power fail and remote inhibit standard

Acme Electric Power Products Group Cuba, New York 14727 (716) 968-2400 CIRCLE NO 202

Power Sources

attenuate transverse-mode noise by 60 dB and common-mode noise by 130 dB. Each unit in the series maintains a sine-wave output and adds less than 0.5% harmonic distortion to the input waveform. The units shut down when the input voltage is more than 24% above or 40% below the nominal input voltage. The units automatically enable the output voltage when the input voltage returns to acceptable limits. The 60-Hz units are UL listed and CSA certified, and they conform to FCC Class B requirements. The 50-Hz models meet VDE and IEC requirements. The 60-Hz models are rated for nominal outputs of 120. 208, or 240V ac; they have rated outputs of 110, 220, 230, or 240V ac. \$599 to \$1279.

Sola, 1717 Busse Rd, Elk Grove Village, IL 60007. Phone (312) 439-2800. TLX 280538.

Circle No 448



POWER PACKS

Performaxx lithium power packs are designed to power downhole equipment. The line of power packs includes battery packs for several standard downhole tools and for custom models. The basic cells have a 3.9V dc open-circuit voltage (OCV) rating, come in four sizes, and have four capacities rated for 3.6V (loaded) at 150°C. These sizes and capacities are RMM 150 AA at 1.3 Ahr, RMM 150 C at 5.1 Ahr, RMM 150 D at 12 Ahr, and RMM 150 DD at 22 Ahr. The basic cells are packaged in an integral pack to meet a specific tool's power requirements. The integral-pack construction incorporates Kapton spacers (rated at >200°C) to allow for thermal expansion of the cells; welded nickel tabs to ensure cell-to-cell continuity; a nonconductive heat-resistive Nomex housing material; and a field-replaceable external fuse. The packs comply with DOT E-7052 safety standards, including altitude testing at 50,000 ft. The units are shock tested to 5000G and temperature tested to 150°C under heavy current drains. Individual cells, from \$32.25 to \$54.25.

Electrochem Industries/DRM, Box 50, Buffalo, NY 14226. Phone (716) 759-2828.

Circle No 449



BACKUP SUPPLY

The PowerMax line of backup power systems provides protection against power blackouts. If a power failure occurs, the system switches from ac power to an internal battery within 2 msec. The battery can operate for as long as 80 minutes, depending on the power demands. The line consists of three units: the 450 VA model, with 300W capacity; the 800 VA model, with 600W capacity; and the 1200 VA model, with 1000W capacity. All models sound an alarm when the battery power of the system is nearing exhaustion. All models are UL recognized and CSA approved, and carry a one-year guarantee. The 450 VA, 800 VA, and 1200 VA models cost \$599, \$1099, and \$1399, respectively.

Panamax Inc, 150 Mitchell Blvd, San Rafael, CA 94903. Phone (800) 472-5555; in CA, (800) 472-5540. FAX 415-472-5540.

Circle No 450

LINE CONDITIONERS

The vendor has added 56 models to its two lines of power-protection systems, the EIT extreme isolation



transformers and the XLC line conditioners, which provide data integrity and security for computer systems in the event of power-line disturbances. The isolation transformers feature output load regulation of $\pm 3\%$ of the input voltage from no load to full resistive load; isolation resistance of 10,000 M Ω : dielectric strength of 2500V ac; and 97% efficiency. All of the transformers meet CSA-22.2-066 and UL-1012 requirements; some meet VDE-0550 specifications. The line conditioners provide input regulation of $\pm 3\%$ of the output for inputs of 120V ac +10%, -20%; load regulation of $\pm 2\%$ from no load to full resistive load; 5% THD max for a resistive load: common-mode rejection of 120 dB or greater; voltage spike attenuation of 48 dB or greater; short-circuit protection with short-circuit current limited to 200% of rated value; and 85% efficiency. Isolation transformers, from \$175; line conditioners, from \$275.

Xentek, 760 Shadowridge Dr, Vista, CA 92083. Phone (619) 727-0940. TWX 910-322-1155.

Circle No 451

POWER SUPPLIES

Minivolt miniature power supplies measure $90 \times 64 \times 32$ mm and are suitable for chassis or pc-board mounting. They operate from 110/ 250V line inputs. The single-output versions provide a 5V output at 0.5, 1.0, 1.5, 2.0, or 2.5A; a 12V output at 1.2A; or a 24V output at 0.6A. The dual-output versions provide $\pm 15V$ outputs at 0.1, 0.2, or 0.5A. You can ground the positive or negative output of the single-output supplies to generate a negative or positive output. The dual-output versions have a common ground. The

LIF YOUR CAMS AWAY

LOW INSERTION FORCE (LIF) CONNECTORS BEAT ZERO INSERTION FORCE (ZIF) CONNECTORS 3 TIMES:

- 1. WIPE: contact wipe eliminates corrosion and disconnects caused by cable weight.
- 2. COST: jack screw coupling costs less than cam actuated coupling.
- 3. RELIABILITY: jack screw coupling eliminates intermittent contact.

The Hypertronics N-series of connectors eliminate the common problems of comparable ZIF connectors. They provide lower cost in high pin count models and applications flexibility:

- 70 to 700 contact positions
- Rack and panel, cable to chassis, cable to cable models
- 5 Amp and 9 Amp contacts
- Crimp, solder cup, wire wrap,[®] and dip solder termination.

The N-series utilize the Hypertac[®] contact which provides:



- Extremely low contact insertion/extraction force (as low as 1/2 ounce)
- Electrical continuity under extremes of shock and vibration (tested below 10 nanoseconds)
- Contact life exceeding 100,000 with excellent electrical repeatability
- Contact resistance under 5 milliohms.

To learn more about these versatile connectors and which configurations are right for you, call us toll-free 1-800-225-9228 or write for a copy of our complete 1987 catalog.





HYPERTRONICS CORPORATION

16 Brent Drive, Hudson, MA 01749-2904 MA & Canada Tel: (617) 568-0451

Telex: 95 1152 Fax: (617) 568-0680

® Wire wrap is a registered trademark of Gardner Denver.

Power Sources

line regulation is $\pm 0.05\%$; the zero to full-load output regulation is 0.15% for single-output versions and 0.35% for dual-output versions. Output ripple is less than 1 mV. Around £100.

Hunting Hivolt Ltd, Riverbank Works, Old Shoreham Rd, Shoreham-by-Sea, W Sussex BN4 5FL, UK. Phone (0273) 454511. TLX 87466.

Circle No 454 Hunting Hivolt, 1008 W 9th Ave, King of Prussia, PA 19406. Phone (215) 265-7462.

Circle No 455

STANDBY SUPPLY

To eliminate unnecessary duplication of equipment in dc uninterruptible power-supply systems, you can use these 20 or 30A modular standby-power supplies to build a 24 or 48V system. Such a system can fur-



nish a maximum of 120A, and a single switching unit can handle all load switching. The modules also ease future expansion or modification of your system.

The modules provide load current and battery-charging current for suitable lead-acid batteries. The switching unit automatically switches the load to the batteries if the line supply fails. Features include output overvoltage protection, automatic temperature compensation of the battery-cell recharge voltage, and a low-voltage disconnect facility that prevents deep discharge of the batteries. Remote alarm outputs are provided for lineinput failure and out-of-limit voltage excursions. You can mount each module on a 19-in. rack. Powersupply modules, from £957; switching unit, £924.

F W O Bauch Ltd, 14 Gunnels Wood Industrial Estate, Gunnels Wood Rd, Stevenage, Herts SG1 2BH, UK. Phone (0438) 727684. TLX 27502.

Circle No 456

A *NEW* TERMIFLEX TERMINAL FOR \$195.



ST/32 — INDUSTRIAL QUALITY

- 32 Character LCD
- Compact
- RS232C Interface
- 30 Alphanumeric Keys
- Custom Graphics Available

Termiflex has taken its years of experience and leadership in control/display units (CDU) and produced the ST/32. This rugged, versatile CDU is available for overnight delivery.



TERMIFLEX CORPORATION 316 Daniel Webster Highway Merrimack, NH 03054 (603) 424-3700 DID YOU KNOW?

You can obtain EDN designer's guides to semicustom integrated circuits, CMOS ICs, and innovative linear circuits.



That set the standard for high performance programmable ICs:

The company that brought you CMOS programmable devices with bipolar performance now introduces the next logical step: CMOS programmable devices that surpass bipolar in speed, and in density.





Nothing this big ever went this fast with so little power.

16,384 words by 8 bits, with address-to-valid-output in 45 nanoseconds!

Isn't new technology wonderful? Here's PROM with the speed and density to keep up with microprocessors running at 20MHz and beyond.



Actual size!

High performance PROM for program and table storage with the density and low power you need for cooler, smaller designs.

Beyond speed: CMOS advantages that make bipolar obsolete:

There are no viable bipolar PROM suppliers supporting this density.

A density that lets you design bigger systems with fewer devices.

Devices that, in turn, need less power.

100mA Active.

Two 64K bipolar parts would require nearly four times the power!

And bipolar PROM can't match our standby power-down features for lowest system power requirements.

30mA Standby Power, with no sacrifice in speed!



45ns. 100mA. 30mA Standby. 128K PROM 43ns. 100mA, 30mA Stara 300 mil package. Three fast chip selects. Power-down chip enable. (Military: 55ns, 120mA, 35mA Reprogrammable. Standby.) Actual size!





16K PROM 25ns. 120mA. Reprogrammable. (Military: 30ns, 120mA)

Prom II is here! Speed records tumble!

Sub-micron fabrication (0.8 micron, to be exact) means our newest 16K delivers record setting performance: Clock-to-output of 12ns for the registered CY7C245A, 18ns set-up.



16K Power-down PKOM 25ns. 120mA. 20mA Standby. Reprogrammable. (Military: 30ns, 120mA, 30mA Standby.) And access time of 25ns for the unregistered CY7C291A and CY7C293A. The 25ns CY7C293A also offers unprecedented low standby power: Only 20mA, and with no loss in performance!

16K Registered PROM 18ns Set-up. 12ns t CO. 120mA. Pipeline accelerator.

CY7C2454

Plus a wide range of 4K, 8K, and 16K PROM

In registered and non-registered versions. Some with windows. And all with the key Cypress Semiconductor CMOS PROM Technology Advantages.



64K Performance PROM: Choices.

For highest performance, lowest power 64K PROM devices, you have little choice but Cypress Semiconductor. We give you the fastest low power parts in the industry. And we give you plenty of options:

Registered versions. Registered diagnostic versions. Reprogrammable versions. Power-down versions.

More *choices*, so you have more ways to configure the best system.



64K PROM 35ns. 100mA. Reprogrammable. (Military: 45ns, 120mA)



64K PROM 35ns. 100mA. Reprogrammable. (Military: 45ns, 120mA)



64K Registered Diagnostic PROM 40ns Set-up. 20ns t CO. 100mA. 28-pin, 300 mil package. Reprogrammable. (Military: 50ns, 120mA)



64K Power-down PROM 35ns. 100mA. 30mA Standby. Reprogrammable. (Military: 45ns, 120mA, 30mA Standby.)



64K Registered Diagnostic PROM 64Ns Set-up. 20ns t CO- 100mA. 32-pin, SSR[™] Compatible. Full Diagnostics. Reprogrammable. (Military: 50ms, 120mA)

CY7C268

First bytewide diagnostic PROM: 64K. Registered. 20ns.

Widely accepted in military applications, diagnostic PROM is now gaining in popularity for commercial applications.

Two new innovations should accelerate that acceptance: Our CY7C268 and our CY7C269.

Both function in the normal pipeline mode, with high performance.

Or, when selected, the Diagnostic Register can be loaded with the data on the bus, or the data in the Pipeline Register. Conversely, the system can load the contents of the Diagnostic Register into the Pipeline Register.

If board space is at a premium, the designer can select the 300-mil, 28-pin CY7C269. The CY7C268 offers full compatibility with the SSR Diagnostic Standard, but with the important addition of bytewide capabilities.

Either way, the designer has powerful tools for system diagnostics.

Who uses diagnostics?

Designers of state machines. Controllers. Bit-slice machines. Debugging systems. Anyone who needs to step through programs.



And, you can specify these packages. Our robotic assembly makes your package requirements easy to satisfy.

How innovation gives you better, more reliable technology. With every Cypress PROM or PLD:

Speed: As we continue to exploit the capabilities of CMOS, you see CMOS surpassing bipolar performance, delivering the highest speed available.

Low Power: A fraction of the power of bipolar, in fact. Invaluable for today's highest performance systems. With power-down features that let you create the lowest overall system power possible.

Reliability: First, because our floating gate cell technology can be erased, we are able to test and erase every cell in every product prior to shipment, to assure you of the highest possible programming yields.

Second, our engineers have created designs that have the highest tolerance to static discharge and voltage fluctuation. Translation:

Tolerates 2001V Static Discharge. Tolerates $\pm 10\%$ voltage fluctuation.



Second Generation Programmable Logic: Our best seller.

The Cypress 22V10 difference. It is fast, 25ns with 15ns set-up time, and it is shipping in quantity.

It sips power. It is available in reprogrammable versions, to simplify your development cycle.

And our 22V10 features Programmable Macro Cells, which lets you define the architecture of each output, individually. Options include



The 22V10 is also available in these packages. Our robotic assembly means we can supply the package that's best for your system.

registered operation, combinatorial operation, selectable output polarity, and array-configurable outputenable; you have up to 22 input terms and 10 outputs at your disposal. These options let you configure the part to your system needs like no other PLD.

Our Variable Product Term architecture allows you the functions you need for most applications without burdening the performance of the part.

Finally, there is an array of enhanced test features to accelerate development. Not to mention our handy QuickPro[™] for easy programming and diagnostics right on your PC-compatible.



25ns. 33MHz. 55mA "L". 90mA Standard. 300 mil package. Reprogrammable. (Military: 25ns, 25MHz, 100mA)

6 Tools for design, faster.

QuickPro: PROM and PLD programming and diagnostics right now, right from your PC-compatible.

QuickPro is fast becoming an essential complement to the PROM programmer in the development lab.

Quick	QuickPro IPNOV7LD programmer	
	i = for PLD devices 2 = for SPMM devices 9 = Exit	
QuickPre	Entor command _ Software and Hardware Copyright	(c) 198

Menu-driven: PROM and PLD options are easily selected through hierarchical menus. Help screens make the system easy to learn and use.

Here's why:

1. You have the software updates you need to use the latest Cypress PROM and PLD releases quickly typically several months before the updates are released by PROM Programmer vendors. Because the QuickPro is software driven, updates are simple floppy disk files; the system is future proof. 2. You have an easy, screen and menu oriented system that gives you lots of options, and saves you lots of time.

3. You can program any Cypress Semiconductor programmable part, on PC-compatibles.

4. As you can see, you can quickly display the contents of any device, to speed debugging.

5. Using the JEDEC standard, (PC-DOS[™] binary for PROM) QuickPro is compatible with the output of all the popular PLD programming tools, including CUPL[™], ABEL[™] and PALASM.[™]

2866	80	88	88	66	86	88	69	88	88	86	88	88	86	88	88	88		
8010	80	00	00	00	00	00	00	00	88	80	88	00	86		88	88		
3828-	00	00	00	00	00	00	00	00	20	00	00	00	00	88	80	86		
10.20	80	80	00	80	00	00	80	00	00	00	00	00	00	88	50	88		
1010	98	80	60	00	60	80	00	00	00	00	50	00	00	80	00	00		
10.30	80	00	00	00	00	00	00	00	00	00	00	00	00	80	66	88		
878	80	80	80	00	00	00	00	00	00	00		88	00	80	88	88		
1000	88	00	80	80	00	00	00	00	00	00	00	00	00	60	88	66		
1200	88	00	00	00	80	00	00	20	00	00	30	68		85	68	88		
RAR	80	80	80	00	00	00	00	00	00	00	00	00	00	00	88	80		
ARA	88	88	80	00	80	80	00	00		00	50	80	88	68	88	88		
ACR	20	80	80	00	90	00	00	60		00	00	00	00	50	86	80		
ana	88	88	80	00	00	00	20	00	00	00	00	90	80		88	60		
AFA	88	88	80	80	00	00	00	80	00	80	86	88	58	80	88	88		
ISTS:	88	88	80	80	00	00	00	69	88		90	88		88	88	68		
	00	00	00	00	00	00	60	60	96	63	66	66	60	68	69	80		

Memory display/editing: You can display the contents of PROM (shown) and PLD parts, for simplified debugging. You can also edit the contents of memory, and reprogram easily. Result: Faster development, more productive 'what-ifs'.

6. You can read the contents of virtually any 20- to 32-pin PLD or PROM. This allows you to copy your parts easily to Cypress devices, for comparative evaluations.

BQuickF



Powerful options: You select from a broad



Get the CMOS good book, faster.

High speed SRAM. High speed PROM. High speed PLD. High speed Logic.

Over 600 pages.

Including every data sheet on every Cypress Semiconductor product. Plus preliminary data sheets on devices in progress. Plus full information on our military capabilities. Designin information. Application Briefs. And much more.

Data Book Hotline: 1-800-952-6300, ask for Dept. C30 1-800-423-4440 (In CA), ask for Dept. C30 (32) 2-672-2220 (In Europe) (416) 475-3922 (In Canada)



Applied Power Electronics Conference and Exposition

1-5 February 1988

The Fairmont Hotel New Orleans, Louisiana

You Are Invited!

Join with us in an exciting week of technical sessions, seminars and exhibits at the third annual Applied Power Electronics Conference and Exposition, the Premier Conference for practicing power electronics designers.

Special Feature Events

- Micro-Mouse Contest
- Vendor exhibits and reception
- Technical rap sessions discussing magnetic core characterization, semiconductor packages and 300 V distribution busses.

Social events including a tour of New Orleans and an evening at Algiers Landing

For More Information Call (202) 639-4990



New Orleans, Louisiana

APEC 88 Will Feature

Technical Sessions

High Frequency Power Conversion

Computer Aids and Simulation Tools for Power Electronics Engineers

Motion Control

- Nonlinear Magnetic Circuits
- Power System Considerations
- Power Supply Design
- Semiconductor Devices

Rectification, Cycloconversion and Power Factor Compensation

Professional Education Seminars

Basic Power Converter Control Design — Rudy Severns

■ Fundamentals of Power Transistors Bipolar and MOSFET— Kim Gauen and John Phipps

■ Design-Oriented Analysis Methods for Power Electronics: The Extra Element Theorem — R.D. Middlebrook

Digital Control in Switched-Mode
 Power Electronics —
 Christopher Henze

 Applying Personal Computers in Power Supply Modeling — H. Dean Venable

■ High Frequency DC-DC Power Conversion — Martin Schlecht

■ High Voltage Power Supply Design — John Collins

■`Microprocessor to Motor: Bridging the Gap with Power Electronics — Thomas Hopkins

APEC 88 is sponsored by the Power Electronics Society of

The Institute of Electrical and Electronics Engineers CIRCLE NO 204



Cache-memory controller with bus-watching capability (Intel)

As µP clock frequencies increase, the access time of the memories servicing the µPs must decrease. When you use a cache memory, you can use low-cost, relatively slow main memory and still keep up with the microprocessor.

Cache-memory systems benefit from on-chip solutions

David Shear, Regional Editor

The motivation behind using a cache is to improve a CPU's throughput by eliminating wait states. Not too many years ago, only those engineers designing advanced mainframes concerned themselves with cache memories. Nowadays, with the proliferation of high-performance 16- and 32-bit μ Ps and inexpensive, though rather slow, dynamic-RAM main memory, almost all systems can benefit from cache memories (see **box**, "Caches increase CPU throughput"). Your next μ P design may very well require the performance gains afforded by an architecture with a cache.

To address this need, many IC vendors have introduced cache-memory controllers. You have a slew of choices, from simple cache-tag RAMs to complex and complete 4-way, set-associative subsystems. Before you can make an intelligent decision about which product to use, you have to be able to evaluate the various approaches and determine the effect each approach will have on the performance of the system you're designing.

The goal in using a cache is not necessarily just to achieve optimal cache efficiency—or even optimal processor performance. Rather, it is usually a more global objective, typically involving optimizing system performance within certain cost, size, and power limits. Simply stated, your main design goals are as follows:

- Minimize the probability of not finding a memory reference's target in the cache (the miss rate)
- Minimize the time to access information that is indeed in the cache
- Minimize the delay due to a miss
- Minimize the overhead of updating main memory and maintaining coherency.

The miss rate is a key parameter

One of the key variables in evaluating a cache implementation is the miss rate, the ratio of memory misses to the total number of memory accesses. The miss rate is a statistical estimate derived from the results of simulation or by actual measurement. (For more information on determining the performance advantage in using a cache, see **box**, "Estimate the performance gains possible with a cache.")

Using a cache requires many design decisions

You'll find many approaches to using a cache. The major differences you'll have to evaluate are the size of the cache, the placement policy, the use of either a write-through or a copy-back memory-update policy, the choice of a real or virtual implementation, the coherency policy, the single-vs-split implementation, and the replacement scheme.

The size of the cache is the most dominant cache parameter in terms of both cost and potential performance tradeoffs. You can't just make a large cache and expect great performance; you must use this resource well. Common cache sizes range from a few hundred bytes inside a μ P chip to a few hundred kilobytes inside a mainframe. The cache controllers from Austek, Chips and Technologies, and Intel, for example, all have a size of 32k bytes (**Table 1**). The NEC single-chip implementation has only an 8k-byte cache, but because of its design it maintains a miss rate that's comparable to the others'.

Although a cache's miss rate varies significantly with the software that is being executed, it has been shown that increasing the size of the cache increases the hit rate (**Ref 1**). As the cache size increases, the miss rate is asymptotic to a miss rate of 0. Therefore, the increase in performance with an ever-increasing cache size reaches a point of diminishing returns. The main penalty in increasing the size of a cache is the cost incurred.

Another cache-design decision you'll be confronted with involves the placement policy. Placement determines how the main memory is mapped into the cache. You have three choices: direct mapped, set associative, or fully associative.

A direct-mapped cache is implemented as a RAM addressed by some of the low-order memory address bits (Fig 1). The incoming address bits (index) select

The most important, and elusive, parameter for evaluating the performance gains possible with cache memories is the miss rate.

one of the cache entries and the most significant address bits are compared to the stored tag. If a match is detected, then a hit has occurred. Direct mapping is the simplest of the placement policies, but has the disadvantage that the miss rate increases sharply when two or more references are made to memory locations with the same lower address bits (index).

A set-associative cache is similar to a direct-mapped cache, but the index selects a set of two or more entries. Each entry can use the same lower address bits. In a 4-way set-associative cache, for example, four separate addresses can use the lower address bits (**Fig 2**). This approach greatly decreases the miss rate as compared with the direct-mapped approach.

A fully associative placement policy is implemented as a content-addressable memory by means of including a tag comparator with each entry. Few caches use this placement policy because it is such a complex approach, and because the decrease in miss rate (compared with that of a 4-way set-associative approach) is so small.

Fig 3 shows the decrease in miss rate possible with the various placement policies. All of the available cache-memory controllers use the set-associative approach (although Intel's 82385 can use a direct-mapped mode, too). Both Intel's and Chips and Technologies' ICs are 2-way, set-associative caches, whereas Austek's and NEC's are 4-way, set-associative types.

Keeping main memory up to date

You'll also have to determine which memory-update policy is best for your application; when data in the cache is modified, it is important that the main memory be modified as well. To meet this end, there are two basic approaches: write through and copy back.

In the write-through approach, all memory-write

operations are written to both the cache and the main memory simultaneously. This approach greatly simplifies the updating process because the main memory always contains an up-to-date copy of the data. The drawback is that each write is treated as a cache miss because the CPU must wait for the main memory to be written to.

Using a buffered write alleviates this problem. The buffer holds the data that's to be written to main memory to meet the timing of the main memory, and it allows the CPU to continue processing without having to wait. The buffered write through is by far the most popular implementation: All of the controllers available use it. A good write-through implementation seldom has to wait while a write operation to main memory finishes.

Copy-back main-memory updating allows writes to the cache, but main-memory updates occur at a later time. Almost always, this approach results in less main-memory traffic because data is written to the main memory only when the data leaves the cache when a miss requires that a cache location be relinquished, for example, or when task switching takes place.

Should it be virtual or real?

Your next design decision will involve the cache's implementation, which can be either virtual or real. The difference centers on where the cache is placed in the data and address paths relative to the CPU and the memory-management unit (MMU). If the cache is between the CPU and the MMU, then it'll deal with virtual addresses—hence the name "virtual implementation." This implementation can cause confusion when you consider that a virtual address can point to many

COMPANY	DEVICE	PART	SIZE	PLACEMENT POLICY	REPLACEMENT POLICY	
AUSTEK MICROSYSTEMS	MICROCACHE	A38152	32k BYTE	4-WAY SET-ASSOCIATIVE	LRU	
CHIPS AND TECHNOLOGIES INC	CACHE CONTROLLER	82C312 (PART OF CS8231 CHIP SET)	16/32k BYTE	2-WAY SET-ASSOCIATIVE	LRU	
INTEL CORP	CACHE CONTROLLER	82385	32k BYTE	2-WAY SET-ASSOCIATIVE OR DIRECT-MAPPED	LRU	
NEC ELECTRONICS INC	SINGLE-CHIP CACHE SUBSYSTEM	μPD43608	8k BYTE	4-WAY SET-ASSOCIATIVE	LRU	

TABLE 1—CACHE-MEMORY CONTROLLERS

Caches increase CPU throughput

According to Webster's, a "cache" is a hiding place for concealing and preserving provisions. In the case of computers, the provisions are prefetched data stored separately from the main memory. When the µP accesses memory, the cache supplies the concealed provisions (data) if it is able. If it is unable, the main memory will supply the data while the CPU waits for the main memory to respond. At the same time, the cache stores the most recently requested data for future reference.

In essence, caches are small, fast memories placed between a processor and the main memory of a computer system to reduce the amount of time necessary for memory accesses (Fig A). The only reason for having a cache is to increase CPU throughput with a rather small number of static RAMs (albeit more expensive) to make up for the rather slow access times of the dynamic RAMs.

When a cache satisfies a mainmemory access, the overhead resulting from accessing the main storage memory is eliminated. This elimination frees the system bus for DMA or multipleprocessor activity and provides a significant improvement in the cost/performance ratio of memory design. The μ P can therefore operate at cache speeds while maintaining the economic advantages of a slower main-storage memory.

A cache works by means of

what is called the property of locality. This property has two aspects, temporal and spatial. According to temporal locality, information that'll be in use in the near future is likely to be in use already. You can expect this type of behavior from program loops in which both data and instructions are reused.

According to spatial locality, portions of the address space that are in use generally consist of a fairly small number of individually contiguous segments of that address space. A cache memory buffers segments of information that have been used recently, and thus the property of locality implies that the needed information is likely to be found in the cache.





WRITE BUFFER	BUS WATCHING	SPEED	ADDRESS SPACE	PACKAGE	COST	SPECIAL FEATURES
YES	NO	16 OR 20 MHz (80386)	4G BYTE	84-PIN PLCC	\$58 (16 MHz) (10,000)	80386-BASED SYSTEMS 5-CHIP SOLUTION
YES	NO	20 OR 25 MHz (80386)	64M BYTE	100-PIN PFP	\$169.80 (20 MHz) (10,000) CS8231-20 CHIP SET	INTEGRATED DYNAMIC- RAM CONTROLLER
YES	YES	16 OR 20 MHz (80386)	4G BYTE	132-PIN PGA	\$130 (16 MHz) \$165 (20 MHz) (1000)	
YES	YES	READY, 70 nSEC DATA, 85 nSEC CYCLE, 125 nSEC	256M BYTE	132-PIN PGA	\$260 (100)	16- OR 32-BIT CPUs; SINGLE-CHIP SOLUTION

The size of the cache is the most dominant parameter in terms of both cost and potential performance.

real addresses. In a real implementation, the cache is situated after the MMU, so each address in memory has only one address.

A virtual cache's advantage is that it doesn't have to wait while the MMU translates an address, and thus it can respond much faster. Faster response time notwithstanding, a virtual cache complicates the hardware design and adds some complexity to the software design because it has to keep track of which real address the virtual address is pointing to. As μ P technology advances, however, more CPUs will have the MMU on chip. This will leave you with no choice you'll have to use a real cache. Another potentially critical design decision of which you should be aware is a cache's coherency policy. When several sources, such as multiple CPUs and a DMA controller, can change data in main memory, you can have a problem with the data's coherency (or consistency). You must make sure that the data you're using from the cache isn't stale. For example, if data from main memory also exists in a cache, and a DMA controller or other processor modifies the data in main memory, the computer must invalidate the old data in the cache.

There are many methods for maintaining coherency. The Intel 82385 takes one of the most sophisticated



Fig 1—A direct-mapped cache implementation is the simplest approach. The μ P's address is split into an index, which points to a tag. The tag is then compared to the rest of the address. Note that only one main-memory location can be stored in the cache for each index.

approaches, the bus-watching approach (Fig 4). By keeping an eye on all of the transactions on the system bus, the cache controller automatically invalidates data in the cache when an external source modifies main memory. The NEC μ PD43608 also has bus-watching capability to maintain coherency.

As far as a split-vs-single cache implementation is concerned, most, if not all, of the available controllers are single-cache implementations. You can have more than one cache in a system, though. A split cache is an architecture that uses more than just a single cache. A typical approach is to have an instruction cache and a *Text continued on pg 252*

Estimate the performance gains possible with a cache

You can use the equations below to evaluate the increase in performance afforded by a cache implementation. By playing with various values of the miss rate, you can see how much of an improvement is possible.

The average memory-access time is often useful in evaluating the performance gains that various cache implementations can provide. You can calculate the average access time from a combined relationship between cache use and main-memory use:

Tav=

R((1-M)Tcr+M Tmr)+W Tw,

where Tav=average memory-access time, R=percentage of memory cycles that are reads (typically 85%), W=percentage of memory cycles that are writes (typically 15%), M=cache miss rate, Tcr=cache read-cycle time, Tmr=main-memory read-cycle time, Tw=write-cycle time (main-memory time for unbuffered systems or cache-memory time for buffered systems).

Many times, you can gain further insight by estimating the average number of wait states that a system will require when accessing memory:

Ncw = R((1-M)Ncr + (M Nmr)) + (W Nw),

where Ncw=average number of wait states, R=percentage of memory cycles that are reads (typically 85%), W=percentage of memory cycles that are writes (typically 15%), M=miss rate, Ncr=cache read-cycle wait states, Nmr=main-memory read-cycle wait states, Nw=write-cycle wait states (main-memory write-cycle wait states for unbuffered systems or cache-memory write-cycle wait states for buffered ones).

Evaluate throughput increase

It is possible to evaluate the increase in system performance by comparing the speed of a design using a cache with one that doesn't. You can define CPU throughput as the CPU clock frequency divided by the number of clock states per memory cycle. The CPU clock frequency is constant, and therefore the speed improvement provided by the cache can be expressed as a ratio: the clock states per memory cycle provided with a cache to the clock states per memory cycle with full wait states. That is,

FC = (No + Nm)/(No + Ncw),

where FC=throughput with cache relative to without, No=number of processor states per memory cycle with no wait states, Nm=number of wait states for main memory, and Ncw=average number of wait states with cache system.

For example, a 68010 µP requires four clock states per memory cycle (No=4). Assume you have a 12.5-MHz clock and a 250-nsec main memory requiring two wait states (Nm=2). With a buffered write and a cache requiring no wait states, having an access time of 50 nsec, and having a miss rate of 10% (M=0.1), you end up with the following estimation: average memory-access time=67 nsec, average number of wait states=0.170, and increase in CPU throughput=44%.

Note that with a RISC-based CPU, the potential for increasing performance by using a cache is higher. Because a RISC machine has only one clock state per memory cycle, the number of wait states makes a much larger difference. If you use a RISC machine with a memory that has two wait states, a cache similar to the one in the previous example would yield a 156% increase in throughput.



W ACCS

WINNING DOBBERRAR

AGCS family now expanded to 11 devices – see box at right for details.



TELESSEE

201 W

PPP

N ACCS

W AGCS

Finally, graphics to match your imagination...now more than ever.

INTRODUCING THE FIRST EFFECTIVELY PARTITIONED VLSI ARCHITECTURE FOR TRULY FLEXIBLE GRAPHICS SYSTEMS DESIGN

Imagine a graphics architecture so powerful, you can achieve 16K-by-16K resolution. So effective, you can add virtually unlimited planes of color without degrading performance. So flexible, you can integrate it into an existing design or use it to build an entire range of new systems.

That's the Advanced Graphics Chip Set from National Semiconductor.

By using a multiple-chip, modular approach, the Advanced Graphics Chip Set avoids the design compromises and limitations of single-chip solutions.

That gives you two unprecedented benefits: *performance* and *flexibility*.

Which means you can design exactly the type of system you need with exactly

the level of performance your application demands.

For example, you can integrate part of the chip set with an existing general-purpose microprocessor for a low-end display.

Or you can utilize the chip set's full capabilities for a high-end, high-performance, high-resolution CAE/CAD workstation or laser printer — with virtually unlimited planes of color. Yet with the same highspeed performance as a black-and-white application.

In fact, you can design an entire range of graphics systems without having to "reinvent the wheel" each time, by using the same hardware building blocks and the same central software in each of the systems.

© National Semiconductor 1987

THE ADVANCED GRAPHICS CHIP SET

Now expanded for even more design flexibility and freedom.

2 BitBlt Processing Units (BPUs). 20-MHz devices that control data movements within their own dedicated memory planes or between those planes and other memory planes in multi-color systems. AVAILABLE NOW.

4 Video Clock Generators (VCGs). Timing and control generators providing all the synchronization signals needed by a graphics system. Pin-programmable pixel frequencies for both low-frequency (125 MHz) and high-frequency (225 MHz) applications. AVAILABLE NOW.

C

U

2 Video Shift Registers (VSRs). Parallel-to-serial shift registers capable of serial-output rates up to 225 MHz. Compatible with 10K ECL outputs or with 100K ECL outputs. AVAILABLE NOW.

3 Video RAM Controllers (VRCs). Memory-array controllers for dualport video RAMs from 256K to 4 Mbits,

THE MULTIPLE-CHIP SECRET

The secret to all this flexibility and performance is our unique multiple-chip, modular approach. Rather than trying to squeeze all the important graphics functions onto a single chip — which would require some significant design and performance compromises — we've partitioned appropriate functions onto individual buildingblock ICs. This allows us to optimize the design of each chip, and allows you to optimize your own design for your particular application.

GRAPHICS WITHOUT LIMITS

What matters most about the Advanced Graphics Chip Set, of course, is what it does for *you*. And that answer is clear when you consider its high performance, its including dual-access arbitration logic for multiple-CPU applications. AVAILABLE NOW.

A total of 11 chips — all introduced in a single year between Siggraph 1986 and Siggraph 1987. An unmatched commitment to graphics system design.

And soon another family member, now in betasite testing: **Raster Graphics Processor (RGP)**. A fully programmable, high-performance microprocessor specially tuned for graphics applications.



modular approach, its open architecture, and its programmability: It gives you graphics without limits. It gives you true design freedom. It gives you the opportunity, for the first time, to design a graphics system "custom fit" to your exact specifications.

So what are you waiting for? If you're tired of those limited single-chip solutions bogging down your designs, take a look at the Advanced Graphics Chip Set. And learn how you can design a graphics system to match your needs... as well as your imagination.

For more information and availabilities, just contact your local National Semiconductor Sales Engineer or write:

National Semiconductor Advanced Graphics, MS 23-200 P.O. Box 58090 Santa Clara, CA 95052-8090



When data in the cache is modified, it is important that the main memory be modified as well.

data cache or to have separate user and supervisor caches.

Next, you'll have to consider the replacement scheme. When a cache miss occurs and all of the available cache memory is used up, you have to ensure that the data in the cache is replaced with the most recently requested data. If you have a direct-mapped cache, you have no choice but to replace the data pointed to at the index. With a set-associative approach, you have to decide which set to replace. Common replacement schemes employ random, FIFO, or LRU (least recently used) algorithms. The LRU algo-



Fig 2—In a set-associative cache, each index points to more than one tag. In this diagram, the Fujitsu MB81C50 provides four different tags to decrease the probability of a miss. The MB81C50 also includes the logic for the LRU replacement policy.



Fig 3—As the number of sets increases in a set-associative cache, the miss rate decreases. The gain in system performance with a cache larger than an 8-way, set-associative type rarely outweighs the increase in system cost.

rithm constantly keeps track of which set has the least recently used data, and it is this set that is then replaced. The LRU algorithm is the most efficient replacement scheme, and all of the available controllers use it.

Cache-tag RAM is the basic building block

In any cache-memory system, the basic building block is the cache-tag RAM. This RAM includes the comparator used to detect a cache hit. Cache-tag RAMs are built into all cache-memory controllers and provide the highest speed and the most flexible design solution. If the existing cache-memory controllers don't fit your needs, you can use these RAMs and devise your own system. They are especially useful in simple cache Text continued on pg 258



Fig 4—It is important to ensure that the data within the cache isn't stale. The Intel 82385 has a bus-watching capability that nullifies any cache references that may no longer be valid.





The NS32532: Real-world performance for real-world applications.

At National, we believe that a highperformance 32-bit microprocessor should be worked with, not around.

That's why the NS32532 offers you some of the highest performance specs in the industry.

Yet it's performance you can *use*. Because the NS32532 was created for realworld designers working on real-world systems to meet real-world needs.

PERFORMANCE YOU CAN COUNT ON

The NS32532 is capable of delivering 15 MIPS peak performance, 8-10 MIPS sustained, at 30 MHz.

Not "no-ops" MIPS. Not benchmarking MIPS. Not RISC MIPS. But genuine VAX® 11/780 MIPS.

You're looking at 16,600 Dhrystones per second.

Not to mention high integer performance and high floating-point performance. With a range of FPU solutions that deliver up to 8 million double-precision Whetstones per second.

Below: NS32532 chip

Left: VME532 evaluation board; NS32532 block diagram; competitive performance comparison*

* Sources:

N832532 — August 1987 Performance Evaluation Tests 80386 — ''The 80386: A High-Performance Workstation Microprocessor,'' Intel Corp., June 1, 1986 68020 — SUN 3/20 @ 25 MHz, as published by Sun Microsystems

The NS32532

- 8-10 MIPS sustained, 15 MIPS peak
- 20-, 25-, and 30-MHz devices
- On-chip 1,024-byte 2-way set associative physical data cache
- On-chip 512-byte direct mapped physical instruction cache
- Hardware cache invalidate for highperformance cache coherency
- On-chip demand-paged memory management including 64-entry fully associative Translation Lookaside Buffer
- 4-stage instruction pipeline including instruction prefetch and branch prediction
- 2-clock basic READ/WRITE cycle
- 1-clock burst-mode transfers
- Unique bit-manipulation and stringhandling instructions
- Highly symmetrical and orthogonal instruction set producing compact code
- Extremely fast context switch $(3.6 \,\mu s)$ and interrupt service $(1.3 \,\mu s)$
- Fabricated in M²CMOS
- 370,000 transistor sites
- SAMPLES AVAILABLE NOW

SUPER-MINI PERFORMANCE ON A CHIP

The NS32532 achieves its superior performance because it integrates key systems functions on a single piece of silicon.

Only the NS32532 incorporates on-chip data and instruction caches, demand-paged virtual memory management, and a 4stage instruction pipeline. With instruction prefetches and branch prediction. Plus a hardware cache invalidate mechanism that ensures cache coherency.

Series 32000 is a registered trademark of National Semiconductor Corp. VAX is a registered trademark of Digital Equipment Corp. UNIX is a registered trademark of AT&T Bell Labs VRTX is a registered trademark of Hunter & Ready Corp. © 1987 National Semiconductor Corp.

SCALABLE PERFORMANCE

The NS32532 is one of seven CPUs based on the same 32-bit architecture. With the same orthogonal, highly symmetrical instruction set.

Which means you can migrate your design throughout the entire performance range without having to re-engineer your software at any level. And you can build consistently competitive systems without resorting to some "more innovative" architecture that leaves you and your software investment in the lurch.

PERFORMANCE THAT'S READY FOR YOU TODAY

We've already begun sampling silicon. We've already ported UNIX* SystemV.3 and VRTX* And we've already produced a board-level implementation — a fully integrated, fully populated, plug-and-go VME-compatible native environment... available now for evaluation. So are nearly 150 other members of the Series 32000* family, including coprocessors, peripherals, development tools and optimizing compilers.

To talk about putting our performance into practice in your application, call our Application Engineers toll free: 800/ 538-1866, ext. 532 or 800/672-1811, ext. 532 (within California).







With 242 passengers on final approach into O'Hare, the last thing they're thinking about is your voltage regulator.

For devices with a critical performance envelope — devices that *have* to deliver, especially in harsh environments or hazardous conditions — you never compromise reliability.

And neither do we.

RELIABILITY FOR FOUR GENERATIONS

National has set the standard for reliability in IC voltage regulators since we introduced the world's first 3-terminal fixed regulator in 1970.

And we've maintained that standard into our *fourth generation*, in the world's first — and largest — family of low dropout (LDO) voltage regulators.

Fabricated in a deep-base PNP process, our LDO regulators give you low quiescent current (0.75 mA typ), low dropout voltage (input-output differentials of 0.6 V typ), tight line-to-load regulation (0.05% typ), low output noise (150 μ V_{RMS} typ), and high ripple rejection (60 dB typ).

Which not only means you can design-in the highest levels of reliability, but means you can design smaller, cooler, quieter systems that operate with lower input voltages. And that means you can boost system efficiency by 30-50% while cutting system cost substantially.

RELIABILITY FOR EVERY APPLICATION

National LDO regulators give you a choice of single-output, dual-output, and three-output configurations.

© 1987 National Semiconductor Corporation

All with 60-volt load-dump and reverse-transient protection. And all with "drop-in" design ease, regardless of your applications:

Avionics Marine electronics Cellular telephones Computer power supplies Medical instrumentation Automotive systems Battery-powered systems CMOS-based systems Solar-powered systems And you can choose from a variety

of packages, including TO-220, TO-92, 8-pin miniDIP, and small outline (SO) surface mount. And soon, mil-spec TO-3 steel cans.

And, in addition to our LDO family, National has 478 other voltage regulators — positive and negative, fixed and adjustable, switching and tracking to match your exact design needs.

RELIABILITY FOR NO EXTRA COST

At National, we subject all our LDO regulators to the most rigorous reliability screening flow in the industry.

Our unique P+ Thermal Limit Burn-in program is an *abnormal* test for devices that have to perform in potentially abnormal conditions.

Going beyond even A+ screening, P+ involves a dynamic self-heating accelerated burn-in that tests a device at thermal shutdown. This approach has been proven more effective than standard 125°C burnin as an early screen for infant mortality defects in power devices, such as regulators. The result of P+? Zero defects.

The cost of P+? Zero price adder. Which means you get the highest reliability available in the industry, while sharply cutting the cost of your own incoming testing program, and without having to pay a price premium for ours.

For more information on P+, ask your National sales engineer or distributor for a free copy of "The Secret Behind the Most Reliable Voltage Regulators in the World." And see for yourself how this unique screening program gives you devices you can depend on — for the people depending on you.

Nation	al's Low Dropout Regulator Family
LM2925	Low dropout, 5 V, 750 mA with delayed reset
LM2930	Low dropout, 3-terminal, 5 V or 8 V, 150 mA
LM2931	Low dropout, low quiescent current, 5 V or adjustable, 100 mA
LM2935	Low dropout, dual 5 V for memory keep-alive, 750 mA or 10 mA
LM2940C	Low dropout, 5 V, 12 V, or 15 V, 1 A
LP2950/ 2951	Low dropout, micropower, 5 V or adjustable, 100 mA
LM2984	Low dropout, 3 tracking 5 V outputs with watchdog

National Semiconductor Linear Solutions P.O. Box 58090 Santa Clara, CA 95052-8090



One problem with having a cache in a system is the difficulty of determining the execution speed of an application.

implementations, but suffer in large caches because of their high chip count.

As you can see by looking at **Table 2**, the cache-tag RAMs from Integrated Device Technology, Saratoga, Texas Instruments, and Thomson/Mostek have a 4- or 8-bit tag width. The Saratoga SSL2152/4 has a 9-bit width. The Thomson/Mostek MK4202 is a 2048-index×20-bit device, and it can map a simple 2k-word cache into a 31-bit address.

The Fujitsu MB81C50 cache controller provides the flexibility of a cache-tag RAM, but also includes some of the control logic for implementing a complete cachememory system. The device contains the circuitry for a 2- or 4-way set-associative placement policy as well as the LRU algorithm.

Once you've evaluated the various approaches and determined your design needs, you can measure various important performance ratios. You can easily do this, at least to a first-order approximation, by using a



Fig 5—You can evaluate the real-world hit rate by connecting two counters to your system. The counters can determine the ratio of hits to total memory reads, the ratio of reads to writes, the ratio of no-wait-state writes to total memory writes, as well as other important ratios. An output port can control the counters so that you can isolate sections of your code that do not use your memory system efficiently.

COMPANY	DEVICE	PART	SIZE (INDEX/TAG)	SPEED	MATCH OUTPUT TYPE	PACKAGE	COST
FUJITSU	INTELLIGENT CACHE-TAG RAM	MB81C50	512 OR 1024/20 (4- OR 2-WAY SET-ASSOCIATIVE)	ADR TO HIT 35 nSEC DATA TO HIT 18 nSEC	TOTEM POLE	64-PIN PGA	\$35 (1000)
INTEGRATED DEVICE TECHNOLOGY INC	CACHE-TAG RAM	IDT7174S	8196/8	ADR TO HIT 37/45/55 nSEC DATA TO HIT 28/35/45 nSEC	OPEN DRAIN	28-PIN 600-MIL DIP 28-PIN 400-MIL DIP 32-PIN LCC/PLCC	\$51.75 (37 nSEC) (100)
SARATOGA SEMICONDUCTOR	TAGRAM	SSL4180	4096/4	ADR TO HIT 20/25/35 nSEC DATA TO HIT 12/15/20 nSEC	TOTEM POLE	22-PIN 300-MIL DIP	\$39.50 (20 nSEC) (1000)
	TAGRAM	SSL4181	4096/4	ADR TO HIT 20/25/35 nSEC DATA TO HIT 12/15/20 nSEC	OPEN DRAIN	22-PIN 300-MIL DIP	\$39.50 (20 nSEC) (1000)
	TAG-CACHE	SSL2152	2048/9	ADR TO HIT 25/30 nSEC DATA TO HIT 17/20 nSEC	TOTEM POLE	28-PIN 600-MIL DIP	\$41.50 (25 nSEC) (1000)
	TAG-CACHE	SSL2154	2048/9	ADR TO HIT 25/30 nSEC DATA TO HIT 17/20 nSEC	OPEN DRAIN	28-PIN 600-MIL DIP	\$41.50 (25 nSEC) (1000)
TEXAS INSTRUMENTS INC	CACHE ADDRESS COMPARATOR	TACT2150	512/8	ADR TO HIT 20/30 nSEC DATA TO HIT 15/20 nSEC	TOTEM POLE	24-PIN 300-MIL DIP	\$16.20 (20 nSEC) (10,000)
	CACHE ADDRESS COMPARATOR	TACT2152	2048/8	ADR TO HIT 25/35 nSEC DATA TO HIT 16/18 nSEC	TOTEM POLE	28-PIN 600-MIL DIP 28-PIN PLCC	\$23.60 (25 nSEC) (100)
	CACHE ADDRESS COMPARATOR	TACT2154	2048/8	ADR TO HIT 25/35 nSEC DATA TO HIT 16/18 nSEC	OPEN DRAIN	28-PIN 600-MIL DIP 28-PIN PLCC	\$23.60 (25 nSEC) (100)
THOMSON COMPONENTS/	TAGRAM	MK41H80	4096/4	ADR TO HIT 20/25/30 nSEC DATA TO HIT 12/15/20 nSEC	TOTEM POLE	22-PIN 300-MIL DIP	\$29.93 (20 nSEC) (100)
MOSTEK CORP	TAGRAM	MK48H74	8196/8	ADR TO HIT 35/45/55 nSEC	TOTEM POLE	28-PIN 600-MIL DIP	\$25.64 (35 nSEC) (100)
	TAGRAM	MK4202	2048/20	ADR TO HIT 20/25 nSEC	TOTEM POLE	68-PIN PLCC	\$71.43 (20 nSEC) (100)

EDN December 10, 1987

One PC data acquisition system grows up: PCI-20000.







Special function modules: trigger/ alarm, simultaneous sample/hold.

Expandable digital I/O module (to 128 points per carrier).

> DMA carrier board with clock and digital I/O transfers data at 360 kBytes/sec. Holds 3 modules.





Counter/timer, clock, pulse generator & frequency measurement module.

Analog output modules: 2 or 8 channel, 12 or 16 bits, V_0 or I_0 .



Expandable analog input module (to 80 channels per carrier).

The others just grow old.

Some personal computer data I/O systems make you pay for functions you don't need. These same inflexible systems can't be updated—at any price.

The unique PCI-20000 modular system, on the other hand, is easily configured to provide literally thousands of data acquisition, test, measurement and/or control options. Just plug the application-specific modules you need into a carrier board. Then plug the carrier into your IBM/compatible PC. Change or add modules as your needs change. In other words, the PCI-20000 grows up, not old!

Up to 128 digital I/O points or 80 analog inputs can be configured on a single carrier board. A unique DMA carrier/module combination transfers analog, digital and/or counter data at

Circle 78 for General Information

speeds limited only by your computer. Capture, analyze and react to real-world events in real-time. Plus, ruggedly constructed termination panels provide long-lasting screw-in connections to analog and digital I/O signals.

No programming experience needed. Many easy to use, menu driven software packages support the entire PCI-20000 family. Multiple language software drivers are also available. Best of all, years from now when other systems are collecting cobwebs, your PCI-20000 will still be collecting data.



	Page 1	Senal Con		1
	E C.		hut	2
	A CO			
		In LU		
		No. of Concession, Name		
1	-	And in the second	a state	
	i		100	
	1			

Free 300 Page PC Data Acquisition Handbook. For fast service, call 602/746-1111, or return the coupon to Burr-Brown PCI Handbook, P.O. Box 11400, Tucson, AZ 85734.

Name	
Title	
Company	analain duratit
Address	entre entre situe
City/State/Zip	en ette Dorge Heilig og
Phone ()	TO THE PART OF THE POPULATION

Circle 117 for OEM/VAR Program

In the future, you can expect to see large, high-speed cache systems on single chips, tightly coupled to the CPU and to the system bus for bus watching.

For more information . . .

For more information on the cache-memory controllers and cache-tag RAMs discussed in this article, contact the following manufacturers directly or circle the appropriate numbers on the Information Retrieval Service card.

Austek Microsystems Inc 444 Castro St, Suite 1020 Mountain View, CA 94041 (415) 960-1315 FAX (415) 960-0799 Circle No 458

Chips and Technologies Inc 3050 Zanker Rd San Jose, CA 95134 (408) 434-0600 Circle No 459

Fujitsu 3320 Scott Blvd Santa Clara, CA 95054 In CA, (800) 556-1234 Outside CA, (800) 441-2345 Circle No 460 Integrated Device Technology Inc 3236 Scott Blvd Santa Clara, CA 95054 (408) 727-6116 TLX 887766 Circle No 461

Intel Corp 3065 Bowers Ave Santa Clara, CA 95051 (800) 548-4725 Circle No 462

NEC Electronics Inc 401 Ellis St Mountain View, CA 94039 (415) 960-6000 TWX 910-379-6985 Circle No 463 Saratoga Semiconductor 10500 Ridgeview Ct Cupertino, CA 95014 (408) 864-0500 Circle No 464

Texas Instruments Inc Semiconductor Group (SC-725) Box 809066 Dallas, TX 75380 (800) 232-3200 Circle No 465

Thomson Components/Mostek Corp 1310 Electronics Dr Carrollton, TX 75006 (214) 466-6000 TLX 463-0093 Circle No 466

couple of counters. Put one counter on the read line of the μ P and the other on the hit output of the cache controller (**Fig 5**). Run your application software and look at the counters after an appropriate period of time. You may have to put a divide-by-10 or -1000 circuit in front of the counters so that they won't overflow, but this extra circuitry won't have any effect because all you need is the counters' ratio.

You can also determine the ratio of reads to writes and the ratio of writes without wait states to writes with wait states. With a small amount of software overhead, you can even enable the counters in certain sections of your code by controlling a bit on an output port to isolate where a low hit rate occurs.

You should be aware, however, that in the real-time control world it's difficult to determine the response time of the system. When using worst-case analysis, you have to assume that all memory accesses will be misses, and thus you have to assume that the cache doesn't even exist. In such applications, therefore, you may decide against using a cache at all.

Although cache-memory controllers provide subsystem-on-a-chip solutions, they don't have many options to offer—most are cast in silicon. Their advantage lies in the fact that you can capitalize on the knowledge and insight of the chip designers when you design your system, thereby avoiding a lot of reinvention of the wheel. The NEC μ PD43608, for instance, is a complete cache subsystem, including the data RAM.

In the future, you can expect to see large, high-speed cache systems on single chips, tightly coupled to the CPU and to the system bus for bus watching. The devices available are already quite complex: The Austek part has 128,000 transistors; the NEC chip has 680,000 transistors. With the speed of CMOS RAMs getting close to 10 nsec and the promise of BiCMOS around the corner, it should be easy for cache memories to keep up with the ever-increasing speeds of μ Ps. EDN

References

1. Smith, Alan, "Cache Memories," Computing Surveys, Vol 14, No 3, September, 1982, pg 473.

2. Nalesnik, Robert, "Cache accelerates operation of 32bit μ P systems," *EDN*, May 28, 1987, pg 183.

> Article Interest Quotient (Circle One) High 479 Medium 480 Low 481
| • | R | IF | A | М | IC | R | 0 | E | L | E | С | т | R | 0 | N | 1 | C s | 5 | D | 1 | V I | S | I | 0 | N | |
|----------|---|-----------------|------------------------------|--------------------|------------------------------|---------------------|---------------------|--------|---|---|---|---|---|---|---|---|-----|---|---|---|-----|---|---|-----|---|---|
| ш | | | | | | | | | | | | | | | | | | | | | | | | | | Π |
| R | | | | | | | | | | | | | | | | | | | | | | | | | | - |
| 4 | | | | | | | | | | | | | | | | | | | | | | | | | | G |
| υ | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | Ш |
| 0 | | | | | | | | | | | | | | | | | | | | | | | | | | Z |
| F | | | | | | | | | | | | | | | | | | | | | | | | | | 0 |
| | | | | | | | | | | | | | | | | | | | | | | | | | | |
| I | | | | | | | | | | | | | | | | | | | | | | | | | | G |
| U | | | | | | | | | | | | | | | | | | | | | | | | | | I |
| | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0 | | | | | | | | | | | | | | | | | | | | | | | | | | T |
| Z | | | | | | | | | | | | | | | | | | | | | | | | | | 0 |
| Ш | | | | | | | | | | | | | | | | | | | | | | | | | | 0 |
| _ | | Dri
you | ver circu
1 for cho | uits tha
bice. | it spoil | | | | | | | | | | | | | | | | | | | | | 0 |
| _ | | Inte | elligence
e chip. L | e and p
oad far | oower o | on | | | | | | | | | | | | | | | | | | | | J |
| A | | ind | ication a | as well | , with | | | | | | | | | | | | | | | | | | | | | ш |
| Σ | | SOU | rce capa | ability. | | | | | | | | | | | | | | | | | | | | | | |
| S | | con | if pick o
iductive | loads | up to 2 | A. | | | | | | | | | | | | | | | | | | | | |
| | | PBI
– th | 0 3545 an
ne driver | nd 354
rs toug | 8
h | | | | | | | | | | | | | | | | | | | | | S |
| | | enc
in 1 | ough for
nind. | what | you ha | ve | | | | | | | | | | | | | | | | | | | | Z |
| Ш | | • 1 | ouilt-in p | protect | ion | | | | | | | | | | | | | | | | | | | | | Þ |
| <u>п</u> | | • 5 | hort cire | cuit pr | otection | n/ | | | | | | | | | | | | | | | | | | | | |
| 0 | | • • | letection | ı
cuit de | tection | | | | | | | | | | | | | | | | | | | | | |
| 0 | | • 1 | S-TTL, C
compatil | MOS
ble inp | uts | | | | | | | | | | | | | | | | | | | | | т |
| 0 | | • 5 | -45 V oj | peratin | ng | | | | | | | | | | | | | | | | | | | | | z |
| - | | • 1 | O 220, 5 | 5-pin p | ackage | | | | | | | | | / | | | | | | | | | | | | 0 |
| | | from | m | | | | | | | | | / | | | | | | | | | | | | | | C |
| I | | | 2 | 7 | A | | | | | | / | | | | | | - | | | | | | | | | G |
| U | | RIFA I
CT 06 | NC, GREENWI
836, 3110 USA | CH OFFICE | PARK 3, P.0
625 73 00, TE | D. BOX 3
LEFAX 2 | 110, GRE
03-6257 | ENWICH | | | | | | | | | | | | | | | | | | I |
| | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0 | | | | | | | | | | | | | | | | | | | | | | | | | | - |
| Z | | | | | | | | | | | | | | | | | | | | | | | | | | 0 |
| ш | | | | | | | | | | | | | | | | | | | | | | | | | | 0 |
| | | | | | | | | | | | | | | | | | | | | | | | | | | Þ |
| 0 | | | | | | | | | | | | | | | | | | | | | | | | | | J |
| ш | | | | | | | | | | | | | | | | | | | | | | | | | | т |
| | N | 0 1 | C 1 | ٨ | | - | | | | - | | | _ | - | - | - | | | ~ | | | | | | | |
| | N | 01 | 51 | Λ | U U | 5 | | , , | N | 0 | B | 4 | 5 | E | 1 | E | 0 | B | 5 | | J | A | E | ר א | | |

Contraction of the

100 V/µs GUARANTEED

PMI's OP-44 also guarantees a 15 MHz GBW and full power BW of 1.5 MHz. And no compromises on accuracy. . .

C)P-44	HA-2	520
VOS	1.0	8	mV max
TCVOS	4	20	μV/°C typ
A _{VOL}	200	10	V/mV min
IB	0.2	200	nA max
CMR	86	80	dB min

The OP-44 is available now . . . in 883 too. Get the high-speed facts from our 12page OP-44 data sheet. Circle the reader service number or call 1-800-843-1515.

Precision Monolithics Inc. A Bourns Company Santa Clara, California USA 408-727-9222





ORANGE COUNTY: (714) 637-6902. LOS ANGELES: (818) 886-6881, MILPITAS: (408) 942-8060. DALLAS: (214) 341-1742. CHICAGO: (312) 250-0808, ATLANTA: (404) 263-7995. PHILADELPHIA: (215) 675-7600, BOSTON: (617) 794-0026

Chip set provides physical-layer interface to fiber-optic data links

The SP9960 encoder/LED-driver. SL9901 transimpedance amplifier, and SP9921 decoder provide most of the interface hardware required to implement a 50M-bps Manchesterencoded fiber-optic communications link. The SP9960 encoder/LEDdriver accepts either TTL- or ECLlevel clock and data signals and encodes them by using Manchester biphase-mark coding. It has an output that can directly drive the fiber's transmission-end LED, and you can program the LED drive current to 15, 25, 45, 80, 115, or 150 mA by using dedicated IC inputs.

The SL9901 transimpedance amplifier accepts the output of the fiber's receiving-end PIN-diode detector and converts it to a voltage drive for the decoder IC. The amplifier has a 3-dB bandwidth of 50 MHz, so it is suitable for use in systems having NRZ data rates reaching 100M bps.



The SP9921 decoder can operate at a data rate of between 20M and 50M bps, recovering both clock and data signals from the received signal. It incorporates two phase-lockloop circuits in a Costas-loop circuit, which gives the recovered clock signal a high degree of immunity to input signal noise. In addition, the decoder can detect idle-code patterns that violate normal Manchester codes; it can operate in links that utilize burst-data modes. The decoder has ECL-level outputs.

All three devices are available in die form or in surface-mount packages. The encoder and decoder ICs are also available in DIPs. The chip set requires a single 5V supply and operates over -40 to $+85^{\circ}$ C. In surface-mount packages, the SP9960, SL9901, and SP9921 sell for £11.74 (\$21.04), £4.66 (\$7.78), and £23.17 (\$38.69) (1000), respectively. Delivery, 60 days ARO.

Plessey Semiconductors Ltd, Cheney Manor, Swindon, Wiltshire SN2 2QW, UK. Phone (0793) 36251. TLX 449637.

Circle No 583 Plessey Semiconductors, 9 Parker, Irvine, CA 92718. Phone (714) 472-0303.

Circle No 584

Gallium arsenide comparator features a data rate of dc to 2G bps

The HMD-11685-2 is a gallium arsenide (GaAs) ultra-high-speed comparator for use as a line driver, line receiver, system clock-driver, pulse driver, or buffer amplifier. All its inputs and outputs are both GaAs and ECL compatible. With an input-to-output propagation delay of 500 psec, the chip's processing speed is typically four times faster than ECL products of equivalent function.

The comparator's output capability is adequate for driving a fan-out of 3 into a 50Ω terminated transmission line. The HMD-11685-2 also



provides a latch function that lets you use the part in sample/hold mode. The comparator functions normally when the latch-enable input is held high. At the time of the latch input transition, when the latch enable is driven low, the outputs are locked into their existing logical status.

The device features a Ti/Pt/Au metalization system and operates over -55 to 85 °C. Packaged in a 16-pin hermetic flat pack, the HMD-1165-2 costs \$155 (100).

Harris Microwave Semiconductor, 1530 McCarthy Blvd, Milpitas, CA 95035. Phone (408) 433-2222.

Circle No 590

Analog I/O port includes an 8-bit ADC, an 8-bit DAC, and a T/H amplifier

The AD7569 is a monolithic, analog I/O port that combines an 8-bit A/D converter, an 8-bit D/A converter, a track-and-hold (T/H) amplifier, a buffer amplifier, and a voltage reference. The ADC's maximum conversion time (to 0.5 LSB) is 2 μ sec; the DAC is buffered by the on-chip amplifier and settles to 0.5 LSB in 1 μ sec max. The AD7569 can replace as many as five separate ICs.

The manufacturing process combines low-power CMOS devices and high-speed, high-accuracy bipolar transistors on a single chip. The IC uses CMOS transistors for the converters' switches, the T/H amplifier, and the chip's logic interface. Bipolar devices are used to build the high-speed JFET-input buffer amplifier, comparator, bandgap reference, and DAC current sources.



Because all the necessary conversion circuitry is on the chip, the AD7569 simplifies logic timing; a single command generates a hold signal for the T/H amplifier, delays an A/D conversion until the T/H amplifier has acquired the signal, and initiates the conversion. The fast logic interface, compatible with high-speed μ Ps and DSPs, is a result of the 75-nsec bus-access time and the <80-nsec write-pulse width.

The AD7569 consumes <60 mW and is suitable for battery operation. The part comes in six grades for use over three temperature ranges. Package options include a 24-pin plastic DIP, a 24-pin ceramic DIP, a 28-pin LCC, and a 28-pin PLCC. The commercial version in a plastic DIP costs \$6, the industrial version in a ceramic DIP is \$9, and the military part in a ceramic DIP is \$27 (100).

Analog Devices, Box 9106, Norwood, MA 02062. Phone (617) 320-4700. TLX 174506.

Circle No 586

CMOS erasable programmable logic device features 25-nsec propagation delay

According to the manufacturer, the 5AC312 is the first CMOS erasable programmable logic device (EPLD) to combine a total propagation delay of 25 nsec with previously unavailable architectural features in a 24-pin package. Based on the company's advanced CHMOS technology, the 5AC312 accommodates logic functions—such as decoding, wait-state generation, data latching, and bus arbitration—in critical timing paths of high-performance applications, such as 80286- and 80386-based systems. Under typical high-speed operating conditions, the device draws <50 mA of current, which is reportedly 45% less than other techniques require.



To accommodate the latching or holding of incoming data, the 5AC312 offers a flexible input structure that you can configure in one of five different ways. The 5AC312 also features a user-controllable product-term (P-term) allocation scheme that reallocates unused logic resources to functions with high P-term demand.

The 5AC312 is supported by the vendor's Programmable Logic Development System II (IPLDS II) version 1.5, which contains the software and hardware necessary to turn EPLD design concepts into working silicon on an IBM PC/XT, PC/AT, or fully-compatible system. The 5AC312, in a 24-pin ceramic DIP sells for \$22.50 (100). IPLDS II V1.5 costs \$3450.

Intel Corp, Dept W-388, Box 58065, Santa Clara, CA 95052. Phone (916) 351-2747.

Circle No 587

Happy days are here again.

New production capabilities make the most advanced EEPROM MCU available to everyone.

We're celebrating and you're the guest of honor our new increases in production capacity mean we can deliver enough HCMOS 68HC11s for everyone: giants and start-ups alike.

More of a good thing.

Motorola's MC68HC11 microcontroller with EEPROM has long been the most advanced single-chip MCU in the industry. Its advanced features created such an immediate success that we were unable to meet the enormous demands. To those who had to wait, we apologize; the backlogs are unjammed and a steady supply of 'HC11s is now available to everyone. Increased production schedules and technology advances have improved our output, assuring that a constant inventory will be on hand to meet both your immediate and future needs.

The MC68HC11 was the first HCMOS microcomputer with on-chip EEPROM and it's still the best. Besides 512 bytes of EEPROM, the 'HC11 features 256 bytes

of RAM, 8 bytes of mask ROM, two serial ports, an enhanced timer subsystem, an 8-channel A/D converter, a pulse accumulator, and a COP watchdog system. But best of all, it's now available for delivery in quantity.

Additional design support is available with our HDS300 Evaluation Module and our 68HC11EVB Evaluation board which makes designing and debugging your system a breeze.

One-on-one design-in help.

Get an engineer-to-engineer update on designing-in Motorola's MC68HC11 microprocessor. Call toll free any weekday, 8:00 a.m. to 4:30 p.m., M.S.T. If the call can't answer your question we'll



have a local applications engineer contact you. For published data on the HC11 return the completed coupon below to Motorola.

FILIT

We're on your tesign-in team.



SATA NOL AND NEU ALALES	To: Motorola Semiconductor Products, Inc. P.O. Box 20912, Phoenix, AZ 85036 Please send me more information on the MC68 evaluation products. Name	BHC11 and its 346EDN121087
	Title	na aida miduar
·	Company	
	Address	
Bistington Biston	City State	Zip
D of Barrow Au	Call me ()	otherall spece

SCSI protocol IC employs dual data bus, performs 20M-byte/sec host transfers

The AIC-6250 CMOS IC supports asynchronous and synchronous data transfers across the SCSI bus. The chip includes a dual data-bus interface on the host side, and the host interface supports data transfers as fast as 20M bytes/sec. Single-ended bus transceivers are included on chip, but you can also interface directly with external differential transceivers to the on-chip logic.

The AIC-6250 includes state machines for performing the SCSI protocol, and it automatically performs such functions as arbitration, selection, and preselection. The IC fits both target and initiator applications. As a target, the IC automatically generates a response to selection or reselection.

The chip's architecture serves to



offload the host's bus. The chip uses a 16-bit bus to handle 8- or 16-bit data transfers in DMA or programmed I/O modes. A separate 8-bit data port allows the controlling μ P to access the control registers at all times, even during DMA transfers.

On the SCSI-bus side, the IC performs 3M-byte/sec asynchronous transfers and can achieve 5M-byte/ sec synchronous transfers. An 8-byte FIFO buffer links the SCSI bus and the host-bus interface. The chip can burst data into or out of the buffer at 20M bytes/sec.

The chip also features automatic parity generation and checking, and it has two general-purpose I/O ports. In differential applications, the I/O ports control the differential transceivers. You can interface the SCSI chip to a μ P without using glue logic, even if the μ P uses a multiplexed data/address bus. The IC costs \$20 (1000) and comes in a 68-pin plastic leaded chip carrier.

Adaptec Inc, 580 Cottonwood Dr, Milpitas, CA 95035. Phone (408) 432-8600.

Circle No 578

Programmable video RAM controller can drive arrays as large as 64M bytes

Part of an advanced graphics chip set, the DP8522 video RAM controller/driver can directly address and drive an array of 4M-bit video RAMs as large as 64M bytes in size. The company's chip-set architecture permits resolutions as high as 16k×16k pixels and a virtually unlimited number of color planes under the control of a single rastergraphics processor. By employing a separate video RAM or dynamic RAM controller, the advanced graphics chip set lets you decide which type of memory component best fits your system's cost and performance goals.

The fully programmable DP8522 works with a variety of computer systems. Its adjustable control-sig-



nal pulse widths let you use microprocessors operating at frequencies to 20 MHz. The device supports video RAMs that provide simultaneous read/write functions through a dual-port configuration. The DP8522 also supports dual accessing, provided that a second graphics controller, CPU, DMA, or LAN controller has access to the same memory bank.

The DP8522 supports memory interleaving, and the chip's programmable wait-state logic helps to improve the overall performance of this CMOS device. All major aspects of video-RAM interface, control, and drive functions are fully integrated in the DP8522. Features such as on-chip address latches, bank-select logic, dual-porting, a refresh counter, and a high-speed row/ column/refresh multiplexer are built in. The DP8522 comes in an 84-pin plastic chip carrier and costs \$28 (1000).

National Semiconductor Corp, Box 58090, Santa Clara, CA 95052. Phone (408) 721-5404. TLX 346353. Circle No 581



A compact 1553 that carries a busload.

The UT1553B BCRT data bus system proves that big things do come in small packages. It's loaded with features including both MIL-STD-1553B Bus Controller and Remote Terminal functions and advanced, specialized memory management all on one low-power CMOS chip.

It's the next generation product in our 1553 family. The BCRT was designed to reduce host intervention with automatic DMA and address generation. It automatically executes message transfers, provides interrupts, and generates status information. UTMC's BCRT allows you to implement a pseudo-transparent dual-port RAM configuration. The BCRT's bus controller uses a linked-list message scheme to provide the host with message "chaining." Memory space is optimized by using programmable address pointers. As an RT, the BCRT implements time tagging and message history functions. It also supports multiplemessage buffering—up to 128 including variable-length messages to any subaddress.

The BCRT complies with the standard LAN used for military systems while meeting selected tests in MIL-STD-883C. It is available in 84-pin LCCs, PGAs, or Cerquads.

Don't miss the bus on your 1553 system needs. Call UTMC. Product Marketing United Technologies Microelectronics Center 1575 Garden of the Gods Road Colorado Springs, Colorado 80907 1-800-MIL-UTMC



High-resolution conversion



in the blink of an eye.

Get video speed, low power consumption, high resolution and superior price/performance with our new CMOS data converters.



We've expanded our line to include more CMOS flash ADC's, a charge balancing ADC, an SPI ADC and a DAC. All featuring single 5V supply operation.

We also offer a new high-speed op amp especially wellsuited to driving ADC's or video cables.

4, 6 and 8-bit CMOS flash ADC's.

Choose from 4, 6 and 8-bit ADC's. All operate at video speeds, with clocking speed and input bandwidth specified at 5V. What makes these flash ADC's special is silicon-onsapphire construction, resulting in low cost, high speed, very low input capacitance, low power consumption and inherent latch-up resistance.

10-bit CMOS charge balancing ADC.

This 10-bit successive approximation ADC captures fast moving signals, providing excellent resolution.

It features a built-in fast track and hold, with conversion rates of 150 KHz and an input bandwidth of 1.5 MHz. Even at the maximum rate, power consumption is less than 20 mW.

10-bit CMOS serial ADC.

The CDP68HC68A2 is selectable for either 8- or 10-bit resolution and has an 8-channel multiplexer allowing up to 8 channels of inputs. The device can be used directly with our CDP68HC05C4, C8 or D2 microprocessors or other similar SPI (Serial Peripheral Interface) buses.

8-bit CMOS R-2R video-speed DAC's.

These CMOS/SOS digital-to-analog converters operate



from a single 5V supply at video speeds and can produce "railto-rail" output swings. Typical update rate is 50 MHz. Settling is fast (20 ns typical) to 1/2 LSB. "Glitch" energy is minimized by segmenting and bar graph decoding of upper 3 bits.

High-speed op amp.

Specially designed for use with data converters, the CA3450 op amp has excellent speed and transmission line driving capabilities.

For 10-bit accuracy, it settles to within 1/2 LSB in 40 ns with a 2V input signal. And it can drive up to four 50 ohm transmission lines.

ADC's	Res. Bits	Conv. Rate Hz	Power Diss. (MW)	Pkg. Leads	1K Price
CA3304E	4	20M	30	16	2.95
CA3304AE	4	25M	35	16	4.50
CA3306CE	6	10M	65	18	5.50
CA3306E/3306AE	6	15M	70	18	6.25/11.25
CA3318E/3318CE	8	15M	150	24	38.50/24.00
CA3310E/3310AE	10	150K	15	24	6.00/8.00
CDP68HC68A2E	10	10K	15	16	3.75
DAC's		Sector Stars	S. Complete March 199		
CA3338E/3338AE	8	50M	100	16	6.00/8.40
OP AMP	UGBW Hz	Slew Rate (X10)	Iout MA	Pkg Leads	1K Price
CA3450E	200M	300V/µSec	±75	16	2.70

Data in a flash.

For data sheets of these new products, call toll-free 800-443-7364, extension 19. Or contact your local GE Solid State sales office or distributor.

In Europe, call: Brussels, (2) 246-21-11; Paris, (1) 39-46-57-99; London, 0276-685911; Milano, (2) 82-291; Munich, (89) 63813-0.



GE Solid State

GE/RCA/Intersil Semiconductors These three leading brands are now one leading-edge company. Together, we have the resources – and the commitment – to help you conquer new worlds.

The One Week Analog ASIC.



The leading technology . . . the best support . . . go!

The leading analog ASIC family: RLA80, RLA120, and RLA160 userconfigurable macrocell arrays. Onchip thin film SiCr resistors and duallayer metal for ease of interconnect routing and maximum array utilization and performance. Wide supply voltage range $-\pm 1V$ to $\pm 16V$. And simplified design procedures that take days, not weeks.

□ Configurable macrocells: 8, 12, or 15 gain blocks in any combination as general purpose op amps, open collector output comparators, or as input amplifiers with ground sensing function for single-supply systems. RLA160 has a preconfigured onboard adjustable ±30 ppm voltage reference. **□** Thin-film resistors: on-chip SiCr resistors exhibit 1% matching and temperature drift characteristics comparable to discrete film resistors. High performance and high values (1.25 kΩ to 150 kΩ) handle a wide variety of applications.

□ Design support: The RLA Breadboarding Kit contains complete design and applications documentation, 200x plots, a pre-drilled printed circuit board, and 23 ICs. Friendly RLAModel software includes menudriven user interface program for PSPICE¹, SPICE² model library for RLA series, documentation files, and full screen editor. Not to mention the attention you get from applications engineers who have 15 years experience meeting custom and semi-custom requirements.

Call Raytheon for access to RLA program information and details on the RLA Macrocell Array Breadboarding Kit. We promise you a week that will go down in history.

Raytheon Company Semiconductor Division 350 Ellis Street Mountain View, CA 94039-7016 (415) 966-7716

¹PSPICE is a trademark of MicroSim Corporation. ²SPICE developed by University of California.

Access to the right technology



Fast CMOS multiplier-chip family offers high speed for DSP applications

This family of four multiplier chips derives its speed from an optimized architecture implemented in a 1.8-µm CMOS process. Three of the devices (the 8-bit, 12-bit, and 16-bit parts) are straight multipliers that can compute a product in as little as 35 nsec. The fourth device is a 12-bit multiplier that has a built-in accumulator and can compute a product and add it to the accumulator in 45 nsec.

The 16-bit LMU18 multiplies two 16-bit inputs and then delivers the full 32-bit product in 35 nsec. Much of the LMU18's speed advantage (twice that of its nearest competitor, according to the manufacturer) comes from its ability to produce the entire 32-bit product at once. Other multipliers can produce only 16 bits



at a time, so they require a 2-step process.

The 12-bit LMU12 multiplies two 12-bit inputs and produces a 24-bit product in 35 nsec. It is pin and function compatible with TRW's MPY-12HJ. The 8-bit LMU08 can multiply two 8-bit inputs to produce a 16-bit product in 35 nsec. You can choose a 16-bit output that's read in parallel or an output that's multiplexed to a single 8-bit bus for more compact designs. You can also load the inputs in parallel, or individually from an 8-bit bus.

The LMA1009 multiplier-accumulator (MAC) chip has a built-in accumulator, which lets you build algorithms that require the successive addition of products. The device multiplies the values loaded into its two 12-bit inputs, adds the resultant product to the accumulator, and produces the result in 45 nsec. The LMU18 (in a PLCC package) costs \$30.53. In DIPs, the LMU12 is \$22.29, the LMU08 costs \$17.06, and the LMA1009 (DIP) sells for \$26.95 (100).

Logic Devices Inc, 628 E Evelyn Ave, Sunnyvale, CA 94086. Phone (408) 720-8630.

Circle No 582

Flat-panel display driver scans LCDs at multiplex rates as high as 1:256

Providing an interface between industry-standard flat-panel display controllers and liquid-crystal displays, the PCF2201 LCD driver can control as many as 81 row lines or 80 column lines of a dot-matrix LCD. As a result, you need only 21 of the drivers to scan a 640×400 -pixel display. The PCF2201 can drive twisted-nematic LCDs and super-twisted birefringence-effect LCDs at multiplex rates as high as 1:256.

To operate the device as a row driver, you serially clock row-select data through an internal 81-stage shift register. The maximum clock rate for the shift register, and hence the maximum row-scan rate for the display, is 100 kHz.

When the IC operates in column-

driver mode, the shift register functions as a set of static latches that holds parallel output data for 80 of the display's column lines. A data buffer, provided by 80 more data latches, allows you to assemble more column information while the driver sends the current column information to the LCD. You can enter data in the data buffer either serially or in 4-bit nibbles.

The PCF2201 provides internal level shifters that shift the logiclevel row/column data contained in the shift register to the voltage levels required by the LCD. The driver can handle drive voltages as high as 25V, and the level shifters require four bias voltages between 5V and -25V. The display driver draws a typical operating current of 0.4 mA and a standby current of 15 μ A, and it provides on-chip overtemperature protection. All its data and control inputs are 5V CMOS compatible. The driver is supplied on reels in a tape-automated-bonding package with 120 leadouts. It costs around Swiss Fr 8 (10,000).

Philips, Elcoma Div, Box 523, 5600 AM Eindhoven, The Netherlands. Phone (040) 757005. TLX 51573.

Circle No 579 Signetics Corp, 811 E Arques Ave, Sunnyvale, CA 94088. Phone (408) 991-4571.

Circle No 580

16-bit, sampling A/D converters digitize high-frequency signals

The MN6290 (10V input span) and MN6291 (20V input span) are highspeed, 16-bit, sampling A/D converters designed for digital-signalprocessing (DSP) applications. The devices feature internal, user-transparent, track-and-hold (T/H) amplifiers that let these ADCs accurately sample and digitize dynamically changing input signals at sampling rates to 20 kHz. When sampling and digitizing at 20 kHz, both devices maintain an 84-dB min S/N ratio and a minimum of 88 dB of harmonicdistortion attenuation.

The T/H amplifier is necessary because of the device's successiveapproximation (SA) technique. By



itself, the SA type of ADC is inherently incapable of accurately converting rapidly changing analog input signals. The T/H amplifier overcomes this shortcoming by holding the signal constant whenever the ADC performs a conversion. A high-impedance input buffer isolates the T/H amplifier from its signal source, and the T/H amplifier's operational mode is internally controlled by the ADC's status line.

The vendor tests each device both statically and dynamically with a series of 512-point FFTs on the stored digital output data. The devices come in 32-pin, double-width DIPs and are available in commercial, industrial, and military temperature grades. Pricing varies from \$180 to \$270 (100), depending on the bit-accuracy specification and the temperature range.

Micro Networks, 324 Clark St, Worcester, MA 01606. Phone (617) 852-4000.

Circle No 589

CMOS DSP IC offers 80-nsec cycle time; operates on IEEE floating-point numbers

The Model WE DSP32C CMOS floating-point digital signal processor (DSP) features cycle times as low as 80 nsec. The processor is compatible with the IEEE standard floating-point format. Three 512×32 -bit banks of RAM on the IC ensure fast access to memory.

The chip includes 15 general-purpose registers, five increment registers, two external interrupts, eight vectored interrupts, and a 16M-byte address space. You can program the DSP chip for 8-, 16-, or 32-bit accesses to external memory. The chip automatically inserts as many as three wait states when used with slow main memory. On-chip I/O resources consist of a 16-bit parallel port and a serial port capable of operating as fast as 22.5M bps.

The DSP32C can fetch two 32-bit

numbers from memory, multiply and accumulate the result, and write it to memory in one 80-nsec instruction cycle. Because the DSP32C is source- and object-code compatible with its predecessor, the NMOS WE DSP32, you have direct access to a large library of applications code.

The DSP32C internally uses a 24-bit mantissa and 8-bit exponent floating-point format. For access to IEEE databases, it includes logic that converts between the IEEE floating-point format and the IC's internal format in a single cycle. To support access to external data, the DSP32C interfaces to codecs, other DSP32s and DSP32Cs, and time-division-multiplexed lines without requiring glue logic. The on-chip serial port is double buffered, and

an on-chip DMA controller supports simultaneous DMA transfers between the serial port and the parallel port without program intervention.

A full complement of development tools—including a C-like assembler, a link editor, a simulator/debugger, and a C compiler—support software development for the DSP IC. The software-development package executes on systems running MS-DOS and costs \$995. Samples are available now, and production quantities will be shipped in the first quarter of 1988. The \$70 (10,000) device will be packaged in a 133-pin PGA.

AT&T Technology Systems, 555 Union Blvd, Allentown, PA 18103. Phone (800) 372-2447.

Circle No 577

SEEQ EEPROMS IN THE FACTORY.

Bubble memories as a technology seem to be bursting all over the place.

Which is one sound reason why if you use bubbles for non-volatile memory — you may want to replace them with high-density EEPROMs from SEEQ. Because let's face it, bubbles just don't stack up against SEEQ E²s.

Compare speed, for example. Since bubble memories access data serially — like tape drives — they're slower than molasses in January. A typical bubble read cycle will get you about 17-18.5K bytes per second. In that same time, a SEEQ E² gives you 5 Megabytes. Write times for E²s are also faster by an order of magnitude.

SEEQ E²s not only work faster, they work harder in harsh environments. They operate over extended and full military temperature ranges, with greater inherent reliability than any electromagnetic bubble. Or any other E².

SEEQ E²s aren't a lot of toil and trouble for designers, either. For one thing, with all their coils and support circuits, bubbles can be real current hogs.

But not E^2 s. A 256K part from SEEQ draws just 60 mA in active mode, 150 μ A in standby. And by including many peripheral functions on board, SEEQ E^2 s make it easy to build hardware and software interfaces to popular microprocessors. Plus E^2 s fit comfortably on most system boards, using surface mount packages.

At SEEQ, we can help you with virtually any non-volatile memory application — from high-density E²s to micro-computers with E² on board. For information on bubble memory replacement, call us today for our Application Note #24. SEEQ Technology, Inc., 1849 Fortune Drive, San Jose, CA 95131. (408) 432-9550.



CIRCLE NO 80

Get The Bubbles Out of Your Product Once And For All.

Bipolar/CMOS bus-interface devices cut total system power consumption

Six bus-interface devices fabricated in a new digital bipolar/CMOS technology are the first members of the SN74BCT product family. The devices are 10-bit bus drivers, 10-bit memory drivers, and 10/9-bit transceivers, all with 3-state outputs. The SN74BCT2827 and -2828 are designed specifically for driving the capacitive inputs of MOS memories; each chip's outputs have 25Ω damping resistors, which eliminate the need for external components. The outputs of the -2827 and -2828 provide true data and inverted data, respectively.

The -29827 and -29828 are buffers and bus drivers for high-performance bus interface with wide data paths or buses that carry parity.



The devices are functionally equivalent to the AM29827 and AM29828. The -29861 and -29863 are 10- and 9-bit bus transceivers, respectively; they are functionally equivalent to the AM29861 and AM29863.

Characterized for operation over 0 to 70°C, the devices are available now in 24-pin DIPs. The company plans to offer plastic leaded chip carriers and SOIC packages for surface mounting. In DIPs, the -29827, -29828, -29861, and -29863 cost \$3.46 (1000) each. The -2827 and -2828 are \$3.60 (1000). The vendor plans to offer versions for the military temperature range; they'll be available in ceramic DIPs and leadless ceramic chip carriers.

Texas Instruments, Semiconductor Group, Box 809066, Dallas, TX 75380. Phone (800) 232-3200 ext 700.

Circle No 588

Single-chip microcontroller offers analog and digital I/O facilities

Targeting automotive applications, the 80C51-based PCB83C552 singlechip CMOS microcontroller is also suitable for medical, instrumentation, and industrial-control equipment. The chip's functional enhancements include an 8-channel, 10-bit A/D converter; two PWM outputs; additional parallel I/O ports; an additional timer/counter; and an I²C-bus interface.

The microcontroller has six 8-bit parallel I/O ports. Ports P0, P1, P2, and P3 are identical in function to those on the 80C51. Port P1's I/O lines also provide control inputs for the chip's additional counter/timer and for its serial clock and data lines.

The parallel I/O capabilities of port P4 allows you to couple it to one

of the on-chip timer/counters. When the timer/counter reaches predetermined points, six of P4's outputs are set or reset, and two of its outputs are toggled. Port P5 operates only as an input port, but you can use it either as an 8-bit digital port or as an 8-channel analog port for the A/D converter's input multiplexer.

The two PWM outputs, driven by push-pull drivers, have dedicated output pins. An 8-bit control register allows you to select a common repetition frequency for both outputs, and two more registers allow you to define the mark/space ratio for each individual channel.

The analog input circuitry includes an 8-channel analog input multiplexer and an A/D converter with 10-bit resolution. The A/D-conversion time is 50 μ sec with a 12-MHz clock frequency. An 8-bit control/status register allows you to select a particular input channel and software-trigger the ADC.

The PCB83C552 includes 8k bytes of mask-programmable ROM, and it lets you expand ROM and RAM externally to as much as 64k bytes. The device comes in a 68-pin PLCC and sells for around DM 26 (10,000).

Philips, Elcoma Div, Box 523, 5600 AM Eindhoven, The Netherlands. Phone (040) 757005. TLX 51573.

Circle No 575 Signetics Corp, 811 E Arques Ave, Sunnyvale, CA 94088. Phone (408) 991-4571.

Circle No 576

Introducing CHIPLOC Bags from Dow:

CHIPLOC ES Delivers *Up To 80%* More Static Protection Than The Leading Surface Shielding Bag.



Capacitive probe tests show that CHIPLOC* ES static shielding and dissipative packaging from Dow has up to 80% more shielding capability than the leading surface shielding bag on the market.

CHIPLOC ES has a thin, high-quality conductive metallized layer[†] designed specifically to minimize the penetration of electric fields from highly charged objects. It provides superior Faraday cage protection of the most sensitive electronic devices.

It is reusable, too, because of the exclusive "buried shield" construction used in CHIPLOC ES. Two layers of static dissipative film protect the metallized layer against abrasion, tears and punctures. Such damage, more common in bags with surface metallized layers, can dramatically reduce shielding effectiveness. In fact, tests⁺⁺ show that after just eight simulated use cycles, competitive exposed-film bags retain only 52% of their shielding ability.

CHIPLOC ES retains 92%.

Free Samples

For the complete CHIPLOC story, including free samples and a copy of the brochure "Two New Solutions to ESD Problems," call 1-800/258-2436, Extension 32/CHIPLOC. Or write: The Dow Chemical Company, Packaging and Industrial Foams Dept., 2020 Willard H. Dow Center, Midland, MI 48674.



+Manufactured of **STATICUPE** static dissipative films ++Test results available upon request.



*Trademark of The Dow Chemical Company

Who delivers PWM's in ceramic, plastic and surface mount? The General does.



Isn't that just what you would expect from the inventor of the pulse width modulator?

Now we are in the third generation of PWM's with a truly broad line. Fourth generation parts are on their way.

The General processes PWM's to 883B, Rev. C and Class S. All standard package types are offered including SOIC, LCC, and PLCC.

All parts are available on short lead times. Sample quantities for evaluation purposes can be shipped immediately.

Built in QPL Plant.

You are assured quality. MIL-M-38510 approval has been granted for our plant to produce JAN parts. JAN products include the MIL-M-38510/10103 BGA and the MIL-M-38510/13001 BEA.

A PRODUCT MATRIX TO BUILD BY.

Military Temp Range (-55° C to 125° C)	Commercial Temp Range (0° C to 70° C)		
Volta	ge Mode		
SG1524J	SG3524N		
SG1524BJ	SG3524BN		
SG1525AJ	SG3525AN		
SG1526J	SG3526N		
SG1527AJ	SG3527AN		
SG1840AJ	SG3840AN		
Curre	nt Mode		
SG1842J	SG3842N		
SG1843]	SG3843N		
SG1846J	SG3846N		
SG1847]	SG3847N		

Procedures developed by Silicon General to achieve this status include quality assurance, testing, burn-in, careful assembly and fabrication programs and other elements

of high reliability manufacturing technology.

New catalog available.

Ask for your free copy, please address Silicon General, 11861 Western Ave., Garden Grove, CA 92641. Phone (714) 898-8121. TWX 910-596-1804. FAX (714) 893-2570.



Dual-output 5V regulators simplify battery-backup circuitry

To simplify the design of systems that require battery backup for some of their circuitry, the L4901, L4902, L4903, and L4904 voltage regulators have two separately regulated 5V outputs, one of which specs a leakage current of $<1 \mu$ A. The low-leakage regulator sections' quiescent input-current drain is only 0.6 mA, so it's suitable for operation from battery input sources. The second 5V output is suitable for driving circuitry that doesn't require backup.

The regulators also generate a μ P-compatible reset signal during power-up conditions, after brief supply interruptions, or when the output to the battery-backed section of your circuit falls below a safe value—4.9V typically. You can control the reset-period timing with a



single external capacitor.

The L4901 and L4902 are housed in 7-lead Heptawatt plastic packages. They provide a 5V/0.3A output for battery-backed circuitry and a 5V/0.4A output for other circuitry. The L4903 and L4904 come in 8-pin miniature DIPs. Both their outputs are rated at 5V/0.1A, and both devices have separate inputs to their two regulator sections. The L4901 has a separate input for each of the two regulator sections.

The L4902 has a common input for both regulator sections. Both the L4902 and the L4903 have a TTL/ CMOS-compatible disable input that controls the output that's not designed for battery back-up circuitry. All the regulators have input overvoltage protection to 60V, as well as output short-circuit and thermal-overload protection. They cost around \$1.30 (1000).

SGS Microelettronica SpA, Via C Olivetti 2, 20041 Agrate Brianza, Italy. Phone (039) 65551. TLX 330131.

Circle No 596

SGS Semiconductor Corp, 1000 E Bell Rd, Phoenix, AZ 85022. Phone (602) 867-6100. TLX 249976. Circle No 597

Single-chip token-bus modem supports MAP networks

The SAB82511 baseband modem provides the functions of layer 1 of the OSI communications model for IEEE-802.4 token-bus networks. It is therefore suitable for use in MAP (manufacturing automation protocol) networks. The modem is also compatible with Motorola's tokenbus controller.

Using phase-coherent FSK modulation, the modem transmits data at 5M or 10M bps. It also includes a digital demodulator to decode received data. The modem chip generates the receive and transmit clock signals from a 20-MHz crystal or an external frequency source. It also provides station-management functions, and it has an electrical interface that you can connect directly to a network-medium coupling transformer.

The modem recognizes five distinct transmission states from the media-access control (layer 2) functions of the token-bus controller silence, non-data, pad-idle, data one, and data zero—and modulates the transmit carrier signal accordingly. The SAB82511 also supports station-management functions that include a loop-back mode for use in fault diagnosis. In addition, it incorporates a watchdog timer that prevents the modem from going into continuous-transmit mode and thus locking up the network.

The SAB82511 comes in a 44-pin

ceramic leadless chip carrier or plastic leaded chip carrier and operates over 0 to 70°C. It operates from a single 5V supply and draws a maximum supply current of 290 mA. All inputs and outputs that interface the modem to the token-bus controller are TTL compatible. Samples are available at \$175 each.

Siemens AG, Zentralstelle für Information, Postfach 103, 8000 Munich 1, West Germany. Phone (089) 2340. TLX 5210025.

Circle No 592 Siemens Components Inc, 2191 Laurelwood Rd, Santa Clara, CA 95054. Phone (408) 980-4500.

Circle No 593

EDN REPRINTS

You asked for it!



A Designer's Guide to Linear Circuits-VOLUME I

This original, 186-page collection by Jim Williams offers a wealth of analog design information. It includes practical and efficient ways to use op amps, comparators, data converters, and other analog ICs, and discusses the theories behind all the design techniques presented.



A Designer's Guide to Innovative Linear Circuits-VOLUME II

The reader response to Volume I was so positive, that we're offering Jim Williams' latest analog design articles – from 1983 to 1986 – in an all-new Volume II. An even bigger collection than before, Volume II is still written in the language of working engineers, but now covers the newest and more complex circuits and systems *you* asked for! 266 pages.

The Latest from the Best!

You can buy the volumes separately, or as a set. Either way, you'll have all the latest information on the most sophisticated linear ICs ... from Jim Williams, one of the country's foremost linear-circuit designers.



A Designer's Guide to CMOS ICs CMOS is fast becoming the chosen technology for developing integrated circuits. That's because CMOS ICs are able to implement ultra-complex system-level functions on a chip! Now you can meet the special challenges posed by this new breed of ICs with *A Designer's Guide to CMOS ICs.* You'll learn the advanced design and fabrication techniques required. Plus the latest linear and digital CMOS ICs available.

Se	micus rated (tom
		EDH

A Designer's Guide to Semicustom Integrated Circuits

Learn how to design a semicustom IC with A Designer's Guide to Semicustom Integrated Circuits. Based on EDN's own design experience, this ninechapter booklet outlines the complete procedure used to design, fabricate, and test EDN 1, a chip with a 1200 equivalent-gate complexity. You'll not only learn the steps to take when creating ICs, but also the design/cost analyses and vendor-interface methods that lead to successful semicustom chips.

Mail coupon to:

EDN Reprints/EDN Magazine • Cahners Building • 275 Washington Street • Newton, MA 02158-1630

Linear Circuits Volume I and Volume II

Check or money order made out to EDN REPRINTS must accompany each order. No COD. Mass. residents add 5% sales tax.

Please print clearly. This is your mailing label.

NAME	est transport	seeding of the second
TITLE		
COMPANY	nation of the state	boman in gyh-
ADDRESS		Ashe and bals
CITY	10,000 1000	aperal Surveys
STATE	_ ZIP	in the second second
		EDN 121087





HITACHI now makes it possible to secure greater profits. Our quality products are ideally suited for a wide variety of electronic applications, and have become a must for cordless devices.

Specify HITACHI for economic, maintenance-free reliability. You'll never regret it. HITACHI, the safest name in batteries.

Contact today for full details. CIRCLE NO 213

Manufacturer/Exporter (A Member of the HITACHI Group)

Shin-Kobe Electric Machinery Co., Ltd.

SHINJUKU MITSUI BUILDING POSTAL ADDRESS: P. O. BOX 218, MITSUI BLDG. SHINJUKU-KU, TOKYO, 163 JAPAN TEL: (03) 344-2811 FAX: (03) 348-3722 CABLE ADDRESS: HIGHLONGBATTERY TOKYO TELEX NO. 2324107 SKEMCT J

1-GHz, 3000-gate GaAs array targets high-speed digital applications

Supporting LSI applications at toggle rates as high as 1 GHz, the TQ3000 GaAs gate array is fabricated in the company's Q-ED process, a 1-µm enhancement/depletion MESFET (metal-epitaxial-semiconductor FET) construction that features two layers of interconnect metal, including air-bridge technology for the second layer.

The gate array supports 64 dedicated high-speed I/O pins that the user can program to interface with TTL, CMOS logic, or ECL. Internally, the array has 1020 cell locations containing 3000 equivalent gates. You can, for example, create 255 master/slave flip-flops by using the available gates. The part's power consumption is 0.75 mW per



equivalent gate and 2.4 mW per cell. The array operates from a single 2.6 or -2.6V supply. The cell library for the TQ3000 is fully supported on Daisy, Mentor, and Tektronix CAE workstations.

The TQ3000 is available in die form or in a 132-pin multilayer ceramic package. A high-speed evaluation board with a quick connect socket is available for rapid prototyping and system characterization. Nonrecurring engineering cost for the TQ3000 is \$80,000 and includes design manuals and workstation software. The vendor delivers five tested and packaged parts plus a high-speed evaluation board. The typical turnaround time from customer input to delivery of the packaged parts is 16 weeks.

TriQuint Semiconductor, Group 700, Box 4935, Beaverton, OR 97075. Phone (503) 629-3535.

Circle No 585

IC supports PS/2 graphics modes and 800×600-pixel, 16-color resolution

The PVGA1 is a single-chip graphics controller for use with IBM's Video Graphics Array (VGA), which is the standard graphics interface for the Personal System/2. The company also offers two VGAcompatible boards based on the chip.

Because the chip is compatible with the VGA at the register level, you can program the graphics hardware directly instead of programming only through the software-interface portion of the VGA BIOS (basic input/output system). This hardware compatibility confers a greater degree of confidence that a PVGA1-based board will be VGA compatible: In the past, application programs for the PC have bypassed the BIOS and accessed the graphics hardware directly to gain a speed advantage.

Besides supporting the VGA functions, the chip also supports the graphics standards developed for MS-DOS systems: the EGA (enhanced graphics adapter), MDA (monochrome display adapter), CGA (color graphics adapter), and Hercules and AT&T Model 6300 graphics boards. Note, however, that the chip supports the EGA standard only to the BIOS level, not to the register level.

The PVGA1 implements a proprietary mode that offers 16 colors and a resolution of 800×600 pixels. Its monochrome mode provides 1280×1024-pixel resolution. The vendor's proprietary bus interface for the PVGA1 allows data transfers of 8 bits over the PC bus and 16 bits over the PC/AT bus.

Another mode, Mode 13, specifies a resolution of 320×200 pixels and 256 colors. In your search for higher resolutions, don't forget that although pixel resolution is the most important factor in 2-D images, when you perceive 3-D images your eye is most sensitive to color resolution.

The PVGA1 chip costs \$60 (100) and comes in a 100-pin plastic pingrid array, plastic leaded chip carrier (PLCC), or plastic flat pack. It comes with a VGA-compatible BIOS.

Paradise Systems Inc, 217 E Grand Ave, South San Francisco, CA 94080. Phone (415) 588-6000. Circle No 598 Let us build your first PCB Prototype.

FREE.

That's right, and up to five copies. An exclusive offer from the industry leader.

Who qualifies? Anyone. Anyone, that is, who places an order for our PCB WorkSystem," the complete printed circuit board development system that takes you from schematic capture through physical layout. We'll also give you free help from a qualified Tektronix Design Center. It's the kind of support you've come to expect from Tektronix.

It's all part of Tektronix Aided Engineering, an integrated software approach addressing each area of your product development cycle.

So use the handy coupon or call us today at 800-TEK-WIDE, ext. 1594, to get all the details on your *free* PCB prototype manufactured at our class "A" MRP certified plant in Forest Grove, Oregon. Hurry, this offer can't last forever. *Place an order for our PCB WorkSystem now through December 18, 1987, and we will provide you with facilities, computers and consulting support to help you develop an approved printed circuit board design before you accept delivery of the WorkSystem. Up to 5 copies of your first unstuffed board will be manufactured. Subsequent boards do not have to be manufactured at our PCB facility. All board designs must have prior Tektronix approval and there will be a per day fee for cancelled purchase orders.

Yes. I want a Free PCB Prototype. Send more information.

Name

Title

Company

Address

Phone

Tektronix/CAE Systems Division, P.O. Box 4600, MS 94/520, Beaverton, OR 97076. Or call 800/TEK-WIDE ext. 1594.



EDN 121087

Echo-canceling chip set links ISDN to existing subscriber lines

By using DSP techniques to perform echo cancellation at either end of a telephone line, the PCB2390 ISDN (Integrated Services Digital Network) chip set allows existing 2-wire subscriber wiring to carry ISDN information over distances as great as 8 km. Two of the chip sets, incorporated in a repeater, can span distances as great as 14 km. The chip set's operation complies with the West German PTT's U_{KO} specification for the CCITT U-interface.

Capable of operating at a data rate of 144k bps, the chip set provides full-duplex transmission of two 64k-bps B channels of encoded voice or data and a 16k-bps D channel of signaling and low-speed data —the requirements for basic ISDN access. To achieve this transmission rate, the PCB2390 encodes the bit stream by using a 4B/3T line code (four binary digits compressed into



three ternary digits) so that the data-signaling rate is reduced to 108k bps. A 1-kHz maintenance channel, and 11-bit frame words added to the bit stream, results in a line-signaling rate of 120k baud. In addition to its U-point interface, the chip set has an industry-standard IOM (ISDN-oriented modular) interface that connects it to circuits that implement other CCITT interface functions.

At initial power-up, the PCB2390 injects a signal into the telephone line to evaluate the required filter coefficients for its adaptive DSP echo-cancellation and equalization filters. Additional adaptive filters allow you to connect the devices to loops that contain bridged taps. The 2-chip CMOS implementation of the PCB2390 currently costs around \$80. A single-chip version is under development.

Philips, Elcoma Div, Box 523, 5600 AM Eindhoven, The Netherlands. Phone (040) 757005. TLX 51573.

Circle No 594 Signetics Corp, 811 E Arques Ave, Sunnyvale, CA 94088. Phone (408) 991-4571.

Circle No 595

Data-acquisition chip contains 10-bit ADC, S/H circuit, and multiplexer

The LTC1090 data-acquisition system contains a 10-bit A/D converter, an S/H circuit with a 1- μ sec acquisition time, and an analog input multiplexer, all on a single piece of silicon packaged in a 20-pin DIP. The secret of its low pin count is the device's full-duplex, serial μ P interface. Selected versions of the part feature a total unadjusted error of ± 0.5 LSB over the full operating temperature range.

You can configure the analog input multiplexer as eight singleended inputs, four differential inputs, or a combination of singleended and differential inputs by means of the chip's 8-bit input data word. This data word selects a multiplexer input channel, picks singleended or differential operation for the selected analog input, sets the polarity of the input pins for a selected differential-input pair, selects unipolar or bipolar A/D operation, defines the output word width, and determines whether the LSB or the MSB of the conversion will emerge first from the serial output. The internal S/H circuit operates only for single-ended conversions.

You can select either 10-bit unipolar or 9-bit-plus-sign bipolar conversions by means of the chip's serial input data word. A conversion requires 20 μ sec. The total unadjusted error for either the unipolar or the bipolar conversion mode over the device's full temperature range is ± 0.5 LSB for the LTC1090A and ± 2 LSB for the LTC1090A and ± 2 LSB for the LTC1090. The LTC1090CN, in a plastic package and rated for -40 to $+85^{\circ}$ C operation, costs \$11.95 (100). A similarly packaged LTC1090ACN costs \$18.95 (100).

Linear Technology Corp, 1630 McCarthy Blvd, Milpitas, CA, 95035. Phone (408) 942-0810. TLX 172110.

Circle No 574

DSP Development Cut through the clutter

You've seen the advantages offered by the A100 Digital Signal Processor. The single-chip DSP solution that features 32 multiply-accumulators, executes up to 320 MOPs, and easily attaches to microprocessors.

Now INMOS speeds A100 system development with the new D704, the complete DSP Development System. The D704 overcomes the clutter normally encountered in developing DSP systems such as hand-crafted assemblers, interleaved busses and power-hungry glue. And since it is tailored for the A100, your end product is first to market and second-to-none in performance.

The D704 combines a comprehensive set of software tools, PC plug-in card and extensive documentation, providing a powerful yet easy-to-use DSP environment. You can experiment with the technology, simulate DSP algorithms in software and run them in real time on the A100's provided on the board.

The A100 is quickly becoming the number one choice in everything from avionics to ultrasonics. And with MIL-STD 883C devices available soon, it will be a natural for military DSP programs of all types. With the D704 Development System, creating DSP solutions has never been easier.

So if you'd like to cut through the clutter, start by clipping the coupon.

THE A100 DSP FAMILY

IMS A100	Single-Chip 32-Stage Cascadable Transversal Filter—16-Bit Data, 16-Bit Coefficients, 320 MOPs	
IMS 8009	PC Plug-In Card Including Four A100's	
IMS D704	IMS B009 + Interactive Software Simulator/ DSP Development Suite	



I'd like to cut through the clutter. Please send me full details of the IMS D704 DSP development system.

Title

EDN 121087

Name _____

Company_

Address _____ Telephone

INMOS Corporation, PO Box 16000, Colorado Springs, Colorado 80935. Tel (303) 630-4000.

INMOS Limited, PO Box 424, Bristol BS99 7DD. Tel (0454) 616616.

Low-power precision op amp needs only 600 µA of supply current

The OP-97 is a low-power alternative to the industry-standard **OP-07** precision amplifier. Except for its noise specification, the OP-97 maintains the original standards of performance set by the OP-07, but needs only 600 µA of supply current —less than ¹/₆ that required by the OP-07.

Several of the OP-97's specs are improved over those of its predecessor. The OP-97's bias current is 100 pA max at 25°C, and it remains below 250 pA over the full military temperature range. These characteristics let you use the OP-97 without external offset adjustments in the majority of applications. The device's 25-µV offset voltage and



0.6-µV/°C drift, combined with its low bias current and improved common-mode rejection (114 dB), practically eliminate the op amp as a contributor to system error.

The OP-97's guaranteed noise specs (at 10 Hz) are $<30 \text{ nV}/\sqrt{\text{Hz}}$.

At 1 kHz, the noise drops to 22 nV/\sqrt{Hz} max; at 10 kHz, the typical noise level is 17 nV/ $\sqrt{\text{Hz}}$.

Suitable for battery-powered equipment, the OP-97 is characterized for use with supply voltages from ± 2 to ± 20 V. Its power-supplyrejection spec is 114 dB. The OP-97 is available in 8-lead, TO-99 metal cans and in ceramic and plastic miniature DIPs. Prices start at \$2.50 (100) for an OP-97 in a plastic miniature DIP for use over the industrial temperature range.

Precision Monolithics Inc, 1500 Space Park Dr. Box 58020. Santa Clara, CA 95052. Phone (408) 727-9222. TWX 310-371-9541.

Circle No 591



CIRCLE NO 35 EDN December 10, 1987

Score a Whole In One

Score the MS-DOS-Compatible System On a Chip from NEC

New Iow price

Now you can score on your next round of systems designs and parlay your MS-DOS investment. Simply use our CMOS V25™ Whole in One[™] — the new 16-bit microcomputer on a chip from NEC.

It lets you tee off with features like a 16-bit ALU, two full-duplex UARTs, true STOP and HALT modes, and a whole lot more.

The result is a master performance with a two-cycle data bus (250 ns minimum information transfer time) and ultra-highspeed interrupt service (typically 5 µs).

Keeping score? In direct match play, EDN and Byte benchmark tests show the V25 clearly higher in performance.

MS-DOS is a trademark of Microsoft Corporation. Whole In One and V25 are trademarks of NEC Electronics Inc.

ROGRAMMABLE

Really Learn the Score

Check out the V25's real strengths. Full support, for one. It's here now with hardware and software tools including EPROM/OTP parts. And you're supported by regional design centers with an increasing number of application engineers.



Stand-alone ICE and PC-based mini-ICE use our relocatable assembler and C compiler to provide powerful development capability for system designers.

Production is another winning shot. The V25 is in full production in multiple fabs with high yields allowing very competitive pricing. Now add NEC's traditional high quality and leadership in CMOS manufacturing for a par-beating system on a chip.

For complete technical documentation and the number of your local Distributor Pro Shop, call 1-800-632-3531. In California, call 1-800-632-3532 and score your own Whole In One: the V25 from NEC.

©Copyright 1987 by NEC Electronics Inc.

NEC Electronics Inc. 401 Ellis Street, P.O. Box 7241

Mountain View, CA 94039

CLOCK GENER

25



The V25 is now on distributor shelves for immediate delivery

INTERRUPT CONTRO

PROGRAMMABLE TIMERICOUNTE

COMPARATOR INPUT



FOR REAL-TIME DESIGNERS THAT DEMAND THE MOST, THE CONTROLLER THAT DEMANDS THE LEAST.



Our new 80C196 delivers the highest performance and the highest integration of any 16-bit microcontroller available. While demanding the least power, the least design time, the least hassle. Which means you can spend more time perfecting the rest of your application.

The 12 MHz 80C196 is the latest member of our proven MCS-96 family of embedded controllers. It offers the lowpower requirements of CMOS technology while doubling the performance of the 16-bit 8096. Which means that it can perform a 16 x 16 multiply in 2.3 microseconds. That's faster than any other microcontroller.

Yet you still get all the features of the 8096. And more. Resident on the highly-integrated 80C196 are a 16-bit cpu with an 8/16-bit bus (reconfigurable), 256 bytes of RAM, PWM, 10-bit A/D, two 16bit timer/counters, 40 I/O pins, full duplex serial port, and a high-speed I/O subsystem. And speaking of getting more features in less space, we're working on an EPROM version of the 80C196 for an even easier design path (available Q2 1988).

Our low cost ICE⁻⁻ 196 PC development tool gives you more for less, too. Together with highlevel languages like PL/M and C, it delivers the easiest, lowestcost design support you can get.

Further support is available from the world's largest network of field applications engineers. Plus customer workshops to get you up to speed fast.



So you see, there's really no easier or more powerful answer to embedded real-time control than Intel's 80C196. For complete technical information, call toll-free (800) 548-4725 and ask for Literature Department W398.

Do it now And relax. Because we're ready to meet your demands.



ICE is a trademark of Intel Corporation. ©1987 Intel Corporation

Turn to the Masters of RF Amplifier Design

Design Engineering Expertise

Feed-Forward & Power-Combining

RF Linear Hybrids

CRT Drivers

RF Power Amplifier Modules & Systems

RF Devices has the talent and the experience it takes. We are RF amplifier performance artists. With our palette of products and capabilities, we can meet your needs – from RF and microwave power transistors and hi-rel hybrids to complete UHF high-power modules and systems – from 100KHz to 4GHz, from under 1W to 1KW.

And not just with standard products. We team up with you to create special and original solutions – and every design bears our industry-leading figure of merit – power at frequency with low distortion.

We've developed RF linear hybrids featuring high gain, very high dynamic range and very low distortion. Our feedforward techniques in these hybrids are meeting demands for faster speeds in CATV systems and wideband LANs.

We're delivering the gain needed in

high-power cellular base stations with our power-combining and feed-forward technology. And, our high-voltage drivers with sub-three nanosecond rise time are reducing the cost of highresolution monitors and VLSI test equipment.

Your solution will have quality, reliability and manufacturability built-in right from the beginning, starting with



our own die design and wafer fab. And, with our high-volume production facility, you'll get a total capability that can handle your largest requirement.

Your challenge will bring out the best in us – and the RF amplifier that's just right for your design. Call us about your application at 213.536.0888 and ask for RF Amplifier Solutions. Or write for our free brochure to TRW RF Devices, 14520 Aviation Blvd., Lawndale, CA 90260. Attn: RF Amplifier Solutions.

Let us paint you a masterpiece.

[©]TRW Inc. 1987 — 713A00887



TRW RF Devices Division



FLASH A/D CONVERTER

The HS1068 20M-sample/sec, flash A/D converter includes all necessary analog-support circuitry in the package: a wideband input amplifier, a precision 1.2V voltage reference, and a 3-state output register. The 8-bit device comes in a 24-pin DIP that occupies less space than the original 28-pin-DIP TDC1048. You pin-program the converter to accept an input range of either 0 to 1V or ± 0.5 V, and you can select straight binary, inverted binary, 2's complement, or inverted 2's complement output code. Separate digital outputs flag input overranges at zero and full scale.

Power supplies are 5V and -5.2V, drawing 101 and 207 mA, respectively. Power dissipation is 1.67W. Other key specs are $\pm \frac{1}{2}$ -LSB integral and differential linearity errors, 60-psec aperture time, 2% differential gain, and 1° max differential phase. HS1068C, \$295; HS1068B, \$375 (100). Delivery, eight to 12 weeks ARO.

Hybrid Systems Corp, 22 Linnell Circle, Suburban Industrial Park, Billerica, MA 01821. Phone (617) 667-8700. TWX 710-347-1575. Circle No 351

Circle No 351

CMOS D/A CONVERTER

The PM-7548 CMOS D/A converter combines 12-bit resolution with an 8-bit data-bus interface that accepts left- or right-justified data. The digital inputs are buffered; you can update the converter immediately



or retain data in the input latches for later use. In addition, a dataoverride function lets you load the converter with all zeros or all ones without altering data in the input latches. It features $\pm\frac{1}{2}$ -LSB integral and differential linearity error over temperature, ±1 -LSB gain error, and 0.03-LSB max zero-scale error.

Compared with the original industry-standard equivalent, the converter offers a 30% reduction in glitch energy, a 30% reduction of input capacitance, and a 20-dB improvement in PSR. The internal voltage regulator ensures TTL compatibility while operating with supply voltages from 5 to 15V. The device comes in two electrical grades for each of the commercial, industrial, and military temperature ranges. From \$7.58 to \$30.92 (100). Delivery, eight to 10 weeks ARO for the commercial grade; the industrial and military grades are available from stock.

Precision Monolithics Inc, Box 58020, Santa Clara, CA 95052. Phone (408) 727-9222. TWX 310-371-9541.

Circle No 352

CMOS EPROM

The 35-nsec WS57C49B is the world's fastest 8k×8-bit CMOS EPROM, according to the manufacturer. As a pin-compatible, programmable alternative to bipolar PROMs, the device consumes a fraction (400 mW) of the power bipolar PROMs use. Available in a 35-nsec commercial version or a 45-nsec mil-



itary version, the EPROM comes in a 300-mil-wide ceramic DIP, a 600mil-wide DIP, or a 28-pin ceramic LCC. 35-nsec version in a 300-mil ceramic DIP, \$29.50 (100).

Waferscale Integration Inc, 47280 Kato Road, Fremont, CA 94528. Phone (415) 656-5400.

Circle No 353



DATA ACQUISITION ICs The SDM862 and SDM863 are miniature, complete data-acquisition systems, available either in a 68lead LCC or a 68-lead pin-grid array. They both include an input multiplexer (the 16-channel, singleended SDM862 or the 8-channel, differential SDM863); an instrumentation amplifier that is jumper-programmable for gains of 1, 10, and 100; an S/H amplifier; an A/D converter with a μ P-compatible interface; and 3-state output buffers.

The throughput rate for both devices is 22.22k samples/sec in the serial mode or 33.33k samples/sec in the overlap mode. Both have input ranges of 0 to 10V, \pm 5V, and \pm 10V and come in accuracy grades of 0.024% FSR and 0.012% FSR in the commercial-, industrial-, and military-temperature versions. Both models come in versions qualified

for the requirements of BS9450/ CECC63000. To evaluate the LCC versions, you can obtain a Eurocard pc board with an LCC socket from the company. From \$103 (100). Delivery, stock to eight weeks ARO.

Burr-Brown Corp, Box 11400, Tucson, AZ 85734. Phone (602) 746-1111. TLX 666491.

Circle No 354



ANALOG SWITCH

The LR404 is a 4×1 crosspoint analog switch that comes in a 14-pin plastic DIP. The device is suitable for use in video signal-switching matrices; using multiple devices, you can switch many outputs to a common output. The chip provides differential phase and gain of 0.05° and 0.05%, respectively, at 3.58 MHz. Crosstalk amounts to <-77 dB at 10 MHz. \$4 (moderate quantities).

Linear Technology Inc, Box 489, Station A, Burlington, Ontario, Canada L7R 3Y3. Phone (416) 632-2996. TLX 0618525.

Circle No 355

A/D CONVERTER

The TSC827 is a CMOS integratingtype A/D converter that includes on-chip drivers for a 101-segment bar-graph LCD. The internal resolution is 1000 counts ($\pm 0.1\%$), and the result of each conversion is



available as an additional serial digital output for use in driving numeric displays. The converter accepts positive inputs with full scale ranging from 0.1 to 2V, and the differential signal and reference inputs simplify the interface to a variety of signal sources. You can use switches or software programming to specify two setpoints; separate annunciators then flag underrange and overrange inputs. The typical conversion rate is 7.5 samples/sec. The device consumes 15 mW and operates from a 9V battery. It comes in a 68-pin PLCC or a 60-pin flatpack. From \$10.80 (100).

Teledyne Semiconductor, Box 7267, *Mountain View, CA 94039. Phone (415) 968-9241. TWX 910-379-6494.*

Circle No 356



CHIP SET

The FE3400 chip set provides PC/AT peripheral-control and CPU functions with only four ICs. Implemented in 2- μ m HCMOS technology, the four chips replace eight support ICs, including the 8284 and 82284 clock generators, the 82288 bus controller, two 8237 DMA controllers, two 8259 interrupt controllers, an 8254 timer, and numerous SSI and MSI logic chips. Using the

chip set reduces the area of a typical PC/AT mother board from 142 to 21.5 in² and reduces the typical chip count from 95 to 19. In addition, the chip set reduces the power requirement by 50% (16W). The FE3400 chips operate under the company's copyrighted BIOS to ensure IBM PC/AT compatibility and are software-programmable for 6-, 8-, 10-, or 12-MHz operation. Starter kits and design-support tools are available. \$118 (100). Delivery, 10 weeks ARO.

Faraday Electronics, 749 N Mary Ave, Sunnyvale, CA 94086. Phone (408) 749-1900. TLX 706738. Circle No 357

QUAD OP AMP

Suitable for use in compact-disk players and other digital-audio systems, the LM837 quad op amp generates less than 0.0015% distortion over a 140-dB dynamic range. The output stage can drive a 600Ω load. The standard pinout (in a 14-pin DIP) lets you upgrade an existing system with few or no design changes. The chip is also available in a molded small-outline package. The monolithic, unity-gain-stable device specs an 8-V/µsec slew rate, a 140kHz power bandwidth, and a 15-MHz gain-bandwidth product. The input noise voltage is $0.5 \mu V$ rms. \$1.25 (25,000).

National Semiconductor Corp, Box 58090, Santa Clara, CA 95052. Phone (408) 721-5856. TLX 346353. Circle No 358

A/D CONVERTER

Using a 2-pass conversion architecture, the ADC-974 A/D converter accomplishes a 16-bit conversion in 2.5 μ sec. The integral-linearity error is guaranteed to $\pm \frac{1}{2}$ LSB max for resolutions as high as 14 bits. The converter accepts inputs over the ± 5 V range and produces 2's complement output code. The output is configured as two octal 3state latches. The offset drift is ± 1 *Text continued on pg 300* EDN December 10, 1987

A LOT OF PEOPLE THINK WE ONLY HANDLE GIANT PROJECTS.



The entire state of New Jersey on a chip.

EVEN THOUGH WE OFFER 100,000 GATES, YOU DON'T HAVE TO USE THEM ALL.

It's no wonder people expect big things from LSI Logic.

We're the largest HCMOS ASIC company there is.

But that doesn't mean you have to be Or we the largest in your field USABLE GATES

10K

 $1.5 - \mu$

 $1.5 - \mu$

 $1.5 - \mu$

20K

LMb6000 Micro bASIC™

LL7000/LL9000 Arrays

LMA9000 Micro Arrav™

LCA100K Compacted Array Plus[™]1·µ

to come to us.

You just need to be doing ASIC. No matter if it's a few hundred gates or a complete system on a chip. Or even a multi-ASIC system.

It's plain and simple, really: We understand your ASIC might not need 100,000 gates today. But it's good to know it's here when you need it.

To simplify your ASIC design task,

we have the largest library available of SSI and MSI building blocks. And more than 400 industry-standard LSI and VLSI building blocks for Channeled and Channel-Free[™] Arrays, and Cell-Based designs. So whether you need an array or cellbased product, you're covered.

If you change methodologies, you don't have to re-design or change vendors. Or worse, change design tools. Simply,

100K

our design tools support both.

There's something else you won't get anywhere else. Our turnaround for prototypes.

It's only two to three weeks for arrays and five to six weeks for cell-based prototypes. All fully tested and guaranteed to work to your specifications.

If you need your arrays even sooner, we can deliver fully tested prototypes in just seven

days. And when cost is an issue, we have a whole range of cost-effective solutions, too.

So don't worry about how big or small your ASIC need is. We're the right size for you.



LSC15 Cell-Based

LCA10000 Compacted

Array[™] 1.5-µ

50K

LSI Logic's family of products covers the entire ASIC spectrum.

WE HAVE SEEN THE FUTURE.

Mini on a chip.

AND IT IS VERY TINY.

Saying our new Modular Design Environment (MDE)[™] is the most advanced ASIC design software anywhere isn't small talk.

Using MDE, we've already accurately designed and simulated systems with

more than two million gates of logic. And that's just for starters.

Our software easily migrates into the latest technology. So your design will always have the highest performance and densities.

MDE is actually comprised of three modules.

The Logic Integrator[™] is an entrylevel module containing the design and simulation tools for building single ASIC chip designs.

The *Silicon Integrator*[™] module handles the design and simulation of complex ASICs ranging from a few hundred to 100,000 usable gates. Its Silicon Compilers allow you to automatically develop logic and memory. Your compiled designs, of course, all have complete simulation and test vectors.



MDE's interactive graphics deliver fast, flawless design and simulation.

You can also effortlessly convert PALs to arrays with our Logic Synthesizer. Our System Integrator[™] module has mixed-mode behavioral and gate-level simulation capabilities. Use it to design your entire system, including multiple

ASICs and standard components.

All with surprising ease and economy. So you can "electronically breadboard" your complete system before going to prototype.

And you can design your ASICs on more platforms than anywhere else. Like all the popular workstation and mainframe environments. Or commercial CAE systems through our CAD

Connection Program. Or at one of our 24 Design Resource Centers—the world's largest ASIC support network.

MDE is also tightly coupled to our worldwide manufacturing facilities. Which is why LSI Logic delivers working parts 100% of the time. Guaranteed.

And why you'll see your future a lot sooner with us.

With more than 4,000 working designs under our belt, one clear fact emerges.

Our system works.

That's true whether your needs call for an entry-level gate array or cell-based design. Or for the world's most advanced ASIC-based system.

Whatever direction your designs take, you can always use the same proven software: LSI Logic's MDE.

MDE can be tailored to your specific situation. Just select the appropriate design modules.

We have all the performance you'll need. Such as ECL-like speed in 1 or 1.5micron HCMOS technology with gate delays of 460 picoseconds. And even more coming soon. We also have more than 230 package options with up to 299 pins. Including a full range of plastic, ceramic pin grid arrays and chip carriers.

Just as important as our high level of technology is our high level of service. Choose as much as you need. You can design at your own workstation. Or at one of our Design Resource Centers. Or we'll do the entire design for you.

What's most important is that our relationship with you works as well as your device.

We see to it that it does. With an iron-clad guarantee that states that your device must operate precisely as simulated.

That's our system. You can't beat it.


WE HAVE ASIC DOWN TO A SYSTEM.

Supercomputer on a board.



CALLUS WITH EVEN YOUR SMALLEST PROBLEM.

Sure, we handle the biggest ASIC projects. But you don't need a big reason to call LSI Logic.

It can be about designing a low complexity part or buying a small quantity of parts.

The important thing is that you call. We're close by. So nothing ever gets lost in transit or translation. Our unique integrated approach means we're the only ASIC company you should ever need. And our worldwide manufacturing facilities are dedicated to ASIC. Which means you can quickly turn your designs into working parts.

Contact your nearest LSI Logic Design Resource Center or Sales Office. It's a small step that will lead to much bigger things.

LSI Logic Sales Offices and Design Resource Centers:

Scottsdale, AZ 602-951-4560 Milpitas, CA 408-433-8000 San Jose, CA 408-248-5100 Irvine, CA 714-553-5600 Sherman Oaks, CA 818-906-0333 Denver, CO 303-756-8800 Westport, CT 203-222-9336 Altamonte Springs, FL 305-339-2242 Boca Raton, FL 305-395-6200 Bethesda, MD 301-897-5800 Chicago, IL 312-773-0111 Waltham, MA 617-890-0161 Ann Arbor, MI 313-769-0175 Minneapolis, MN 612-921-8300 Bridgewater, NJ 201-722-7522 Poughkeepsie, NY 914-454-6593

Raleigh, NC 919-783-8833 Beaverton, OR 503-644-6697 Trevose, PA 215-638-3010 Austin, TX 512-343-4513 Dallas, TX 214-788-2966 Bellevue, WA 206-822-4384 Calgary, Alta 403-262-9292 Edmonton, Alta 403-424-8845 Burnaby, BC 604-433-5705 Kanata, Ont 613-592-1263 Toronto, Ont 416-622-0403 Pointe Claire, Quebec 514-694-2417 Paris, France 33-1-46-21-25-25 Israel 972-3-403741 Milan, Italy 39-651575 Ibaragi-ken, Japan 81-298-52-8371 Tokyo, Japan 81-3-589-2711 Osaka, Japan 81-6-947-5281 Seoul, Korea 82-2-785-1693

Bracknell, United Kingdom 44-344-426544 Munich, West Germany 49-89-926903-0 Dusseldorf, West Germany 49-211-5961066 Stuttgart, West Germany 49-711-2262151

Distributors: Hall-Mark Hamilton/Avnet Wyle



THE ASIC SYSTEMS COMPANY

© 1987 LSI LOGIC CORPORATION Compacted Array, Channel-Free, Micro Array, Micro bASIC, Compacted Array Plus, Modular Design Environment, MDE, Logic Integrator, Silicon Integrator and System Integrator are trademarks of LSI Logic Corporation. PAL is a registered trademark of Monolithic Memories, Inc.

BLAZING SPEEDS

Blazing speeds in a microprocessor or semicustom logic chip? Demanding performance requirements for array processors, ASICs, ALUs? Now you can match power demands with an innovative family of high-efficiency, **truly omnidirectional** heat sinks designed specifically for high lead count chips packaged in ceramic pin grid arrays.

The EG&G Wakefield 840 Series (patent pending) Pin Fin heat sinks are ideally suited for natural convection, serial-flow forced convection, and impingement cooling of critical components. The 840 Series utilizes a pedestal base for optimal heat transfer from the heat source — the die itself. The pedestal base will minimize thermal fatigue and cracking of the ceramic substrate with application of an appropriate adhesive to the substrate at the point of contact. A choice of pin heights allows you to match optimum thermal performance requirements with available board-to-board spacing. Horizontal board mounting? No flat disks or plates in these designs will impede natural convection streams. Round pins optimally spaced in a staggered pattern yield the highest film heat transfer coefficient of any practical heat sink design available. Innovative design allows for clean, burr-free manufacturing and yields the lowest cost per watt dissipated.

If increased speeds in high-density bipolar, ECL, and VLSI MOS designs create junctionto-ambient (θ_{ja}) temperatures that threaten die life and ceramic reliability, call EG&G Wakefield Engineering for innovative solutions from **the** thermal management component company.

EGEG WAKEFIELD ENGINEERING

Components Division 60 AUDUBON ROAD, WAKEFIELD, MA 01880 (617) 245-5900 • TWX: 710-348-6713 FAX: (617) 246-0874 Western Sales Office 3777 RUFFIN ROAD, SAN DIEGO, CA 92123 (619) 279-2253 • TWX: 697938 GAMBI FAX: (619) 576-9286

Integrated Circuits



LSB (at 14 bits) over 0 to 70°C. The reference-voltage temperature coefficient is ± 5 ppm/°C. Supply voltages are ± 5 and $\pm 15V$; the maximum power dissipation is 8.4W. The converter is packaged in a $6 \times 4 \times 0.375$ -in. black enameled-steel module. \$999. Delivery, stock to eight weeks.

GE/Datel, 11 Cabot Blvd, Mansfield, MA 02048. Phone (617) 339-9341. TWX 710-346-1953.

Circle No 360



CMOS STATIC RAMs

The 35-nsec M5M5257 (256k×1 bit) and M5M5258 (64k×4 bits) are the fastest 256k-bit static RAMs available, according to the manufacturer. Combining silicon-gate CMOS peripheral logic and a high-density NMOS memory array, the devices are suitable for use in cache and main-memory applications. Both chips are also available in 45- and 55-nsec versions. They come in 300mil, 24-pin plastic DIPs or plastic SOJ (small-outline J) packages for surface-mount applications. 35-nsec M5M5257P in DIP, \$142; M5M5258P, \$152 (100).

Mitsubishi Electronics America Inc, 1050 E Arques Ave, Sunnyvale, CA 94086. Phone (408) 730-5900.

Circle No 359

MOTOR DRIVER

Housed in an 18-pin plastic DIP, the L6202 motor-driver IC can deliver 70W of power. It has a full H-bridge output and interfaces directly to TTL-level control logic. Operating at a switching frequency of 100 kHz and a junction temperature of 120°C, the driver can deliver continuous rms currents as high as 1.5A at motor supply voltages as high as 54V. The peak nonrepetitive output current limit is 5A. Within this limit, the available output current is limited only by power dissipation.

> CalComp's new graphics subsystem pumps new excitement into Micro Vax II, turning up to four terminals into high performance, high resolution graphic workstations. Brooktree[®] RAMDACs pump out the color, enabling CalComp to do it all on a single board.

Integrated Circuits

Six pins on the 18-pin DIP connect to copper traces on the pc board that function as a heat sink. A similar device, the L6203, can deliver as much as 4A rms to provide 250W of motor power. The L6202, \$5 (100).

SGS Microelettronica SpA, Via C Olivetti 2, 20041 Agrate Brianza, Italy. Phone (039) 65551. TLX 330131.

Circle No 732 SGS Semiconductor Corp, 1000 E Bell Rd, Phoenix, AZ 85022. Phone (602) 867-6100. TLX 249976. Circle No 361

TELEPHONE IC

The MA534 CMOS loop disconnect dialer IC features an integrated speech circuit that complies fully with BS-6305 and -6317 requirements for class A complex matched telephones. The IC also features a 21-digit last-number-redial memory, a selectable make/break ratio of 2:1 or 3:2, and a selectable interdigit pause of 800 or 400 msec. The dialer can perform earth-loop and timedbreak recall, and no dial output is generated if more than one dial-pad key is pressed simultaneously.

All timing is derived from an external, low-cost, 560-kHz ceramic resonator. To compensate for the lower attenuation characteristics of short lines, the device automatically adjusts the gain of its speech circuits so that the volume of received speech is independent of line length. The speech circuits are suitable for dynamic or electret transducers. The MA534 is housed in a 16-pin DIP, and you can power it directly from the telephone line. £3 (100).

Marconi Electronic Devices Ltd, Doddington Rd, Lincoln LN6 3LF, UK. Phone (0522) 688121. TLX 56380.

Circle No 362 Marconi Electronic Devices Inc, 45 Davids Dr, Hauppauge, NY 11788. Phone (516) 231-7710. TLX 275801.

Circle No 363

PS/2 CHIP SET

The 82C100 system-control chip supports 8088/V20 and 8086/V30 microprocessors at speeds to 10 MHz and is targeted for high-performance IBM PS/2 Model 30s, PC/XTs, and compatible computers. It includes a memory controller that supports the Lotus-Intel-Microsoft expanded memory specification and offers power-management features for laptop systems to help reduce battery drain.

The 82C101 chip supports 8088 and V20 8-bit processors. It's aimed at lower-cost PC/XT-compatible computers and terminals and does not include power-management features. The three companion chips are the 82C606 ChipsPak and the 82C605 ChipsPort—both multifunc-



CIRCLE NO 36

New Instruments

µP-based Programmable E/I dc Calibrator



Model 520/A

The Model 520/A is micro-processor based and is compatible with IEEE-488, (GP-IP).

The height is only 31/2 inches, features current mode outputs from 10 nanoampers (nA) to 110 milliampers (mA), in 2 ranges, with extraordinary compliance of 100 Vdc. Even with this power, ideal for transducer instrument testing (4-20 and 10-50 mA), the accuracy is ± 0.005%!

The voltage mode has 3 ranges with outputs from 100 nV to 110 Vdc and optional to 1100 Vdc. Compliance current is 100 mA. The one year accuracy is \pm 0.002%.

All ranges and both modes resolve to 1 ppm. A crowbar zero provides a reference for this essential value.

Availability: 60 days. Price: \$2,895. 1000V option \$550. GSA contract GS00F-86293

Engineering Contact: Bob Ross Tel: (617) 268-9696 **CIRCLE NO 110**

AC Voltage Reference System **Remotely Controlled Multiple Output**



System 408

1 to 8 AC Voltage outputs independently and remotely controlled, variable and simultaneous in a single 51/4" high chassis.

A phase angle of 0° and 180° is also programmable.

All functions programmed via IEEE-488 (GP-IB) interface bus.

Some applications: Synthesize linear velocity sensors, simultaneous calibration of multiple instrumentation and data logging systems without multiplexing delays. Simulation of transducers. For design, evaluation and calibration of accelerometers, amplifiers, A/D converters, digital and analog meters.

Specifications include: Range: 10 mV to 30 Vac resolved to 1 mV. The compliance current is: 50 mA. The accuracy is: \pm (0.05% of setting + 15 mV). Output frequency (synchronized to an external sine wave stimulus): at a selected, fixed frequencies between 10 Hz and 400 Hz.

Price:	Main frame: Output modules:	\$3,995 \$895/each
Engineerin Tel: (617)	g Contact: Bob Ross 268-9696 Cli	RCLE NO 111

ELECTRONIC DEVELOPMENT CORP. 11 Hamlin St., Boston, MA 02127 Tel: (617) 268-9696 TLX: 951596 (ELECDEVCO BSN)

Integrated Circuits

tion peripheral controllers-and the 82C764A floppy-disk data separator. 82C100, \$51.30; 82C101, \$41.10; 82C606, \$23.40; 82C605, \$17.60; 82C764A, \$7.80 (100).

Chips and Technologies Inc. 521 Cottonwood Dr, Milpitas, CA 95035. Phone (408) 434-0600.

Circle No 364

DUAL-PORT RAM

The MK4511 512×9-bit dual-port RAM features independent interrupt outputs for each port, which vou can software control via two interrupt registers. Each port, which operates with multiplexed address and data signals, can simultaneously access RAM locations. The RAM is available with access times of 120, 150, or 200 nsec. The MK4511 is supplied in a 28-pin DIP or 28-pin plastic leaded chip carrier. From \$9.56 to \$12.65 (1000), depending on access-time rating.

Thomson Semiconducteurs. 45 Ave de l'Europe, 78140 Velizy. France. Phone (1) 39469719. TLX 204780.

Circle No 733 Thomson Components-Mostek Corp. 1310 Electronics Dr. Carrollton, TX 75006. Phone (214) 466-6000. TLX 730643.

Circle No 365

MOSFET DRIVERS

The SG1626 and SG3626 are dual. inverting drivers suitable for driving power MOSFETs and for applications that require digital signals to drive large capacitive loads. The devices' 3A-peak current capability can drive 2500-pF loads in less than 40 nsec. The drivers use highvoltage Schottky logic that converts TTL signals to 18V outputs without driving the outputs deeply into saturation. The package options include 8-pin plastic and ceramic DIPs and 16-pin bat-wing, TO-99, and TO-66 packages. An 8-pin plastic DIP, 0 to 70°C version, \$0.90 (10,000). Delivery, 12 weeks ARO.

Silicon General Inc. 11861 Western Ave, Garden Grove, CA 92641. Phone (714) 898-8121. TWX 910-596-1804.

Circle No 366

GATE ARRAYS

The four devices in the BC series of **BiCMOS** gate arrays offer densities from 430 to 2160 3-input gates. Their propagation delay is 550 psec, and the typical power dissipation is 0.25 mW/gate. The input and output buffers' propagation-delay times are 3.0 and 5.5 nsec, respectively. The BC family offers either 10-mA or 24-mA TTL-compatible output drive; the output buffer's power dissipation is 4 mW at 10 mA and 8 mW at 24 mA. BC400 in a 44-pin PLCC, from \$7.85 (1000). Delivery, eight weeks ARO for initial silicon samples; 14 weeks ARO for production quantities.

Fujitsu Microelectronics Inc. 3320 Scott Blvd, Santa Clara, CA 95054. Phone (408) 727-1700. TWX 910-338-0190.

Circle No 367



CLOCK IC

The CDP68HC68T1 is a CMOS realtime clock for µP systems. The monolithic chip indicates seconds, minutes, hours, day of the week, and date. It also lets µC systems implement timer, power up/down, and power-sensing functions. The IC communicates with the μ C over the SPI (Serial Peripheral Interface) bus of the 68C05 or 68HC11, or the four I/O-port lines of µCs such as the 1804A, 80C51, and the 65C02. The chip also includes a power-moni-

Aeroflex announces the new math for MIL-STD-1553 design engineers. In which three goes into one just once.



Dual port RAM with 8K words of memory and full memory management

Low power dual redundant transceivers

Dual decoder, encoder and protocol processor for Remote Terminal, Bus Controller and

Bus Monitor

You are looking at the most powerful, flexible and unique MIL-STD-1553B interface currently available. Bar none. Now, in one $2 \times 3.1''$ package, this new ARX 2427 Uniwereal Pus laterface Unit (UPU D

Now, in one $2 \times 3.1^{\prime\prime}$ package, this new ARX 2427 Universal Bus Interface Unit (UBIU) combines all the functions it takes three competitive hybrids to perform. Fact is, of all hybrids today, only the ARX 2427 reduces interface and hardware time to absolute zero. The powerful ARX 2427 contains a dual port RAM that's double-sided and double-buffered to eliminate contention problems and wait states. Data can be mapped into RAM blocks by subaddress or alternately stacked. Memory is accessed for read and write using address lines and a select line, treated as subsystem memory. The host system is therefore freed from critical



AFRIEDX

CROELECTRONICS

and communication overhead is kept to a bare minimum. The unit also includes extensive error checking, which eliminates handling bad data. Fault monitoring plus many other features make the ARX 2427 clearly the most useful of 1553 interfaces.

timed response to Bus traffic

So forget complex interconnect schemes. Forget special glue logic circuitry design for subsystem compatibility. Forget using up valuable PC board real estate. The ARX 2427 is the UBIU to remember when you want to solve your 1553 problems–once–and for all.

For additional information call toll-free: 1-800-THE-1553 or TWX 510-224-6417. Or write Aeroflex Laboratories Inc., Microelectronics Division, 35 South Service Road, Plainview, NY 11803.

Integrated Circuits

tor function and a 50-Hz, 60-Hz, or crystal-clock reference.

The chip's 32 bytes of internal static RAM provide parameter storage, computer handshaking, and an interrupt structure. Any one of three internal sources can provide an interrupt: the alarm circuit (seconds, minutes, hours); one of 15 periodic signals (subsecond to daily events); or power failure. The timer functions include a 12- or 24-hour format with an AM/PM indicator. The calendar counters provide day of the week and day/month/year with automatic leap year. The device operates on 3 to 6V; at 2.2V, it can maintain timekeeping functions while drawing 10 µA of supply current. The package options are a 16lead plastic or ceramic DIP or a 20-lead SO (small-outline) package. Plastic-DIP version, \$3.16 (100).

GE/RCA Solid State, Box 2900, Somerville, NJ 08876. Phone (201) 685-6771.

INQUIRE DIRECT



SCSI PROCESSOR

The ESP chip is a VLSI device that implements the communications protocol of the SCSI bus. As a host adapter embedded on a CPU mother board or as a controller embedded with drive electronics, the chip replaces existing discrete devices, external drivers, and any earlier SCSI-interface chip. It features a dual-ranked command and transfer counter; bus sequences implemented without μ P intervention; a 16-byte FIFO memory; singleended, 48-mA bus transceivers; and a sustained transfer rate of 3M bytes/sec (asynchronous) or 4.8M bytes/sec (synchronous). It comes in a 68-pin PLCC. \$25 (1000).

Emulex Corp, Box 6725, Costa Mesa, CA 92626. Phone (800) 368-5393; in CA, (714) 662-5600.

Circle No 368



INTERFACE ADAPTER

The monolithic CMOS R65NC22 provides 68000-based systems with two 16-bit counters, one serial bidirectional port, and two 8-bit bidirectional parallel I/O ports. Other fea-5V tures include operation. TTL-compatible control lines, an expanded handshake capability that allows positive control of data transfers between the processor and peripheral devices, and latched input and output registers on both I/O ports. Commercial- and industrial-temperature versions are available in a 40-pin plastic or ceramic DIP or a 44-pin PLCC. Including a 5-year warranty, \$5.20 (1000).

Rockwell International Corp, Box C, Newport Beach, CA 92658. Phone (714) 833-4700.

Circle No 369

FIFO MEMORIES

The SSL7401-SSL7404 family comprises four BiCMOS FIFO memories that are suitable for use in high-speed communications and controller applications, as buffers between digital systems with widely differing bit rates, and as A/Dconverter buffers. All parts offer a 50-MHz throughput rate, a 15-nsec data-access time, a 2-nsec data-setup time, and a 1-nsec data-hold time. Each device is expandable in width and depth and conforms to industry-standard pin configurations: SSL7401, 64×4 bits in a 16-pin DIP; SSL7402, 64×5 bits in an 18-pin DIP; SSL7403, 64×4 bits with output enable in a 16-pin DIP: and SSL7404, 64×5 bits with output enable in an 18-pin DIP. Products come graded for 10-, 15-, 25-, 40-, or operation. 50-MHz 50-MHz SSL7401, \$68.18 (100).

Saratoga Semiconductor, 10500 Ridgeview Ct, Cupertino, CA 95014. Phone (408) 864-0500.

Circle No 370

QUAD POWER DRIVER

Combining NAND logic gates and high-current bipolar outputs, the UDN-2540B power and relay driver provides an interface between lowlevel signal-processing circuits and power loads to 350W. In the On state, each of the four independent outputs can sink as much as 1.5A. In the Off state, the drivers can withstand at least 60V. Internal clamp diodes and a minimum 35V sustaining voltage allow the use of these drivers with many inductive loads. Applications include relay and solenoid drivers and dc stepping-motor drivers. \$0.97 (1000). Delivery, eight to 12 weeks ARO.

Sprague Electric Co, Box 9102, Mansfield, MA 02048. Phone (617) 853-5000.

Circle No 373

FM RECEIVER

A narrowband-FM, dual-conversion low-voltage (2V) receiver, the MC3362 IC incorporates all essential VHF-receiver functions from the antenna input to the audio preamp output. The chip handles RF inputs as high as 180 MHz, or over 400 MHz if you provide the first local-oscillator signal externally. It consumes between 6 and 35 mW and features dual-conversion circuitry, a

PHILIPS IR LED'S SPEED AND ENDURANCE

INTRODUCING THE FASTEST, LONGEST LASTING INFRARED LED EVER MADE.

Still going strong after 10,000 hours. Philips brings you the world's first infrared LEDs based on a single heterojunction gallium aluminum arsenide technology. A new technology that allows them to operate at 80% of their initial intensity after 10,000 hours of continuous operation. When you get that kind of longevity in your remote controls, why settle for anything less?

New technological advantages; Faster response (50ns). Complementary technology for use with existing circuits. Ability to operate at low and high currents makes them well suited to carrier frequencies up to 1MHz. 830nm emission wavelength for standard photodiodes and transistors, 740nm for integrated photoreceivers. Available in 3mm, 5mm and flat pack packages. In stock now.

GET THE JUM Call (401) 232-050 tion on how to ob specifications on infrared LEDs.	P ON YOUR 0, ext. 267 or yo otain free pro- our new heter	write for informa- duct samples and rojunction GaAlAs EDN 121087
Name		
Title		
Company		
Address		
City	State	Zip
Telephone/ext		



Amperex Electronic Corporation, George Washington Highway, Smithfield, RI 02917, (401).232-0500. In Canada: Philips Electronics Ltd., 601 Milner Ave., Scarborough, Ontario M1B 1M8, (416) 292-5161

PHERED AND ENDORANDE



NTRODUCING THE FASTEST, LONGEST LASTING MUTRARED LED EVEN MADE.

Skill gridge strang after 10,000 hours. Philips brings can the workl's bust mirriged for a used on a suglemetropurctor griften duminan anomide rechnology. A new technology the allows therm to operate at 60% of them initial intensity over 10,000 hours of continuous querated. When you get that lefted of hergewity in your space's controls, why settle for any time less?

New technicogical advantages, ja un response (Sons). Complementary technology is use with existing carcuits. Ability to one sheat low and high of times makes them wells solled for arries trogoen one of to (Mills: \$300 vm emission available for standard phosedboles and them was. 480mm for integrated resources was table in Soum Saum and flat pack packages in stock pack

NUTRENADO RUDT NO SMUC DAT TOO

ad (2012) 2010 00 ost 257 or white for an annoear on how to black free product sectors and reconcisions output now hole of writing a man named f. B.Lis.

which which show there over many show that and and the

Mainse____

And a second second second

- Annaplation

Tratamonicalist

5411Hd

Amperes Electronic Corporation, Cercage Washington Highway, Smithfeld, R102017 (401)232-0300 In Canada Philips Electronics Ltd., Oth Milner Ave., Scarborough, Ontario M11B 1M8 (416) 202-0300

Our new X.25 Link Level Controller opens new lines of communications.

Announcing the MK5025 X.25 Link Level Controller, the CMOS device that provides complete Link Level data communications control in a single-chip. Our monolithic design saves you months of programming time and valuable board space.

Fluent in X.25 LAPB, ISDN LAPD, X.32, and X.75, the MK5025 also features a transparent mode making it compatible with other HDLC protocols. And it can be used with virtually all of the popular 8 and 16-bit microprocessors.

At up to a 7 Mbs transfer data rate, it's one of the fastest controllers available, performing in systems clocked up to 10MHz. Internal DMA and buffer control of independent receive and transmit memory rings provide high-speed data packet transfers. And for quicker diagnostics in complicated systems, 25% of the MK5025 ROM code is dedicated to a BIST (built-in self test) feature.

Available in a 48-pin DIP, the MK5025 shares a similar pin-out with our Ethernet controller, making future design for both LAN and wide area network implementations easy. In addition, a 52 PLCC package is planned.

So if you have a data communications control project you'd like to simplify – from central office and packet switching to PBX and point-topoint communications – call us at 214/466-6316. Or write SGS-Thomson, 1310 Electronics Drive, Carrollton, Texas 75006, MS2205.



Three loop back features simplify system troubleshooting.



U.S. and Canadian Sales Offices

Western Area:

Santa Clara, CA 408/970-8585 Irvine, CA 714/250-0455 Woodland Hills, CA 818/887-1010 Seattle, WA 206/632-0245 Longmont, CO 303/449-9000 Tigard, OR 503/620-5517

Eastern Area:

Burlington, MA 617/273-3310 Mariton, NJ 609/596-9200 Huntsville, AL 205/830-9036 Poughkeepsie, NY 914/454-8813 Dublin, OH 614/761-0676 Norcross, GA 404/447-8386

Central Area:

Carrollton, TX 214/466-8844 Schaumburg, IL

312/397-6550 Austin TX

512/451-4061

Canada

Brampton, Ontario 416/454-5252 Western Canada 503/620-5517

LEADING MANUFACTURERS RELY ON GENNUM IC's



WORLDWIDE.

WE DEVELOPED THE SCIENCE OF LISTENING

Listening to the needs of our customers has always been our philosophy at Gennum Corporation. That's the reason leading OEM's in Japan and 17 other countries listen to our experts.

For 15 years we have manufactured specialty linear IC's without compromise in quality or service. From masking and silicon diffusion to chip packaging, our products are produced inhouse, allowing us to monitor and maintain our high standards of excellence.

Our lineup of special application products includes high frequency power supply controller

P.O. Box 284 Buffalo, N.Y. 14220 Toll Free: 1-800-263-9353



GENNUM

IC's, AGC amplifiers and video switches. We are the leaders in applications requiring low power IC's like audio and operational amplifiers operating down to 1.0V.

Custom and semicustom play an important role in our business. Depending on your needs we can draw from our complete range of ASIC products and services.

We have developed an RF monolithic capability for applications up to 500 MHz, including high linearity amplifiers. We would like to listen to **your** needs. Call or write for our free brochure.

> P.O. Box 489 Station ''A'' Burlington, Ontario Canada L7R 3Y3 (416) 632-2996 Telex: 061-8525 Fax: (416) 632-2055

CIRCLE NO 165

GENNUM CORPORATION IS AN LTI COMPANY

Integrated Circuits



received-signal-strength output, and a data-slicing comparator that allows recovery of FSK data at rates as high as 30k bps. The operating temperature range is -40 to $+85^{\circ}$ C. \$1.80 (100).

Motorola Inc, Box 52073, Phoenix AZ 85072. Phone (602) 897-3842.

Circle No 371



FILTER

You can configure the XR-1020 as one of 10 filters that can characterize telephone lines and other telecommunications links. It conforms to the IEEE standard 743/Bell Systems technical reference 41009 and the CCITT (International Consultative Committee for Telephony and Telegraphy) Series 0 recommendations. The device requires only external 3.579-MHz-crystal and digital control inputs. The repertoire of filter functions includes a C-message and a C-notch filter, a psophometric filter, and an 825-Hz notch filter. The device also functions as a program-weighting filter, 3- and 15-kHz flat filters, a 1-kHz bandpass filter, the lowpass portion of a 50kbps filter, and a peak-to-average ratio filter. It has a power-down mode for battery-powered operations and comes in a 28-pin ceramic DIP. \$63 (100).

Exar Corp, Box 3575, Sunnyvale, CA 94088. Phone (408) 732-7970. TWX 910-339-9233.

Circle No 374

CMOS EEPROMs

The 38C16 (2k×8-bit) and 38C32 (4k×8-bit) CMOS electrically erasable PROMs (EEPROMs) offer 35nsec access times. This speed matches that of traditional bipolartype PROMs. The EEPROMs offer low power consumption (350 mW) and in-circuit programmability. The key features include a guaranteed 10k erase/write cycles/byte (1M cycles typical), a 50-msec chip erase, 5V operation, and power up/down protection circuitry. In addition, the chips have data-bar polling, a 20nsec chip-enable output time, a JEDEC-approved pinout, and a latched timer that allows an automatic byte-erase before write. The 38C16 comes in a 24-pin ceramic DIP, and the 38C32 is available in a 28-pin ceramic DIP. Both models are also available in a 32-pin chip carrier. 38C16, \$27; 38C32, \$38 (100).

Seeq Technology Inc, 1849 Fortune Dr, San Jose, CA 95131. Phone (408) 432-9550.

Circle No 372

A/D CONVERTER

The ADC1600-2 A/D converter performs a 16-bit conversion in just 2 μ sec. Its internal sample/hold amplifier requires another 2 μ sec, bringing the conversion time for the combination to 4 μ sec max. The separately controlled, byte-wide, 3state outputs allow interface to an 8or 16-bit data bus. The package is a $3.576 \times 5.50 \times 0.062$ -in. module that has EMI shielding on five sides. The device operates with 5V and $\pm 15V$



supplies and consumes 7.65W typ. \$1120 (100).

Intech Advanced Analog, 2270 Martin Ave, Santa Clara, CA 95050. Phone (408) 988-4930. TWX 910-338-2213.

Circle No 375



SUPPLY MONITOR

The S2862 power-supply monitor can detect positive or negative transients that appear on any one of the three power-supply voltages it monitors simultaneously. The device contains three window comparators with external resistor-programmable switch points, a 2.5V bandgap reference, a hold comparator, and four open-collector output drivers. All four drivers turn on (low) when the chip detects a fault on any of the three supplies, and they remain low for an interval determined by an external hold capacitor. You can set thresholds within 1.25% of desired values. Available in a 16-pin DIP or SO (small-outline) package, the device operates with supply voltages in the range from 4.3 to 16V. \$3.20 (1000).

Siltronics Ltd, 436 Hazeldean

Integrated Circuits

Rd, Kanata, Ontario K2L 1T9, Canada. Phone (613) 836-5003. TLX 0533936.

Circle No 376



DSP EEPROM

The DSP320EE12 is the industry's first monolithic digital-signal-processing µP that includes EEPROM, according to the manufacturer. Operating at 20.5 MHz, the CMOS device is pin compatible with the standard 32010, and it runs software written for that μP . The EEPROM's ability to accept and store new commands enables the chip to fine-tune its performance without intervention by an operator. Applications for it include intelligent FIR filters, adaptive LANs, equipment diagnostics, and instrument self-calibration. The device features an 8- and a 16-bit data interface, special operating modes for improved factory testing, the capability for reprogramming on a standard PROM programmer, and an inhibit circuit that prevents inadvertent data writes during powerup or supply glitches. Security mechanisms prevent unauthorized internal or external access to the EEPROM code. \$100 (100).

General Instrument Microelectronics, 2355 W Chandler Blvd, Chandler, AZ 85226. Phone (602) 963-7373.

Circle No 377

VIDEO BUFFER

The hybrid LH4002 is a unity-gain buffer amplifier that can drive 50Ω and 75Ω loads at frequencies greater than 200 MHz. The device is suitable for video distribution, for impedance transformation, and for increasing the output-current capability of conventional op amps. Intended for operation with $\pm 5V$ supplies, the buffer provides a 1000V/µsec min slew rate, 2° phase linearity (from 1 to 20 MHz), and less than 0.1% distortion. The LH4002 is pin compatible with the industry-standard LH0002, and it comes in a 10-pin plastic DIP or an 8-pin TO-5 metal can. The plastic DIP has better heat transfer than the metal can, providing a thermal impedance of 120°C/W (vs 125°C/W for the metal can). MIL-processed versions are available. From \$9.50 (100).

National Semiconductor Corp, Box 58090, Santa Clara, CA 95052. Phone (408) 721-5856. TLX 346353. Circle No 378



SCSI CONTROLLER

You can directly substitute the L5380 asynchronous SCSI-controller chip for existing devices without modifying your circuit board. Substituting the CMOS part gives you 2.5 times the speed (4M bytes/sec) and one tenth the power dissipation (75 mW typ) of the NMOS device it replaces. The L5380 implements the asynchronous SCSI interface as defined by the ANSI X3T9.2 committee in the X3.131-1986 document. Further, the part works in both the initiator and the target modes, so you can use it in both the computer and the disk drive. It comes in a 40-pin plastic DIP or a 44-pin PLCC and is graded for 2- or 4-MHz operation. 2-MHz version in a DIP, \$8.53; 4-MHz version in a PLCC, \$18.71 (100).

Logic Devices Inc, 628 E Evelyn Ave, Sunnyvale, CA 94086. Phone (408) 720-8630.

Circle No 379



OP AMP

The AD9610 is a hybrid transimpedance op amp. Using current feedback instead of voltage feedback, the amplifier provides bandwidth that is relatively independent of closed-loop gain: 100 MHz at unity gain, 95 MHz at a gain of -10, and 75 MHz at a gain of -20. In addition, different gains have little effect on the op amp's 3.5-nsec rise and fall times, its 18-nsec settling time (to within $\pm 0.1\%$), and its 3500V/µsec slew rate. Laser trimming reduces the input offset voltage to ± 0.3 mV; the V_{os} drift is 4 μ V/°C. The equivalent input noise over the frequency range from 5 to 150 MHz is 0.7 nV/ $\sqrt{\text{Hz}}$ typ and 23 pA/\sqrt{Hz} typ.

The amplifier has internal frequency compensation and an internal 1.5-k Ω feedback resistor; you add one resistor to set the closedloop gain. The AD9610 comes in a 12-pin TO-8 metal can, operates with ±15V supplies, and dissipates 630 mW typ. Industrial-tempera-

Harris guarantees ASICs to specs <u>after</u> irradiation! (There — we put it in writing!)

We're hard-liners about reliability in rad-hard ASICs.



Hey...it happens to the best of 'em...your rad-hard ASIC design's first pass requires first aid!

For better results, avoid rigid design systems that lock you into the wrong solution and keep you there. Come to Harris: nobody offers you more front-end flexibility.

- Advanced rad-hard library...Primitives, 7400 and 4000 equivalents, 80C86 peripherals — cells and macros you can intermix to enhance design
- Broad workstation support...Simulations include both pre- and post-radiation performance models. Our UNIX-based software and library are supported on Daisy[™], Mentor[™], and SDA[™] design stations

with Silicon Compilers due soon

- Guaranteed parametrics...Harris can guarantee your ASICs to specs after irradiation exceeding 1 megarad
- **Packaging options...**Select from ceramic DIPs, chip carriers and pin grid arrays; screenings to Class S standards
- More on the horizon...Soon, JEDEC functions and scan-path testability will further enhance your design flexibility

So what does it all mean? More ASIC design options. Less design risk. For a faster time to market, it's time to call Harris Custom Integrated Circuits Division. In U.S. phone

1-800-4-HARRIS, Ext. 1910, or (305) 729-5757. In Canada: 1-800-344-2444, Ext. 1910.





Trademarks: Daisy: Daisy Systems Corp. Mentor: Mentor Graphics SDA: SDA Systems Inc. ©1987, Harris Corporation

NEW SONY/TEK CURVE TRACERS

NEW POWER. FAMILIAR 1 you get hardcopy

Three thousand

watts. The new 371 handles it easily-without requiring a heat sink. You'll calculate and display both DC (H_{FF}) and small signal (H_{fe}) beta, and ON resistance. Test power MOSFETS, gate turnoff thyristors, IGO, power diodes, insulate gate bipolar transistors and more.

Push-button hardcopy and program-mability. With the 370 and 371

RANGE 370 Max Peak Voltage Peak Current Pulsed Max Peak Power 3000W Price \$17325 \$19950

bility, quality, and support. To learn more, contact your local Tek representative, or call 1-800-835-9433, ext. 170.

while you work-

no waiting. Get more done too

with new programmability-

rugged design. Like the

Familiar front panel,

371

-400A

standalone or over the GPIB.

hardworking 576, the new 370

and 371 come with Tek relia-



CIRCLE NO 39

ICs

ture version, \$49.88; military-temperature version, \$79 (100).

Analog Devices Inc, Box 9106, Norwood, MA 02062. Phone (617) 329-4700. TWX 710-394-6577. **Circle No 380**



SMPS IC

The TDA-4918 and -4919 are switchmode power-supply control ICs for push-pull and single-ended driver outputs, respectively. Their output stages are optimized for driving MOSFET power transistors, sinking a current of 1A to turn the MOSFET off, and sourcing 300 mA to turn it on. This asymmetrical drive current helps to match the turn-off and turn-on times of the MOSFET, so that the MOSFET switching is symmetrical, even at clock frequencies as high as 200 kHz.

The ICs have an integral frequency generator that operates to frequencies as high as 300 kHz. In addition, the ICs have three on-chip comparators that monitor the supply's output for overvoltage and undervoltage conditions and provide dynamic current limiting. The ICs also provide soft-start facilities. The maximum supply current to the devices in standby mode is 2 mA. The TDA4918 comes in an 18-pin DIP; the TDA4919 is housed in an SO-20L surface-mount package. \$2.50(1000).

Siemens AG, Zentralstelle für Information, Postfach 103, 8000 Munich 1, West Germany. Phone

ICs

(089) 2340. TLX 5210025. Circle No 387 Siemens Components Inc. 2191 Laurelwood Rd, Santa Clara, CA 95054. Phone (408) 980-4500. Circle No 388



MICROCONTROLLER

In addition to the 80C51's usual onchip functions, the PCB83C552 CMOS microcontroller includes an 8-channel analog multiplexer, a 10-bit, 50-µsec A/D converter, two PWM outputs, additional parallel I/O ports, an additional timer/counter, and an I²C-bus interface. It retains the 80C51's internal architecture and instruction set.

In total, the microcontroller has six 8-bit parallel I/O ports, several of which function either as conventional I/O ports or as control inputs and outputs for the chip's additional functions. The two PWM outputs have dedicated output pins, and you can control a repetition frequency, common to both outputs, in the range of 92 Hz to 23.5 kHz for a clock frequency of 12 MHz. You can then define the mark/space ratio for each individual output in the 0 to 1 range, with 8-bit resolution. Only simple external filtering is required to derive analog outputs from the PWM outputs. You can arrange for the on-chip timer to automatically set, reset, or toggle certain I/O bits, and to generate interrupts.

The 83C552 has a 15-source, 2level interrupt structure and incorporates the 80C51 instruction set; a watchdog timer detects program crashes. The microcontroller has an 8k-byte on-chip program ROM and a 256-byte on-chip RAM, both of which are externally expandable to

NEW SONY/TEK CURVE TRACERS

NEW RELIABILITY. CLASSIC LINE.

Durable, strong, and

hardworking. Like their predecessor, the 576, the new 370 and 371 deliver day-in, day-out dependability. But they bring you much more than that.

Smooth, fast, and power-

RANGE

Price

ful. Both the 370 and 371 have an easy-to-use front panel and time-saving features like no-wait

hardcopy, pushbutton sequenc-

370 Max Peak Voltage 2000V Peak Current Pulsed 20A Max Peak Power 220W 3000W \$19950

371

ing, and standalone or GPIB programmability. And the 371 can handle up to 3000 watts.

Part of a truly classic line. The 370 and 371 combine the best of what's new with what's proven—including the Tektronix commitment to industry-leading service and support. To learn more, contact your local Tek represen-

tative, or call 1-800-835-9433, ext. 170. 400A



Integrated Circuits

64k bytes. The 83C552 is packaged in a 68-pin plastic leaded-chip carrier. A ROMless version is also available. Approximately DM 26 (10,000).

Philips, Elcoma Div, Box 523, 5600 AM Eindhoven, The Netherlands. Phone (040) 757005. TLX 51573.

Circle No 395 Signetics Corp, 811 E Arques Ave, Sunnyvale, CA 94088. Phone (408) 991-4571.

Circle No 396



PHONE ICs

The MTC-2083 telephone IC incorporates a DTMF/pulse repertory dialer that supports on-hook dialing, and speech circuits that provide 4wire/2-wire conversion and background-noise reduction. It also contains line impedance matching and load/gain regulation circuitry so that it provides all the functions necessary to interface telephone sets with PSTN or PABX networks. The speech circuit incorporates an additional receive amplifier that you can use either to drive a loudspeaker or to increase the receiver gain in phones made for people who are hard of hearing.

For the PABX or central-office end of the line, the MTC-6042 provides a single-chip solution to many of the Borsht functions of the subscriber-line interface. These functions include a high- or low-ohmicvalue battery feed, overpower, and 2-wire/4-wire conversion circuitry, and supervisory functions that monitor hook-switch status, ring-trip, and ground-wire conditions. The MTC-6042 also has a driver for relay-operated or electronic ringingsignal injection circuitry. MTC-2083 and MTC-6042, approximately £1.55 and £3, respectively (OEM qty).

Mietec, Westerring 15, B-9700 Oudenaarde, Belgium. Phone (055) 332211. TLX 85739.

Circle No 397

16-BIT μP

Suitable for application in industrial equipment control and office automation, the HD641016 16-bit μ P has a RAM-based architecture that joins register and memory storage in a 1k-byte array. The chip's multiple programmable register banks (sixteen 32-bit registers) alleviate the context-switch bottleneck encountered during subroutine jumps and during switching between interrupts. In response to an interrupt, the μ P can execute a bank-switch instruction in less than 1 μ sec.

It also features a 1k-byte RAM that's used for general-purpose CPU registers and for high-speed data memory; a 4-channel DMA controller; a 16-bit, 2-channel timer; a 2-channel ASCI interface; an interrupt controller with 22 internal interrupt sources; a memory-access controller; and a clock generator. Intended for running C-language programs, the HD641016 is supported by a real-time in-circuit emulator and a complete development and debug system. It comes in an 84-pin PLCC or plastic pin-grid array. \$75 for a sample. The IC will be available in the first quarter of 1988.

Hitachi America Ltd, 2210 O'Toole Ave, San Jose, CA 95131. Phone (408) 435-8300. TLX 171581. Circle No 382

D/A CONVERTER

The ZN559 is a μ P-compatible 8-bit D/A converter with an on-chip 2.5V bandgap reference. After a full-scale output change, the output settles to $\frac{1}{2}$ LSB typically within 1.25

μsec. The typical settling time for a 1-LSB output change is 800 nsec. The maximum linearity error is ±1 LSB, and maximum differential nonlinearity is ±³/₄ LSB, with monotonicity guaranteed over the full operating temperature range. The maximum zero offset is 6 mV, and the full-scale output is typically 2.55V with a full-scale output temperature coefficient of 2 ppm/°C.

On-chip latches with TTL/CMOScompatible inputs allow you to load 8-bit parallel data into the device under the control of a latch-enable input. The ZN559 operates from a single 5V supply and typically consumes 20 mA of supply current. It's available in a 16-pin DIP that operates over the commercial or military temperature range, or you can order it in an SO-16 surface-mount package that operates over the commercial temperature range. \$2.98 (100) for commercial-temperaturerange devices.

Ferranti Electronics Ltd, Fields New Rd, Chadderton, Oldham OL9 8NP, UK. Phone 061-624-0515. TLX 668038.

Circle No 391 Ferranti Electric Inc, 87 Modular Ave, Commack, NY 11725. Phone (516) 543-0200. TLX 6852104.

Circle No 392

GATE ARRAYS

The MAF Series gate arrays employ a 1.2- μ m, silicon-gate CMOS technology to achieve typical gate delays of 1 nsec—making the devices suitable as low-power replacements for bipolar PLDs. Gate complexities range from 250 to 1200 gates. Typical power dissipation for the 1000-gate array, operating from a single 5V supply at a clock speed of 10 MHz, is around 250 mW.

Because they are architecturally the same as the company's MA Series gate arrays, you can use the same design tools and libraries that are supplied for the MA Series. Software that allows you to develop

DRAMATIC! Now...Highest speeds AND production... 60/70/80ns 1Mb AND 256K DRAMS...

Exclusively from NMB Semiconductor - the high speed DRAM specialist - we've broken the speed barrier with FutureFast[™] 256K and 1Mb DRAMS...first with access times of 60/70/80ns. This means designers can now have true "0" wait state systems without using complex, expensive cache memory techniques.

1Mb	DRAM /	Access	Time (ns)	256K	DRAM	Access	Time (ns)
		Corr	petitors				Com	petitors	
	NMBS	814			NA	IBS			
60ns	80ns	100ns	120ns	140ns	60ns	80ns	100ns	120ns	140ns

We've broken the delivery barrier too. NMBS offers much higher volume production than our competitors. These dramatic advances are made possible in the most advanced CMOS/VLSI plant in the world optimized for volume production of high speed DRAMS. With computerized operation and robot control in Class 1 ultra-clean rooms. Plus state-of-the-art design, processing and testing.

	Prod	uct Line Su	mmary			
Series*	Access Time	Organization	Package**	Availability		
AAA2800 256K	60/70/80 (ns)	256Kx1	P-DIP PLCC C-DIP	Production Production Production		
AAA1M100 1Mb	100/120 (ns)	256Kx4 1Mbx1	P-DIP SOJ ZIP	Production Production Production		
AAA1M200 1Mb	60/70/80 (ns)	256Kx4 1Mbx1	P-DIP SOJ ZIP	2Q88 2Q88 2Q88		

Available in the packages and organizations designers want for high performance projects.

More good news. We're now shipping qualification samples of our new 1Mb DRAM.

So for complete specs, evaluation units, quantity prices and delivery call NMBS - the high speed DRAM specialists - today. Prove to yourself that with FutureFast[™] DRAMS, your future is now.

いたい NMB SEMICONDUCTOR CORPORATION

11621 Monarch Street•Garden Grove, CA 92641 Telephone: (714) 897-6272 FAX: (714) 891-0895•TLX: 67-8486



UREFAS



BBC has the appropriate module for your equipment. A wide variety of functional building blocks are manufactured with SCR's, Transistors and Diodes. Industry standard circuits are integrated into module packages with an electrically isolated base.

- Glass passivated chips result in long term electrical stability
- High thermal cycle capability results in high reliability
- Compact package requires less space

For Applications Engineering assistance or more information, please contact

RMC, Power Semiconductor Division A member of the Brown Boveri Group 2150 West 6th Ave Broomfield, CO 80020 (800) 992-0312



704187E

DHL

ICs

designs on a range of computers and workstations, including the IBM PC, Daisy workstations, or VAX computers, is available.

The package options include DIP and surface-mount packages, and pin-grid arrays. Packages can have as few as eight or as many as 68 pins. 40-pin plastic DIP, from \$2.30 to \$4.30 (100), depending on gate complexity.

Matra-Harris Semiconducteurs, Centre de Guyancourt, 38 Blvd Paul Cezanne, BP 309, 78054 Saint-Quentin-Yvelines Cedex, France. Phone (1) 30607000. TLX 697317.

Circle No 398



HIGH-SIDE DRIVER

Targeted at automotive applications, the L9801 high-side driver suits 12V/6A, inductive or resistive load-switching applications where one side of the load is connected to ground. It is manufactured with the company's Multipower-BCD process. The chip incorporates a DMOS power transistor having an R_{ON} of 0.08 Ω , and it includes on-chip control, diagnostic, and protection circuitry.

The driver is suitable for lamp switching because it limits the inrush current to 25A, using a linear technique, which does not generate EMI. It has a TTL/CMOS-compatible control input and an open-drain diagnostic output, which is activated when output short-circuit, open-circuit, or overvoltage conditions occur, or when the device goes into thermal shutdown. The L9801 is housed in a 5-lead Pentawatt package with the tab connected to the ground terminal. Approximate-

EDN December 10, 1987

CIRCLE NO 33

The Ultimate Complement

EDN magazine for technology in depth. EDN News for news of products, technology, and careers.

Contract assemblers offer SMT services

suits DSP tasks

Together, they provide complete coverage of electronics for engineers and engineering managers worldwide.

EDN MAGAZINE/EDN NEWS Cahners Publishing Company • 275 Washington Street • Newton, MA 02158-1630 • (617) 964-3030 EDN December 10, 1987



Don't be foiled when you need both CMOS and NMOS E²PROMs.

If you're designing with highdensity E²PROMs, you've just met your match. Because with Xicor's 256K CMOS E²PROMs, now you can more easily match your system's power needs. And with our 256K NMOS E²PROM parts, you can optimize your budget requirements.

Cut design cycles down to

size. Compared with alternative solutions, Xicor 256K E²PROMs reduce design complexity and simplify interface tasks. They're fullfeatured, 5V only nonvolatile devices, ideal for applications where *field reprogrammability* and ease of use are critical. In convenient, byte-wide 32K organizations, these parts deliver effective byte write times of 78 µsec, in 64-byte page mode operation. In addition, DATA Polling or Toggle Bit schemes can be used to detect the early completion of a write cycle.

Safeguard data integrity with Software Data Protection. To prevent inadvertent writing to the device during power-up, powerdown or any unexpected condition, Xicor's 256K E²PROMs include Software Data Protection — pioneered by Xicor. This JEDEC-approved feature eliminates the need for external hardware protection.

Back your designs with

Xicor. Our CMOS and NMOS E²PROMs score extra points for design freedom, too. They're volume-manufactured in JEDECapproved 28-pin DIPs, and 32lead LCC or PLCC configurations for surface mounting. Plus they come in commercial, industrial and military temperature ranges. And we back them with onsite technical design support.

So if you're adding up the price and performance of 256K E²PROMs, check with Xicor. We're the only supplier who can help you settle the score — in both CMOS and NMOS. Call (408) 432-8888 today, or write: Xicor, Inc., 851 Buckeye Court, Milpitas, CA 95035.



Integrated Circuits

ly \$3 (1000).

Olivetti 2, 20041 Agrate Brianza. Italy. Phone (039) 65551. TLX 330131.

Circle No 399 SGS Semiconductor Corp. 1000 E Bell Rd, Phoenix, AZ 85022. Phone (602) 867-6100, TLX 249976. **Circle No 400**



COMM CHIP SET

The ZN1440 chip set performs all the common signaling and error-detecting functions required in a 2.048M-bps, 30-channel PCM transmission link. All the devices conform to the appropriate CCITT rec-The **ZN1440E** ommendations. simultaneously and asynchronously codes and decodes data to and from the HDB3 format used on the link and detects any coding errors.

At the transmission end of the link, the ZN1444E generates a synchronizing word and injects it into the PCM data highway during time slot 0 of alternate transmission frames. At the receiving end of the link, the ZN1445E detects the frame synchronization word and synchronizes the receiver. It also flags synchronization errors. The ZN1446E operates at either end of the data link, transmitting or receiving signaling information during each frame's time slot 16. It accepts information in either binary or AMI format.

All the devices operate from a single 5V supply, and all their relevant inputs and outputs are TTL compatible. They are available in either ceramic or plastic 16-pin DIPs and are pin and function compatible with corresponding MJ1440 Series devices. ZN1440E, \$6.20; ZN1444E, \$10.18; ZN1445E, \$6.20; ZN1446E, \$7.38 (1000).

Ferranti Electronics Ltd. Fields SGS Microelettronica SpA, Via C New Rd, Chadderton, Oldham OL9 8NP, UK. Phone 061-624 0515. TLX 668038.

> **Circle No 402** Ferranti Electric Inc. 87 Modular Ave, Commack, NY 11725. Phone (516) 543-0200. TLX 6852104.

> > **Circle No 403**

THYRISTORS

Suitable for use in power-conversion equipment operating at power levels between 10 kW and 1 MW, ZTO (zero turn-off time) thyristors allow you to design high-power choppers and inverters that operate at frequencies in excess of 20 kHz, and resonant converters that operate at 50 kHz or more. The initial offerings include the ZT340 and ZT570, which have peak forward current ratings of 400 and 700A at 20 kHz, respectively. Both devices are available

with blocking voltage ratings as high as 1600V. The company plans to extend the range to 2000A/2500V devices in 1988.

ZTO thyristors are gate-assisted turn-off devices that require only small commutation components and simple gate-drive circuitry. The advantages over GTO (gate turn-off) thyristors include a maximum controllable current approximately 10 times greater than that of a similarsized GTO, and no minimum on-time or off-time requirement In addition, because the anode current falls to zero before the anode voltage starts to increase, turn-off switching losses are small. As a result, you can use ZTO devices at higher frequencies than GTOs. From \$200 to \$300 (1000).

Thomson Semiconducteurs, 43 Ave de l'Europe, 78140 Velizy, France. Phone (1) 39469719. TLX 204780.

Circle No 401

STANDARD AND CUSTOM **OPTICAL SWITCHES**

100 STANDARD VARIATIONS

- Direct Honeywell and TRW replacements.
- Analog, TTL, DTL, and CMOS interface
 Pin or Wire leads.
- Complete CUSTOM Capabilities.
- Dock-To-Stock certified.
- Statistical Process manufacturing Control.
- Prompt and Courteous customer service.

For over 20 years HEI has designed and built optical switches and assemblies to the strictest of specifications

CALL FOR OUR NEW CATALOG 612-443-2500

IElinc

Optoelectronics Division P.O. Box 5000 1495 Steiger Lake Lane Victoria, MN 55386



Introducing The World's Most Advanced Power Supply Control IC.

The CS-320 from Cherry Semiconductor Corporation

The CS-320. A power supply control IC so advanced it is the first to provide for unconditionally stable Hysteretic control.

The CS-320. A power supply control IC so advanced it is the world's first to offer power supply designers the option of working in any one of three modes of control: Hysteretic, Constant-Off-Time or Conventional (constant frequency).

The CS-320. A power supply control IC so advanced it offers better short circuit protection than any other control chip in the world. Load Current Demand and Inductor Current Responses



Three Types of Control

The CS-320 offers power supply designers greater range and flexibility. While conventional control can be used, Hysteretic and Constant-Off-Time are both superior. Conventional control does **not** instantaneously respond to load current demand. Hysteretic and Constant-Off-Time control, by comparison, **do** provide instantaneous response, which guarantees that the power supply will remain well-controlled and stable.



Cherry Semiconductor Corp., 2000 South County Trail, East Greenwich, RI 02818 (401) 885-3600 FAX (401) 885-5786 Telex: WUI6817157

Output Voltage Response to a 5:1 Load Change.

5 volt output	
	20 mV
	5 amp load
1 amp load	
- unip iouu	

Unconditional Stability.

Hysteretic control directly controls both the peak and valley inductor current. Additionally, slope compensation is not required. A power supply using Hysteretic control is free from subharmonic oscillation and is unconditionally stable. Figure 2 shows the response of a CS-320 controlled Hysteretic DC-DC converter to a 5:1 variation in load current.



Unconventional Control of Short Circuits

The unique (patent pending) circuitry of the CS-320 prevents current runaway at or near short circuit conditions during high frequency operation.

All of these advances can be working for you, plus operation at up to 1MHz, flexible current sensing, use in parallel operation of converters without master/slave designation, and Under Voltage Lockout with a choice of start/stop thresholds.

Excellent Application Support

Cherry Semiconductor is a leading producer of power supply control ICs. In addition to product innovation, CSC is recognized for helping customers to anticipate problems, arriving at workable solutions, and effectively integrating CSC ICs into end product designs.

Call or write for more information.

WE'VE REDUCED THE COVER CHARGE ON EPROMS.

Our new plastic One-Time-Programmable CMOS EPROMs hand you ceramic performance at less than two-thirds the cost.

You'll get everything you expect from ceramics except the price. And you'll also get the versatility only plastic delivers.

Because, unlike fragile ceramics, our advanced plastic packages stand up to automated assembly. And you know what that can mean to manufacturing costs. Not to mention system reliability.

Of course, there's also the inherent benefit of OTPs. You can order as many as you want to minimize unit cost, but you only have to program what you need immediately. You can make last-minute code decisions without wasting inventory. Our plastic OTPs are CMOS, so they run

cooler than NMOS ceramics. And, they're available in densities that let you upgrade your system without changing your design: 128K, 256K, 512K, and soon, 1Mb. All 100% pin and plug compatible with the ceramic EPROMs you're using now.

You won't have to sit on your hands waiting for delivery, either. We have plenty available, right off the shelf.

Call our Hot Line today at (800) 556-1234, Ext. 82; in California (800) 441-2345. You'll get great EPROM performance, without being held up for the cover charge.



FUJITSU MICROELECTRONICS INC.

Technology That Works.



Mega Module[™] Series Now up to 600 Watts

Component Solutions For Your Power System? Talk To VICOR!

INPUT	r	POWER	OUTPUT
Nominal (R	ange)	Up to 600 Watts	Nominal (Adjustable)
300 (200-400) 150 (100-200) 72 (55-100) 48 (42-60) 36 (21-56) 24 (21-32) 12 (10-20)	VDC VDC VDC VDC VDC VDC VDC	EFFICIENCY 80-90%	5 (0-5.5) VDC 12 (0-13) VDC 15 (0-16) VDC 24 (0-26) VDC 48 (0-52) VDC

VI-L00 Series up to 200W 2.5" x 4.9" x 0.62"

VI-M00 Series up to 400W 4.9" x 4.9" x 0.62"

VI-N00 Series up to 600W 7.3" x 4.9" x 0.62"

Call VICOR today for our new Catalog VICOR Corporation, 23 Frontage Road, Andover, MA 01810 Tel: 617-470-2900, TWX: 910-380-5144, FAX: 617-475-6715



Our 100 mA voltage converter has a non-magnetic personality

It's time you met our highly flexible LT1054 voltage converter. The bipolar LT1054 uses switchedcapacitor circuitry for power conversion and requires no inductors. It has several features not previously available in voltage converters.

Power conversion functions include voltage inversion, voltage doubling or negative voltage doubling. The LT1054 can be used as a simple voltage changer or with feedback to obtain a regulated output. Only two resistors are required to set the output voltage.

The LT1054 provides roughly ten times as much output current as previous voltage converters. When used as a voltage inverter, the LT1054 can supply up to 100 mA of output current with a voltage loss of only 1.1V, and it can do this over its entire input voltage range of 3.5 to 15V. Quiescent current ($I_L = OmA$) is only 2.5mA. In addition, the LT1054 can be shut down, lowering quies-

Regulating Voltage Inverter



TECHNOLOGY

TOUGH PRODUCTS FOR TOUGH APPLICATIONS. cent current under 100μ A, for battery powered applications.

The LT1054 is ideal for use in a wide variety of applications where a supply voltage is needed that is either higher, lower, or of a different polarity than what is available.

LT1054 is pin-compatible with switched capacitor voltage converters such as LTC1044 and ICL7660, and it comes in 8-pin plastic or ceramic DIP configurations. Military versions are also available.

Pricing begins at \$2.95 for the 8-pin plastic LT1054CN8, and \$3.90 for the LT1054CJ8 ceramic version, in quantities of 100 up.

For technical details on the LT1054 and a free T-shirt (featured above), just tell us your shirt size and input voltage. We'll see you get the shirt (first 5000 responses) and a datasheet. For further details, contact Linear Technology Corporation, 1630 McCarthy Blvd., Milpitas, CA 95035. Or call **800-637-5545**.

DESIGN IDEAS

EDITED BY TARLTON FLEMING

Circuit protects solenoids in dot printer

Emile Hebert

Comtrex Systems Corp, Mount Laurel, NJ

In Fig 1, chips IC_1 through IC_4 constitute a drive circuit for seven solenoids of a dot-matrix printer. Following the activation of one or more solenoids, the remaining chips (IC_5 through IC_9) protect the solenoid coils by automatically de-energizing them. (The alternative is software protection, in which the μP de-energizes the coils by asserting an all-zeros control word and another latch pulse.) Fuse F_1 provides backup protection.

During operation, the system writes a control word to the latch IC₁. The latch pulse transfers this word via the buffer IC₂ to the Darlington drivers IC₃ and IC₄, where each high input produces a low output, placing 28V across the corresponding solenoid coil. This voltage must be removed immediately after the coil-actuation time (550 µsec in this case) to avoid heat damage.

A 200-nsec pulse at the CLR input (pin 1) of latch IC_1 deactivates the coils by setting the latch outputs to zero. The circuit generates this pulse as follows:

NOR gates IC_{6A} through IC_{6C} monitor the control lines. The all-lines-low condition prevents the 250-kHz clock signal from reaching counter IC_{9A} by producing a low level at the pin-1 input of gate IC_{7D} . This gate opens when one or more control lines are high, allowing the clock signal to drive the IC_9 counters. Decoder IC_8 issues a 4-µsec pulse 548 µsec later. The leading edge of this pulse produces a 200-nsec pulse that first resets the counters and then resets the IC_1 latch, deactivating the solenoids.

To Vote For This Design, Circle No 748



Fig 1—Following a command to activate one or more solenoids, chips IC_5 through IC_9 first generate the proper coil-activation interval (550 µsec) and then deactivate the coils by producing a 200-nsec pulse that clears latch IC_1 .

Compressed amplifier improves dynamic range

Ralph Lu

Litton Applied Technology, Sunnyvale, CA

You can increase the dynamic range of an absolutevalue circuit by adding a preamplifier that reduces the



Fig 1—In this absolute-value circuit, the main amplifier's gain is 2 or -2, depending on the polarity of V_{IN} as sensed by the zero-crossing comparator within IC_1 .

comparator's minimum required overdrive. The basic circuit of **Fig 1**, for example, has a maximum V_{IN} of 5V and a minimum V_{IN} of 1.5 mV, set by the comparator (part of IC₁). The dynamic range is $20\log(5V/1.5 \text{ mV})=70.5 \text{ dB}$.

In Fig 2, the preamplifier (compressed amplifier), IC₂, has a gain of 1.1 for V_{IN} near 5V, and it has a gain of 20 for a small V_{IN}. Thus, a V_{IN} of 80 μ V, for instance, produces enough overdrive for the comparator (80 μ V×20=1.6 mV), yet a V_{IN} of 5V won't saturate the comparator's input. The resulting dynamic range is 20log(5V/80 μ V)=95.9 dB.

The comparator's time error in sensing V_{IN} 's zero crossing increases for smaller amplitudes of V_{IN} . Conversely, the significance of a given comparator error increases with frequency. For the Fig 2 circuit, dynamic range exceeds 95 dB for input frequencies as high as 1 kHz.

To Vote For This Design, Circle No 749



Fig 2-By amplifying low levels of V_{IN}, this absolute-value circuit's compressed amplifier (IC₂) adds 26 dB to the overall dynamic range.



Introducing touch-sensitive computer power for the price sensitive.

The Casio PB-1000 hand-held computer. Don't let its size fool you. When it comes to power, the PB-1000 is a real handful—with 8K bytes, in fact, which can be easily expanded to 40K, with an optional RAM pack.

Besides impressive power for its small size, the PB-1000 has an LCD large enough for 32 columns of 4 lines of data. And the screen is touch-sensitive, so you can step through programs and data with the touch of a finger. To that you can add, as a low cost option, a 3.5" floppy disk drive that includes both an RS-232C and printer port. All this has made the PB-1000 the computer of choice for many different professionals.

Business and salespeople, bankers, insurance and real estate brokers, construction engineers, auto dealerships and other small, inventory intensive businesses—they've all found the PB-



1000 to be useful for expanding productivity both in the office and in the field. And new applications are being discovered daily.

Let Casio or our VAR network show you how it can be customstructured with the appropriate hardware and software to suit your requirements exactly. The PB-1000 starts at less than \$200. So you can make the most of its handful of power, without having to reach deep into your pockets.



DESIGN IDEAS

Amp provides 100V common-mode range

Mark Stitt Burr-Brown Corp, Tucson, AZ

The unity-gain amplifier of Fig 1 can reject commonmode voltages as high as 100V. For an application that does not require galvanic isolation, this circuit is an inexpensive alternative to the conventional isolationamplifier solution.

IC₁ is a monolithic gain-of-10_difference amplifier. By reversing normal connections to the on-chip resistor network, you place 100-k Ω resistors (instead of the 10-k Ω ones) at the amplifier's input, which attenuates the normal- and common-mode signals by a factor of 10. Then, resistors R₁, R₅, and R₆ form a T network in the feedback path that boosts the normal-mode gain to unity.

Because the addition of R_5 and R_6 degrades commonmode rejection by unbalancing the internal resistor ratios, you should restore the balance by adding about 158 Ω (R_7) in series with R_3 . A fixed-value R_7 that differs by 2% from the T network's equivalent value degrades CMR by only a few dB, but note that IC₁'s CMR is already 20 dB below its specified value (100 dB min) because the amplifier is operating at a gain of 0.1 instead of 10. You can improve the CMR by using a 500 Ω potentiometer for R_7 , as shown.

The differential-gain accuracy is within 2% if you use 1% resistors for R_5 and R_6 . Adjusting the R_6/R_5 ratio can improve the gain accuracy, but calibration is diffi-



Fig 1—This amplifier offers unity gain to $E_z - E_1$ signals while rejecting common-mode voltages as high as $\pm 100V$.

cult because the gain and CMR adjustments interact. You can eliminate this interaction and improve the gain accuracy by using the **Fig 2** circuit.

In Fig 2, IC₂ preserves IC₁'s CMR by buffering the R_5/R_6 network. Again, IC₁'s gain-of-0.1 connection reduces the guaranteed CMR by 20 dB—to 80 dB min. (This CMR estimate is reliable because the IC₁ amplifi-



Fig 2—Adding an op amp to the Fig 1 circuit eliminates interaction between the gain-adjust potentiometer and the CMR-adjustment pot (not shown).

OPA501/883B

This is the only true military power op amp in the world.

Can you afford anything less for your program?

OPA501/883B is a unity-gain stable, high power operational amplifier capable of 260W peak output. It drives heavy loads, including motors, with a wide margin of safety.

Full Military Processing, Fully Certified Lines

A true military hybrid part, like the OPA501, has to be fully compliant with MIL-STD-883, Rev. C, Class B processing. And it has to be manufactured on lines which are DESC certified to MIL-STD-1772. Burr-Brown is the **only** manufacturer of power op amps who currently meets these rigorous requirements, and we hope you won't settle for anything less than the real thing.

Key OPA501/883B Features

- wide $\pm 10V$ to $\pm 40V$ supply range
- high ±10A peak output current
- high 260W peak output power
- low 2.2°C/W DC thermal resistance
- full /883C, Class B processing; other processing available, including Class S
- complete test and reliability documentation
- off-the-shelf delivery
 CIRCLE NO 154

If your systems require true military power amps, you can obtain complete details from your Burr-Brown technical rep, or contact Applications Engineering, 602/746-1111. Burr-Brown Corporation, P.O. Box 11400, Tucson, AZ 85734.

MILITARY DR/MING



EDN December 10, 1987

SMALL IS POWERFUL!

Power Tronic's new PTS Series Switching Power Modules are the smallest in the world and its compact DC-DC converters can meet the strictest requirements. What's more, they are reliable due to their innovative design, rigid quality control and powerful production, which makes them versatile enough for all OEM applications.

Power Tronic — For profitable OEM partnership.

PTA-4100 DA

PTA-4200 DA

Uniter In

PTA-4135 CF PTA-4195 CF

Summer and the

Annun mann

NEW POWER SUPPL

TS-1010BC

Taipei Office: 11/Fl., 45. Fu Shin S. Rd., Sec. 2, Taipei, Taiwan, R.O.C. Tlx: 27001-ZEKIN Tel: (02)703-5501/5

POWER TRONIC CO., LTD

PTS-10 Servies Directly mountale on PCB $93 \times 63 \times 14$ mm

PTA-4075 DF

Safety Approval: E 102868

LR 65702

CIRCLE NO 195

PTA-3050 DF

PTA-4200 CF

DC-DC Converter:

er (distinct from its thin-film resistor network) contributes only -120 dB of CMR error. Therefore, the resistor network is responsible for most of the residual CMR error that remains after laser trimming. This trim error affects CMR by about the same amount whether operating with a gain of 10 or a gain of 0.1.)

You can improve this circuit's CMR by adding 10Ω in series with R_1 (pin 2) and adding a 20Ω potentiometer in series with R_3 (pin 3). To adjust CMR, connect the inputs and drive them with a 1-kHz square wave whose amplitude is in the range from $\pm 10V$ to $\pm 100V$. (A sine wave will introduce unwelcome CMR-vs-frequency effects.) Adjust the 20Ω pot for a minimum-amplitude signal at E_0 .

As before, $1+R_6/R_5$ sets the gain. The tolerance on this expression plus $\pm 0.01\%$ (contributed by IC₁) deter-

mines the overall gain accuracy. You can improve gain accuracy by using higher-precision resistors or by adding the optional gain-adjust network shown (R_7 and R_8). Gain and CMR adjustments don't interact in the Fig 2 circuit.

One application for the circuit of Fig 1 or Fig 2 is in monitoring high-side load current in a regulator or power supply. By connecting the difference amplifier across a 1Ω resistor in series with the supply's output, you can interpret the difference amplifier's output as one ampere of load current per volt for supply voltages in the range from -100V to 100V.

To Vote For This Design, Circle No 750

Multiplexers enhance timer's capabilities

Dan Sporea

Central Institute of Physics, Magurele, Romania

You can use a single 8253 programmable timer to accomplish multiple timing jobs by multiplexing the timer's clock and gate signals and demultiplexing the output (Fig 1). The timing jobs must not overlap.

One or more I/O ports control the multiplexers as shown, allowing the system to optimize timer use by executing various tasks in sequence. Moreover, the demultiplexed timer outputs can drive an interrupt controller that dynamically selects the appropriate servicing subroutines. Different combinations of input clock and gate signals can summon the same subroutine. Or, by selecting different outputs, you can service the same input conditions with different subroutines.





Fig 1—In this circuit, multiplexers let you port a single programmable timer (IC_4) from one timing job to the next. The interrupt controller IC_5 lets the system select a desired service subroutine.

DESIGN IDEAS

Design Entry Blank

\$75 Cash Award for all entries selected by editors. An additional \$100 Cash Award for the winning design of each issue, determined by vote of readers. Additional \$1500 Cash Award for annual Grand Prize Design, selected among biweekly winners by vote of editors.

To: Design Ideas Editor, EDN Magazine Cahners Publishing Co 275 Washington St, Newton, MA 02158

I hereby submit my Design Ideas entry.

Name			-
Title	and the second	Phone	-
Company	Cardiero C.	Di Sale Line Day	
Division (if any)			
Street			
City	State	Zip	_
Design Title	1.11		_
Home Address	a subscriptions		
and the second			1
Social Security Nu	mber	Lange and service service	
(Must accompany	all Design	Ideas submitted by	19

(Must accompany all Design Ideas submitted by US authors)

Entry blank must accompany all entries. Design entered must be submitted exclusively to EDN, must be original with author(s), must not have been previously published (limited-distribution house organs excepted), and must have been constructed and tested.

Exclusive publishing rights remain with Cahners Publishing Co unless entry is returned to author or editor gives written permission for publication elsewhere.

In submitting my entry, I agree to abide by the rules of the Design Ideas Program.

Signed

Date

Your vote determines this issue's winner. All designs published win \$75 cash. All issue winners receive an additional \$100 and become eligible for the annual \$1500 Grand Prize. Vote now, by circling the appropriate number on the reader inquiry card.

ISSUE WINNER

The winning Design Idea for the September 17, 1987, issue is entitled "Direction detector doubles as decoder," submitted by Tracy Allen of EME Systems (Berkeley, CA).

Power op amp forms position controller

Dennis Eichenberg

WL Tanksley & Associates Inc, Brook Park, OH

You can build an inexpensive closed-loop position controller by driving a permanent-magnet motor with a power op amp (**Fig 1**). Bipolar power supplies allow the op amp to provide bidirectional motor operation. The motor is a 6V permanent-magnet type whose starting current must not exceed 0.5A.



Fig 1—Power op amp IC_1 drives the motor according to the wiper position you set on potentiometer R_6 .

You configure the op amp as a differential amplifier in which the gain equals R_2/R_1 . A gain of 100 is optimum for this configuration. Gains from 10 to 500 provide good response times but cause increasing oscillation at the higher values, and a gain of 1000 causes instability. Resistor R_5 sets the amplifier's input-stage bias current.

Potentiometer R_6 lets you adjust the desired set point. Potentiometer R_7 connects to the motor shaft through a 10:1 gear ratio and provides position feedback to the amplifier's inverting input. The diodes in series with these potentiometers ensure that the magnitudes of the voltages applied to the amplifier's inputs don't come within 1.75V of the magnitude of either supply rail, as the amplifier requires. Using the ±6V supplies shown, the amplifier can apply as much as ±5.2V to the motor.

To Vote For This Design, Circle No 746
Because you're thinking fast...

you need responsive suppliers as well as fast parts. Comlinear is tuned in. With high quality, high speed products. Assistance from R&D-level applications engineers to help develop your ideas quicker. Sales and distribution that get you what you need fast. Quality product documentation with guaranteed specs so you don't waste time. In your business, time is everything. Count on us for the speed you need.

with guaranteed specs so you don't waste time. In your business, time is everything. Count on us for the speed you need. With 10ns settling times and 150-200NHz bandwidths.

Now, only from Comlinear, monolithic op amps with incredible high-speed, fast-settling performance.

Our new 200MHz CLC400 is designed for low-gain applications $(\pm 1 \text{ to } \pm 8)$ and settles in a mere 10ns to 0.1%. For gains greater than 7, choose our 150MHz CLC401, with the same 10ns settling time. Both feature low power (150mW), low distortion, stability without compensation, plus overload and short circuit protection. They're ideal as flash A/D drivers and D/A current-tovoltage converters, or in video distribution and line driving applications.

Our experience in high speed amplifiers now brings you monolithic op amps with numbers like you've never had before. A new dimension in performance is now available for your analog designs.

Try one. Fast.

Comlinear Corporation Solutions with speed

4800 Wheaton Drive Fort Collins, Colorado 80525 (303)226-0500 That's fast!

MOVE UP TO A NEW LINE

FROM HOUSTON INSTRUMENT

Prepare to be impressed. Meet the new line of high-performance plotters from Houston Instrument.[™] HI's sleek new DMP-60 series is designed to impress even the most demanding CAD professional.

Discover unprecedented flexibility—blended with ultra-fine resolution, speed, and software compatibility. Benefit from HI's rigorous standards for quality, reliability, and service. All at prices starting from \$4,695.*

Watch the DMP-60 series double as a scanner with HI's unique SCAN-CAD[™] option. Quickly produce multicolored drawings when you use the Multi-Pen adaptor. Plot several originals—without tying up your PC when you add HI's buffer expansion board.

Select media as small as 8½"×11" or as large as 36"×48". Load either DM/PL™ or HP-GL 758X-compatible software. Then watch as your plotter quickly produces a drawing polished to a precise resolution of 5 ten-thousandths of an inch. Smile when you see smoothly formed circles, curves, and lettering.

Explore HI's host of support

programs including an overnight plotter-replacement service. And then relax, knowing that HI's new plotters rest on 27 years of engineering excellence.

Move up. To a fine, new line. From Houston Instrument. Begin by calling 1-800-444-3425 or 512-835-0900 or writing Houston Instrument, 8500 Cameron Road, Austin, TX 78753. *U.S. suggested retail price.



Houston Instrument, SCAN-CAD, and DM/PL are trademarks of AMETEK, Inc.

MODELS



Catalog presents static and dual-port RAMs

The 121-pg 1987-88 CMOS Static Memory catalog describes the vendor's line of high-speed static RAMs and dual-port RAMs for use in miniand microcomputers, control-system applications, and graphics systems. Covered are 16k×8-bit, 8k×8bit, and 32k×8-bit static RAMs. The publication also includes data sheets for 1k×8-bit and 2k×8-bit dual-port RAMs.

Vitelic Corp, 3910 N First St, San Jose, CA 95134.

Circle No 678



Publication discusses CMOS microcontrollers

Single-Board Solutions lists the vendor's SBS Series CMOS-Z80 microcontrollers and accessories that are designed for a variety of applications, including process control, data acquisition, test and measurement, and environmental control. The 44-pg catalog provides specifications for the series and information about peripheral devices and related software such as CAMBasic and PC SmartLink.

Octagon Systems Corp, 6510 W 91st St, Westminster, CO 80030. Circle No 679



Publication covers buses

The vendor's 1988 Standard Bus Catalog Products Engineered for High Reliability highlights over 400 board-level products, development systems, software, and support products. It features the CDI-Ladder system, which implements relay ladder logic, programming on the STD Bus, new SBX boards, an expanded card cage line, and an enlarged process-control software section. Also included are sections on CPU boards, memory boards, communications boards, controller boards, industrial I/O boards, stepper-motor controllers, and ADCs. The 44-pg booklet includes engineering specs, block diagrams, and illustrations.

Computer Dynamics, 107 S Main St, Greer, SC 29651.

Circle No 680

Handbook lists industrial computer products

The 400-pg Systems Data Book covers the vendor's line of 8088 μ Pbased industrial computer systems and boards. It provides specifications and applications for the System 1 programmable control computer with relay ladder logic; the System 2 IBM PC/XT-compatible industrial computer; and MS-DOScompatible computer systems and subsystems. Also covered are 8088compatible STD Bus cards, I/O expansion cards, and accessories. The appendixes contain specifications and application notes for the STD Bus, a description of the 16-bit STD Bus, and a discussion on how to increase the MTBF.

Pro-Log Corp, 2560 Garden Rd, Monterey, CA 93940.

Circle No 681



Reference set details HCMOS programming

The M68HC11PM/AD, a Programming Reference Manual, is the basic software reference document for the MC68HC11 family of highspeed, CMOS single-chip µC devices. Besides general information, it presents descriptions of CPU register and addressing modes, instruction-set details, cycle-by-cycle CPU bus activity, and miscellaneous conversion tables. The MC68HC11-A8RG/AD, a pocket programming reference guide, includes sections on programming models, crystal-dependent timing, interrupts, memory and opcode maps, addressing modes, execution times, Hex/decimal conversions, and an ASCII chart.

Motorola Inc, Microprocessor Products Group, 6501 William Cannon Dr W, Austin, TX 78735.

LITERATURE

Brochure features industrial computer

This 12-pg pamphlet details the features, specifications, configuration options, packaging and power supplies, and pricing information for the System 2 IBM PC/XT-compatible industrial computer. Also included in the brochure is a list of STD Bus cards (peripheral, I/O, memory, and utility) that can be configured for users' needs as well as PC/XT-compatible programs for use with the System 2.

Pro-Log Corp, 2560 Garden Rd, Monterey, CA 93940.

Circle No 682

Book references computer industry

According to recent figures published in the Computer Industry Almanac, a 780-pg reference book, the US can lay claim to more than half of the world's computing power. The volume presents an inside view of the computer world. It includes a computer industry overview: a ranking of companies, company award winners, and a company business directory; a ranking of hardware and software companies; product trends and product award winners; a ranking of international companies and statistics; financial facts; forecasts; organizations and agencies: publications; and research activities. Soft cover, \$29.95; hard cover, \$49.95.

Computer Industry Almanac Inc, 8111 LBJ Freeway, Dallas, TX 75251.

INQUIRE DIRECT

Networking system described in brochure

This CADDSnetwork pamphlet presents the networking capabilities of the CADDStation family of CAE/ CAD/CAM workstations. It describes the data highway that allows access to computers from IBM and Digital Equipment Corp, as well as from the company. At the



CADDStation level, networking is enhanced by windowing, which allows simultaneous access to Unix, IBM's VM, Digital Equipment's VMS, and the design data base.

Computervision, Dept 615, 100 Crosby Dr, Bedford, MA 01730. Circle No 685

Brochure and synopsis on PC-based courses

The R200 series PC-based instrumentation laboratory courses contains a 500-pg course text with a variety of hardware packages. The applications include teaching labs, PC-based workstations, university courses, vocation technology for classrooms, and company training courses. Topics cover assembly and high-level programming languages, data acquisition, instruments, operating systems, and data links and buses. The text, with a selection of hardware packages, is priced from \$999 to \$2995.

Rapid Systems Inc, 433 N 34th St. Seattle, WA 98103.

INQUIRE DIRECT

Catalog of VME Bus products

This 4-color, 16-pg catalog describes the manufacturer's VME Bus boards, systems, and software. The short-form catalog covers such products as systems and packaging, CPUs, multiprocessing engines, system resources, single-board computers, memory, analog I/O and DSP devices, displays, special-function products, and peripherals.

Ironics Inc, 798 Cascadilla St, Ithaca, NY 14850.

Circle No 686

Literature package has app notes, product guide

This package of publications comprises four application notes, a VAXBI Third-Party Directory, and a product guide entitled *New Opportunities*. The notes explain how the vendor's products interact with other companies' products to make manufacturing tasks easier. The directory lists tool and service vendors and licensed option vendors. Finally, the guide describes the company's microcomputer systems, local-area networks, and local-area VAX-cluster systems.

Digital Equipment Corp, Channels Marketing Group, 2 Mount Royal Ave, Marlborough, MA 01752.

Circle No 687

Bus products described

Everything for the EXORbus is a 6-pg product guide that provides on a family information of EXORbus-compatible boards, modules, and accessories. It features a product overview on 6800/6809 µP modules that are suitable for use in systems dedicated to production automation, process control, data acquisition, and materials testing. Other sections deal with processor modules, memory modules, I/O modules, microcomputer systems, enclosures, and packaging and accessories.

Creative Micro Systems, 3822 Cerritos Ave, Los Alamitos, CA 90720.

LITERATURE



Guide details STE Bus products

The fourth edition of *The STEbus Product Guide* presents more than 750 products for the 8-bit STE Bus backplane computer system. Published on behalf of the STE Bus

> Now with zero waitstates at 20 MHz

Manufacturers' and Users' Group, the publication describes products from more than 30 manufacturers and lists STE Bus product suppliers. New items include processor boards based on the Z280 μ P and the Transputer, and Bitbus interface, DSP, speech synthesis, and motor controller cards.

The STE One Number Source, Dean Microsystems Ltd, 7 Horseshoe Park, Pangbourne, Reading, Berks RG8 7JW, UK.

Circle No 690

Report addresses use of laser for graphics

The 8-pg paper, Lasers in Graphic Arts, discusses laser technology as a bridge between typographic output, and hardware and software used for publishing. The report deals with three graphics-arts applications: image setting, scanning, and printing.



Compugraphic Corp, Literature Div, 65 Industrial Way, Wilmington, MA 01887.

Circle No 683

Slide chart features specs for pc boards

This double-sided slide chart makes it easy to refer to material specifications for pc boards. For example,

The HK68/V2F is a high-performance VME microcomputer with race-bred 32-bit power for real-time applications. High engine output and economical, dependable performance are just the start of the HK68/V2F's standard equipment:

ACE CI

Up to 25MHz Motorola 68020 CPU
 Up to 4MB of on-board DRAM with
 parity • 128K EPROM • Serial Port
 • Mailbox interrupt support • VSB compatible memory expansion bus

Optional racing equipment includes 68881 Floating Point Coprocessor and no wait-state DRAM.

HEURIKON

Take Heurikon's HK68/V2F for a test-lap today. Call toll-free: 1-800-356-9602 (ext. 912).

CIRCLE NO 41

3201 Latham Drive Madison, WI 53713



CIRCLE NO 42



LITERATURE

you can specify a manufacturer and grade of material to see physical, mechanical, electrical, or thermal properties at a glance. The reverse side of the chart explains tooling concepts and includes a recommended panel layout for the maximum use of raw materials.

Dynacircuits Inc, 11230 Addison St, Franklin Park, IL 60131.

Circle No 688



Brochure examines key features of Futurebus

This 6-pg awareness brochure covers key features of the IEEE-896 (Futurebus) specification. Formatted as a set of questions and answers, the brochure addresses such issues as which processors and architectures you can use on the bus, how Futurebus overcomes the bus driving problem, how the bus handles multiprocessing, and how it supports cache memories. Also included is information about message passing, fault-tolerant systems, and silicon support.

Futurebus Information Service, Unit 2, Rowan Close, St Peters Park, Brackley, Northants NN13 5UP, UK.

LITERATURE: COMPONENTS



Guide summarizes thyristor product line

The fifth edition of the vendor's *Thyristor Selector Guide* includes sections on SCRs, triacs, and trigger devices. The vendor has reduced its thyristor product offering by eliminating odd-value voltage parts and replacing them with the next highest voltage part.

Motorola Inc, Literature Distribution Center, Box 20924, Phoenix, AZ 85063.

Circle No 663



Brochure presents military products

This 12-pg, 4-color booklet describes the vendor's line of electronic components for military applications. It consists of five sections that include thick- and thin-film hybrid microcircuits, quartz crystals, molded pc-board connectors, memories—core and semiconductor, and DIP switches.

CTS Corp, 905 North West Blvd, Elkhart, IN 46514.

Circle No 665



LED source book

Light Years Ahead is the vendor's 48-pg, 1987-88 users' guide to LEDs. It covers a range of products: pc-board-mounted LEDs; standard or snap-in panel lights; and LED multichip, lamp-based incandescent replacements. The product specifications include dimensional drawings, actual-size photos, applications, and electrical specifications. You can order custom configurations from a wide range of lenses, bezels, LEDs, bases, and terminations. The catalog also provides an alphanumeric index and selector guide.

Data Display Products, Box 91072, Los Angeles, CA 90009. Circle No 664

Packet explains circuit-protection devices

This literature kit contains a brochure, data sheets, and application notes that provide an overview of the company's circuit-protection products. It includes descriptions of devices that provide protection for subscriber-line interface circuits,



PBX and key telephone systems, telecommunications networks, loudspeakers, and batteries. The kit contains a press release introducing the company's newest family of devices.

Raychem Corp, 300 Constitution Dr, Menlo Park, CA 94025.

Circle No 666



Miniature switches categorized

The 288-pg catalog provides information on the vendor's full line of miniature and subminiature switches. A table of contents and an alphanumeric product index will assist you in locating a particular device. The book also includes a price list.

Augat/Alcoswitch, 1551 Osgood St, North Andover, MA 01845.

FROM ONE SOURCE: WORLD'S WIDEST SELECTION OF WIREWOUND RESISTORS.

With quality that goes straight to the core.

IRC is now THE largest supplier of wirewounds...standard products, special assemblies, and units with custom characteristics.

The combined resources and over 100 years experience of IRC and Welwyn Electronics (U.K.) make the Crystalate Group your logical single source for any wirewound application.

We offer failsafe and flameproof units. Moisture-barrier vitreous enamelled units. Aluminum-housed chassis mounts. Custom TCs. Pulse and surge protectors with special fusing characteristics to meet your exact design needs.

We support your production efficiency, with chassis-mount designs and SMD packaging. And we can custom-produce special devices and assemblies to solve your circuit problems. Just ask us.

For product specs or application assistance, contact The Resistor People: IRC, Inc., Greenway Road, P.O. Box 1860, Boone, NC 28607. Phone 1-800-255-4-IRC. (In NC. 704-264-8861.)



FLAMEPROOF LINE FEED RESISTOR GENERAL PURPOSE AND FAILSAFE SEMI-PRECISION, TC ± 20 ppm/°C 0.5 TO 10 W 0.9 10 10 W Q 0.1 TO 17.5K Q 0.1 ± 0.196 TO 596 TOL. ± 0.196 TO 596 VITREOUS ENAMELLED

GENERAL PURPOSE

1 AND 2 W 0.1 TO 2400 Ω

0

LOW-RESISTANCE CURRENT-SENSING 3 TO 15 W 01 TO 1 1 TO 10% CHASSIS MOUNT 10 TO 50 W

0.05 TO 82K Ω 0.05 TO 82K Ω TOL. ± 196 TO 1096 GENERAL PURPOSE POWER

2 10 100 W 0 1 70 30k Ω TOL.± 5% AND 10% SPECIALS, CUSTOMS, ASSEMBLIES

2 TO 100 W ± 5% AND 10% TO 60k Ω 0.1

TOL

The Resistor People

EDN December 10, 1987

LITERATURE



Synchro/resolver LVDT converters described

This short-form catalog presents more than 45 families of products for conversion of synchro-, resolver-, Inductosyn-, and linear-variable differential transformer (LVDT) signals to digital codes. The listing includes single- and 2-speed converters, having 8- to 24-bit resolution. Applications for the devices include portable testers, multichannel data acquisition, airborne attitude synchro amplifiers, and angleposition indicators.

Control Sciences Inc, 9509 Vassar Ave, Chatsworth, CA 91311. Circle No 667

Listing of digital switches

This catalog describes a wide range of switches, including Digiswitch, Minilever, Digivider, and Digidecade switches, as well as Minikey keypad systems. Its easy-reference format guides you through military and commercial switch selection. The catalog also includes a features and options chart, truth tables listed by product series, engineering parameters, and layout drawings. It covers thumbwheel switches, lever/toggle switches, pushbutton switches, custom products, accessories, and switch-andassembly ordering instructions.

Digitran, 3100 New York Dr, Pasadena, CA 91107.

Circle No 671

Paper discusses PWM amplifiers

The 6-pg reprint, *Pulse Width Modulated Power Amplifiers*, introduces PWM amplifiers, starting with their basic principles. It discusses applications and compares PWM-amplifier technology with alternative linear amplifiers and SCR power systems. The article explains how applications fit into four broad categories: coil drivers, ac/dc power sources, motion control, and highpower function generators. Photographs and schematics highlight the text.

Copley Controls Corp, 375 Elliot St, Newton, MA 02164.

Circle No 674



have an average lifetime in excess of 10 years. Make the brilliant choice. Find out more about these powerful additions to our high-efficiency LED product line. Call Data Display. TOLL-FREE (800) 421-6815. Within California, call (213) 640-0442. Free catalog.



Who makes LED Illuminators

enough to replace incandescents?

Data Display Products has the newest answer to plugcompatible replacement of incandescents. Our multi-chip LED illuminators provide more than 4 times the light output of the previously best available single chip LEDs. What's more, they

301 Coral Circle, El Segundo, CA 90245 (213) 640-0442 TELEX 664-690

INTERNATIONAL REPS: Argentina YEL SRL, PH: 54146 2211, T.X: 390 18605 • Australia Ampec, PH: 02 7122466, TLX: 790 27136 AMPEC • Belgium /Holland Klassing Elc, PH: 01620 81600, TLX: 844 54598 KLBDNL • Denmark Radio Parts, PH: 01333311, TLX: 855 19613 RPARTOK • France A Jahnichen, PH: 387 5909, TLX: 84290714 • tsrael R.C. MO. Computers, PH: 03 485192, TLX: 922 342471 IL • Italy Microdata, PH: 0187 988182, TLX: 8432 71333 • South Africa Liberty Elec., PH: 52 7637 / 89, TLX: 950 429435 5A • Spain Betatron, PH: 6932421, TLX: 831 23911 PC0E • United Kingdom Mari Int'I, PH: 0229 52430, TLX: 851 65100 MARLG • West Germany /Austria Kuhn Gmbh, PH: 06235 5662, TLX: 841 464766 KUHND

CIRCLE NO 45

"EDN NEWS PROVIDED AN OVERWHELMING RESPONSE OF HIGH-QUALITY LEADS FOR OUR MICRO PEDESTAL ENCLOSURE."

Barry Holman Sales Manager Everest Electronic Equipment, Inc.

Meet our new line of tower enclosures. Enjoy versatility low cost and immediate availability.

"As a result of a full-page, four-color ad we ran in EDN News, interest in our product has increased substantially," says Barry Holman, sales manager at Everest Electronic Equipment, Inc., a manufacturer of enclosures. "Sales are climbing steadily by roughly 45%, and we have found new market segments for

our products, such as publishers of automotive parts manuals."

"Everest has a reputation for high-quality enclosure products," says Holman, "and EDN News has brought us more than 170 high-quality leads. We consider the association a tremendous success!"

Advertising in EDN News works for Everest Electronic Equipment. It can work for you.



Where Advertising Works



Data sheet summarizes manufacturing aids

This data sheet describes three circuit-board manufacturing aids: connector protectors, a gold-fingers glove, and pc-board stiffeners. Product specifications are included in each description.

Stevens Products Inc, 128 N Park St, East Orange, NJ 07019. Circle No 670

Brochure presents IR pyroelectric detectors

This 6-pg app note, Introduction to Infrared Pyroelectric Detectors, describes the basics of lithium tantalate pyroelectric detectors. Three introductory topics are entitled "When to Use Infrared," "Beyond Photodiodes," and "Pyroelectrics are Practical." Other topics include electrical considerations and laser applications.

Eltec Instruments Inc, Box 9610, Daytona Beach, FL 32020. Circle No 675

Brochure discusses traveling-wave tubes

This brochure covers the vendor's line of microwave tubes and amplifiers for manufacturers of communications and military products. It describes products for military electronic counter measures (ECM) and radar. It also details products you can use for stationary and mobile transmitters, transmitter amplifiers for satellite up-link ground stations, and point-to-point satellite transmission of business data. The 20-pg booklet includes a section on product safety.

Stantel Components Inc, 636 Remington Rd, Schaumburg, IL 60173.

Circle No 672

Catalog aids in choosing ceramic filters

Ceramic EMI/RF1 Filters features descriptions of filter-circuit configurations and functions. It includes a filter-selection flow chart, installation guidelines, definitions of terms, and military test procedures. Catalog FD-129 is divided into dc-rated and ac/dc-rated sections. Subcategories are defined by circuit function. Within each general circuit category, devices are shown in





0 MARLG - West Germany / Austria Kuhn Gmbh, PH: IND CIRCLE NO 47

Higher frequencies. Smaller size.

00000

731 JPN

1329 8.00000 731 JP

ACTUAL SIZE

NDK 1300 Series **Compact Crystal Clock** Oscillators

NDK's 1300 Series offers the widest range of CMOS- and TTL-compatible compact oscillators available. Frequencies from 28 kHz to 70 MHz with enable/ disable std and dual-frequency output as an option. All in rugged, space-saving, half-size packages that are perfect for high density pc-board applications.

NDK 1300 Series Features

- Broadest range of available frequencies 28 kHz to 70 MHz
- Low-power/low-heat CMOS technology
- · Choice of TTL, CMOS or dual-compatibility Compact size (0.52-inch square) - perfect
- for portables
- Quick rise and fall times (5, 7, 10 ns)
- Excellent fan out (2 or 5 TTL gates)
- Sealed, grounded metal case resists EMI, high temperatures, humidity
- Shock and vibration resistant

AVA	ILABLE FF	REQUEN	ICIES	
28 kHz	MHz	MHz	25 MHz	70 MH:
ND	K 1300 Seri	es Crysta	I Clock Osc	illators
	Other Bran	1		N 10 3
	other branc	15		1.

NDK: Your single source.

NDK offers the widest range of compact crystal oscillators, microprocessor quartz crystals, and standard crystal oscillators available. All fully guaranteed to be free from impurities and defects. And all readily available through NDK's nationwide network of stocking distributors.

For a free product catalog, or to order evaluation samples, contact NDK today.



CIRCLE NO 48

DID YOU KNOW?

Half of all EDN's articles are staff-written.



LITERATURE

order of current and voltage rating. Sprague Electric Co, Technical Literature Service, Box 9102, Mansfield, MA 02048.

Circle No 673



Product guide to panel displays

This 40-pg catalog of flat-panel plasma displays is divided into three sections: segmented displays; displays with drive electronics/interfaces; and bar-graph displays. A product guide and a list of customer representatives are included on the inside covers.

Dale Electronics Inc, 2064 12th Ave, Columbus, NE 68601.

Circle No 669

Guide details optoelectronics products

The 45-pg, 4-color Optoelectronics Product Guide is a combination data book/selector guide that provides electrical and optical characteristics, package outlines, and pinout specifications. It also describes product features and applications. The book provides sections that cover visible-light lamps; single- and multiple-digit displays; integrated displays; custom capabilities; infrared emitters and detectors; and optocouplers.

Three-Five Semiconductor Inc. Box 111, Tempe AZ 85282.

LITERATURE



Brochure details miniature ceramic-plate capacitors

The 20-page color brochure entitled *Miniature Ceramic-Plate Capacitors* describes a range of ceramicplate capacitors that are suitable for use in such applications as coupling, decoupling, timing, and resonant circuits. The brochure also describes the manufacture, quality control assessment, and ordering information for these components, and outlines some advantages of their mechanical design.

Philips, Elcoma Div, Box 523, 5600 AM Eindhoven, The Netherlands.

Circle No 677



EDN December 10, 1987

STIMPSON "C-E" RIVETS...

...Provide the quality and savings needed for today's most common riveting applications.



STIMPSON "C-E" Rivets are available in brass or steel, along with a selection of enamelled colors and plated finishes to suit your design specifications.

The "C-E" Rivet, teamed with the C-1 or No. 500 machine, provides one of the most economical and versatile riveting systems available today.

Send for your free copy of STIMPSON'S latest Designer's Catalog, which illus-

trates our full line of "C-E" Rivets and our precision-built automatic riveting machines.





900 SYLVAN AVE. BAYPORT, N Y 11705-1097 (516) 472-2000

Turn Good Ideas Into Good Articles With EDN's FREE

Writer's Guide! Would you like to get paid for sharing

your clever engineering ideas and methods with your professional colleagues? If so, then send for EDN's new FREE writer's guide and learn how.

You don't need the skills and experience of a professional writer. And you don't need to know publishing jargon. All you *do* need are a little perseverance, your engineering skills, and the ability to communicate your ideas clearly.

Our new writer's guide takes the mystery and intimidation out of writing for a publication. It shows you how to write for EDN using skills you already have. Plus, it takes you step-bystep through the editorial procedures necessary to turn your ideas into polished, professional articles.

Get your FREE copy of EDN's writer's guide by circling number 800 on the Information Retrieval Service Card or by calling Sharon Gildea at (617) 964-3030.



CIRCLE NO 50

LITERATURE: INSTRUMENTS



Instrument-rental catalog

Featuring instruments from vendors such as Hewlett-Packard, Tektronix, and Fluke, this illustrated catalog presents more than 1000 models of electronic test, industrial, and telecommunications equipment that the company offers for rental. The instruments listed include oscilloscopes, analyzers, signal sources, recorders, temperature equipment, power-line monitors, and laser-measurement equipment. Also included are protocol analyzers, microwave analyzers, fiber-optic test equipment, signal generators and video equipment, µP test-and-development systems, logic analyzers, PROM programmers, plotters, and printers. The publication features a manufacturers' index and a product index.

Leasametric, Instrument Rental Div, 1164 Triton Dr, Foster City, CA 94404.

Circle No 647

App notes discuss waveform digitizing

Application notes AN-2017, Principles of Digital Waveform Recording, and AN-2018, Digital Signal Processing, provide an overview of waveform digitizing and analysis. The two papers fill 28 pages with text, diagrams, and illustrations. They address such topics as the fundamentals of ADC technology, understanding digitizer specifications, digitizer applications, digital signal processing, and computer-aidedtest system design.

LeCroy, 700 S Main St, Spring Valley, NY 10977.

Circle No 651



Product guide for dc power supplies

The 132-pg 1987/88 DC Power Supply Catalog describes the vendor's manually controlled and computercontrolled dc power supplies. It's divided into three general categories: system, analog-programmable, and special-purpose and lab-bench power supplies. The book includes voltage-rating and model-number indexes, a guide for replacing discontinued models, a listing of sales and support offices, and a section on applications-information and terminology.

Hewlett-Packard Co, 1820 Embarcadero Rd, Palo Alto, CA 94303. Circle No 648

Data-acquisition and control equipment

This 56-pg booklet categorizes the vendor's data-acquisition and control equipment for IBM and Apple computers. It highlights 55 hardware and software products used for process control and laboratory measurements, and for monitoring



temperature, strain, and pressure. The publication also features a hardware-software cross-reference guide.

Strawberry Tree Computers Inc, 150 N Wolfe Rd, Sunnyvale, CA 94086.

Circle No 649



Oscilloscope-probe kits and test accessories

The 32-pg, 4-color publication Perfection for Quick Connection presents the vendor's clip, insulator, test-lead, and interconnect offerings from A to W (adapters to wire). It lists product specifications, presents engineering drawings, and describes applications.

Mueller Electric Co, 1583 E 31st St, Cleveland, OH 44114.

Booklet depicts test and measuring instruments

The 16-pg short-form catalog, *Test* & *Measuring Instruments*, focuses on the company's complete line of oscilloscopes. It also features scope wagons, trace-recording camera systems, a selection chart of oscilloscope accessories, and a passiveand active-probes chart.

Iwatsu Instruments Inc, 430 Commerce Blvd, Carlstadt, NJ 07072.

Circle No 652



Test and measurement instruments categorized

This 16-pg catalog on test and measurement instruments outlines performance features, applications, and specifications for 22 instruments. The products featured include digital multimeters, data-acquisition and logging instruments, dynamic analysis and vibration equipment, and communications test sets.

Solartron Instruments, 2 Westchester Plaza, Elmsford, NY 10523. Circle No 655

Brochure highlights electronic products

This 4-color brochure (Publication No 5953-7040) presents information on 22 basic electronic measuring instruments that are grouped into four types: digital multimeters; counters; pulse and function generators; and power supplies. Included in the leaflet are brief product descriptions, specifications, and prices.

Hewlett-Packard Co, 1820 Embarcadero Rd, Palo Alto, CA 94303. Circle No 653

Tutorial pamphlet for semiconductor testing

A Coordinated Set of Instruments Specifically Designed for Semiconductor Use is a 12-pg color brochure that describes how to use instruments to make semiconductor measurements. The publication is a combination of tutorial and product descriptions. It explains techniques such as low-level, capacitance-voltage tests, resistance and electromigration studies, and Hall-effect measurements. It also explains how to use specialized instruments, electrometers, switch systems, picoammeters, and capacitance-voltage instruments.

Keithley Instruments Inc, 28775 Aurora Rd, Solon, OH 44139.

Circle No 657

Instrument catalog

This 32-pg catalog presents the company's line of products for industrial and laboratory test and measurement applications. Products covered include handheld thermometers, temperature controls, panel meters, calibration equipment, temperature loggers, IR thermometers, thermocouples, RTDs, handheld probes, humidity instruments, anemometers, digital voltmeters, temperature baths, pH meters, oxygen analyzers, and tachometers. Also listed are multifunction instruments that can measure several different parameters by using plug-in modules and sensors; the listing describes each product, giving its operating specifications and price.

Owen Instruments Inc, Box 2193, Provo, UT 84603.

Circle No 661



Listing of test and measurement instruments

This 64-pg catalog presents more than 1400 products from A W Sperry, Amprobe, B&K Precision, Check-It, Fluke, Simpson, TIF, and Yokogawa. Among the products listed are leak detectors, counters, oscilloscopes, a variety of meters, and power supplies. The products described fill the requirements of electronic-, electrical-, and industrial-equipment users.

W W Grainger Inc, 1250 Busch Parkway, Buffalo Grove, IL 60015. Circle No 654

Booklet summarizes features of spectrum analyzer

The 16-pg, 4-color brochure 400-MHz Spectrum Analyzer 2382 illustrates Model 2382's RF design and details specifications. A section on measurement problems shows you how to speed up measurements at a single frequency, how to display demodulated FM signals, and how to get permanent records of tests.

Marconi Instruments, 3 Pearl Ct, Allendale, NJ 07401.

Circle No 658

Signal sources bulletin

This 4-pg technical bulletin describes the series 6150A AM/FM signal sources. It details the modulation, harmonics, and stability of the instruments, which are solid-

LITERATURE

state oscillators employing a GaAs FET as the active element. The pamphlet also contains specifications and a description of the vendor's 6140 GPIB adapter.

Marconi Instruments, 3 Pearl Ct, Allendale, NJ 07401.

Circle No 659

Book describes licensing of broadcast equipment

Procedures for Granting Licenses for the Operation of RF Devices. Radio and TV Receivers in Western Germany, an EMI guide published in English, provides information to help equipment manufacturers understand West German regulations. The 206-pg booklet examines the laws and VDE regulations concerning radio-interference suppression. It also presents a list of Deutsche Bundespost decrees on the subject along with brief summaries of the decrees. A flow chart depicts approval procedures for equipment, and the final chapter gives examples of test setups prescribed by a number of VDE regulations. DM 23.

Rohde & Schwarz, Muhldorfstrasse 15, 8000 Munich 80, West Germany.

INQUIRE DIRECT

Note discusses programming on simulator system

Product Note 8770S-2, Effective Use of the HP 8770S Signal Simulator System, offers programming help with the HP 1177A Waveform Generation Language. The 64-pg document presents principles of digital synthesis and provides product-specific information about the features and operation of the HP 8770S. It explains how to program six different waveforms, from sine waves to frequency-hopped and multipletone carriers. Another section examines pulsed waveforms, pulsed carriers, and those with phase tagging, variable repetition rates and jitter, and pulse trains with AM and scan characteristics. Seven appen-



NTS is on the move with increased capability, expanded staff, new facilities. Over 26 years experience in EMI/EMC testing, including transducers, pacemakers, mobile power carts, military communications, CB transceivers, digital slot machines, marine radios. • Hewlett-Packard Automatic

- Microwave Spectrum Analyzer.
- Test to MIL-STD-461A/B/C, FCC, VDE regs, military and customer specs.
- On-site testing, e.g., FCC Part 18 testing at Logan airport, shielded enclosures at NORAD to MIL-STD-285.
- 4 EMC test enclosures.
- FCC listed open field test site.
- Calibration traceable to NBS.



CUT THE COST OF DOING BUSINESS



Broad range? The broadest. Philips rectifier diodes.

Shopping around can cost you. But with Philips and Amperex, all your general purpose, Schottky, epitaxial, double diffused, and high voltage rectifier diode needs can be met at a single source. That's one-stop-shopping—and *that* saves money.

You get the quality you expect of a world leader. In the broadest range of voltage capacities, designed for exceptional performance in every application. Plus world-class service that never varies: no matter what your volume.

Cut your cost of doing business. Write or call Amperex Electronic Corporation, a North American Philips Company, Discrete Semiconductors Business Unit, George Washington Highway, Smithfield, RI 02917. Phone (401) 232-0500. TWX: 710-381-8808. Or contact your local authorized Amperex distributor.

Amperex[®] A NORTH AMERICAN PHILIPS COMPANY DISCRETE SEMICONDUCTOR PRODUCTS GROUP

PHILIPS



In Canada, contact PHILIPS ELECTRONICS LTD, ELCOMA DIVISION. CIRCLE NO 207

DID YOU KNOW?

EDN serves electronic engineers and engineering managers in more than 100 countries worldwide.



LITERATURE

dices complete the booklet.

Hewlett-Packard Co, 1820 Embarcadero Rd, Palo Alto, CA 94303. Circle No 656

Frequency synthesizers described

This catalog gives general information about frequency synthesizers and outlines their characteristics. It lists specifications for the product line and provides illustrations of each device. The 20-pg catalog also includes ordering information, and data sheets for the company's newest models.

Programmed Test Sources Inc, Box 517, Littleton, MA 01460. Circle No 660

Technical report describes modal analysis

To help you evaluate the complex behavior of vibrating structures, the technical report Modal Testing Principles describes the steps involved in using the company's model 1202 structural analyzer in modal analysis experiments. With the aid of diagrams, the 100-pg report highlights the factors involved in setting up the experiment, in analyzing the problem theoretically, and in assessing the quality of the modal data. Some of the chapters focus on how to identify modal parameters and how to achieve structural modifications. The report also provides a detailed explanation of 42 different equations related to modal analysis.

Solartron Instruments, Victoria Rd, Farnborough, Hants GU14 7PW, UK.

LITERATURE: COMPUTER-AIDED ENGINEERING



Digital plotter media for computer-aided design

This brochure describes digital-plotter materials for computer-aided design. It describes the vendor's Diplomat and PermaScale media, and provides an applications guide of media characteristics. Further, its plotter-suitability charts list the products available for flatbed or drum plotters.

Dietzgen Corp, 250 Wille Rd, Des Plaines, IL 60018.

Circle No 643

Newsletter provides CAE coverage

Design Line, a quarterly newsletter, publishes news about and editorial comment on CAE trends, applications, and events. It features user stories as well as articles on workstations (large systems), simulation, performance, and testability analysis.

Aida Corp, 5155 Old Ironsides Dr, Santa Clara, CA 95054.

Circle No 645

Newsletter contains CAD/CAM information

Published since 1981, the *Computer Aided Design Report* newsletter covers computer-aided design and manufacturing topics. The May and June issues provide a comparison of personal-computer CAD software from three Fortune 500 firms and software from two smaller companies. The results show that buying software from major manufacturers won't necessarily be the solution that best meets your particular needs. Copies of both issues are available for \$23. An annual subscription costs \$138.

CAD/CAM Publishing Inc, 841 Turquoise St, Suite D, San Diego, CA 92109.

INQUIRE DIRECT

Catalog features CAD products

This 37-pg product guide deals with the vendor's hardware, firmware, software, and custom designing and consulting. It also focuses on the CAD software packages HiWire and SmartWork. The HiWire section describes the product as an aid that shortens and simplifies the electronic-design process; the section covers features, specifications, and system requirements. The SmartWork section describes how SmartWork makes pc-board design easier and less tedious.

Wintek Corp, 1801 South St, La-fayette, IN 47904.

Circle No 644

Brochure on dataacquisition system

This brochure describes the P-CAM system, which includes software packages for data acquisition/analysis and process control applications. The 4-color publication covers the product's applications and provides illustrations, figures, and specifications.

KineticSystems Corp, 11 Maryknoll Dr, Lockport, IL 60441.





TOSHIBA ST LCD NODULT

When your eyes need high quality displays, you need the Toshiba ST LCD.

Once again Toshiba has made a breakthrough in display quality. Clear and beautiful displays are achieved with the ST LCD. The LCD for the new age. And for your eyes. Now, by employing a new operating mode, this module provides excellent readability from a viewing angle perpendicular to the LCD panel. This was difficult to achieve with conventional LCDs. The aim was to make our LCD easier on the eyes. We succeeded with the ST LCD. Just another improvement in the man-to-machine interface by Toshiba.

Model name	Number of dots	Duty	Dot pitch (mm)	Outline dimensions (mm)	EL Back Light (Option)	Recommended controller
TLX-1181*	640 × 400	1/200	0.35 × 0.35	276 × 168 × 12	Yes	T7779
TLX-932	640 × 200	1/200	0.375 × 0.375	293 × 97.6 × 14	No	T7779
TLX-561	640 × 200	1/200	0.35 × 0.49	275 × 126 × 14	Yes	T7779
TLX-711A*	240 × 64	1/64	0.53 × 0.53	180 × 65 × 12	Yes	T6963C**
TLX-341AK*	128 × 128	1/64	0.45×0.45	93.2 × 86.6 × 12	No	T6963C

ST LCD Module Specifications

*Under development, **Built-in controller

CIRCLE NO 194



Toshiba America, Inc., Chicago Office: 1101A Lake Cook Rd., Deerfield, IL 60015 Tel: 312-945-1500 Northwestern Area Office: 2021 The Alameda, Suite 220, San Jose, CA 95126 Tel: 408-244-4070 Eastern Area Office: 67 South Bedford Street, Suite 200W, Burlington, MA 01803 Tel: 617-272-4352, 5548

EDN Product Mart

This advertising is for new and current products.

Please circle Reader Service number for additional information from manufacturers.



VOICE SCRYWAJING

Choose from 3 levels of security, with the only CMOS scramblers made. Analog for no-lag. Economical, high voice quality. Send for a FREE demo cassette of all 3 options from simple inverter to rolling code scrambler.

> MX.COM.INC. TOLL FREE 1-800-638-5577

DROPIN IPL.

Don't settle for the either-or codecs of Motorola and Harris. Spec the fullduplex MX609 and get simultaneous decode/encode, space-saving on-chip filters, 8 - 64 kb/sec. programmable sampling, and extended temp range.

MX · COM, INC

ia Station Road • Winston-Salem, NC 27105-1201 L FREE 1-800-638-5577 • (919) 744-5050 **CIRCLE NO 332**



NEW ENGINEERING SOFTWARE Filter designs active filters up to order 30. Bessel. Butterworth, Chebyshev, Allpass; High, Low Band-pass and Bandstop. Fully menu driven, Filter designs, plots, and selects component values for any filter in seconds. LSAP analyzes linear systems nicer in seconds. LSAP analyzes linear systems producing Bode. Nyquist, Impulse, Step Response and Root-Locus plots. Micro-CSMP simulates con-trol and servo systems with full support for non-linear behavior. Filter is \$900, LSAP is \$450, Micro-CSMP is \$900 for the IBM PC.

California Scientific Software 1159 North Catalina Ave, Pasadena, CA 91104 (818) 798-1201

CIRCLE NO 334



16-BIT CMOS SINGLE BOARD COMPUTER The LPM-SBC50 is an all CMOS STD Bus V-50 (CMOS 80186) SBC featuring 1M byte addressing, DMA, 32-pin memory sockets, serial RS-232/422 channel, 3 timers, 24 parallel I/O lines, real time clock, and watchdog timer. - 40° to +85°C operating temperature. Very low power consumption. Available as NMOS/TTL or CMOS from

WinSystems, Inc. P.O. Box 121361, Arlington, TX 76012 (817) 274-7553





ALPHACOM 42®

The ideal printer for MEDICAL, SCIENTIFIC and INDUSTRIAL INSTRUMENTATION.

- Fast 2 lines/sec.
- Quiet Thermal Dot Matrix Printing
- Low Cost Less than \$125 in
 - **OEM** quantity
- · Plug-In Interface for Serial or Parallel

Alphacom[®] is a Trade Name of **BROWN KELLOGG, INC.** 2108-C Bering Drive San Jose, CA 95131 (408) 436-0801 **CIRCLE NO 335**





For 1200 baud radio telemetry, remote data terminals, and packet radio, the full duplex MX519 Minimum Shift Key Modem offers high noise immunity. on-chip filtering, and easy μP interface. Now in both DIL and PLCC.

> MX.COM.INC. TOLL FREE 1-800-638-5577

CIRCLE NO 333



STD BUS SINGLE BOARD COMPUTER THE STD8809

- Up to 256K of ROM
- Up to 128K of RAM Optional DM86 Monitor "C" language software d
- "C" language software development tools available Supports both 8088 and Z80 vectored interrupts Serial port with on board RS 232C drivers

- Two 8-bit parallel I/O ports Five counter/timer channels
- Direct addressing of up to 1MB

 Eight level priority interrupt controller
 Optional 8087 math coprocessor
 Quantity 1 Price — \$275 without memory Call TOLL FREE 1-800-521-0714 Ext. 229

M.K. HANSEN COMPANY 634 Industry Drive, Seattle, WA 98188 **CIRCLE NO 336**

IEEE-488 IEEE-488, PARALLEL, and SERIAL

PORTS PLUS 4M BYTES of MEMORY

- Control any instrument. RS232 or '488.
- 4Mbytes of extended/expanded memory.
- · Software library and memory manager.
- High speed DMA. Risk free guarantee.



CIRCLE NO 339



CIRCLE NO 346



Analog Circuit Simulation



NEW SPICE NET

Make SPICE input files from schematic drawings using pull down menus and a mouse to draw and

for

IBM

PC's

from

connect parts. Use an IBM PC with any UC Berkeley compatible SPICE program. Purchase the program for the special in-troductory price of \$245.00 before Feb. 1, 1988.

Simulation Programs

- IS_SPICE, \$95.00. Performs AC, DC and Transient analysis.
- PRE SPICE \$200.00: Adds Monte Carlo Analysis, Sweeps, Optimization, libraries and algebraic parameter evaluation

you will ever need.

intusoft Intu_Scope \$250: A graphics post processor works like a digi-(213) 833-0710 tal oscilloscope. Easy to use with all the waveform operations

P.O. Box 6607 San Pedro, CA 90734-6607

CIRCLE NO 751

DEVELOP ROMABLE SOFTWARE WITHOUT AN EMULATOR

ROM C86[™] is a software package that works in conjunction with the Aztec C86 c[™] compiler. ROM C86 provides a cost effective means of developing efficient, ROMable software for 8088, 8086, 80188, 80186, and 80286 based microcomputers. The only hardware required is an XT/AT and a functional target system with a serial port.

WITH ROM-C86 YOU CAN:

- .
- Use "C" library functions including PRINTF, FPRINTF, SCAN, FSCAN, MALLOC, and CALLOC. Specify the size and location of the stack and heap. Download programs from an XT AT to target RAM via a serial link using the DBR86 loader debugger program and the DM86 target system monitor.
- Debug programs in target RAM using the powerful symbolic debugging capabilities provided by the DBR86 loader/debugger working in conjunction with the DM86 target system monitor. Use the HEXCON conversion program to convert
- relocatable EXE files to extended hex format for down loading to an EPROM programmer. ROM C86 Price \$499

Call TOLL FREE 1-800-521-0714 Ext 229

M.K. HANSEN COMPANY 634 Industry Drive, Seattle, WA 98188 Aztec C86 c is a tr **CIRCLE NO 754**



LeCROY MODEL 9100 HIGH SPEED CUSTOM WAVEFORM GENERATOR

LeCroy's new Arbitrary Function Generator features an output rate of up to 200 megapoints/sec to permit the generation of wide bandwidth custom waveforms not previously possible with simple digital techniques. The 9100 offers 2 channels, 10 V output range, 5 nsec risetime, 350 KB of non-volatile waveform storage and 64 KB of high speed operating memory. Standalone operation as either a standard function generator or pulse generator is built in. Easy-to-use waveform creation software is MS-DOS compatible. Price, \$8900 (U.S.A.), plus options.

LeCROY CORPORATION, 700 Chestnut Ridge Rd. Chestnut Ridge, NY 10977-6499 (914) 578-6020

CIRCLE NO 757









EDN December 10, 1987



The Fastest Growing Electronics Newspaper arch vields **Now Reaches The Fastest Growing** Electronics Market!

JAPAN

The newspaper is EDN NEWS. The market, the Pacific Rim.

Starting with the December 1987 issue, EDN NEWS increases its circulation by 7,500 engineers and engineering managers in the key Pacific Rim markets of Japan, Taiwan, South Korea, Hong Kong, Singapore, and Malaysia.

This increase of 7,500 gives EDN NEWS the largest controlled circulation in the Pacific Rim of *any* electronics industry newspaper or magazine. EDN NEWS also reaches EDN magazine's U.S. circulation of 121,500...now for a total of 129,000 readers worldwide!

For details, contact Warren Dickson, Publisher, or Peter Coley, Advertising Sales Director, at (617) 964-3030 or your local EDN NEWS sales representative.



News of Products, Technology, and Careers for Engineers and Engineering Managers

Cahners Publishing Company • 275 Washington Street Newton, MA 02158-1630 • (617) 964-3030

PACIFIC RIM

MALAYSIA

SOUTH KOREA

TAIWAN

HONG KONG

SINGAPORE

PROFESSIONAL ISSUES

An experimental graduate-engineering program opens new study opportunities

Deborah Asbrand, Associate Editor

set up to aid people who, like him,

Design engineer Daniel Sternlicht has always been good at making the most of opportunities. Shortly after graduating from the University of Pennsylvania with a degree in marine biology, Sternlicht abandoned a planned oceanographic career and decided instead to pursue an interest in engineering. He headed for the mecca of engineering, California, and after several months of door-knocking, succeeded in getting a job as an engineering technician at Teledyne Microwave in Mountain View.

To supplement his on-the-job learning, Sternlicht immediately began taking courses in advanced math and electronic technology at local colleges. Two and a half years after joining Teledyne Microwave, he was promoted to design engineer. But there was one area in which there were few opportunities available to him: education. What he really wanted was a master's degree in engineering, but without a bachelor's degree in the subject, the chances were slim that he would gain admission to a traditional program.

Now, though, Sternlicht is enrolled in a master's program and slowly working his way toward an advanced engineering degree. He's one of many students taking advantage of an innovative program that the University of Santa Clara has

have technical positions in electronics companies but who have risen through the ranks minus undergraduate engineering degrees. Nearly 100 students are enrolled

Nearly 100 students are enrolled in the university's largely experimental program, known as Program 2. Although many of them are studying graduate-level material, others have been accepted into the program on the condition that they first complete undergraduate math requirements. Only one student has been graduated to date, and Ken Haughton, dean of engineering at the small Jesuit college, says the school wants to keep the program's enrollment small while it fine-tunes the curriculum. istrative professionals in the electronics industry would phone Haughton looking for part-time engineering programs that would complement their business expertise. Except for recommending that the callers enroll in undergraduate night classes, Haughton had no solutions.

The phone conversations nagged at him, though, because the callers' dilemmas were not new to him; he had known many people in similar predicaments during his 25-year career at IBM. "I often saw people who'd had their responsibilities expanded to the point where they felt frustrated at not having a technical background," he recalled. "No matter where you start [in a technology

Haughton expects that engineering education will someday be conducted primarily on the graduate level in professional schools, much as medical and legal education is today.

While Sternlicht was wondering how he'd get the advanced engineering education that he wanted, Haughton was wrestling with the educator's side of the same problem. Engineers weren't the only ones looking for programs that offered alternative forms of study. From time to time, marketing and admincompany], if you have the inclination, you're somehow going to wind up involved in the technology."

When Haughton left industry in 1982 to become dean of the University of Santa Clara's engineering school, he suddenly found himself in a position to solve the problem. During informal round-table discussions

PROFESSIONAL ISSUES

between the university and industry representatives, Haughton broached the idea for a graduate engineering program tailored for individuals with undergraduate degrees in liberal arts and natural sciences. The participants' reactions were positive. "Typically, the response was 'My God, I wish I had had a chance at a program like that,'" Haughton remembers.

The changing face of education

Haughton had another reason for wanting to start Program 2: his expectation that engineering education as a whole will someday be conducted primarily on the graduate level in professional schools, much as medical and legal education is today. "I think the . . . day is coming when we're going to have to re-evaluate engineering education in this country . . . We are experiencing enormous technical progress, and it's becoming increasingly difficult for undergraduate programs to keep up."

With those thoughts in mind, Haughton decided in 1983 to undertake his grand experiment. Students in the program give it rave reviews. Sternlicht says the fivecredit course in microelectronics that he's currently enrolled in grated to the United States from Rumania, where he had been a violinist with the state-national orchestra. Arriving in San Francisco, he joined the musicians' union and paid his \$400 dues only to discover that he was one of roughly 240 out-ofwork professional violinists in the Bay Area. Looking for a field that offered a better chance of employment, Bostan took a job as a badge assembler. After climbing the ladder through a variety of engineering-technician positions, he was promoted to design engineer in 1982.

Although Bostan questions whether a person must have a degree to succeed as an engineer-"I don't think Edison or Faraday had degrees"-he expects the degree he's working toward to "legitimize" his engineering work. Bostan has taken 20 undergraduate classes in mathematics, C and assembly languages, and microprocessor design. In 1983, he was conditionally accepted into Program 2. He's been gradually completing his mathematics requirements while taking engineering courses, but nonetheless anticipates another four years of study before he graduates.

Haughton concedes that because the program is largely an experiment—as he carefully explains to ing students, for example, take a couple of major courses in mechanical engineering and three in electrical engineering."

Haughton also worries about the long years of study that most students need to complete the required courses. He estimates that parttime students will need six to eight years of study to complete the program. "Our objective isn't to grant students degrees because they've served [time] but rather because they've learned a certain body of knowledge. We're trying to make that as streamlined as possible."

His greatest worry, though, is the program's experimental nature. Response to the program by the school's 37 engineering faculty members has been lukewarm, Haughton says. "Half of them say it's worth trying, and the other half think I'm nuts." Mention of the program to other engineering educators can also elicit skepticism. "Usually they raise their eyebrows and say 'You're what?' But I haven't heard anyone badmouth the program. Most people are taking a wait-and-see attitude."

Haughton, too, takes a wait-andsee attitude toward the program. The biggest test will come after its graduates have been in industry several more years and their progress can be reviewed. But he's optimistic that individuals who have the motivation to plow through several years of rigorous part-time study will also have the fortitude to succeed in industry. For now, he's proud of the opportunities that the program offers. "What a degree does is give you a chance to demonstrate what you know. People may hire you based on your degree, but what you do is the real payoff."

EDN

Article Interest Quotient (Circle One) High 518 Medium 519 Low 520

A mong Haughton's concerns is that the graduates, though skilled in their areas of expertise, will miss out on the breadth of engineering experience from which typical students benefit.

teaches him the theories behind the work he's been doing. "I've used a lot of the equipment and devices that we learn about, and now I'm really learning the theory."

Design engineer Andrei Bostan believes that Program 2 has given him an opportunity to study that he might not otherwise have had. In 1978, Bostan and his family immieach enrollee—there are still aspects of it to be worked out. For instance, he fears that Program 2 graduates, though skilled in their areas of expertise, will miss out on the breadth of engineering experience from which typical engineering students benefit. "That's the thing that worries me most," he says. "Our undergraduate civil engineer-

EDN's CHARTER

EDN is written for professionals in the electronics industry who design, or manage the design of, products ranging from circuits to systems.

EDN provides accurate, detailed, and useful information about new technologies, products, and design techniques.

EDN covers new and developing technologies to inform its readers of practical design matters that will be of concern to them at once or in the near future.

EDN covers new products

- that are immediately or imminently available for purchase
- that have technical data specified in enough detail to permit practical application
- for which accurate price information is available.

EDN provides specific "how to" design information that our readers can use immediately. From time to time, EDN's technical editors undertake special "hands-on" projects that demonstrate our commitment to readers' needs for useful information.

EDN is written by engineers for engineers.



275 Washington St Newton, MA 02158 (617) 964-3030

BUSINESS/CORPORATE STAFF

F Warren Dickson Vice President/Publisher Newton, MA 02158 (617) 964-3030 Telex 940573 Diann Siegel, Assistant

Peter D Coley VP/Associate Publisher/ Advertising Sales Director Newton, MA 02158 (617) 964-3030 Ora Dunbar, Assistant/Sales Coordinator

NEW ENGLAND John Bartlett, Regional Manager Chris Platt, Regional Manager 199 Wells Ave Newton, MA 02159 (617) 964-3730

STAMFORD 06904 George Isbell, Regional Manager 8 Stamford Forum, Box 10277 (203) 328-2580

NEW YORK, NY 10011 Daniel J Rowland, Regional Manager 249 West 17th St New York, NY 10011 (212)463-6419

PHILADELPHIA AREA Steve Farkas, Regional Manager 487 Devon Park Dr Suite 206 Wayne, PA 19087 (215) 293-1212

Clayton Ryder, Regional Manager Clayton Ryder, Regional Manager Cahners Plaza 1350 E Touhy Ave, Box 5080 Des Plaines, IL 60017 (312) 635-8800

DENVER 80206 John Huff, Regional Manager 44 Cook St (303) 388-4511

DALLAS 75243 Don Ward, Regional Manager 9330 LBJ Freeway Suite 1060 (214) 644-3683

SAN JOSE 95128 Walt Patstone, Regional Manager Bill Klanke, Regional Manager Philip J Branon, Regional Manager James W Graham, Regional Manager 3031 Tisch Way, Suite 100 (406) 243-8838

LOS ANGELES 90064 Charles J Stillman, Jr Regional Manager 12233 W Olympic Blvd (213) 826-5818

ORANGE COUNTY/ SAN DIEGO 92715 Jim McErlean, Regional Manager 18818 Teller Ave, Suite 170 Irvine, CA (714) 851-9422

PORTLAND, OREGON 97221 Pat Dakin, Regional Manager Walt Patstone, Regional Manager 1750 SW Skyline Blvd, Box 6 (503) 297-3382

UNITED KINGDOM/BENELUX Jan Dawson, Regional Manager 27 Paul St London EC2A 4JU UK 44 01-628 7030 Telex: 914911; FAX: 01-628 5984

SCANDINAVIA Stuart Smith 27 Paul St London EC2A 4JU UK 01-628 7030 Telex: 914911; FAX: 01-628 5984

FRANCE/ITALY/SPAIN Alasdair Melville 27 Paul St

London EC2A 4JU UK 01-628 7030 Telex: 914911; FAX: 01-628 5984

WEST GERMANY/SWITZERLAND/AUSTRIA Wolfgang Richter Sudring 53 7240 Horb/Neckar West Germany 49-7451-7828; TX: 765450 ISRAEL Igal Elan Elan Marketing Group 13 Haifa St, Box 33439 Tel-Aviv, Israel Tel: 972-3-268020 TX: 341667

EASTERN BLOC Uwe Kretzschmar 27 Paul St London EC2A 4JU UK 01-628 7030 Telex: 914911; FAX: 01-628 5984

FAR EAST Ed Schrader, General Manager 18818 Teller Ave, Suite 170 Irvine, CA 92715 (714) 851-9422; Telex: 183653

TOKYO 160 Kaoru Hara Dynaco International Inc Suite 1003, Sun-Palace Shinjuku 8-12-1 Nishishinjuku, Shinjuku-ku Tokyo 160, Japan Tel: (03) 366-8301 Telex: J2322609 DYNACO

TAIWAN Acteam International Marketing Corp 6F, No 43, Lane 13 Kwang Fu South Rd Mailing Box 18-91 Taipei, Taiwan ROC 760-6209 or 760-6210 Telex: 29809 FAX: (02) 7604784

KOREA Korea Media Inc Rm 110, A-11 Bidg 49-4, Hoihyundong 2-Ka, Chung-Ku CPO Box 2314, Seoul, Korea Tel: 82-2-755-9880 Telex: K26249

SINGAPORE Cheny Tan Associates 1 Goldhill Plaza No 02-01 Newton Rd Singapore 1130 Tel: 2549522 Telex: RS 35983 CTAL

PRODUCT MART Joanne Dorian, Manager 249 West 17th St New York, NY 10011 (212) 463-6415

CAREER OPPORTUNITIES/ CAREER NEWS Roberta Renard National Sales Manager 103 Eisenhower Parkway Roseland, NJ 07068 (201) 228-8602

Janet O Penn Eastern Sales Manager 103 Eisenhower Parkway Roseland, NJ 07068 (201) 228-8610

Dan Brink Western Sales Manager 18818 Teller Ave Suite 170 Irvine, CA 92715 (714) 851-9422

Diann Siegel Boston Sales Representative Newton, MA 02158 (617) 964-3030

Maria Cubas Production Assistant (201) 228-8608

Cahners Magazine Division William Platt, President Terry McDermott, Executive Vice President Frank Sibley, Group Vice President Tom Dellamaria, VP/Production & Manufacturing

Circulation Denver, CO: (303) 388-4511 Sherri Gronli, Group Manager Eric Schmierer, Manager

Reprints of EDN articles are available on a custom printing basis at reasonable prices in quantities of 500 or more. For an exact quote, contact Joanne R Westphal, Cahners Reprint Service, Cahners Plaza, 1350 E Touhy Ave, Box 5080, Des Plaines, IL 60018. Phone (312) 635-8800.

CAREER OPPORTUNITIES

1988 Editorial Calendar and Planning Guide



Southern Research Institute

You Can Have The Best In Professional/Lifestyle Advantages!

Southern Research Institute has a solid track record of over 40 years experience in highly diversified research projects of national significance. We provide our team of professionals with ongoing opportunities to use the latest scientific tools on exciting assignments. Utilize and enhance your knowledge and expertise with us now.

ELECTRONIC ENGINEERS

Current work involves design, development and testing of complex electro-optical and mechanical systems for military applications. We seek Electrical Engineers with advanced degrees, both entry-level and experienced, with background in any of the following areas:

- Microprocessor Hardware/Software Design
- Real-Time Assembly Language Programming
- Simulation/Algorithm Development
- Analog Circuit Design
- Video Systems
- Infrared Systems

After you have explored the realm of career possibilities with us, you'll want to know more about the Birmingham lifestyle. This highly desirable city is already home to more engineers than any other city in the Southeast and provides a broad range of advantages. Here, you can enjoy a mild, seasonal climate; any type of recreation; below average living costs and taxes; and so much more.

We offer competitive salaries and excellent benefits. Your confidential resume or letter of inquiry will receive immediate consideration. Respond to: James G. Kerr, Personnel Office, Dept. 256 Southern Research Institute, P.O. Box 55305, Birmingham, AL 35255-5305. An Affirmative Action/Equal Opportunity Employer. U.S. Citizenship Required.

Issue Date	Recruitment Deadline	Editorial Emphasis	EDN News	
Jan. 7	Dec. 14	Computers & Software, Communications ICs	. Closing: Dec. 21 Mailing: Jan. 14	
Jan. 21	Dec. 30	Microprocessors, Software, Components		
Feb. 4	Jan. 14	Semicustom ICs, Computors & Peripherals	. Closing: Jan. 21 Mailing: Feb. 11	
Feb. 18	Jan. 28	Materials & Hardware, CAE, Power Sources		
Mar. 3	Feb. 11	Communications, CAE, High-Speed Logic	Closing: Mar. 3 Mailing: Mar. 24	
Mar. 17	Feb. 25	Graphics, Filters, Software/CAE		
Mar. 31	Mar. 10	Power Semiconductors, Memory/Graphics, Fiber Optics		
Apr. 14	Mar. 23	Communication Technology Special Issue, Communication Systems	- Closing: Mar. 31 Mailing: Apr. 21	
Apr. 28	Apr. 7	Software, Industrial Computers, Interface ICs		
May 12	Apr. 21	Analog Technology Special Issue, Analog Converters	. Closing: Apr. 28 Mailing: May 19	
May 26	May 5	CAE, Software, Sensors/Transducers		
June 9	May 19	CAE, Analog ICs, Test & Measurement	. Closing: May 29 Mailing: June 16	
June 23	June 2	Data Communications, DSP, Components		
July 7	June 14	Product Showcase—Vol. I, Power Sources, Software	_ Closing: June 23 Mailing: July 14	
July 21	June 30	Product Showcase—Vol. II, CAE, Test & Measurement		

Call today for information: East Coast: Janet O. Penn (201) 228-8610 West Coast: Dan Brink (714) 851-9422 National: Roberta Renard (201) 228-8602





Some will follow the old standards. Some will create the new.

An engineer has only a few precious opportunities to create a new industry standard. This is one of them. If you're traveling within the limits of today's technology, but want to break through to the next generation of microprocessing, AMD has some exciting news for you... Your appointment with destiny has arrived.

AMD has gone way beyond the limits of existing microprocessing to create the super chip of the 1990s — the Am29000. At 32 bits and 17 MIPS, the Am29000 RISC-based microprocessor is 400% faster than the current industry standard. This exciting evolutionary breakthrough will make a whole new range of applications possible, bringing the power of a mainframe to desktop workstations; and providing embedded controller applications such as fiber optic networking and laser printer and communications controllers.

The Am29000 is just one of many significant developments at AMD. Our recent merger with Monolithic Memories makes us stronger and more versatile than ever before. The opportunities are better than ever for experienced hardware and software engineers to set new standards, with the following opportunities now open.

Am29000

Software Support Engineers

Experience in UNIX and C, plus MS DOS, PASCAL, FORTRAN, and Assembler makes you an ideal candidate. Be involved in customer support, developing tools and utilities, testing S/W packages, user manual review, documentation, writing application notes and magazine articles.



Hardware Strategic Marketing Engineer

Join the team that will provide marketing support for languages, operating systems, and support tools for the Am29000. Blend into our superb talent bank your 3 to 5 years' experience in marketing, design or applications of software for fixed instruction set microprocessors or large minicomputer products. Bring along experience in C, FORTRAN or PASCAL, UNIX*, VRTX or large operating systems, and you will be a prime candidate to be involved in all phases of defining and introducing products, including product definition and market research.

Sr. Product Planning Engineer

You will provide microprocessor and systems architecture design support for Am29000 follow-on products. This includes support for chip design, marketing, and tools development. Requires solid background in hardware and software systems, with knowledge and experience of RISC system architectures preferred.

Senior H/W — S/W Applications Engineers

Support the design-in of the Am29000 using your experience in H/W and S/W design of digital systems in computers and embedded controllers. Required experience ranges between 5 and 10 years for individuals with strong system architecture backgrounds, good communication skills, and knowledge of system optimization.

Software QA Applications Engineers

Develop test plans and perform S/W QA testing, develop and implement test suites for O/S, compilers and assemblers and develop tools and utilities to aid in testing.

Applications Engineers

Join in the design and support of Am29000 demo/evaluation boards and systems, do customer support and publish documentation. You will need experience in H/W design of digital systems and familiarity with Assembler, C, UNIX and MS DOS.

AMD is writing a new chapter in the history of technology for those who dream of creating the new. **You see, at AMD we figure that, if you don't make history, you're history.**

For immediate consideration, please call (408) 749-3119 or send your resume, indicating position of interest, to Advanced Micro Devices, Professional Employment, MS-57, 901 Thompson Place, P.O. Box 3453, Sunnyvale, CA 94088. An equal opportunity employer.

*UNIX is a trademark of AT&T Bell Labs.



S S Α R N N N R F G F F

Home in on an extraordinary career at GE **Government Electronic Systems Division. If** you are an engineer with the ability to create sophisticated Sonar systems, there is tremendous future within range.

Our Undersea Systems Department is a recognized leader in ASW technology for Surface Ship and submarine based systems. We continue to expand our technology and program base through our reputation for delivering quality products and well funded

As ASW technology continues to grow, you owe it to yourself to grow with the leader

Additional positions are available. For prompt response forward your resume to: **GE-Government Electronic** Systems Division, Code EDN, Box 4840,

The Future

Is Working At **General Electric**

CSP-4-48, Syracuse, NY 13221

- Senior Systems Engineers opportunities currently exist in: •Large Scale Combat Systems Analysis;
- Design & Development
- Acoustics development
- Algorithm development
- Sensor systems design & development
- Control systems engineering
- •Signal/data processing design

Senior Software Engineers opportunity to advance if you're

- experienced with:
- Real time software development
- Architecture and design of embedded programmable processors (68000 or
- similar processor)
- Top down structured design in ADA or Fortran (UYK-43 desirable)
- •Software Quality Assurance in accordance with MIL-S-52779
- Configuration Management in accordance with MIL-S-483

TOPPORTUNITY SLIP BY

Senior Hardware Engineers

- Advanced architecture and design CMOS gate array development
- Power supply design
 Analog or digital circuit design (board and component level)
- Transmitter design

Senior Test & **Evaluation Specialists**

with experience in: •Detailed test plan development

- Facilities layout

BOEING

- Top level test documentation
- Subcontract management

U.S. Citizenship Required-minorities, females, handicapped and Vietnam Era Veterans encouraged to apply. No agencies please




North American Aircraft Operations in El Segundo & Lakewood, California

For Immediate Consideration, Call 1-800-221-3333, ext. Rockwell, 24 hours a day, 7 days a week

Rockwell International Corporation's North American Aircraft Operations in Southern California is preparing to meet the next generation of aircraft development challenges with the justawarded National Aerospace Plane (NASP) program.

The research and development of hypersonics, along with technologies associated with the recently awarded AC-130U Gunship Project, X-31 Enhanced Fighter Maneuverability Program and other advanced programs will provide involved professionals with a technological edge that will serve them well into the next century.

And this is your opportunity to become immediately involved in the future of flight.

ADVANCED DESIGN ENGINEERING

Vehicle Management System (100002)

Control Analysis & Synthesis (100003)

Guidance System Design (100004)

Advanced Subsystem Engineers (100005)

Propulsion System Aerodynamics (100006)

Aerodynamic Design (100007)

Senior Configuration Designers (700005)

AVIONICS SYSTEMS ENGINEERS (100009)

THERMODYNAMICS ANALYSTS-SENIOR & ENTRY-LEVEL (100010)

MATERIAL AND PROCESS ENGINEERS (100011)

STRESS ENGINEERS (100012)

EXTERNAL STRUCTURAL LOADS ENGINEERS (100013)

STRUCTURAL DESIGN ENGINEERS (100014)

WIND TUNNEL MODEL DESIGN ENGINEERS (100015)

PACKAGING ENGINEERING (100016)

VIBROACOUSTICS ENGINEERS (100017)

FLUTTER ENGINEERS (100018)

ENGINEERING CHECKING (100019)

AVIONICS & ADVANCED WEAPON SYSTEMS INTEGRATION EO/IR Systems Engineer (484311)

Project Manager-Advanced Avionics Systems (606252)

EW Systems Engineers (569428)

RF System Engineers (566046)

Digital Avionics Systems Engineers (700001)

Electro-Optical Systems Engineers (700002) RF Design Engineers (700003)

Display Systems Engineers (700004)

AVIONICS SOFTWARE ENGINEERS Software Development Tools (568095)

AIRFRAME & SYSTEMS DESIGN Avionics/Electrical Installations (300001)

Crew Station Design Engineer (300002)

Oxygen System Design Engineer (300003)

Interior Lighting Design Engineer (300004)

Landing Gear Design Engineer (300005)

Advanced Aircraft Subsystems Design Engineers (300006)

TPS/TESTABILITY ANALYSIS (500001)

COMPUTER-AIDED SYSTEMS

Software Systems Designer (440563)



MODEM USERS: For immediate consideration. use your computer and modem to submit your resume. Our online Career Center can be accessed 24-hours a day. 7-days a week. Just call (modem only) 213-372-4050 and type GO ROCKWELL upon entry.

Rockwell International offers excellent compensation and benefits. For immediate consideration call our toll-free number. or send your resume to: **Professional Staffing**: EDNI210, Attn: V.B. Martinez, 051-GA07, 201 N. Douglas St., El Segundo, CA 90245. Equal Opportunity Employer M/F. U.S. Citizenship may be required for some positions.

Rockwell International

...where science gets down to business

HAVING THE BEST TECHNOLOGY IS ONLY HALF THE BATTLE.



The Trojan Horse was a very progressive technological idea for its day — but what was it without those ingenious and determined soldiers inside? Nothing but an oversized wooden horse on wheels.

At Litton Data Systems we understand that it's the people behind technologies that make

them work. And the people inside a company who make things happen.

Over twenty-five years of excellence in the design and manufacture of vital military C^3 systems mark our commitment to an entrepreneurial atmosphere that encourages our professionals to do what's necessary to conquer today's technologies.

If you're interested in joining a company with a classically simple strategy for success, consider one of the following positions:

SYSTEMS ENGINEERING

Air Defense Systems

Will assist in preparation of Requirements Documents, Mission Analysis, Functional Flows/Allocations, System Synthesis and perform required Trade Studies. Requires a minimum of 10 years experience in C³I systems and working knowledge in one or more of the following type systems: Tactical Air Command Center, Tactical Air Operations Center, Direct Air Support Center, Command Operation Center, Forward Air Command Post, Forward Area Air Defense.

SOFTWARE/FIRMWARE ENGINEERING

Requires 5-10 years' experience in Assembly language programming for military systems and a minimum 5 years' experience in digital signal processing applications.

• Will be responsible for programming state-of-the-art digital and voice communication systems. Requires experience in the programming of the ZILOG Z80, INTEL 8748 and TI TMS32020 micro-processors. 3-5 years' experience in the development of communication firmware and a solid understanding of hardware design is necessary.

Above positions require a BS in Computer Science or Engineering.

- Will be responsible for contributing to the design and modeling of new algorithms. Requires an MS/PhD in Computer Science or Engineering and a minimum of 15 years' experience applying signal processing theory in the development of tracking systems.
- Will implement firmware for high speed digital data bus and impeded computer peripherals. Requires a BS in Computer Science, EE or Math and 3-5 years' experience in Assembly language, programming techniques and use of the UNIX* Operating System.

Jr. & Sr. Level Programmers

• Will generate PDL from detailed design documents, coding of programs in CMS2 and Assembly language and unit testing of the programs. Requires 1-8 years' software experience.

Send your resume to: Employment, Dept 605, 8000 Woodley Ave., Van Nuys, CA 91409-7601.

Litton

Data Systems

Principals Only/Equal Opportunity Employer

*UNIX is a registered trademark of AT&T.

THE EDN MAGAZINE/EDN NEWS

Recruitment Package

The most cost-effective way to reach the most professionals!

EDN reaches more than 137,000 engineers and engineering managers, the largest circulation in the electronics field. EDN News reaches EDN's U.S. circulation of more than 121,500. And, when you place equivalent space in both the *Career Opportunities* section of EDN, and the *Career News* section of EDN News in the same month, you'll get a ¹/₃ discount off the EDN News rate!

EDN MAGAZINE/EDN NEWS Where Advertising Works.



Involvement through Innovation.

That's the success tradition at Rockwell International's Telecommunications Businesses.

We create traditions that evidence involvement. The fruit of our lateral integration strategy, for instance, offers the opportunity to work across the entire technological spectrum. By placing product planning, advanced technology, R&D, manufacturing and quality in one central location we achieve a focus on technical excellence.

Our far-reaching commitment to R&D and innovation is reflected by our market leadership position. We were the first leading equipment maker to offer completely digital systems and helped pioneer both analog and digital microwave systems. Today, product lines that include the most advanced, high performing one gigabit fiber optic transmission systems, digital and analog multiplex systems, and 1.7 to 19.7 GHz frequency microwave communications systems are the foundation of our strong reputation in telecommunications.

Our development teams pursue lightwave, microwave and digital innovation combining technology, involvement and company support. To become involved, consider the following:

Process/Hybrid Engineers

Should possess a BS or MS in EE, Physics or Chemistry with 5 years experience in semiconductor processing technology. This Team Leader position provides technical direction, work-flow control, and hands-on expertise while coordinating the Process Team efforts in pilot production and InGaASP/InP devices research and development. Requires understanding of processing techniques and equipment, such as: photolithography, wet and dry etching, dielectric and metal deposition, diffusion and alloying. Prefer experience with InGaASP/InP material.

Digital Circuit Design Engineers

BSEE and a minimum of 4 years experience in high frequency analog and digital circuit design. Position requires experience in discrete amplifier design (15mhz +). clock recovery circuit design, phase lock loop design (15mhz +) and line conditioning for line buildout circuits. Telephony background and knowledge of DS1-DS3 signals are required. Experience in functional partitioning is desirable.

Opto-Electronic Device Design Engineers

Requires a PhD/MSEE/Physics with 5-10 years of optoelectronic device experience. Should be familiar with longwave length (1.2-1.6 microns) InP based source and/or detectors design and characterization. Position involves design and characterization of devices including PIN photodetectors, GaAs avalanche photodiodes, semiconductor lasers and LED's. Record of scientific accomplishment and publication is desirable.

Digital VLSI Engineers

Requires BSEE/MSEE with 6-8 years experience in telephony digital hardware design. Experience with CMOS or ECL logic design, VLSI gate array design, and Daisy CAE Design techniques necessary. Desire experience with 40-50 mhz CMOS, DS3 and/or DS1 signals and modulation techniques. Recognized ability to address systems redundancy, signal integrity and system monitor and control must be demonstrated.

Software Engineers

Positions call for a BSCS or BSEE and 5 years software architecture/design experience OR an MSCS or MSEE and 3 years software architecture/design experience. Involves software development for distributed microprocessor network control systems. Experience in circuit switched and packet switched network control is necessary. Team software development experience for Motorola 68000 systems is desirable. Candidates with "C". UNIX[™] ADA and OSI data communications experience will be given special consideration.

Product Specialist

BSEE/CS plus 6 years experience with minimum 2-3 years in long-range network planning, network service applications and technical interface with diverse network users required. Must have knowledge of new technologies with strong revenue potential for the BOC, IXC.

Responsibilities involve product planning and product application of Digital Transmission Systems Products. Good working knowledge of the telecommunications network is essential, with emphasis on network applications of multiplex, Digital Cross Connects and Operational Support Systems. Technical familiarity with SONET, SYNTRAN, HDLC/X.25 protocols required. Network experience with circuit grooming, hub planning development and capability of working closely with customer network planners to assess product requirements and trends are necessary. Network experience and strong interpersonal skills are essential.

Rockwell International's compensation package includes a saving/stock ownership plan, comprehensive medical coverage, dental insurance, retirement plan, tuition reimbursement and much more!

We are interested in hearing from you immediately. Please send your resume to: **Richard Skelnik**, **Rockwell International**, **Telecommunications**, **M/S 401-152**, **#8568**, **P.O. Box 10462**, **Dallas**, **Texas 75207**. Permanent Residency Required. Equal Opportunity Employer M/F.

Rockwell International

... where science gets down to business

[™] UNIX is a trademark of AT&T Bell Laboratories.

ADVERTISERS INDEX

Abbott Transistor Labs Inc	
ABC Taiwan Electronics Corn	357
ACCEL Technologies Inc	355
ACDC Electropics	
ACDC Electronics	
Acme Electric Corp	230-231
Advance Power Supplies Inc*	
Advanced Micro Devices	
Advanced Microcomputer Systems I	nc 22F
Acrefley Laboratorian Inc.	202
Aeronex Laboratories inc	
AIE Magnetics	
Airpax Corp/Cheshire Div	
Airpax Corp/Frederick Div	
Alexander Batteries	353
Alexander Dalleries	
Ametek Inc	139
AMP Inc	118-119
Amperex Electronic Corp*	305.350
Archimodos Software	186
Archimedes Soltware	
Arium Corp	183
Arnold Magnetics Corp	
Atlanta Signal Processors Inc	64
Autodesk Inc	171
Autodosk mo	174
Avocet Systems inc	
Axelen Industrial Inc	
AYE Enterprise Co Ltd	
Baver AG**	14-15
PRC	316
Dec Mieroputama	250.050
Dao Microsystems	
BICC-Vero Electronics Inc	95
BP Microsystems	
Brain Power Inc	361
Prooktrog Corp	200 201
Blooklige Colp	
Brown Kellog Inc	
Burndy Corp	109-111
Burr-Brown Corn	45, 259 320
PV Engineering	256
By Engineering	
Вутек Согр	
Cadnetix Corp	
Cahners Exposition Group	
California Scientific Software	354
Canionna Ocientine Sonware	
Capital Equipment Corp	
Casio Inc	
Cherry Electrical Products Inc	
Cherry Semiconductor	320-321
Chinon Amorica Inc	190
Chinon America Inc	
C&K Components Inc	
Comair Rotron Inc	
Comlinear Corp	
Computer Vision	101
Consumer Microsireuite Ltd**	
Consumer Microcircuits Lia	
Conversion Devices Inc	
Converter Concepts Inc	
Corning Materials	140
Cotronic**	
	300
1 10 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	
Cybernetic Micro Systems	
Cypress Semiconductor	
Cypress Semiconductor	
Cypernetic Micro Systems Cypress Semiconductor Dale Electronics Inc	
Cypernetic Micro Systems Cypress Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue	
Cypernetic Micro Systems Cypress Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data VO Corp.	
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Lipplay Products	323 284 235-242 1 2 .341, 343, 345
Cyperest CMICro Systems Cypress Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Josplay Products Data I/O Corp Dataram Corp	323 284 235-242 341, 343, 343, 345 190
Cypernetic Micro Systems Cypress Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data I/O Corp Dataram Corp De Found Electronics	323 284 235-242 341, 343, 345 8 190 66
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data I/O Corp Data I/O Corp De Found Electronics Deltron Inc	323 284 235-242 .341, 343, 345 8 .341, 343, 345 66 .226
Cypernetic Micro Systems Cypress Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc	323 .284 .235-242 .341, 343, 345
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Dinital Media Inc	323 284 235-242 341, 343, 345 8 190 66 226 355
Cypernetic Micro Systems Cypress Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Josplay Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc	323 284 235-242 341, 343, 345 8 190 66 226 359 358 358
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Isplay Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc	323 284 235-242 341, 343, 345 66 226 355 356 356 356 356 356 356 356 356 35
Cyperest CMICro Systems Cypress Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data I/O Corp Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA	323 284 235-242 341, 343, 345 341, 343, 345 190 66 226 355 355 355 184 275
Cypernetic Micro Systems Cypress Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre	323 .284 .235-242 .341, 343, 345 .8 .190 .66 .226 .355 .355 .356 .356 .356 .356 .356 .35
Cyperest CMICro Systems Cypress Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data I/O Corp Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems	323 284 235-242 341, 343, 345 490 66 355 355 355 184 277 112-113 136-137
Cypernetic Micro Systems Cypress Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp	323 284 235-242 341, 343, 345 6 226 355 355 355 355 355 355 355 355 355 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Connector Systems Eaton Corp Core Cale Engineering Inc	323 284 235-242 341, 343, 345 45 341, 343, 345 490 66 355 355 355 355 184 275 112-113 136-137 355 290
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc	323 284 235-242 341, 343, 345 8 355 355 355 355 355 355 112-113 136-137 355 299 200
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Digital Media Inc Digital Media Inc Dionics Inc Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp	323 284 235-242 341, 343, 345 45 356 356 356 356 356 356 356 356 356 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Co Vacre Du Pont Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc	323 284 235-242 341, 343, 345 341, 343, 345 341, 343, 345 341, 343, 345 356 356 356 356 356 356 356 356 356 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Trans Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Emulation Technology Inc	323 284 235-242 235-242 341, 343, 345 66 226 355 356 356 356 356 356 356 356 356 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Emulation Technology Inc	323 284 235-242 341, 343, 345 341, 343, 345 355 356 356 356 356 356 356 356 356 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Trans Corp De Found Electronics Delfron Inc Design Computation Inc Digital Media Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Emulation Technology Inc Encounter Products Corp	323 284 235-242 341, 343, 345 4 341, 343, 345 4 226 356 356 356 356 356 356 356 356 356 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Ji/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Emulation Technology Inc Encounter Products Corp Endicott Research Group	323 284 235-242 341, 343, 345 490 666 355 356 356 356 356 356 356 356 356
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Trans Corp De Found Electronics Delfron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Emulation Technology Inc Encounter Products Corp Endicott Research Group ETA Industries Inc	323 284 235-242 341, 343, 345 4 355 356 356 356 356 356 356 356 356 356
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Torp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Emulation Technology Inc Encounter Products Corp Enclott Research Group ETA Industries Inc	323 284 235-242 341, 343, 345 490 666 226 355 356 356 356 356 356 356 356 357 357 355 302 317 355 357 357 357 357 357 357 357 357 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd**	323 284 235-242 341, 343, 345 341, 343, 345 356 356 356 356 356 356 356 356 356 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Torp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Connector Systems Eaton Corp Ed&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Emcounter Products Corp Emclott Research Group ETA Industries Inc Farnell International Ltd**	323 284 235-242 341, 343, 345 490 666 226 355 356 356 356 184 275 112-113 136-137 355 299 302 317 355 357 284 357 284 357 284 357 284 357 284 357 284 357 284 357 284 357 284 357 284 357 284 357 284 357 284 357 284 357 357 284 357 284 357 284 357 284 357 284 357 284 357 284 357 284 357 284 357 357 357 357 357 357 357 357 357 357
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data I/O Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc	323 284 235-242 341, 343, 345 341, 343, 345 355 356 356 356 112-113 136-137 355 299 302 302 302 302 317 355 299 302 302 317 355 299 302 302 317 355 299 302 317 355 299 302 317 355 299 302 317 355 299 302 317 355 299 302 317 355 299 302 317 317 355 299 302 317 317 355 299 302 317 317 317 317 317 317 317 317 317 317
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Torp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Co Vacre Du Pont Covere Eaton Corp EdasG Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computer Products Group*	323 284 235-242 341, 343, 345 66 226 355 356 356 356 356 357 112-113 136-137 355 299 302 317 355 357 284 341 148 28-22 144 148
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Ji/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computer Sinc Fujitsu Components of America Inc* Fujitsu Components of America Inc* Fujitsu Components of America Inc* Fujitsu Limited**	323 284 235-242 341, 343, 345 341, 343, 345 356 356 356 356 356 356 356 356 356 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Trans and Goodhue De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emulation Technology Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computer Sinc Fujitsu Components of America Inc* Fujitsu Computer Products Group* Fujitsu Computer Products Group* Fujitsu Computer Products Group Fujitsu Computer Products Group*	323 284 235-242 235-242 341, 343, 345 66 226 355 356 356 356 356 357 112-113 136-137 355 229 302 317 355 357 284 341 .144 28-25 .144 .144 .145 222
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Ji/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Electronic Development Corp Emerson & Cuming Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc Fujitsu Components of America Inc* Fujitsu Components of America Inc* Fujitsu Limited**	323 284 235-242 341, 343, 345 341, 343, 345 355 355 355 355 355 355 355 355 355
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Trans, and Goodhue Data Trans, and	323 284 235-242 341, 343, 345 341, 343, 345 355 356 356 356 356 356 356 356 356 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Torp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc Fujitsu Components of America Inc* Fujitsu Limited** Fujitsu Limited** Fujitsu Limited**	323 284 235-242 325-242 341, 343, 345 341, 343, 345 356 356 356 356 356 357 357 357 357 357 357 357 357 357 357
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Jisplay Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc Fujitsu Components of America Inc* Fujitsu Components of America Inc* Fujitsu Computer Products Group* Fujitsu Limited** Fujitsu Microelectronics Inc* FW Bell Inc Gates Energy Products Inc	323 284 235-242 341, 343, 345 341, 343, 345 355 356 356 356 356 356 356 356 356 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Torp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Connector Systems Eaton Corp Ed&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Emcounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc Fujitsu Components of America Inc* Fujitsu Computer Products Group* Fujitsu Limited** Fujitsu Limited** Fujitsu Limited** Fujitsu Limited** Fujitsu Limited** Fujitsu Sincones	323 284 235-242 341, 343, 345 490 666 226 355 356 356 356 356 357 112-113 136-137 355 299 302 317 315 355 299 302 317 355 299 302 317 355 299 302 317 355 355 357 299 302 317 355 357 299 302 317 355 357 299 302 317 355 357 299 302 317 355 299 302 317 355 357 299 302 317 355 357 299 302 317 355 299 302 317 355 299 302 317 355 299 302 317 355 299 302 317 355 299 302 317 355 299 302 317 355 299 302 317 355 299 302 317 355 299 302 317 355 299 302 317 355 299 302 317 355 299 317 355 299 317 355 299 317 355 299 317 355 299 317 355 299 317 355 299 317 355 299 317 355 299 317 355 299 317 355 299 317 355 357 284 317 355 357 284 317 355 357 357 357 357 357 357 357 357 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data I/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc Fujitsu Components of America Inc* Fujitsu Components of America Inc* Fujitsu Limited** Fujitsu Limited** Fujitsu Limited** Gates Energy Products Inc Ge Calma Gennum Corp	323 284 235-242 341, 343, 345 341, 343, 345 355 356 356 356 356 356 356 356 356 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Torp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp Ed&G Wakefield Engineering Inc Electronic Development Corp Emulation Technology Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc Fujitsu Components of America Inc* Fujitsu Computer Products Group* Fujitsu Microelectronics Inc* FW Bell Inc Gates Energy Products Inc General Silicones Gennum Corp	323 284 235-242 341, 343, 345 66 226 355 356 356 356 356 357 357 357 365 357 365 357 284 341 341 341 341 341 342 344 341 344 341 345 353 357 284 341 341 345 357 357 284 353 357 284 353 357 284 353 357 284 353 357 284 353 357 284 353 357 284 357 284 357 357 357 284 357 357 357 357 284 357 357 357 357 357 357 357 357 357 357
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Ji/O Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Electronic Development Corp Emerson & Cuming Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc Fujitsu Components of America Inc* Fujitsu Components of America Inc* Fujitsu Limited** Fujitsu Limited** FW Bell Inc Gates Energy Products Inc GE Calma General Silicones Genum Corp	323 284 235-242 341, 343, 345 341, 343, 345 355 356 356 356 356 356 356 356 357 317 355 302 302 302 302 317 355 299 302 302 317 355 284 341 345 357 284 341 345 357 357 284 341 345 357 357 357 284 341 345 357 357 357 357 357 357 357 357 357 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Torp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Co Vacre Du Pont Connector Systems Eaton Corp Eds&G Wakefield Engineering Inc Electronic Development Corp Emulation Technology Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computer Sinc Fujitsu Components of America Inc* Fujitsu Components of America Inc* Fujitsu Computer Products Group* Fujitsu Limited** Fujitsu Limited** Fujitsu Endictores Inc General Silicones Gennum Corp GE/RCA Solid State GTEK Inc	323 284 235-242 341, 343, 345 66 226 355 356 356 356 356 357 112-113 1136-137 355 289 302 317 355 357 284 341 144 28-25 144 144 28-25 357 357 284 341 345 357 357 284 341 345 357 357 284 341 345 357 357 284 341 345 357 357 284 341 345 357 357 284 357 357 284 357 357 284 357 357 357 284 357 357 357 284 357 357 357 357 357 357 357 357 357 357
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Torp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Conactor Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Electronic Development Corp Emulation Technology Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc Fujitsu Compoter Products Group* Fujitsu Computer Products Group* Fujitsu Computer Products Group* Fujitsu Limited** Fujitsu Limited** Fujitsu Computer Products Inc General Silicones General Silicones General Silicones GETEK Inc Hansen Co MK	323 284 235-242 341, 343, 345 345 341, 343, 345 356 356 356 356 356 356 356 356 356 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Trans, and Goodhue De Found Electronics Delfuron Inc Digital Media Inc Digital Media Inc Digital Media Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Connector Systems Eaton Corp Ed&G Wakefield Engineering Inc Electronic Development Corp Emulation Technology Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc Fujitsu Components of America Inc* Fujitsu Limited** Fujitsu Limited** Fujitsu Limited** Fujitsu Limited** Fujitsu Limited** Fujitsu Components of America Inc Ge Calma General Silicones Gennum Corp GE/RCA Solid State GTEK Inc Harris Microwaye Semiconductor	323 284 235-242 341, 343, 345 341, 343, 345 356 356 356 356 356 356 356 356 356 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Torp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Connector Systems Eaton Corp Ed&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Electronic Development Corp Emerson & Cuming Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc Fujitsu Components of America Inc* Fujitsu Computer Products Group* Fujitsu Limited** Fujitsu Limited** Fujitsu Limited** Fujitsu Silicones General Silicones Gennum Corp GETK Inc Harris Microwave Semiconductor.	323 284 235-242 341, 343, 345 341, 343, 345 356 356 356 356 356 357 357 299 302 317 355 299 317 355 357 357 357 357 357 357 357 357 35
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data JiO Corp Dataram Corp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EG&G Wakefield Engineering Inc Electronic Development Corp Emerson & Cuming Inc Electronic Development Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc Fujitsu Components of America Inc* Fujitsu Components of America Inc* Fujitsu Compoter Products Group* Fujitsu Limited** Fujitsu Limited** FW Bell Inc Gates Energy Products Inc GE Calma Gennum Corp GE/RCA Solid State GTEK Inc Hansen Co MK	323 284 235-242 341, 343, 345 356 356 356 356 356 356 356 356 356 367 377 355 367 377 355 367 377 355 367 377 355 367 377 355 367 377 355 367 377 355 367 377 355 367 377 355 367 377 356 377 357 357 357 357 354 354 354 354 354 354 354 354 354 354
Cyperest Semiconductor Dale Electronics Inc Dash, Straus, and Goodhue Data Display Products Data Display Products Data Torp De Found Electronics Deltron Inc Design Computation Inc Digital Media Inc Dionics Inc Dow Chemical USA Du Pont Co Vacre Du Pont Co Vacre Du Pont Connector Systems Eaton Corp EdsG Wakefield Engineering Inc Electronic Development Corp Emulation Technology Inc Encounter Products Corp Endicott Research Group ETA Industries Inc Farnell International Ltd** Force Computers Inc Fujitsu Components of America Inc* Fujitsu Computer Products Group* Fujitsu Microelectronics Inc* FW Bell Inc Gates Energy Products Inc General Silicones Gennum Corp GE/RCA Solid State GTEK Inc Hansen Co MK Harris Microwave Semiconductor Hell Inc	323 284 235-242 324 235-242 324 341, 343, 345 66 226 355 356 357 112-113 136-137 355 229 302 302 302 317 355 357 284 341 148 28-22 144 144 28-22 144 144 28-22 144 353 354 355 357 284 353 354 355 357 284 353 354 355 355 357 284 353 354 355 355 357 355 357 284 355 357 357 357 357 357 357 357 357 357

	0.07
Heurikon Corp	
Hewlett-Packard Co85-90	, 103, 122-123
Honlex Industrial Co Ltd	
Houston Instruments	
Hypertronics Corp	
IEEE Applied Power	
Information Scan Technology Inc	
Inmos Corp	10-11 283
Integrated Circuits	360
Integrated Davice Technology Inc	50-51
Integrated Device Technology Inc	107 000 007
Intel Corp	0-107, 280-287
International Power Devices	
International Rectifier	16
Intusoft	
I/O Tech	
IBC Inc	340
Ironwood	357
	105
ITT Pomona Electronics	
Jenson Transformer	
Ji-Haw Industrial Co Ltd**	
John Fluke Manufacturing Co Inc*	20, 148
KEC Electronics Inc	
Kenco Inc	211-218
Kingdatram Electronics	
Industrial Co. Ltd**	210
Leader Instruments Corp	
LeCroy Corp	
Ledex Inc	
Linear Systems**	
Linear Technology Corp	107-108, 324
Loctite Corp	134
Logical Devices Inc.	252
Logical Devices Inc	
Logical Systems Corp	
LSI Logic Corp	291-298
3M Industrial Chemical Products	
Maxconn	106
Maxtor	52
Mechanical Enterprises Inc	42
Menco/Contralab	125
Miero Dot Inc/Maloo	1/2
Micro Dot mc/Marco	
MICro Networks	
Micro Switch'	
Microtek Lab**	
Midwest Components	61
Milpower Source	
Mini-Circuits Laboratories	
Mini-Circuits Laboratories	3, 4, 26-27
Mini-Circuits Laboratories	
Mini-Circuits Laboratories	
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc	3, 4, 26-27
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div	3, 4, 26-27 378 353 C2 38-39
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor	3, 4, 26-27 378 353 22 38-39
Mini-Circuits Laboratories Molad One Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc 17	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MWS Wire Industries	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 147
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MVS Wire Industries MX-Com Inc	3, 4, 26-27 378 353 C2 38-39 .19, 74-75, 265 147 354
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MWS Wire Industries MX-Com Inc National Semiconductor	3, 4, 26-27 .378 353 22 38-39 .19, 74-75, 265
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MWS Wire Industries MX-Com Inc National Semiconductor Corp 250-251, 254	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 47 354 255, 256-257
Mini-Circuits Laboratories Molex Inc. Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc. MX-Com Inc. National Semiconductor Corp. National Technical Systems National Technical Systems	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 147 354 -255, 256-257 349
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MWS Wire Industries MX-Com Inc National Semiconductor Corp NOR Corp	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 147 354 255, 256-257 349
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MX-Com Inc National Semiconductor Corp National Technical Systems NCR Corp	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 47 354 255, 256-257 349 349 349
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MX-Com Inc National Semiconductor Corp. National Semiconductor Corp. NCR Corp NCR Corp	3, 4, 26-27 378
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MWS Wire Industries MX-Com Inc National Semiconductor Corp Orp National Technical Systems NCR Corp NDK NEC Corp	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 147 354 255, 256-257 349 344 344 344 344
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MX-Com Inc National Semiconductor Corp National Technical Systems NCR Corp NEC Corp NEC Corp NEC Electronics Inc	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 47 354 255, 256-257 49 349 349 349 340
Mini-Circuits Laboratories Molad One Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MWS Wire Industries MX-Com Inc National Semiconductor Corp National Semiconductor Corp NCR Corp NDK NEC Corp NEC Electronics Inc Needham Electronics	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 147 354 255, 256-257 349 80 344 334 344 330 354
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc Ntoon Inc National Semiconductor Corp National Semiconductor Corp NEC Corp NDK NEC Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 47 354 255, 256-257 349 349 344 330 344 330 344 330 361
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MX-Com Inc National Semiconductor Corp National Semiconductor Corp National Semiconductor Corp NCF Net Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 .147 354 255, 256-257 349 349 344 330 344 330 341 330 341 330 341 330 341 330 341 330 341 330 341 34
Mini-Circuits Laboratories Molad One Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MWS Wire Industries MX-Com Inc National Semiconductor Corp National Semiconductor Corp NCF Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 147 354 255, 256-257 349 80 80
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc NX-Com Inc National Semiconductor Corp National Semiconductor Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMA Semiconductor Corp Nova Tran Corp	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 447 .255, 256-257 349 349 344 330 344 330 349 34
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc MX-Com Inc National Semiconductor Corp National Semiconductor Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nicolet Test Instruments Div Nicolet Test Instruments Div Nicolet Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 .147 354 .255, 256-257 349 349 349 349 344 30 344 364 355 355
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OK	3, 4, 26-27 378
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Technical Systems NCR Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 447 354 255, 256-257 349 349 344 330 344 330 345 355 355 76-77 355
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc NX-Com Inc National Semiconductor Corp National Semiconductor Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp NMB Semiconductor Corp NMB Semiconductor Corp NVA Tran Corp Octagon Systems OKI Semiconductor* Omation Inc	3, 4, 26-27 378
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc NX-Com Inc National Semiconductor Corp National Semiconductor Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 447 354 255, 256-257 349 349 344 344 330 345 361 361 355 76-77 360 357
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Semiconductor Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp NMB Semiconductor Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 .147 354 .255, 256-257 349 364 354 364 364 364 365 365 45 355 367 376 376 376 376 376 376 376 376 376 376 376 376 376 376 376 377 376 3777 3777 3777 3777 3777 3777 37777
Mini-Circuits Laboratories Molex Inc. Monad One Inc. Monolithic Memories Inc. Motorola Semiconductor Products Inc. National Semiconductor Corp. National Semiconductor Corp. NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp. Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals	3, 4, 26-27 378 373 22 38-39 .19, 74-75, 265 147 354 255, 256-257 349 80 344 330 80 354 354 355 355 76-77 360 357 44 360 357 44 41 360 357 41
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Technical Systems NCR Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp. Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co*	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 447 354 255, 256-257 349 349 344 300 344 300 345 355 355 45 355 45 360 360 367 44 49 361.
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Semiconductor Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp NMB Semiconductor Corp NMB Semiconductor Corp NMB Semiconductor Corp NMB Semiconductor Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orin Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 .147 354 .255, 256-257 349 349 344 30 344 30 345 355 45 355 76-77 360 357 44 357 44 351 493 357 44 351 493 351 493 351 493 351 493 351 493 351 493 351 493 4
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papto Mechatronic	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 447 354 255, 256-257 349 349 344 330 285 349 349 344 330 345 361
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wiz Systems Inc	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 47 354 255, 256-257 349 349 344 330 344 330 344 330 345 355 45 355 76-77 360 357 44 357 44 357 44 357 44 337 357 44 357 44 337 44 45 337 44 45 337 44 44 45 44
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Semiconductor Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp NMB Semiconductor Corp NMB Semiconductor Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wizz Systems Inc PC-Cad	3, 4, 26-27 378 378 353 22 38-39 .19, 74-75, 265 .147 354 .255, 256-257 349 349 344 330 285 354 354 355 355 355 355 357 357 367 357 367 357 367 357 367 357 361 361 361 361
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papt Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 447 354 255, 256-257 349 349 344 330 344 330 345 355 355 76-77 360 357 44 361 361 361 361 361 361 361
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Technical Systems NCR Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div**	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 47 354 255, 256-257 349 364 344 330 285 344 330 285 349 349 344 330 345 355 44 355 3
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Paton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div** Philips Elcoma Div** Philips Microcontrollers**	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 147 354 255, 256-257 349 349 344 330 285 354 361 361 361 360 357 44 360 357 44 360 361 360 361
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Technical Systems NCR Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp. Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div** Philips Microcontollers** Philips Test &	3, 4, 26-27 378 53 52 38-39 .19, 74-75, 265 447 354 255, 256-257 349 349 344 300 344 300 345 355 355 355 45 355 45 355 44 361 190 315 355 45 361 33 45 361 33 45 361 33 361361 361361361361361361361361
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monolithic Memories Inc Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Semiconductor Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp NMB Semiconductor Corp NMB Semiconductor Corp NMB Semiconductor Corp NMB Semiconductor Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div** Philips Elest & Measuring Instruments Inc**	3, 4, 26-27 378 53 52 38-39 .19, 74-75, 265 47 354 255, 256-257 349 349 344 30 344 30 355 355 355 355 355 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 361 45 45 45 45 45 45 45 45 45 45 45 45 45 46 45 46 45 46
Mini-Circuits Laboratories Molex Inc. Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc. National Semiconductor Corp. National Semiconductor Corp. NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp. Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papt Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div** Philips Test & Measuring Instruments Inc** Plessey Optoelectronics**	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 447 354 255, 256-257 349 349 344 344 330 285 354 361 3
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Montorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp NEC Electronical Systems NCR Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nicolet Test Instruments Div Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div** Philips Test & Measuring Instruments Inc** Plessey Optoelectronics** Power General	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 47 354 .255, 256-257 349 349 344 330 344 330 344 330 345 355 45 355 45 355 44 355 355 44 3555 3555 3555 35555 35
Mini-Circuits Laboratories Molex Inc. Monad One Inc. Monolithic Memories Inc. Motorola Semiconductor Products Inc. National Semiconductor Orp. National Semiconductor Corp. National Semiconductor NAC-Om Inc. National Technical Systems NCR Corp. NEC Corp. NEC Corp. NEC Corp. NEC Corp. NEC Corp. NEC Corp. NEC Electronics Inc. Needham Electronics. Nicolet Test Instruments Div. Nidec Torin Corp. NMB Semiconductor Corp. Nova Tran Corp. Octagon Systems OKI Semiconductor* Omation Inc. Omega Engineering Inc. Orion Instruments Oyster Terminals. Panasonic Industrial Co* Papst Mechatronic Paton & Patton PC Wizz Systems Inc. P-Cad. Philips Elcoma Div** Philips Elcoma Div** Philips Test & Measuring Instruments Inc** Plessey Optoelectronics** Power General. Powerex Inc.	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 47 354 255, 256-257 349 349 344 330 344 330 344 330 344 330 345 355 355 355 361 36
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monolithic Memories Inc Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Technical Systems NCR Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div** Philips Test & Measuring Instruments Inc** Plessey Optoelectronics** Power General Power Inc Power Inc	3, 4, 26-27 378 53 52 38-39 54 554 54 555, 256-257 354 354 354 354 354 354 354 354 354 354 354 354 354 355 354 355 360 361 361 361 361 322 329 320 327 329 320 327 320 327 329 320 327 320
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monolithic Memories Inc Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Semiconductor Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div** Philips Test & Measuring Instruments Inc** Plessey Optoelectronics** Power Cone Inc Powers Inc Power Inc	3, 4, 26-27 378 53 52 38-39 .19, 74-75, 265 47 354 255, 256-257 349 364 364 364 364 361 190 315 45 355 76-77 360 355 76-77 360 355 44 355 357 355 357 361 355 357 361
Mini-Circuits Laboratories Molex Inc. Monad One Inc. Monad One Inc. Motorola Microcomputer Div Motorola Semiconductor Products Inc. National Semiconductor Corp. National Semiconductor Corp. NEC Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papt Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div** Philips Test & Measuring Instruments Inc** Plessey Optoelectronics** Power General Powerex Inc PowerOne Inc PowerOne Inc PowerOne Inc Poweren Inc PowerOne Inc	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 447 354 255, 256-257 349 349 344 330 285 354 361 361 361 361 361 361 361 361 361 361 361 361 361 329 20, 117 329 20, 117 224-225 146 329 20, 117 224-225 146 329 20, 117
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monad One Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp. National Technical Systems NCR Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp. Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elecoma Div** Philips Test & Measuring Instruments Inc** Plessey Optoelectronics** Power General Power-One Inc Powertonic Powertonic Powertonic	3, 4, 26-27 378 53 53 52 38-39 374 354 354 354 354 354 354 354 354 354 354 354 354 354 354 354 354 354 355 354 355 355 355 355 355 355 355 355 355 355 355 355 357 360 357 44 330 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 357 44 357 44 357 44 357 44 357 44 357 44 357 44 357 44 357 44 361 361 361 361 361 361 361 329 3
Mini-Circuits Laboratories Molex Inc Monad One Inc Monolithic Memories Inc Motorola Semiconductor Products Inc National Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Papst Mechatronic Paton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div** Philips Elcoma Div** Philips Est & Measuring Instruments Inc** Plessey Optoelectronics** Power General Poweren Inc PowerIne PowerIonic Precision Etching Laboratory Inc Prospine Marci Inc	3, 4, 26-27 378 53 52 38-39 9, 74-75, 265 47 354 255, 256-257 349 349 344 30 344 30 344 30 355 355 76-77 360 355 355 76-77 360 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 357 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 355 357 44 357 44 355 357 44 357 44 355 46 357 44 357 44 357 44 361.
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Semiconductor Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div** Philips Test & Measuring Instruments Inc** Piessey Optoelectronics** Power General Power Cone Inc Powerline Powerone Inc Powerline Powerone Inc Powerine Powerone Inc Powerine Powerone Inc Powerine Powerone Inc Powerine Powerone Inc Powerine Powerone Inc Powerine Powerone Inc Powerine Powerone Inc Powerine Powerone Inc	3, 4, 26-27 378 53 22 38-39 9, 74-75, 265 447 354 255, 256-257 444 330 344 300 344 300 345 355 355 355 45 355 45 355 45 355 45 355 45 355 45 361 361 361 361 329 20, 117 329 20, 117 329 20, 146 356 356 356 356 329 339 339 339 339 329 329 339 3
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monolithic Memories Inc Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Semiconductor Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elecoma Div** Philips Test & Measuring Instruments Inc** Plessey Optoelectronics** Plessey Optoelectronics** Power General Powertonic Powerline Powertonic Precision Etching Laboratory Inc Precision Etching Laboratory Inc	3, 4, 26-27 378 53 52 38-39 38-39 38-39 354 354 354 354 354 354 354 354 354 355 355 44 355 355 45 355 355 44 355
Mini-Circuits Laboratories Molex Inc. Monad One Inc Monolithic Memories Inc Motorola Microcomputer Div Motorola Semiconductor Products Inc. National Semiconductor Corp. National Semiconductor Corp. National Semiconductor Corp. NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div** Philips Test & Measuring Instruments Inc** Plessey Optoelectronics** Power General Poweren Inc Powerline Powerline Powerline Powerline Powerline Powerline Powerline Powerline Powerline Powerline Powerline Precision Etching Laboratory Inc Precision Monolithics Inc Prism Electronics Ltd**	3, 4, 26-27 378 353 22 38-39 .19, 74-75, 265 47 354 255, 256-257 349 349 344 330 285 354 361 361 361 361 361 361 361 361 361 361 361 329 20, 117 224-225 146 329 20, 117 224-225 146 329 20, 117 224-225 146 356 262 224.225 146 356 262 224.225 146 356 262 224.225 146 356 262 224.225 27 224.225.225.225.225.225.225.225.225.2
Mini-Circuits Laboratories Molex Inc Monad One Inc Monad One Inc Monolithic Memories Inc Motorola Semiconductor Products Inc National Semiconductor Corp National Semiconductor Corp National Semiconductor Corp NEC Corp NEC Electronics Inc Needham Electronics Nicolet Test Instruments Div Nidec Torin Corp NMB Semiconductor Corp Nova Tran Corp Octagon Systems OKI Semiconductor* Omation Inc Omega Engineering Inc Orion Instruments Oyster Terminals Panasonic Industrial Co* Papst Mechatronic Patton & Patton PC Wizz Systems Inc P-Cad Philips Elcoma Div** Philips Test & Measuring Instruments Inc** Pissey Optoelectronics** Power General Power Inc PowerInc PowerInc PowerInc PowerInc PowerInc PowerInc PowerInc PowerInc PowerInc Precision Etching Laboratory Inc Precision Etching Laboratory Inc Precision Monolithics Inc	3, 4, 26-27 378 53 52 38-39 38-39 354 22 38-39 47 354 357 354 357 354 357 354 357 354 357 354 357 360 357 361 361 361 361 329 327 329 327 329 357

Quelo Inc	358
Raytheon Co, Semiconductor Div	
Raytheon Ocean Systems Co	62
Rifa Inc.	261
Rifa Inc/Capacitor Div	342
Rifa Inc/Power Products	201
Robinson-Halpern	357
Robinson-Nugent Inc	130-131
Robotrol	358
Rogers Corp	. 357, 361
Rohde & Schwarz**	267
Samtec Inc	360
Seagate Technology	63, 65, 67
Seeq Technology Inc	273
SGS Semiconductor Corp	46-47
Shin-Kobe Electric Machinery Co Ltd	279
Siecor Corp	120
Siemens AG**	, 305-307
Sierra Power Systems	72
Signal Transformer Co Inc	C4
Signetics Corp	54-55
Silicon General	276
Silicon Systems Inc	60
Single Board Solutions	360
Spectrum Signal Processing Inc	355
Spectrum Software	43
Stanford Research Systems Inc	184
Stimpson Co Inc	346
Switching Power Inc	
Taiwan Liton Electronic Co Ltd	149
Targa Electronics Systems Inc	182
Tauhas Electronics	
lauber Electronics	66
Tektronix Inc	, 312, 313
Tektronix Inc	, 312, 313
Tektronix-CAE Systems Inc	, 312, 313 , 281 , 172-173
Tektronix Inc	, 312, 313 , 281 , 172-173 , 361
Tektronix Inc	, 312, 313 281
Tektronix Inc	
Teleperences and a second seco	
Televideo Systems Televideo Systems Televideo Systems Inc Teltone Corp Termiflex Corp Texas Instruments Inc Thomas and Betts Corp Thomson Components-Mostek* 150-151 TL Industries Inc Todd Products Corp Toko America Inc	
Televideo Systems	
Tabler Electronics	
Tauber Electronics	
Tauber Electronics	
Tabler Electronics	
Tabler Electronics	
Tabler Electronics	66 ,312,313 ,281 ,172-173 ,361 ,234 ,175-176 ,364 ,306-307 ,364 ,306-307 ,364 ,352 ,353 ,353 ,222 ,355 ,353 ,222 ,355 ,355

Recruitment Advertising

AMD															. 367
Boeing												3	6	6,	368
GE Government.															.368
Litton															. 370
Rockwell															.369
Rockwell Collins			١,	ι,											.371
Southern Resear	c	h			*				•						. 366

*Advertiser in US edition **Advertiser in International edition

This index is provided as an additional service. The publisher does not assume any liability for errors or omissions.

LOOKING AHEAD

EDITED BY	CYNTHIA	B RETTIG
-----------	---------	-----------------

(\$ MILLION AT OEM SUBSYSTEM LEVEL)	1986	1987	1988	1989	1990	1991	1992
READ-ONLY	20.3	44.3	71.7	97.8	124.3	143.1	158.1
WRITE-ONCE	74.2	265.1	499.8	766.7	1031.5	1367.3	1730.9
ERASABLE	0.0	0.3	8.5	59.7	155.5	278.9	387.5
TOTAL DRIVES	94.5	309.7	580.0	924.2	1311.3	1789.3	2276.5
GROWTH FROM PREVIOUS YEAR	120	70%	47%	37%	30%	27%	21%

Erasable optical drives to surge into marketplace

As erasable optical disk drives become a commercial reality, they promise to alter dramatically the revenue pie currently shared by the two other optical storage methods. read-only drives and write-only, read-many (WORM) devices, according to the management-consulting firm Freeman Associates (Santa Barbara, CA). Over the next several years, substantial numbers of OEMs and system integrators will choose the erasable optical drives. Indeed, revenues from sales of these drives will overtake the annual earnings of read-only devices by 1990, even though samples of the erasable optical drives are just now entering the market.

For the three categories of drives, Freeman Associates distinguishes between revenues and units shipped. In 1990, for example, vendors will ship 338,100 read-only drives, 235,600 WORM drives, and only 119,100 erasable optical drives. But revenues in that year are projected to be \$124.3 million, \$1.032 billion, and \$155.5 million, respectively. By 1992, the total market should yield \$2.3 billion (see EDN, June 25, pg 350, for a related report on the same market).

Read-only drives will dominate the market from 1986 to 1992 in terms of unit shipments, although WORM drives will maintain a strong lead in revenues each year, ranging from 79% of optical-drive revenues in 1986, to 76% in 1992. In 1986, 97% percent of all read-only shipments were CD ROMs, and these will continue to constitute the great majority of read-only units shipped.

Because the CD-ROM business is totally dominated by a combination of various Japanese makers and by Philips of the Netherlands, US manufacturers are unlikely to enter it. US activity, albeit substantial, will be in publishing, marketing, systems integrating, and disk manufacturing.

For market analysis, the writeonce market can be divided into three groups defined by drive stor-

Unexpected growth seen for enclosure sales

The electronic-enclosure market is far from mature, according to Venture Development Corp (VDC) of Natick, MA. The industrial market for electronic enclosures, estimated at \$383 million for 1987, will top \$640 million by 1992. These numbers translate into a 10% compound

age size: <1G-byte drives, 1G- to 3G-byte drives, and those with even higher capacities, which will be available in low-volume production quantities next year. Manufacturers established the middle range in the marketplace early, and this range will continue to generate the most revenues through 1991. The lowest capacity group, however, will surpass the middle range in number of unit shipments within the next year. By 1992, the difference in unit shipments between these two groups will lessen considerably, although an aggressive pricing strategy for the devices with less than 1G byte will keep their share of revenue down; in that year, their portion of revenue will amount to only 17% of the market total. High-capacity drives should gain a 12% share of revenues within the same period.

In the erasable-device segment, manufacturers will begin by offering capacities below 1G byte. Drives of larger capacity should reach the market in 1990 as specialized mainframe devices.

annual growth rate. Three segments—telecommunications, military/aerospace, and medical/scientific—will consume more than 60% of the total shipments for this market throughout the period.

VDC defines an electronic enclosure as any covering or package used to house electronic components and equipment.



Molex Is Making The Connection Between... HIGH CURRENT HIGH DENSITY

From power supply to power distribution, Molex makes the connection.

Molex, the industry leader, now offers the most complete line of pin and socket connectors available. From standard wire-to-wire and wire-to-board versions, to the new high-performance "Mini-Fit Jr."

Mini-Fit Jr. meets today's demand for miniaturized design components.

With current handling capability of up to 9 amps per circuit, and a connector mating force of only 1.54 pounds per circuit, the Mini-Fit Jr. offers the ideal solution to your high current and high density interconnection requirements.





Molex is THE source for immediate delivery of pin and socket products.

Mini-Fit Jr. is our new generation power connector for your panel-towire, wire-to-wire, and board-towire applications.

Molex has factory stock and

distributor inventory around the world. Our pin and socket connectors meet full UL, CSA, VDE, and EAMCL standards. Features include silo protected terminals, positive lock, and pull tabs. They're available in brass or phos-bronze, with tin or selective gold plating for low cost and high performance.

Molex has the pin and socket connector you need, in the size and configuration you need, for every discrete wire application.



Corporate Headquarters: 2222 Wellington Ct., Lisle, IL 60532 USA, (312) 969-4550 • European Headquarters: Aldershot, England, (0252)318221 Northern Asia Headquarters: Tokyo, Japan, 03-478-8777 • Southeast Asia Headquarters: Jurong Town, Singapore, 65-261-9733



Exotic Customs at UDS

The special requirements of data communications OEMs have resulted in some pretty exotic custom modem cards from Universal Data Systems.

Funny form factors are routine fare for our custom designers. Nooks, crannies and odd card configurations are no problem, given sufficient square inches of real estate. UDS engineers have even designed a circular 212A modem that fits in the back of a residential electric meter.

Non-standard modem functions are another specialty of the house. For example, UDS engineers have already designed and



For a generous sampling of UDS' custom design capabilities, ask for the new, free OEM modem brochure.

delivered a hand-held RF modem operating at 4800 bps!

UDS has successfully handled more than 3,000 custom OEM modem design assignments — and we can handle yours. To begin an exotic custom, contact Universal Data Systems, 5000 Bradford Drive, Huntsville, AL 35805. Telephone 205/721-8000; Telex 752602 UDS HTV.



UDS modems are offered nationally by leading distributors. Call the nearest UDS office for distributor listings in your area. DISTRICT OFFICES: Apple Valley, MN, 612/432-2344 • Atlanta, GA, 404/998-2715 • Aurora, CO, 303/368-9000 • Blue Bell, PA, 215/643-2336 • Boston, MA, 617/875-8868 • Columbus, OH, 614/895-3025 • East Brunswick, NJ, 201/238-1515 • Glenview, IL, 312/998-8180 • Houston, TX, 713/988-5506 • Huntsville, AL, 205/721-8000 • Livonia, MI, 313/522-4750 • Mesa, AZ, 602/820-6611 • Milwaukee, WI, 414/273-8743 • Mission Viejo, CA, 714/770-4555 • Mountain View, CA, 415/ 999-3323 • Renton, WA, 206/235-9977 • Richardson, TX, 714/680-0002 • St. Louis, MO, 314/434-4919 • St. Peters, MO, 314/434-4919 • Silver Spring, MD, 301/942-8558 Tampa, FL, 813/684-0615 • Uniondale, NY, 516/222-0918 • Van Nuys, CA, 818/891-3282 • Willowdale, Ont, Can, 416/495-0008 • Winston-Salem, NC, 919/760-4184

CIRCLE NO 215

Imitation. The sincerest form of flattery.

We call Signal "The American Original." And we must be doing something right because our design innovations are being copied around the world.

While this imitation may be flattering to us, it could be extremely risky for you. After all, just because a transformer looks like Signal's doesn't mean it will perform like Signal's.

Our innovation, creativity and reliability are one-of-a-kind. We pioneered the high isolation split bobbin design.

Now our exciting new VDE certified International Series takes another leap forward with a dual, high-temperature bobbin and insulating shroud that provides

significantly better performance at lower costs than ever before. One-4-All™

and More-4-Less[™] transformers are so reliable they meet – or surpass – every important international specification (UL, CSA, VDE and IEC).

We also introduced low-profile, Flathead[™] plug-in transformers. Our latest series, available in five sizes, is arguably the best in the industry. The innovative non-concentric windings eliminate the need for



an electrostatic shield and feature hum-bucking construction.

Beyond that, Signal has a full line of superior low power PC board transformers, as well as smallerthan-ever "2-4-1" Series, competitively-priced rectifier power transformers, chokes and industrialgrade step-up and step-down power isolation transformers.

We maintain significant levels of our stock transformers and sell direct – without a middleman to slow things down – or mark prices up. Even better, we can ship to you in quantity within just 24 hours. We call it our PRONTO service... and it's unique in the industry.

Just let our competition try to play "follow the leader" with that!

Of course, if we don't have a standard stock item that fits your needs, our custom engineering department will gladly quote your specific requirements. *PRONTO*.

But for you, it's easy to follow our lead. Simply send for our complete, free catalog by contacting: Signal Transformer, 500 Bayview Avenue, Inwood, NY 11696.

BUY DIRECT (516) 239-5777

